

RealView® Platform Baseboard for ARM1176JZF-S

HBI-0147

User Guide



RealView Platform Baseboard for ARM1176JZF-S

User Guide

Copyright © 2007-2011 ARM Limited. All rights reserved.

Release Information

Change History			
Date	Issue	Confidentiality	Change
November 2007	A	Non-Confidential	First release.
March 2008	B	Non-Confidential	Second release to change memory map and TZ content.
June 2008	C	Non-Confidential	Third release to provide more information on interrupt controllers, power control, and protection control.
January 2009	D	Non-Confidential	Fourth release to correct errata.
March 2010	E	Non-Confidential	Fifth release to correct errata.
April 2011	F	Non-Confidential	Sixth release to correct errata.

Proprietary Notice

Words and logos marked with ® or ™ are registered trademarks or trademarks owned by ARM Limited, except as otherwise stated below in this proprietary notice. Other brands and names mentioned herein may be the trademarks of their respective owners.

Neither the whole nor any part of the information contained in, or the product described in, this document may be adapted or reproduced in any material form except with the prior written permission of the copyright holder.

The product described in this document is subject to continuous developments and improvements. All particulars of the product and its use contained in this document are given by ARM in good faith. However, all warranties implied or expressed, including but not limited to implied warranties of merchantability, or fitness for purpose, are excluded.

This document is intended only to assist the reader in the use of the product. ARM Limited shall not be liable for any loss or damage arising from the use of any information in this document, or any error or omission in such information, or any incorrect use of the product.

Confidentiality Status

This document is Non-Confidential. The right to use, copy and disclose this document may be subject to license restrictions in accordance with the terms of the agreement entered into by ARM and the party that ARM delivered this document to.

Unrestricted Access is an ARM internal classification.

Product Status

The information in this document is final, that is for a developed product.

Web Address

<http://www.arm.com>

Conformance Notices

This section contains conformance notices.

Federal Communications Commission Notice

This device is test equipment and consequently is exempt from part 15 of the FCC Rules under section 15.103 (c).

CE Declaration of Conformity



The system should be powered down when not in use.

The ARM1176JZF-S generates, uses, and can radiate radio frequency energy and may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment causes harmful interference to radio or television reception, which can be determined by turning the equipment off or on, you are encouraged to try to correct the interference by one or more of the following measures:

- ensure attached cables do not lie across the card
- reorient the receiving antenna
- increase the distance between the equipment and the receiver
- connect the equipment into an outlet on a circuit different from that to which the receiver is connected
- consult the dealer or an experienced radio/TV technician for help

———— **Note** ————

It is recommended that wherever possible shielded interface cables be used.

Contents

RealView Platform Baseboard for ARM1176JZF-S User Guide

	Preface	
	About this book	xx
	Feedback	xxvii
Chapter 1	Introduction	
	1.1 About the PB1176JZF-S	1-2
	1.2 Precautions	1-5
Chapter 2	Getting Started	
	2.1 Setting up the PB1176JZF-S	2-2
	2.2 Setting the configuration switches	2-3
	2.3 Connecting JTAG, Trace, and configuration equipment	2-10
	2.4 Supplying power	2-14
Chapter 3	Hardware Description	
	3.1 PB1176JZF-S architecture	3-2
	3.2 ARM1176JZF-S development chip	3-8
	3.3 Development chip peripherals	3-17
	3.4 FPGA peripherals	3-22
	3.5 FPGA configuration	3-30

3.6	Reset controller	3-32
3.7	Power supply	3-35
3.8	Clock architecture	3-38
3.9	Test, configuration, and debug interfaces	3-51

Chapter 4

Programmer's Reference

4.1	Memory map	4-3
4.2	ARM1176JZF-S development chip system controller	4-12
4.3	Advanced Power Controller and Power Management Interface	4-22
4.4	Advanced Audio CODEC Interface, AACI	4-27
4.5	Character LCD display	4-29
4.6	Color LCD Controller, CLCDC	4-32
4.7	Dynamic Memory Controller, DMC	4-34
4.8	Ethernet	4-36
4.9	FPGA status and system control registers	4-37
4.10	General Purpose Input/Output, GPIO	4-57
4.11	Interrupt controllers in the ARM1176JZF-S development chip	4-58
4.12	Interrupt controllers in the FPGA	4-74
4.13	Level 2 Cache Controller	4-106
4.14	Keyboard and Mouse Interface, KMI	4-107
4.15	MultiMedia Card Interfaces, MCI	4-108
4.16	PCI controller	4-109
4.17	Real Time Clock, RTC	4-120
4.18	Serial bus interface	4-121
4.19	Smart Card Interface, SCI	4-123
4.20	Synchronous Serial Port, SSP	4-124
4.21	Synchronous Static Memory Controller, SSMC	4-126
4.22	System Controller	4-130
4.23	Timers	4-131
4.24	TrustZone Protection Controller	4-132
4.25	UART	4-140
4.26	USB interface	4-142
4.27	Watchdog	4-143

Appendix A

Signal Descriptions

A.1	Synchronous Serial Port interface	A-2
A.2	Smart Card interface	A-3
A.3	UART interface	A-5
A.4	USB interface	A-6
A.5	Audio CODEC interface	A-7
A.6	MMC and SD flash card interface	A-9
A.7	CLCD DVI display interface	A-11
A.8	GPIO interface	A-12
A.9	Keyboard and mouse interface	A-13
A.10	Ethernet interface	A-14
A.11	RealView Logic Tile header connectors	A-15
A.12	Test and debug connections	A-16

Appendix B	Specifications	
B.1	Electrical specification	B-2
B.2	Clock rate restrictions	B-4
B.3	Mechanical details	B-5
Appendix C	RealView Logic Tile	
C.1	About the RealView Logic Tile	C-2
C.2	Signals on the tile header connectors	C-7
Appendix D	PCI Backplane and Enclosure	
D.1	Connecting the PB1176JZF-S to the PCI enclosure	D-2
D.2	Backplane hardware	D-6
D.3	Connectors	D-10
Appendix E	Memory Expansion Boards	
E.1	About memory expansion	E-2
E.2	Fitting a memory board	E-4
E.3	Connector pinout	E-5
Appendix F	Boot Monitor and platform library	
F.1	About the Boot Monitor	F-2
F.2	About the platform library	F-3
F.3	Using the baseboard Boot Monitor and platform library	F-4
Appendix G	Boot Monitor Commands	
G.1	About Boot Monitor commands	G-2
G.2	Boot Monitor command set	G-3
Appendix H	Loading FPGA Images	
H.1	General procedure	H-2
H.2	Board files	H-3
H.3	The progcards utilities	H-5
H.4	Upgrading your hardware	H-6
	Glossary	

List of Tables

RealView Platform Baseboard for ARM1176JZF-S User Guide

	Change History	ii
Table 2-1	Selecting the boot device	2-4
Table 2-2	Selecting secure debug	2-4
Table 2-3	Clock frequency selection	2-5
Table 2-4	FPGA image selection	2-5
Table 2-5	Default switch position	2-6
Table 2-6	LED Indicators	2-6
Table 2-7	STDIO redirection	2-9
Table 3-1	Serial interface signal assignment	3-21
Table 3-2	Serial interface device addresses	3-26
Table 3-3	Reset sources and effects	3-33
Table 3-4	CFGREMAP signals	3-34
Table 3-5	FPGA clocks	3-39
Table 3-6	ARM1176JZF-S development chip clocks	3-41
Table 3-7	ACLKEXTDIVSLV divisor values	3-45
Table 3-8	ACLKEXTDIVMSTR divisor values	3-46
Table 3-9	SMCMEMCLKDIV divisor values	3-46
Table 3-10	JTAG related signals	3-55
Table 4-1	Memory map	4-4
Table 4-2	Development chip system controller registers	4-12
Table 4-3	Configuration signals register	4-14

Table 4-4	Configuration signals	4-15
Table 4-5	System Control register	4-16
Table 4-6	System Status register	4-17
Table 4-7	PLL Configuration Settings register	4-19
Table 4-8	Example formulas for PLLCFGPERFx registers	4-19
Table 4-9	AXIPriority register	4-20
Table 4-10	SMC Exclusive Access Monitor ID register	4-21
Table 4-11	DLL Calibrate Outputs register	4-21
Table 4-12	Power Management Interface and IEM Interface implementation	4-22
Table 4-13	Power Management Interface registers in the FPGA	4-23
Table 4-14	PWR_CONTROL	4-24
Table 4-15	PWR_READx registers	4-24
Table 4-16	PWR_READx content	4-24
Table 4-17	PWR_AVGx registers	4-25
Table 4-18	PWR_AVGx content	4-25
Table 4-19	PWR_MEMx registers	4-26
Table 4-20	PWR_MEMx content	4-26
Table 4-21	AACI implementation	4-27
Table 4-22	Modified AACI PeriphID3 register	4-28
Table 4-23	Character LCD display implementation	4-29
Table 4-24	Character LCD control and data registers	4-30
Table 4-25	Character LCD display commands	4-31
Table 4-26	CLCDC implementation	4-32
Table 4-27	PrimeCell CLCDC register differences	4-33
Table 4-28	Values for different display resolutions	4-33
Table 4-29	DMC implementation	4-34
Table 4-30	SDRAM register values	4-34
Table 4-31	Ethernet implementation	4-36
Table 4-32	Register map for FPGA System Controller registers	4-37
Table 4-33	ID Register, SYS_ID bit assignment	4-41
Table 4-34	Oscillator Register, SYS_OSCx bit assignment	4-42
Table 4-35	Default values for oscillators	4-43
Table 4-36	Lock Register, SYS_LOCK bit assignment	4-44
Table 4-37	SYS-CFGDATA 1 register	4-45
Table 4-38	SYS-CFGDATA 2 register	4-47
Table 4-39	Flag registers	4-48
Table 4-40	Reset level control	4-49
Table 4-41	PCI bus status	4-50
Table 4-42	Flash control	4-50
Table 4-43	SYS_CLCD register	4-51
Table 4-44	BOOT configuration switches	4-51
Table 4-45	SYS_MISC	4-52
Table 4-46	SYS_BUSID	4-53
Table 4-47	System status registers	4-54
Table 4-48	Oscillator test registers	4-56
Table 4-49	GPIO implementation	4-57
Table 4-50	TZIC implementation in development chip	4-58

Table 4-51	TZIC register summary	4-59
Table 4-52	TZICFIQStatus Register bit assignments	4-60
Table 4-53	TZICRawIntr Register bit assignments	4-60
Table 4-54	TZICIntSelect Register bit assignments	4-61
Table 4-55	TZICFIQEnable Register bit assignments	4-61
Table 4-56	TZICFIQEnClear Register bit assignments	4-62
Table 4-57	TZICFIQBypass Register bit assignments	4-63
Table 4-58	TZICProtection Register bit assignments	4-64
Table 4-59	TZICLock Register bit assignments	4-64
Table 4-60	TZICLockStatus Register bit assignments	4-65
Table 4-61	TZICPeriphID0-3 Register bit assignments	4-65
Table 4-62	TZICPeriphID0 Register bit assignments	4-66
Table 4-63	TZICPeriphID1 Register bit assignments	4-67
Table 4-64	TZICPeriphID2 Register bit assignments	4-67
Table 4-65	TZICPeriphID3 Register bit assignments	4-68
Table 4-66	TZICPCellID0 Register bit assignments	4-68
Table 4-67	TZICPCellID1 Register bit assignments	4-69
Table 4-68	TZICPCellID2 Register bit assignments	4-69
Table 4-69	TZICPCellID3 Register bit assignments	4-69
Table 4-70	GIC implementation in development chip	4-70
Table 4-71	Interrupt signals to development chip interrupt controllers	4-72
Table 4-72	GIC implementation in FPGA	4-74
Table 4-73	Interrupt signals to FPGA primary and secondary GICs	4-75
Table 4-74	FPGA Register summary	4-77
Table 4-75	Distributor Register Control Register bit assignments	4-79
Table 4-76	Interrupt Controller Type Register bit assignments	4-79
Table 4-77	Interrupt Set-Enable Register 0 bit assignments	4-80
Table 4-78	Interrupt Set-Enable Register 1 bit assignments	4-81
Table 4-79	Interrupt Clear-Enable Register 0 bit assignments	4-82
Table 4-80	Interrupt Clear-Enable Register 1 bit assignments	4-82
Table 4-81	Interrupt Set-Pending Register 0 bit assignments	4-83
Table 4-82	Interrupt Set-Pending Register 1 bit assignments	4-84
Table 4-83	Interrupt Clear-Pending Register 0 bit assignments	4-85
Table 4-84	Interrupt Clear-Pending Register 1 bit assignments	4-85
Table 4-85	Active Bit Register 0 and 1 bit assignments	4-86
Table 4-86	Interrupt Priority Register 0-3 bit assignments	4-88
Table 4-87	Interrupt Priority Register 4-6 bit assignments	4-89
Table 4-88	Interrupt Priority 7-15 Register bit assignments	4-90
Table 4-89	Interrupt CPU Target Registers 0-6 bit assignments	4-91
Table 4-90	Interrupt CPU Target Register 7 bit assignments	4-91
Table 4-91	Interrupt CPU Target Register 8-15 bit assignments	4-93
Table 4-92	Interrupt Configuration Register 0 bit definition	4-94
Table 4-93	IT[0] interrupt definition encoding	4-95
Table 4-94	IT[1] interrupt definition encoding	4-95
Table 4-95	Interrupt Configuration Register 1 bit assignments	4-97
Table 4-96	Interrupt Configuration Register 2-3 bit definition	4-98
Table 4-97	Software Interrupt Register bit definition	4-99

Table 4-98	CPU interface registers	4-101
Table 4-99	CPU Interface Control register bit assignments	4-101
Table 4-100	Priority Mask Register bit assignments	4-102
Table 4-101	Binary Pointer Register bit assignments	4-102
Table 4-102	Binary Point value meanings	4-102
Table 4-103	Interrupt Acknowledge Register bit assignments	4-103
Table 4-104	End of Interrupt Register bit assignments	4-104
Table 4-105	Running interrupt Register bit assignments	4-104
Table 4-106	Highest Pending interrupt Register bit assignments	4-105
Table 4-107	L2CC implementation in development chip	4-106
Table 4-108	KMI implementation	4-107
Table 4-109	MCI implementation	4-108
Table 4-110	PCI controller implementation	4-109
Table 4-111	PCI bus memory map for AXI M bridge	4-110
Table 4-112	PCI controller registers	4-110
Table 4-113	PCI_IMAP0 register format	4-111
Table 4-114	PCI_IMAP1 register format	4-111
Table 4-115	PCI_IMAP2 register format	4-112
Table 4-116	PCI_SELFID register format	4-112
Table 4-117	PCI_FLAGS register format	4-113
Table 4-118	PCI_SMAPx register format	4-114
Table 4-119	PCI backplane configuration header addresses (self-config)	4-115
Table 4-120	PCI backplane configuration header addresses (normal configuration)	4-115
Table 4-121	PCI configuration space header	4-116
Table 4-122	PCI bus commands supported	4-119
Table 4-123	RTC implementation	4-120
Table 4-124	Serial bus implementation	4-121
Table 4-125	Serial bus register	4-121
Table 4-126	Serial bus device addresses	4-122
Table 4-127	SCI implementation	4-123
Table 4-128	SSP implementation	4-124
Table 4-129	SSMC implementation	4-126
Table 4-130	Register values for NOR2	4-127
Table 4-131	Register values for Intel flash, standard async read mode, no bursts	4-127
Table 4-132	Register values for Intel flash, async page mode	4-128
Table 4-133	Register values for Samsung SRAM	4-128
Table 4-134	Register values for Spansion BDS640	4-128
Table 4-135	Register values for Spansion LV256	4-129
Table 4-136	System controller implementation	4-130
Table 4-137	Timer implementation	4-131
Table 4-138	TrustZone Protection Controller implementation	4-132
Table 4-139	FPGA TrustZone Protection Controller registers	4-133
Table 4-140	FPGA TZPCDECPROT0x bit assignment	4-134
Table 4-141	FPGA TZPCDECPROT1x bit assignment	4-134
Table 4-142	FPGA TZPCDECPROT2 register	4-135
Table 4-143	Development chip TrustZone Protection Controller registers	4-135
Table 4-144	Development chip TZPCDECPROT0x bit assignment	4-137

Table 4-145	Development chip TZPCDECPROT1x bit assignment	4-138
Table 4-146	Development chip TZPCDECPROT2	4-139
Table 4-147	UART implementation	4-140
Table 4-148	USB implementation	4-142
Table 4-149	USB controller base address	4-142
Table 4-150	Watchdog implementation	4-143
Table A-1	SSP signal assignment	A-2
Table A-2	Smartcard connector signal assignment	A-3
Table A-3	Signals on SCI expansion connector	A-4
Table A-4	Serial plug signal assignment	A-5
Table A-5	USB signals	A-6
Table A-6	Audio CODEC expansion connector signals	A-7
Table A-7	Multimedia Card interface signals	A-10
Table A-8	DVI Digital/Analog connector signals	A-11
Table A-9	Mouse and keyboard port signal descriptions	A-13
Table A-10	Ethernet signals	A-14
Table A-11	Trace connector J2	A-18
Table A-12	Trace connector J3	A-19
Table A-13	Logic Tile trace connector J7	A-20
Table B-1	PB1176JZF-S electrical characteristics	B-2
Table B-2	Current requirements from DC IN (12V)	B-2
Table B-3	Current requirements from terminal connector	B-3
Table B-4	Maximum current load on supply voltage rails	B-3
Table C-1	RealView Logic Tile clock signals	C-5
Table C-2	Reset signal descriptions	C-6
Table C-3	HDRX signals	C-8
Table C-4	HDRY signals	C-14
Table C-5	HDRZ signals	C-20
Table D-1	LED indicators	D-7
Table D-2	Configuration switches	D-8
Table D-3	Power and reset switches	D-8
Table D-4	Test points	D-8
Table D-5	ATX power connector	D-10
Table D-6	Mictor connector pinout	D-11
Table E-1	Static memory connector signals	E-5
Table F-1	STDIO redirection	F-5
Table F-2	platform library options	F-11
Table F-3	NFU commands	F-16
Table F-4	NFU MANAGE commands	F-17
Table G-1	Standard Boot Monitor command set	G-3
Table G-2	MMC and SD card sub-menu commands	G-4
Table G-3	Boot Monitor Configure commands	G-5
Table G-4	Boot Monitor Debug commands	G-6
Table G-5	Boot Monitor NOR flash commands	G-7

List of Figures

RealView Platform Baseboard for ARM1176JZF-S User Guide

	Key to timing diagram conventions	xxii
Figure 2-1	Location of S7, S1 and S6	2-3
Figure 2-2	JTAG, Trace, and config connectors	2-10
Figure 2-3	Power connectors	2-14
Figure 3-1	PB1176JZF-S layout	3-3
Figure 3-2	PB1176JZF-S block diagram	3-4
Figure 3-3	ARM1176JZF-S development chip block diagram	3-9
Figure 3-4	AXI master bus multiplexing	3-14
Figure 3-5	Memory devices	3-18
Figure 3-6	Interrupt controller block diagram	3-19
Figure 3-7	FPGA block diagram	3-23
Figure 3-8	PCI bridge	3-28
Figure 3-9	Voltage control and voltage and current monitoring	3-37
Figure 3-10	Clock architecture for PB1176JZF-S	3-38
Figure 3-11	Development chip clocks	3-40
Figure 3-12	DCG clock selection and divider logic	3-43
Figure 3-13	Serial data and SYS_OSCx register format	3-49
Figure 3-14	JTAG data paths in debug mode	3-52
Figure 3-15	JTAG data paths in debug mode with ILA	3-52
Figure 3-16	JTAG data paths in config mode	3-53
Figure 4-1	Memory map	4-11

Figure 4-2	PLLCFGPERFx registers	4-19
Figure 4-3	AACI ID register	4-27
Figure 4-4	ID Register, SYS_ID	4-40
Figure 4-5	SYS_SW	4-41
Figure 4-6	SYS_LED	4-41
Figure 4-7	Oscillator Register, SYS_OSCx	4-42
Figure 4-8	Lock Register, SYS_LOCK	4-43
Figure 4-9	SYS_RESETCTL	4-49
Figure 4-10	SYS_CLCD	4-51
Figure 4-11	SYS_BOOTCS	4-51
Figure 4-12	SYS_MISC	4-52
Figure 4-13	Oscillator Register, SYS_OSCRESETx	4-55
Figure 4-14	TZICFIQBypass Register bit assignments	4-63
Figure 4-15	TZICProtection Register bit assignments	4-63
Figure 4-16	TZICLockStatus Register bit assignments	4-64
Figure 4-17	TZICPeriphID0-3 registers bit assignments	4-65
Figure 4-18	TZICPeriphID0 Register bit assignments	4-66
Figure 4-19	TZICPeriphID1 Register bit assignments	4-66
Figure 4-20	TZICPeriphID2 Register bit assignments	4-67
Figure 4-21	TZICPeriphID3 Register bit assignments	4-68
Figure 4-22	TZICPCellID0-3 Registers bit assignments	4-68
Figure 4-23	Distributor Register Control Register bit assignments	4-78
Figure 4-24	Interrupt Controller Type Register bit assignments	4-79
Figure 4-25	Interrupt Set-Enable Register 0 bit assignments	4-80
Figure 4-26	Interrupt Set-Enable Register 1 bit assignments	4-81
Figure 4-27	Interrupt Clear-Enable Register 0 bit assignments	4-81
Figure 4-28	Interrupt Clear-Enable Register 1 bit assignments	4-82
Figure 4-29	Interrupt Set-Pending Register 0 bit assignments	4-83
Figure 4-30	Interrupt Set-Pending Register 1 bit assignments	4-83
Figure 4-31	Interrupt Clear-Pending Register 0 bit assignments	4-85
Figure 4-32	Interrupt Clear-Pending Register 1 bit assignments	4-85
Figure 4-33	Active Bit Register 0 and 1 bit assignments	4-86
Figure 4-34	Interrupt Priority Register 0-3 bit assignments	4-87
Figure 4-35	Interrupt Priority Register 4-6 bit assignments	4-88
Figure 4-36	Interrupt Priority Register 7-15 bit assignments	4-89
Figure 4-37	Interrupt CPU Target Registers 0-6 bit assignments	4-90
Figure 4-38	Interrupt CPU Target Register 7 bit assignments	4-91
Figure 4-39	Interrupt CPU Target Register 8-15	4-92
Figure 4-40	Interrupt Configuration Register 0 bit assignments	4-94
Figure 4-41	Interrupt Configuration Register 1 bit assignments	4-96
Figure 4-42	Interrupt Configuration Register 2-3 bit assignments	4-98
Figure 4-43	Software Interrupt Register bit assignments	4-99
Figure 4-44	AXI M to PCI mapping	4-111
Figure 4-45	PCI_SELFID register	4-112
Figure 4-46	PCI_FLAGS register	4-113
Figure 4-47	PCI to AXI S mapping	4-114
Figure 4-48	PCI_SMAPx register	4-114

Figure 4-49	Secure and non-secure internal RAM	4-137
Figure A-1	SSP expansion interface	A-2
Figure A-2	Smartcard contacts assignment	A-3
Figure A-3	SCI expansion connector J29	A-4
Figure A-4	Serial connector for J26A, J26B, J27A, and J27B	A-5
Figure A-5	USB interfaces	A-6
Figure A-6	Audio connectors	A-7
Figure A-7	AACI expansion connector	A-8
Figure A-8	MMC/SD card socket pin numbering	A-9
Figure A-9	MMC card	A-9
Figure A-10	DVI Digital/Analog connector	A-11
Figure A-11	GPIO connector	A-12
Figure A-12	KMI connector	A-13
Figure A-13	Ethernet connector J5	A-14
Figure A-14	RealView Logic Tile HDRX, HDRY, and HDRZ pin numbering	A-15
Figure A-15	Test points and debug connectors	A-16
Figure A-16	JTAG connector J12	A-17
Figure A-17	USB debug connector J15	A-18
Figure A-18	AMP Mictor connector	A-18
Figure A-19	Integrated logic analyzer connector J11	A-21
Figure B-1	Baseboard mechanical details	B-5
Figure C-1	AXI busses on Logic Tile	C-3
Figure C-2	JTAG signals to Logic Tiles	C-4
Figure C-3	Power-on reset and configuration timing	C-6
Figure C-4	HDRX, HDRY, and HDRZ pin numbering	C-7
Figure D-1	Installing the platform board into the PCI enclosure	D-3
Figure D-2	Multiple boards on PCI bus	D-5
Figure D-3	PCI backplane	D-6
Figure D-4	JTAG signal flow on the PCI backplane	D-9
Figure D-5	AMP Mictor connector J4	D-11
Figure D-6	PCI expansion board JTAG connector J5	D-12
Figure E-1	Static memory board block diagram	E-2
Figure E-2	Samtec QSH 120-way static expansion connector	E-5

Preface

This preface introduces the *RealView® Platform Baseboard for ARM1176JZF-S User Guide*. It contains the following sections:

- *About this book* on page xx
- *Feedback* on page xxvii.

About this book

This book describes how to set up and use the RealView Platform Baseboard for ARM1176JZF-S (PB1176JZF-S).

Intended audience

This document has been written for experienced hardware and software developers to aid the development of ARM-based products using the PB1176JZF-S as part of a development system.

Using this book

This book is organized into the following chapters:

Chapter 1 *Introduction*

Read this chapter for an introduction to the PB1176JZF-S. This chapter shows the physical layout of the board and identifies the main components.

Chapter 2 *Getting Started*

Read this chapter for a description of how to set up and start using the PB1176JZF-S. This chapter describes how to connect the add-on boards and how to apply power.

Chapter 3 *Hardware Description*

Read this chapter for a description of the hardware architecture of the PB1176JZF-S. This chapter describes the peripherals, clocks, resets, and debug hardware provided by the board.

Chapter 4 *Programmer's Reference*

Read this chapter for a description of the PB1176JZF-S memory map and registers. There is also basic information on the peripherals and controllers present on the Platform Baseboard.

Appendix A *Signal Descriptions*

See this appendix for a description of the signals on the connectors.

Appendix B *Specifications*

See this appendix for electrical, timing, and mechanical specifications.

Appendix C *RealView Logic Tile*

See this appendix for information about the optional Logic Tile.

Appendix D *PCI Backplane and Enclosure*

See this appendix for details of the PCI backplane board.

Appendix E *Memory Expansion Boards*

See this appendix for details of the memory expansion boards.

Appendix F *Boot Monitor and platform library*

See this appendix for details on using the supplied Boot Monitor utilities.

Appendix G *Boot Monitor Commands*

See this appendix for a list of Boot Monitor commands.

Appendix H *Loading FPGA Images*

See this appendix for details on loading new FPGA images.

Product revision status

The *rn**pn**vn* identifier indicates the revision status of products, such as *PrimeCells*, described in this document, where:

<i>rn</i>	Identifies the major revision of the product.
<i>pn</i>	Identifies the minor revision or modification status of the product.
<i>vn</i>	Identifies a version that does not affect the external functionality of the product.

Typographical conventions

The following typographical conventions are used in this book:

<i>italic</i>	Highlights important notes, introduces special terminology, denotes internal cross-references, and citations.
bold	Highlights interface elements, such as menu names. Denotes ARM processor signal names. Also used for terms in descriptive lists, where appropriate.
monospace	Denotes text that can be entered at the keyboard, such as commands, file and program names, and source code.
<u>monospace</u>	Denotes a permitted abbreviation for a command or option. The underlined text can be entered instead of the full command or option name.

<i>monospace italic</i>	Denotes arguments to commands and functions where the argument is to be replaced by a specific value.
monospace bold	Denotes language keywords when used outside example code.

Other conventions

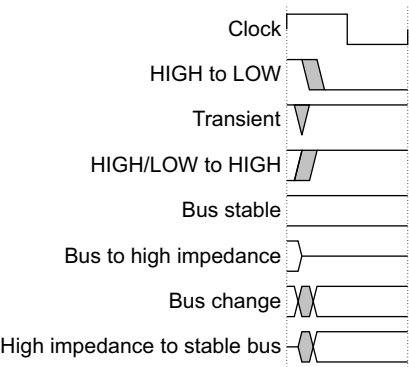
This document uses other conventions. They are described in the following sections:

- *Timing diagrams*
- *Signals* on page xxiii
- *Bytes, Halfwords, and Words* on page xxiii
- *Bits, bytes, k, and M* on page xxiii
- *Register fields* on page xxiv.
- *Numbering* on page xxiv.

Timing diagrams

The figure named *Key to timing diagram conventions* explains the components used in timing diagrams. Variations, when they occur, have clear labels. You must not assume any timing information that is not explicit in the diagrams.

Shaded bus and signal areas are undefined, so the bus or signal can assume any value within the shaded area at that time. The actual level is unimportant and does not affect normal operation.



Key to timing diagram conventions

Signals

When a signal is described as being asserted, the level depends on whether the signal is active HIGH or active LOW. Asserted means HIGH for active high signals and LOW for active low signals:

- Prefix n** Active LOW signals are prefixed by a lowercase n except in the case of AXI, AHB or APB reset signals. These are named **ARESETn**, **HRESETn** and **PRESETn** respectively.
- Prefix A** Denotes global *Advanced eXtensible Interface* (AXI) signals:
- Prefix AR** Denotes AXI read address channel signals.
- Prefix AW** Denotes AXI write address channel signals.
- Prefix B** Denotes AXI write response channel signals.
- Prefix C** Denotes AXI low-power interface signals.
- Prefix H** AHB signals are prefixed by an upper case H.
- Prefix P** APB signals are prefixed by an upper case P.
- Prefix R** Denotes AXI read data channel signals.
- Prefix W** Denotes AXI write data channel signals.

Bytes, Halfwords, and Words

- Byte** Eight bits.
- Halfword** Two bytes (16 bits).
- Word** Four bytes (32 bits).
- Quadword** 16 contiguous bytes (128 bits).

Bits, bytes, k, and M

- Suffix b** Indicates bits.
- Suffix B** Indicates bytes.
- Suffix K** When used to indicate an amount of memory means 1024. When used to indicate a frequency means 1000.
- Suffix M** When used to indicate an amount of memory means $1024^2 = 1\,048\,576$. When used to indicate a frequency means 1 000 000.

Register fields

All reserved or unused address locations must not be accessed as this can result in unpredictable behavior of the device.

All reserved or unused bits of registers must be written as zero, and ignored on read unless otherwise stated in the relevant text.

All registers bits are reset to logic 0 by a system reset unless otherwise stated in the relevant text.

Unless otherwise stated in the relevant text, all registers support read and write accesses. A write updates the contents of the register and a read returns the contents of the register.

All registers defined in this document can only be accessed using word reads and word writes, unless otherwise stated in the relevant text.

Numbering

The numbering convention is:

Hexadecimal numbers

Hexadecimal numbers are always prefixed with 0x, and use uppercase alphabetical characters, for example 0xFFDD00CC.

Binary numbers

Binary numbers are always prefixed with a lowercase b, for example b1001001.

Ranges

Ranges use a standard dash to indicate a range of numbers, for example 12-19.

Bit numbers

Single bit numbers are enclosed in brackets, for example [2]. A bit range is enclosed in brackets with a colon, for example [7:0].

Further reading

This section lists related publications by ARM and third parties.

See <http://infocenter.arm.com/help/index.jsp> for access to ARM documentation.

This book contains information that is specific to this product. See the following documents for other relevant information:

- *ARM1176JZF-S Technical Reference Manual* (ARM DDI 0301)
- *AMBA® Specification* (ARM IHI 0011)
- *AMBA AXI Protocol* (ARM IHI 0022)
- *ARM Architecture Reference Manual* (ARM DDI 0100)
- *ARM PrimeCell Color LCD Controller (PL111) Technical Reference Manual* (ARM DDI 0293)
- *ARM CoreSight Technology System Design Guide* (ARM DGI 0012)
- *ARM CoreSight ETM11 Technical Reference Manual* (ARM DDI 0318)
- *ARM Dual-Timer Module (SP804) Technical Reference Manual* (ARM DDI 0271)
- *ARM ETB11 Technical Reference Manual* (ARM DDI 0275)
- *ARM Intelligent Energy Controller Technical Overview* (ARM DTO 0005)
- *ARM L220 Cache Controller Technical Reference Manual* (ARM DDI 0329)
- *ARM PrimeCell Advanced Audio CODEC Interface (PL041) Technical Reference Manual* (ARM DDI 0173)
- *ARM PrimeCell AXI Configurable Interconnect (PL300) Technical Reference Manual* (ARM DDI 0354)
- *ARM PrimeCell Dynamic Memory Controller (PL340) Technical Reference Manual* (ARM DDI 0331)
- *ARM PrimeCell General Purpose Input/Output (PL061) Technical Reference Manual* (ARM DDI 0190)
- *ARM PrimeCell Infrastructure AMBA 3 TrustZone Protection Controller (BP147) Technical Overview* (ARM DTO 0015)
- *ARM PrimeCell PS2 Keyboard/Mouse Interface (PL050) Technical Reference Manual* (ARM DDI 0143)
- *ARM PrimeCell Multimedia Card Interface (PL180) Technical Reference Manual* (ARM DDI 0172)
- *ARM PrimeCell Real Time Clock (PL031) Technical Reference Manual* (ARM DDI 0224)
- *ARM PrimeCell Smart Card Interface (PL131) Technical Reference Manual* (ARM DDI 0228)
- *ARM PrimeCell Synchronous Serial Port (PL022) Technical Reference Manual* (ARM DDI 0194)

- *ARM PrimeCell Synchronous Static Memory Controller (PL093) Technical Reference Manual* (ARM DDI 0236)
- *ARM PrimeCell UART (PL011) Technical Reference Manual* (ARM DDI 0183)
- *ARM VFP11 Vector Floating-point Coprocessor Technical Reference Manual* (ARM DDI 0274)
- *ARM Watchdog Module (SP805) Technical Reference Manual* (ARM DDI 0270)
- *ARM PrimeCell Infrastructure AMBA 3 AXI to AMBA 2 AHB Bridges (BP137) Technical Overview* (ARM DTO 0010).

The following publications provide information about related ARM products and toolkits:

- *RealView® ICE and RealView Trace User Guide* (ARM DUI 0155)
- *Trace Debug Tools User Guide* (ARM DUI 0118)
- *ARM Versatile/LT-XC2V4000+ User Guide* (ARM DUI 0186)
- *RealView Debugger User Guide* (ARM DUI 0153)
- *RealView Compilation Tools Compiler and Libraries Guide* (ARM DUI 0205)
- *RealView Compilation Tools Developer Guide* (ARM DUI 0203)
- *RealView Compilation Tools Linker and Utilities Guide* (ARM DUI 0206).

Feedback

ARM® Limited welcomes feedback both on the PB1176JZF-S and on the documentation.

Feedback on this product

If you have any comments or suggestions about this product, contact your supplier giving:

- the product name
- a concise explanation of your comments.

Feedback on this manual

If you have any comments about this document, send email to errata@arm.com giving:

- the title
- the number
- the relevant page number(s) to which your comments apply
- a concise explanation of your comments.

ARM® Limited also welcomes general suggestions for additions and improvements.

Chapter 1

Introduction

This chapter introduces the PB1176JZF-S. It contains the following sections:

- *About the PB1176JZF-S* on page 1-2
- *Precautions* on page 1-5.

1.1 About the PB1176JZF-S

The Platform Baseboard for ARM1176JZF-S is a software and hardware development board based on ARM architecture v6:

- If the baseboard is used on its own, it is a fast software development platform with an ARM1176JZF processor and a memory system running at ASIC speed.

The basic system provides a good platform for developing systems supporting ARM11 processors that feature TrustZone® Technology, CoreSight™, and *Intelligent Energy Management* (IEM™). The ARM1176JZF-S development chip is much faster than a software simulator or a core implemented in RealView Logic Tiles.

- If FPGA-based RealView Logic Tiles are stacked on the Platform Baseboard, custom AMBA v3 peripherals, processors and DSPs can be added to the ARM subsystem provided by the baseboard.

The expanded system can be used to develop *Advanced Microprocessor Bus Architecture* (AMBA®) compatible peripherals and to test ASIC designs. The fast processor core and the peripherals present in the ARM1176JZF-S development chip, PB1176JZF-S FPGA, and RealView Logic Tile FPGA enable you to develop and test complex systems operating at, or near, their target operating frequency.

The major components in the PB1176JZF-S are:

- the ARM1176JZF-S development chip
- an FPGA containing additional peripherals and controllers
- 128MB of 32-bit wide Mobile DDR RAM
- 8MB of 32-bit wide static PSRAM
- 2 x 64MB of 32-bit wide NOR flash
- up to 320MB of static memory in an optional PISMO™ static memory expansion board
- programmable clock generators
- *Time-Of-Year* (TOY) clock with backup battery
- connectors for VGA, color LCD display (CLCD) interface board, PCI, UART, GPIO, keyboard/mouse, Smart Card, USB, audio, MMC, SSP, and Ethernet
- RealView Logic Tile connector for one or more optional RealView Logic Tiles to develop custom IP
- debug and test connectors for JTAG, ChipScope, and CoreSight Trace port
- DIP switches and LEDs
- 2 row by 16 character LCD display
- power conversion and voltage control circuitry

1.1.1 Baseboard expansion

You can expand the PB1176JZF-S by adding:

- RealView® Logic Tiles containing custom IP
- RealView Core Tiles containing ARM processor test chips
- a PCI expansion enclosure
- static memory expansion board (PISMO)
- VGA monitor or CLCD adaptor and CLCD display
- MMC, SD, or SIM cards
- custom devices to the 16-bit GPIO
- USB devices to the single OTG port and the two standard Host USB ports
- serial devices to the synchronous serial port and the five UARTs (two with full handshake)
- keyboard and mouse
- audio devices to the onboard Audio CODEC
- an Ethernet network to the onboard Ethernet controller.

1.1.2 About the ARM1176JZF-S development chip

The ARM1176JZF-S processor includes an integer core that implements the ARM11 ARM architecture v6. The processor supports:

- the ARM and Thumb® instruction sets
- Jazelle® technology to enable direct execution of Java bytecodes
- *Single Instruction Multiple Data* (SIMD) DSP instructions
- *Vector Floating Point coprocessor* (VFP), supporting the ARM VFPv2 floating point coprocessor instruction set
- TrustZone security extensions and TrustZone interrupt controller
- *Intelligent Energy Management* (IEM)

Note

Some features of the IEM subsystem require a separate license for the APC component.

- *Tightly-Coupled Memory* (TCM) for code (8KB) and data (8KB)
- AXI secure memory (512KB)
- *Memory Management Unit* (MMU)

- System Controller
- Vectored Interrupt Port
- Embedded-ICE-RT logic for JTAG debugging
- Level 2 Cache and Controller with 128KB unified cache
- *Dynamic Memory Controller* (DMC) supporting 32-bit Mobile DDR memory
- *Synchronous Static Memory Controller* (SSMC) 32-bit for direct connection to static (SRAM or flash) memory
- interface to onboard SMSC LAN9118 Ethernet controller
- interface to onboard USB controller NXP ISP1761 with support for one *On-the-Go* (OTG) and two standard USB ports
- *Color LCD Controller* (CLCD)
- Four UARTs, one SSP and eight GPIO pins
- RTC, six timers and watchdog
- System controller
- *Generic Interrupt Controller* (GIC)
- *Configurable AXI Interconnect* (CAI).

1.1.3 About the PB1176JZF-S FPGA

The *Field Programmable Gate-Array* (FPGA) implements:

- secondary *Generic Interrupt Controller* (GIC)
- *Character LCD Controller*
- *Peripheral Component Interconnect* (PCI) using the Xilinx PCI Core
- *Advanced Audio Codec Interface* (AACI)
- *Smart Card Interface* (SCI)
- *Multimedia Card Interface* (MCI) with support for *Secure Digital Card* (SDC)
- one additional UART (four inside development chip)
- *Keyboard/Mouse Interface* (KMI) and shared keyboard mouse connector
- configuration registers
- interface to onboard audio CODEC and power amplifier
- registers for status, ID, onboard switches, LEDs, and clock control.

1.2 Precautions

This section contains safety information and advice on how to avoid damage to the PB1176JZF-S.

1.2.1 Ensuring safety

The PB1176JZF-S can be powered from one of the following sources:

- the supplied power supply connected to the 12V power connector J44
- a bench power supply connected to the screw terminals on header J46
- an external PCI bus.

Warning

Do not supply more than one power source. If you are using the baseboard with the PCI enclosure for example, do not connect a power source to J44 or J46.

To avoid a safety hazard, only connect *Safety Extra Low Voltage* (SELV) equipment to the connectors on the PB1176JZF-S.

1.2.2 Preventing damage

The PB1176JZF-S is intended for use in a laboratory or engineering development environment. If operated without an enclosure, the board is sensitive to electrostatic discharges and generates electromagnetic emissions.

Caution

To avoid damage to the board, observe the following precautions.

- never subject the board to high electrostatic potentials
 - always wear a grounding strap when handling the board
 - only hold the board by the edges
 - avoid touching the component pins or any other metallic element
 - do not connect more than one power source to the platform
 - always power down the board when connecting RealView Logic Tiles, Core Tiles, or expansion boards.
-

Caution

Do not use the board near equipment that is:

- sensitive to electromagnetic emissions (such as medical equipment)
 - a transmitter of electromagnetic emissions.
-

Chapter 2

Getting Started

This chapter describes how to set up and prepare the PB1176JZF-S for use. It contains the following sections:

- *Setting up the PB1176JZF-S* on page 2-2
- *Setting the configuration switches* on page 2-3
- *Connecting JTAG, Trace, and configuration equipment* on page 2-10
- *Supplying power* on page 2-14.

2.1 Setting up the PB1176JZF-S

The following items are supplied with the PB1176JZF-S:

- the PB1176JZF-S printed-circuit board mounted on a metal tray
- an AC power supply that provides a 12VDC output
- a CD containing sample programs, Boot Monitor code, FPGA and PLD images, and additional documentation
- this user guide.

To set up the PB1176JZF-S as a standalone development system:

1. Set the configuration switches to select the boot memory device, operating frequency, and FPGA image. See *Setting the configuration switches* on page 2-3.
2. If you are using memory expansion boards, connect them to the PB1176JZF-S. See Appendix E *Memory Expansion Boards*.
3. If you are using an external display, connect the CLCD cable to the PB1176JZF-S DVI Digital/Analog connector.
4. If you are using expansion Logic Tiles, mount the tile on the tile expansion site. See Appendix C *RealView Logic Tile* and the manual for your Logic Tile.
5. If you are using a debugger, connect to the JTAG debug port on the board. See *Connecting JTAG, Trace, and configuration equipment* on page 2-10.
6. If you are using a *Trace Port Analyzer* (TPA), connect the Trace Port interface buffer board. See *Connecting the Trace Port Analyzer* on page 2-13.
7. Apply power to the PB1176JZF-S. See *Supplying power* on page 2-14.
8. If you are using the supplied Boot Monitor software to select and run an application, see Appendix F *Boot Monitor and platform library*.

Note

If you are using the PB1176JZF-S with the PCI backplane, see also Appendix D *PCI Backplane and Enclosure*.

2.2 Setting the configuration switches

Configuration switch banks S7 (4-way) and S1 (2-way) are shown in Figure 2-1:

- Switch bank S7 selects the boot device type, secure debug, and the initial clock frequency.
- Switch bank S1 selects the FPGA image to be used by the PB1176JZF-S.
If a Logic Tile is fitted, this switch also selects the FPGA image to be used by the Logic Tile.

Switch bank S6 is not used for hardware configuration but they can be used to configure the Boot Monitor software if it is running on the system (see *Boot Monitor configuration* on page 2-8). The status of these user switches can be read by an application running on the baseboard.

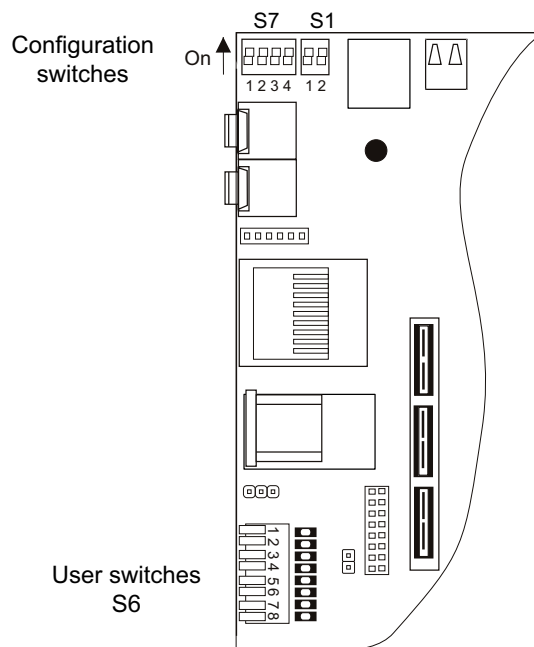


Figure 2-1 Location of S7, S1 and S6

The following section describes:

- *Boot memory selection* on page 2-4
- *Secure debug selection* on page 2-4

- *Clock frequency selection* on page 2-5
- *FPGA image selection* on page 2-5
- *Default switch positions* on page 2-6
- *LED indicators* on page 2-6
- *Boot Monitor configuration* on page 2-8.

2.2.1 Boot memory selection

The configuration switches S7-1 and S7-2 determine boot device type. Table 2-1 lists the boot device selected for each switch setting.

Table 2-1 Selecting the boot device

S7-1	S7-2	Device
OFF	OFF	Boot from NOR flash (normal boot mode) located in CS7 at 0x3C000000. (Secure NOR flash is mapped to be located in CS4 at 0x30000000.)
OFF	ON	Boot from AXI expansion memory
ON	OFF	Boot from Secure NOR flash located in CS7 at 0x3C000000. (NOR flash is mapped to be located in CS4 at 0x30000000.)
ON	ON	Boot from Static expansion memory (PISMO memory)

2.2.2 Secure debug selection

Configuration switch S7-3 determines whether secure debug is used. Table 2-2 lists the switch settings.

Table 2-2 Selecting secure debug

S7-3	Device
OFF	<i>Secure Privilege Invasive Debug ENable (SPIDEN) and Secure Privilege Non-Invasive Debug ENable (SPNIDEN) are both 1 and are enabled.</i>
ON	<i>Secure Privilege Invasive Debug ENable (SPIDEN) and Secure Privilege Non-Invasive Debug ENable (SPNIDEN) are both 0 and are disabled.</i>

Note

Non-Invasive Debug Enable (NIDEN) and *DeBuG ENable* (DBGEN) are always active and is not controlled by configuration switches. The SYS_MISC register described in *Miscellaneous System Control Register, SYS_MISC* on page 4-52 can, however, override the switch settings and the NIDEN and DBGEN states.

2.2.3 Clock frequency selection

The configuration switch S7-4 selects the start-up frequency of the external AXI bus. The start up frequency is set to either the highest supported AXI bus frequency of the PB1176JZF-S or a lower frequency to enable slower Logic Tile based custom FPGA designs to start-up without error. Table 2-3 lists the frequency options.

Table 2-3 Clock frequency selection

S7-4	Clock frequency	Description
OFF	35MHz	Highest supported external AXI bus frequency
ON	20MHz	Alternative lower AXI bus start-up frequency

2.2.4 FPGA image selection

The configuration switches S1-1 and S1-2 select the FPGA image to be used by the PB1176JZF-S. If a Logic Tile is attached to the PB1176JZF-S, S1-1 also selects the Logic Tile FPGA image by controlling **FPGA_IMAGE** at the tile stack. The default position for both switches is OFF and image 0 located at address 0x0 is loaded. For more information on loading new FPGA images see Appendix H *Loading FPGA Images*.

Table 2-4 FPGA image selection

S1-2	S1-1	PB1176JZF-S FPGA image	Logic Tile FPGA image	PB1176JZF-S FPGA image address
OFF	OFF	FPGA image 1 (this is the image supplied with the board)	0	0x0
OFF	ON	FPGA image 2 (not supplied)	1	0x200000
ON	OFF	FPGA image 3 (not supplied)	0	0x400000
ON	ON	FPGA image 4 (not supplied)	1	0x600000

2.2.5 Default switch positions

Configuration switches S7 and S1 are not normally changed from their factory default positions listed in Table 2-5. For more information on configuration switches, see *Configuration control* on page 3-13.

Table 2-5 Default switch position

Switch	Default	Function in default position
S7-1, S7-2	OFF	Selects non-secure NOR flash as boot memory
S7-3	OFF	<i>Secure Privilege Invasive Debug ENable (SPIDEN) and Secure Privilege Non-Invasive Debug ENable (SPNIDEN) are both enabled.</i>
S7-4	OFF	Selects highest supported clock frequency
S1-1, S1-2	OFF	Selects PB1176JZF-S FPGA image 0 and, if fitted, Logic Tile FPGA image 0

———— **Note** ————

For information on other configuration links and status LEDs, see *Test, configuration, and debug interfaces* on page 3-51 and *LED Indicators*,

2.2.6 LED indicators

Table 2-6 lists the PB1176JZF-S LED indicators and their function.

Table 2-6 LED Indicators

LED ID	Color	Device	Function
5V OK	Green	D31	Indicates that the 5V power supply is on.
3V3 OK	Green	D32	Indicates that the 3V3 power supply is on.
FUSED 5V OK	Green	D34	Indicates that the FUSED 5V power supply is on.
Standby	Red	D35	Indicates that the PB1176JZF-S is in standby mode and the power is off. This LED only functions when power is supplied to the board through connector J44.
Config	Amber	D6	Indicates that the PB1176JZF-S is in configuration mode. Configuration mode is entered by setting the CONFIG slide-switch S9 to ON and powering-up.
Image	Green	D11	Indicates that FPGA_IMAGE to the tile stack is HIGH and that Tile Image 1 is selected.

Table 2-6 LED Indicators (continued)

LED ID	Color	Device	Function
Tile Site Detection	Blue	D1, D2	Indicates that nTILE_DET is LOW and that a Logic Tile is present in the tile site.
TZ-LED	Amber	D4	This is an indication of external AXI master transactions from the development chip or Tile Site that are secure into the FPGA.
FPGA Config	Yellow	D25	Directly indicates the status of the FPGA Config pushswitch S4. LED is off when the switch is pressed.
Dev Chip Reconfig	Blue	D27	Directly indicates the status of the DEV CHIP Reconfig pushswitch S5. LED is off when the switch is pressed.
Reset	Amber	D19	Directly indicates the status of the Reset pushswitch S2. LED is off when the switch is pressed.
User	Green	D22	Directly indicates the status of the general purpose pushswitch S3. LED is off when the switch is pressed.
GP (User) LEDs	Green	D16-18, D20-D21, D23-D24, D26	Eight general purpose LEDs. These LEDs are controlled individually by the lower eight bits of the SYS_LED register. See <i>User switches and LEDs</i> on page 3-26 for more details.
Ethernet	Green, Yellow	J5	Ethernet activity indicators. These LEDs are integral to the Ethernet connector J5 and are configured by writing to a register in the LAN9118 fast Ethernet controller. See <i>Ethernet interface</i> on page 3-29 for more details
Global Done	Green	D9	Indicates that all the FPGA devices on the Logic Tiles and the PB1176JZF-S have been configured.
Local Done	Green	D10	Indicates that the PB1176JZF-S FPGA device has been configured
USB Port 1 Power	Green	D13	Indicates that USB Port 1 is powered up.
USB Port 2 Power	Green	D14	Indicates that USB Port 2 is powered up.

Table 2-6 LED Indicators (continued)

LED ID	Color	Device	Function
USB Port 3 Power	Green	D15	Indicates that USB Port 3 is powered up.
USB Debug Busy	Amber	D7	Indicates that the on-board USB debugger hardware is active.
USB Debug On	Green	D8	Indicates that the on-board USB debugger hardware is enabled and can be used to load FPGA images.

2.2.7 Boot Monitor configuration

The Boot Monitor application is typically loaded into the NOR flash memory and selected to run at power on. Follow the instructions in *Loading Boot Monitor into NOR flash* on page F-7 for details of loading the boot flash with the image from the supplied CD. How the Boot Monitor runs is determined by the setting of User Switches.

The Boot Monitor reads switches S6-1 and S6-3 to determine start-up settings after reset. See Figure 2-1 on page 2-3 for the location of S6 on the PB1176JZF-S.

————— **Note** —————

If S6 switch lever is down, the switch is ON. The default is OFF, switch lever up.

User Switches 4 to 8 (S6-4 to S6-8) are not used by the Boot Monitor and are available for user applications. If a different loader program is present at the boot location, the function of the entire User Switch bank becomes implementation dependent.

- The setting of S6-1 determines whether the Boot Monitor starts after a reset:
- S6-1 OFF** A prompt is displayed enabling you to enter Boot Monitor commands.
 - S6-1 ON** The Boot Monitor executes a boot script that has been loaded into flash. The boot script can execute any Boot Monitor commands. It typically selects and runs an image in application flash. You can store one or more code images in flash memory and use the boot script to start an image at reset. Use the SET B00TSCRIPT command to enter a boot script from the Boot Monitor (see Appendix F *Boot Monitor and platform library*).

Output and input of text from STDIO for both applications and Boot Monitor I/O depends on the setting of User Switch 2 (S6-2) and User Switch 3 (S6-3). Table 2-7 lists the STDIO switch settings.

Table 2-7 STDIO redirection

User Switch 2	User Switch 3	Output	Input	Description
OFF	OFF	UART0 or console	UART0 or console	STDIO autodetects whether to use semihosting I/O or a UART. If a debugger is connected and semihosting is enabled, STDIO is redirected to the debugger console window. Otherwise, STDIO goes to UART0.
OFF	ON	UART0	UART0	STDIO is redirected to UART0. This occurs even under semihosting.
ON	OFF	DVI	Keyboard	STDIO is redirected to the DVI display and keyboard. This occurs even under semihosting.
ON	ON	DVI	UART0	STDIO output is redirected to the DVI display and input is redirected to the UART. This occurs even under semihosting

User Switches 2 and 3 (S6-2 and S6-3) do not affect file I/O operations performed under semihosting. Semihosting operation requires a debugger and a JTAG interface device. See *Redirecting character output to hardware devices* on page F-8 for more details on I/O.

2.3 Connecting JTAG, Trace, and configuration equipment

You can use JTAG debugging equipment and the JTAG connector to:

- connect a debugger to the ARM1176JZF-S core and download programs to memory and debug them
- program new configuration images into the configuration flash, FPGA, and PLDs on the board. (You cannot program the normal flash from configuration mode.)

The JTAG connector is shown in Figure 2-2.

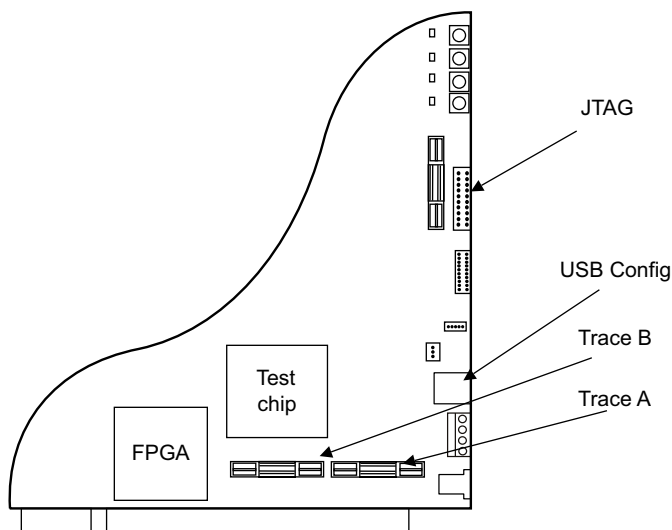


Figure 2-2 JTAG, Trace, and config connectors

———— Note ————

The debug mode is selected by default and the JTAG port can be used to debug applications running on the processor.

If the CONFIG switch is ON, the JTAG or USB config port can be used to load FPGA images. For more details on JTAG debugging see *JTAG debug port and USB config port support* on page 3-51.

The following section describes:

- *ARM CoreSight* on page 2-11
- *Connecting to the USB config port* on page 2-13
- *Connecting the Trace Port Analyzer* on page 2-13.

2.3.1 ARM CoreSight

The ARM1176JZF-S development chip includes ARM CoreSight technology. See *CoreSight Technology System Design Guide* (DGI 0012) for background information on the CoreSight components and interconnect.

Trace capture

The main components used for trace capture are:

CoreSight ETM11, ETB, TPIU and DAP

- The CoreSight *Embedded Trace Macrocell* (ETM11) monitors the ARM core buses and outputs compressed information.
- The *Embedded Trace Buffer* (ETB), buffers the information using 8KB of on chip RAM.
- The *Trace Port Interface Unit* (TPIU) acts as a bridge between the on-chip trace data and the data stream that is captured by an external *Trace Port Analyzer* (TPA).
- The *Debug Access Port* (DAP) provides a dedicated *JTAG Debug Port* (JTAG-DP) for the debug tools and provides access to the CoreSight Debug APB through an APB-Mux. The ETM11, ETB and TPIU are configured and accessed over the Debug APB bus.

Trace connector and adaptor board

The trace connectors enable you to connect a TPA to the PB1176JZF-S. The connector is a high-density AMP Mictor connector. The pinout for these connectors is provided in *Test and debug connections* on page A-16.

The adaptor board buffers the high-speed signals between the Trace connectors and the Trace Port Analyzer.

Trace Port Analyzer

The TPA is an external device (such as RealView Trace) that connects to the trace connector (through the adaptor board) and stores information sent from the TPIU.

Debugger and Trace software

The debugger and trace software controls the JTAG unit, CoreSight ETM11, and TPA. The trace software reconstructs program flow from the information captured in the Trace Port Analyzer.

Note

The trace and debug components must match the debugger you are using. ARM RealView Debugger (RVD) is a component of *RealView Compilation Tools* (RVCT) and supports RealView ICE and RealView Trace.

Always check with the manufacturer of the debug equipment what level of support is provided for CoreSight Technology.

System level debug

The CoreSight subsystem implemented in the ARM1176JZF-S development chip enables system level debug. The main CoreSight components are:

- *ARM11 CoreSight Embedded Trace Macrocell* (CoreSight ETM11)
- *ARM11 Embedded Trace Buffer* (ETB11) with 8KB memory
- *Trace Port Interface Unit* (TPIU)
- *Debug Access Port* (DAP)
- *Cross Trigger Interfaces* (CTI)
- *Cross Trigger Matrix* (CTM)
- Synchronous ATB Bridge.

The CoreSight subsystem enables real-time system level debug and trace of the ARM1176JZF-S development chip and external components. The internal *AMBA Trace Bus* (ATB) is accessible at the device pins through a *Synchronous 1:1 ATB Bridge*. On the PB1176JZF-S, the ATB connects to the tile site HDRZ connector. This enables CoreSight system debug to be extended to the tile site when this is supported by an attached tile and debug software.

Debug modes

For system level debug, fit jumper J1, (DAP ENABLE) on the PB1176JZF-S. This connects the DAP *JTAG Debug Port* (JTAG-DP) to the PB1176JZF-S JTAG debug scan-chain.

Note

There is no JTAG connection to the CoreSight ETM11. Trace is only supported when using the DAP.

For legacy debug of the ARM1176JZF-S, remove jumper J1, (DAP ENABLE) on the PB1176JZF-S. This bypasses the DAP and connects the PB1176JZF-S JTAG debug scan-chain directly to the DBGTap port on the ARM1176JZF-S.

2.3.2 Connecting to the USB config port

The USB config port on the PB1176JZF-S is shown in Figure 2-2 on page 2-10. Use a USB cable to connect the baseboard to a USB port on your workstation.

The USB config port does not connect to the onboard JTAG debug signals, but it does connect to the JTAG configuration signals and can be used to load new FPGA images.

Note

- You must remove other JTAG devices, for example, the RVI from the JTAG connector for the USB config port to work.
 - You must set the CONFIG switch to ON to reprogram the FPGA images.
-

2.3.3 Connecting the Trace Port Analyzer

The ARM1176JZF-S development chip incorporates an *ARM11 CoreSight Embedded Trace Macrocell* (CoreSight ETM11). This enables you to carry out real-time debugging by connecting external trace equipment to the PB1176JZF-S. The ETM11 monitors the program execution and sends a compressed trace to the *Trace Port Analyzer* (TPA). The TPA buffers this information and transmits it to the debugger where it is decompressed and used to reconstruct the complete instruction flow. The trace size implemented by the *Trace Port Interface Unit* (TPIU) is large, (32-bit packets).

Note

The ARM1176JZF-S development chip includes a *Debug Access Port* (DAP). When supported by CoreSight enabled hardware and software the DAP enables system-wide debug and trace.

Connect the *Trace Port Analyzer* (TPA) to the adaptor board and plug the adaptors into the PB1176JZF-S trace ports shown in Figure 2-2 on page 2-10. RealView Trace requires a RealView ICE JTAG unit. The Ethernet and power supply cables connect to the RealView ICE unit.

Note

The high-density cable from the RealView ICE box requires a buffer board to connect to the JTAG connector on the PB1176JZF-S.

The low-density cable can be used to connect the RealView ICE box directly to the JTAG connector, but this interface operates at lower speed.

2.4 Supplying power

When using the PB1176JZF-S as a standalone development system, you must connect the supplied brick power supply to power socket J44 or an external bench power supply to the screw-terminal connector J46. See Figure 2-3.

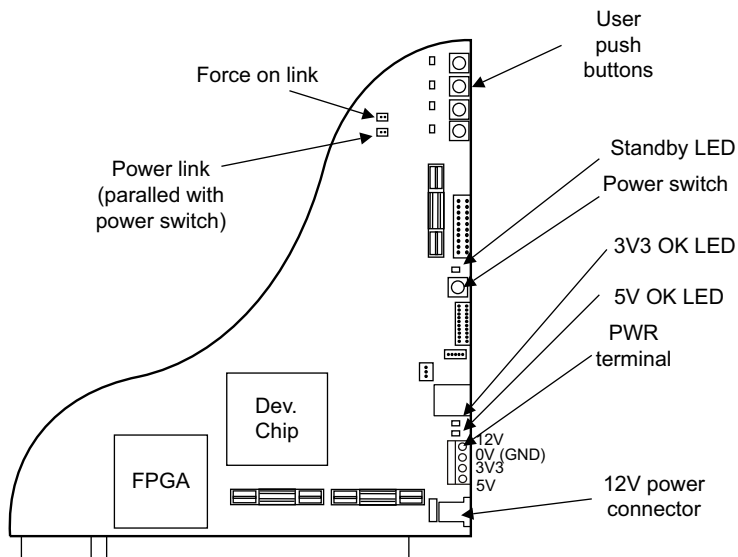


Figure 2-3 Power connectors

Note

If you are using the supplied brick power supply connected to J44, the Standby/power pushbutton S8 toggles the power on and off.

If you are using an external power supply connected to J46, or you are powering the board from the PCI backplane, the Standby/power switch is not used. You control the power by shutting down the external power source.

Caution

You can use only one power source for the system. Use only the PCI connector, J46, or J44. Do not, for example, use the PCI connector and J46 at the same time.

Chapter 3

Hardware Description

This chapter describes the on-board hardware. It contains the following sections:

- *PB1176JZF-S architecture* on page 3-2
- *ARM1176JZF-S development chip* on page 3-8
- *Development chip peripherals* on page 3-17
- *FPGA peripherals* on page 3-22
- *FPGA configuration* on page 3-30
- *Reset controller* on page 3-32
- *Power supply* on page 3-35
- *Clock architecture* on page 3-38
- *Test, configuration, and debug interfaces* on page 3-51.

3.1 PB1176JZF-S architecture

The following sections describe the major architectural blocks in the PB1176JZF-S:

- *PCB layout* on page 3-3
- *System architecture* on page 3-4
- *ARM1176JZF-S development chip* on page 3-5
- *PB1176JZF-S FPGA* on page 3-5
- *Displays* on page 3-5
- *RealView Logic Tile expansion* on page 3-5
- *Memory* on page 3-6
- *Clock generators* on page 3-7
- *Debug and test interfaces* on page 3-7.

3.1.1 PCB layout

Figure 3-1 shows the layout of the PB1176JZF-S.

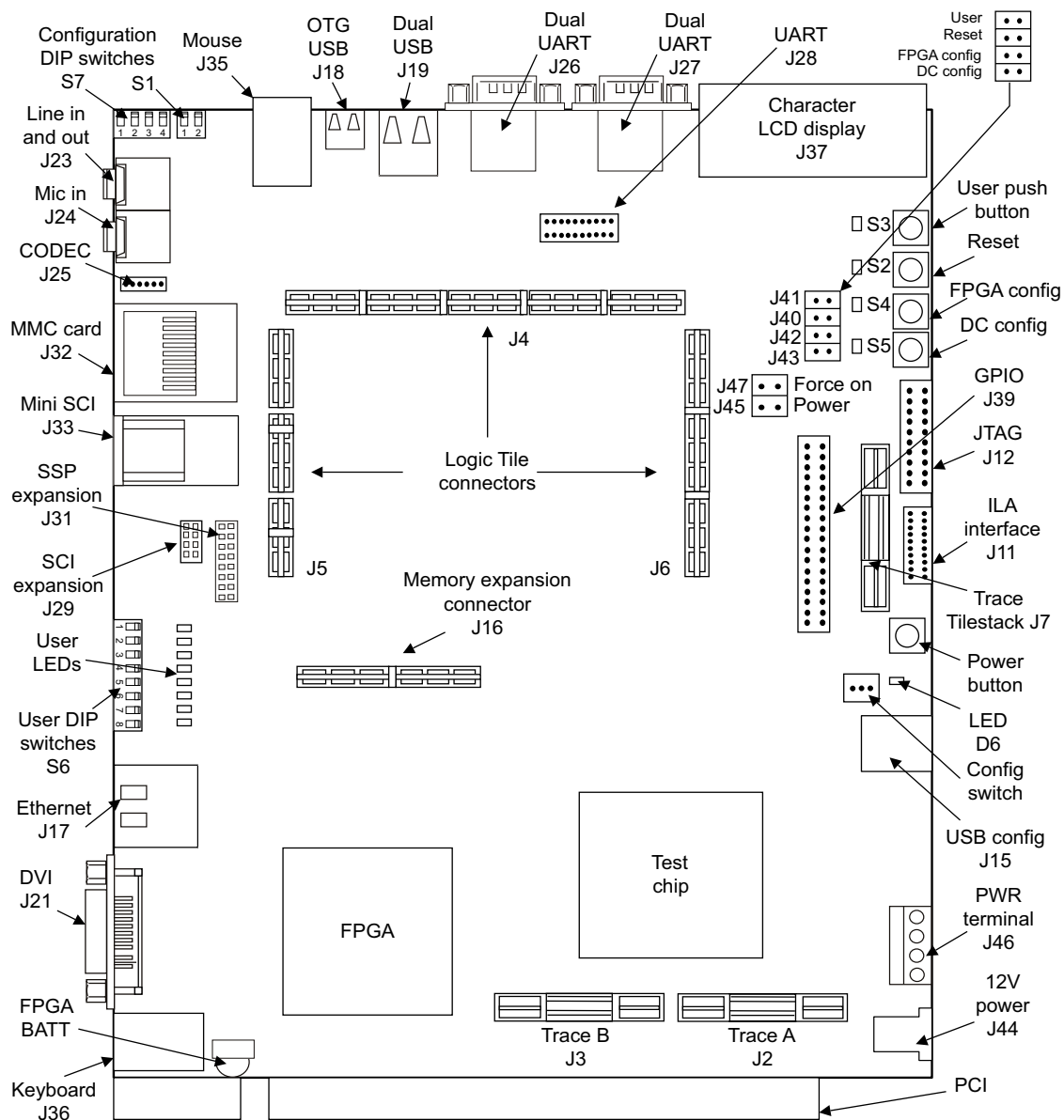


Figure 3-1 PB1176JZF-S layout

3.1.2 System architecture

The block diagram in Figure 3-2 shows the architecture of the PB1176JZF-S.

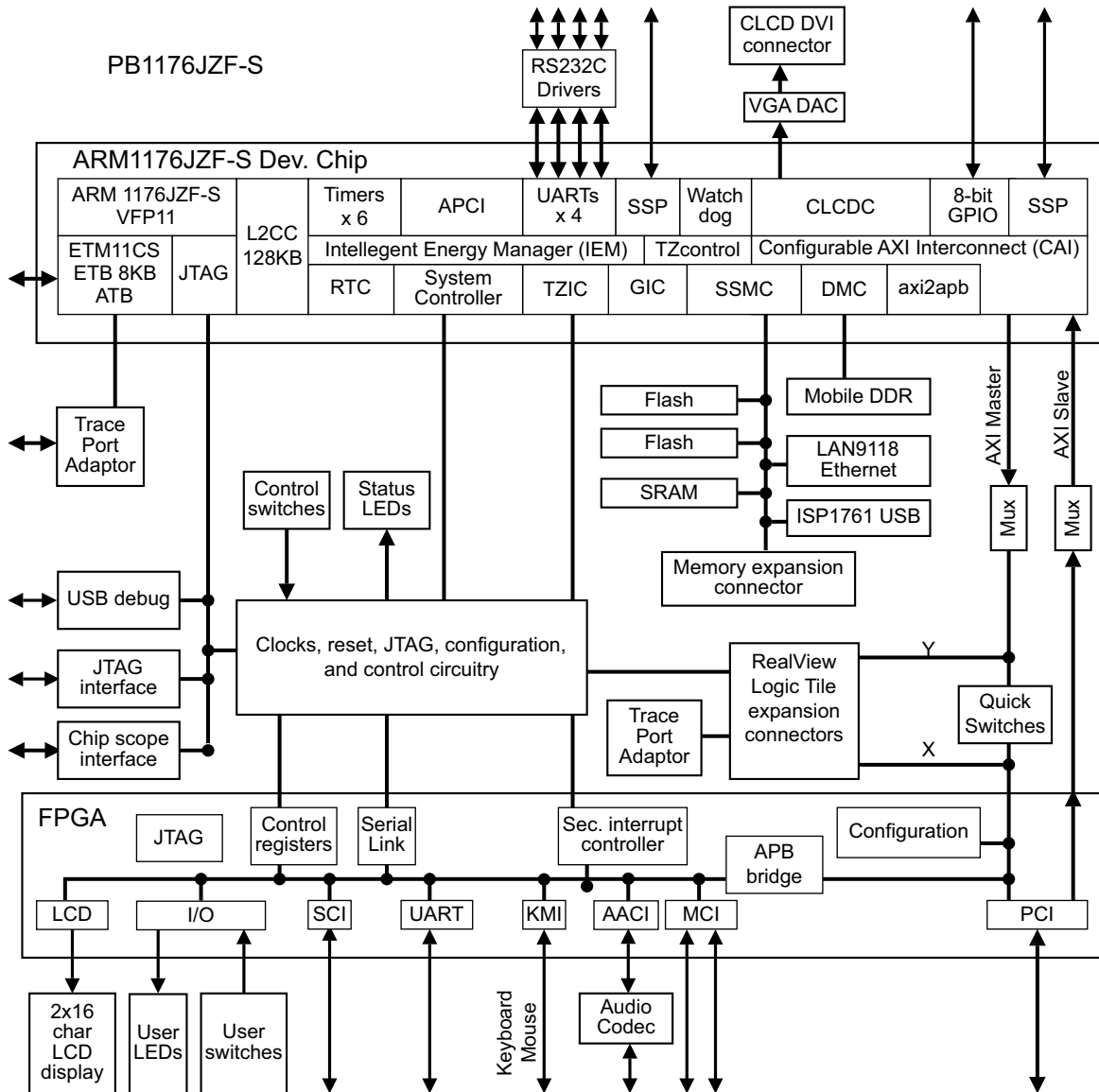


Figure 3-2 PB1176JZF-S block diagram

3.1.3 ARM1176JZF-S development chip

For details on the ARM1176JZF-S development chip, see *ARM1176JZF-S development chip* on page 3-8.

3.1.4 PB1176JZF-S FPGA

The FPGA provides system control and configuration functions for the PB1176JZF-S that enable it to operate as a standalone development system or with expansion RealView Logic Tiles or as a PCI card. See *FPGA configuration* on page 3-30.

The FPGA also implements additional peripherals, for example audio CODEC and PCI interface.

3.1.5 Displays

The ARM1176JZF-S development chip outputs signals for a color LCD display.

The CLCD signals from the ARM1176JZF-S development chip are converted on the PB1176JZF-S to a VGA signal and a DVI signal and output to a DVI Digital/Analog connector. The resolution of the VGA signal is configurable. See *ARM PrimeCell Color LCD Controller (PL111) Technical Reference Manual*.

There is also a two row by sixteen character display mounted on the PB1176JZF-S. This display is accessed using a controller implemented in the FPGA and can be used for debugging or as the output from applications.

———— Note ————

The memory controller bandwidth limits the resolution and color depth options, for example:

- 640 x 480 at 32-bit
- 800 x 600 at 16-bit.

3.1.6 RealView Logic Tile expansion

The ARM RealView Logic Tiles, such as the LT-XC2V6000, enable the development of AMBA 3 AXI peripherals, or custom logic, for use with the PB1176JZF-S.

You can place standard or custom peripherals in the FPGA on the RealView Logic Tile. Two multiplexed AXI buses are brought out to the RealView Logic Tile connectors HDRX and HDRY. See Appendix C *RealView Logic Tile*.

Note

The bus on the tile X header is the master interface and the bus on the tile Y header is the slave interface. If a Logic Tile is not fitted, quick switches on the PB1176JZF-S connect the PB1176JZF-S AXI master directly to the PB1176JZF-S slave interface.

3.1.7 Memory

The volatile memory includes SRAM and DDR memory:

- The development chip contains 512KB of on-chip SRAM. This memory can be partitioned using the development chip TrustZone protection controller into secure or non-secure blocks. The loading of secure memory can be performed through the debugger. The system is then reset to run from the secure memory.
- The PB1176JZF-S has 8MB of 32-bit asynchronous SRAM memory on board. This memory is controlled directly by the PL093 *Synchronous Static Memory Controller* in the ARM1176JZF-S development chip and can be secured by the *TrustZone Protection Controller (TZPC)*.
- You can expand the SRAM memory by installing an external PISMO static memory expansion board. See Appendix E *Memory Expansion Boards*.
- The PB1176JZF-S has 128MB of 32-bit Mobile DDR memory on board. This memory is controlled directly by the PL340 *Dynamic Memory Controller* in the ARM1176JZF-S development chip.

Note

So that the Dynamic Memory interface can be operated at high frequency without any potential signal integrity or timing problems, no provision is made for expansion of the SDRAM memory.

The nonvolatile memory system consists of:

- Two banks of 64MB 32-bit NOR flash.
- The development chip contains 16KB of on-chip SRAM that can be configured as a pseudo-ROM that can be selected as boot memory. It is not actually nonvolatile because the contents do not survive power cycling, but the contents do remain valid after reset.
- There is also 16MB of flash memory dedicated to holding the FPGA image. You must not program this flash memory in user mode because it contains FPGA configuration.

The NOR flash memory is managed by the PL093 *Synchronous Static Memory Controller* in the ARM1176JZF-S development chip.

3.1.8 Clock generators

The PB1176JZF-S has the following clock sources:

- 24MHz Reference clock for configuration and PLLs.
- Five ICS307 programmable clock generators. These clocks are connected to the system FPGA. System control registers in the FPGA translate the clock settings to a serial stream that is output to the clock generators to select the clock division ratios.
- 32,768Hz Reference Clock for RTC.
- If fitted, clocks from the PCI backplane, RealView Logic Tiles or Core Tiles can be selected as the reference clocks for the PB1176JZF-S.

See *Clock architecture* on page 3-38.

3.1.9 Debug and test interfaces

The JTAG connector enables JTAG hardware debugging equipment, such as RealView ICE[®], to be connected to the PB1176JZF-S. See *JTAG debug port and USB config port support* on page 3-51. (The JTAG config chain signals can also be controlled by the on-board USB config port controller and used to load FPGA images.)

Two Mictor connectors on the PB1176JZF-S enable monitoring of the ARM1176JZF-S development chip *Embedded Trace Macrocell*[®] (ETM11) signals by a *Trace Port Analyzer* (TPA). The trace port supports a trace packet size of 16-bit (medium) and 32-bit (large). See *Trace connector pinout* on page A-18 for connection information.

A single trace port connector is also provided for some of the Logic Tile HDRY signals. See also Table C-4 on page C-14.

3.2 ARM1176JZF-S development chip

The ARM1176JZF-S development chip and its interfaces are described in the following sections:

- *ARM1176JZF-S development chip overview* on page 3-9
- *Configuration control* on page 3-13
- *AXI buses* on page 3-14
- *Intelligent Energy Management* on page 3-15.

For more information on using the ARM1176JZF-S development chip components, see also:

- *Development chip peripherals* on page 3-17
- *ARM1176JZF-S development chip clocks* on page 3-40
- *Reset controller* on page 3-32
- *Chapter 4 Programmer's Reference.*

3.2.1 ARM1176JZF-S development chip overview

Figure 3-3 shows the main blocks of the ARM1176JZF-S development chip.

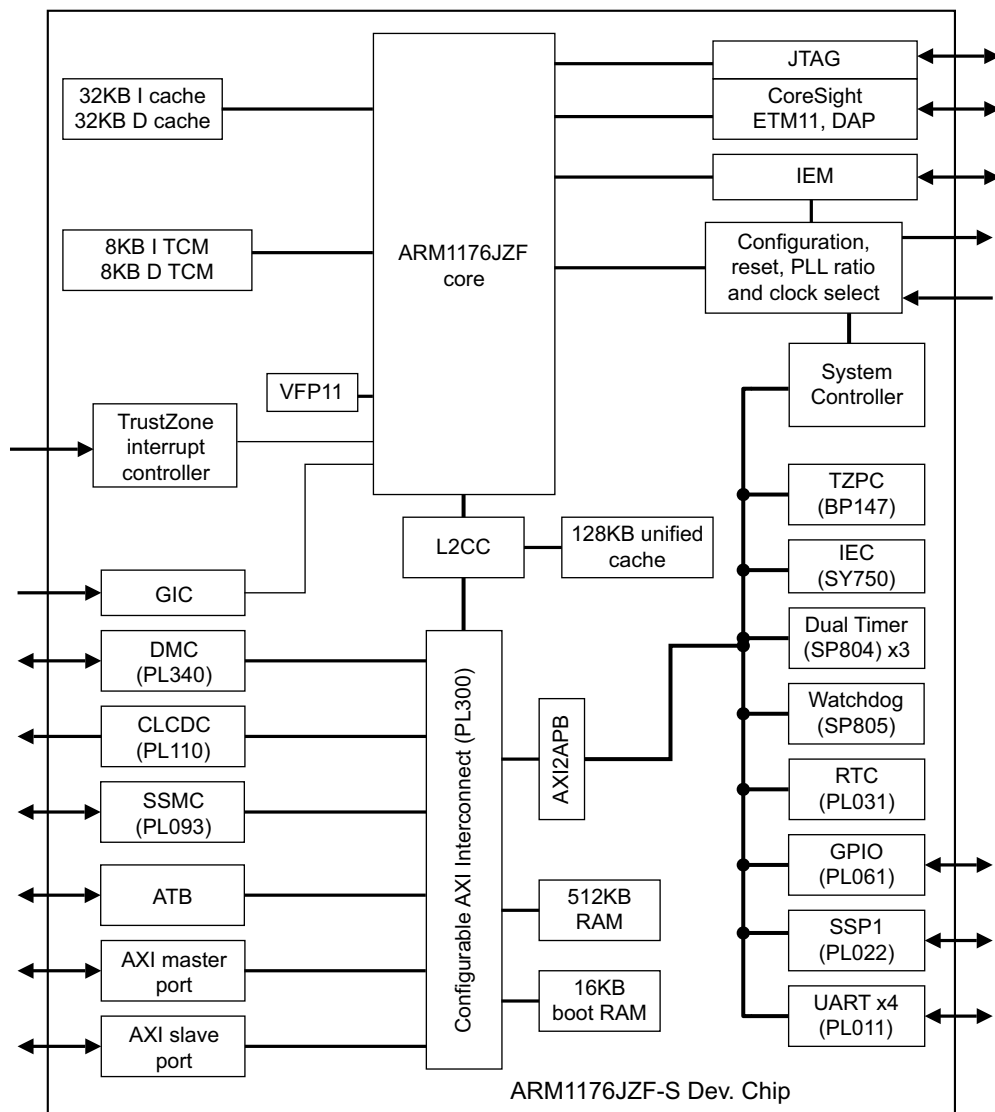


Figure 3-3 ARM1176JZF-S development chip block diagram

The ARM1176JZF-S development chip incorporates the following features:

ARM1176JZF-S

The ARM1176JZF-S CPU is a member of the ARM11 Thumb® family. The ARM1176JZF-S macrocell is a 32-bit cached processor with ARM architecture v6 that supports the ARM and Thumb instruction sets and includes features for direct execution of Java byte codes. Executing Java byte codes requires the *Java Technology Enabling Kit* (JTEK). The development chip also contains:

Cache	Cache memory for instruction (32KB) and data (32KB). Level 2 Cache Controller (L2CC) with 128KB unified cache.
DSP	A range of <i>Single Instruction Multiple Data</i> (SIMD) DSP instructions that operate on 16-bit or 8-bit data values in 32-bit registers
MMU	The ARM1176JF-S contains a <i>Memory Management Unit</i> (MMU).
TCM	8KB of data and instruction <i>Tightly Coupled Memory</i> (TCM). The TCM operates with a single wait-state and provides higher data rates than external memory.
VFP	<i>Vector Floating Point coprocessor</i> (VFP), supporting the ARM VFPv2 floating point coprocessor instruction set.
TrustZone	TrustZone security extensions: <ul style="list-style-type: none"> • <i>TrustZone Interrupt Controller</i> (TZIC) • <i>TrustZone Protection Controller</i> (TZPC).
IEM	Provision for <i>Intelligent Energy Management</i> (IEM): <ul style="list-style-type: none"> • <i>ARM Intelligent Energy Controller</i> (IEC) • <i>National Semiconductor Advanced Power Controller</i> (APCI) • <i>National Semiconductor Hardware Performance Monitor</i> (HPM).
AXI RAM	AXI RAM (512KB) and boot ROM emulation (16KB).
AXI buses	The ARM1176JF processor uses the Configurable AXI Interconnect to connect the processor core to the on-chip AXI controllers and peripherals. An AXI to APB bridge provides the interface to the APB-based peripherals in the development chip. One external AXI master bus and one external AXI slave bus provide the interface to the FPGA peripherals and the optional Logic Tile.
CAI	<i>Configurable AXI Interconnect</i> (CAI).

CoreSight CoreSight components include:

- CoreSight *Embedded Trace Module* (ETM11)
The *Embedded Trace Macrocell* (ETM) provides signals for off-chip trace. The ETM transmits a 16-bit packet to an external trace port analyzer where the signals can be stored and later analyzed to reconstruct the code flow.
- CoreSight *Embedded Trace Buffer* (ETB11), 8KB memory.

VFP11 This high-performance, low-power *Vector Floating-Point* (VFP) coprocessor implements the VFPv2 vector floating-point architecture.

Clock control

The ARM1176JZF-S development chip contains deskew PLLs that use an external reference clock to generate internal clocks for the CPU, AHB bus, memory, and off-chip peripherals. Dividers in the chip are programmable and give flexibility in setting clock rates for the CPU, bridges, and memory.

Memory controllers

The ARM1176JZF-S development chip includes an AXI memory controller (for dynamic memory) and a single port static memory controller AHB device. Both controllers have 32-bit interfaces to external memory. See *Memory interface* on page 3-17.

Interrupt controller

The PrimeCell GIC provides an interface to the interrupt system and provides vectored interrupt support for high-priority interrupt sources from:

- peripherals in the ARM1176JZF-S development chip
- peripherals in the FPGA (a secondary interrupt controller is present in the FPGA). These are routed through the TZIC in the development chip.

See *Interrupt controllers* on page 3-19.

CLCD controller

The CLCDC provides a flexible display interface that supports a VGA monitor and digital LCD displays (external interface circuitry connects the CLCD output to a DVI Digital/Analog connector on the board). See *CLCDC interface* on page 3-18.

UART The four UARTs perform serial-to-parallel conversion on data received from a peripheral device and parallel-to-serial conversion on data transmitted to the peripheral device. (An additional UART is provided by the FPGA.) See *UART interface* on page 3-20.

Timers There are six 32-bit down counters that can be used to generate interrupts at programmable intervals. A Real-Time-Clock is fed with an external 1Hz signal.

Synchronous serial port

The SSP provides a master or slave interface for synchronous serial communications using Motorola SPI, TI, or National Semiconductor Microwire devices.

Smart Card interface

The Smart Card interface signals are programmable to enable support for a Smart Card, *Security Identity Module* (SIM) card, or similar module.

GPIO Eight bits of GPIO are provided by the on-chip interface. (An additional GPIO is provided by the FPGA.)

Watchdog A Watchdog module can be used to trigger an interrupt or system reset in the event of software failure.

3.2.2 Configuration control

The PB1176JZF-S uses configuration switches and the SYS_CFGDATAx registers in the FPGA to control configuration of the ARM1176JZF-S development chip at power-up.

After reset, configuration can be modified by the system controller and the configuration registers in the FPGA. For example, you can simulate a system that boots with the vector table located at address 0xFFFF0000 by changing the value of bits 0 and 1 in the SYS_CFGDATA2 register and pressing the DC RECONFIG button.

See *FPGA status and system control registers* on page 4-37 and *Configuration registers SYS_CFGDATAx* on page 4-45.

Configuration switches

The S1 switches select boot memory and the startup clock frequency. For more information on setting boot memory options, see *Setting the configuration switches* on page 2-3 and *Memory map* on page 4-3.

Changing the ARM1176JZF-S development chip configuration at runtime

The ARM1176JZF-S development chip has many configuration options (clock selection for example) that are configured by loading configuration values onto the data bus when a chip reconfigure signal is received.

To change the configuration of the ARM1176JZF-S development chip:

1. Program the appropriate values in the SYS_CFGDATAx registers, see *Configuration registers SYS_CFGDATAx* on page 4-45.
2. Perform a configuration reset of the PB1176JZF-S, but do not power-cycle, by either:
 - pressing the DEV CHIP RECONFIG pushbutton (next to the blue LED)
 - programming the reset-depth register to level 2 (see *Reset Control Register, SYS_RESETCTL* on page 4-49) and then performing a normal reset from software, the reset pushbutton, or JTAG.

Restoring the default configuration

To restore the default processor configuration, power-cycle the PB1176JZF-S or press the FPGA CONFIG pushbutton.

3.2.3 AXI buses

The ARM1176JF-S development chip has one external AXI master bus and one external AXI slave bus.

Both the master and slave buses are 64-bit and include TrustZone control signals.

The data signals on the AXI master bus are multiplexed and connected to the FPGA slave bus as shown in Figure 3-4. An equivalent demultiplexor connects the FPGA AXI master and the development chip AXI slave bus. Some control signals are not multiplexed.

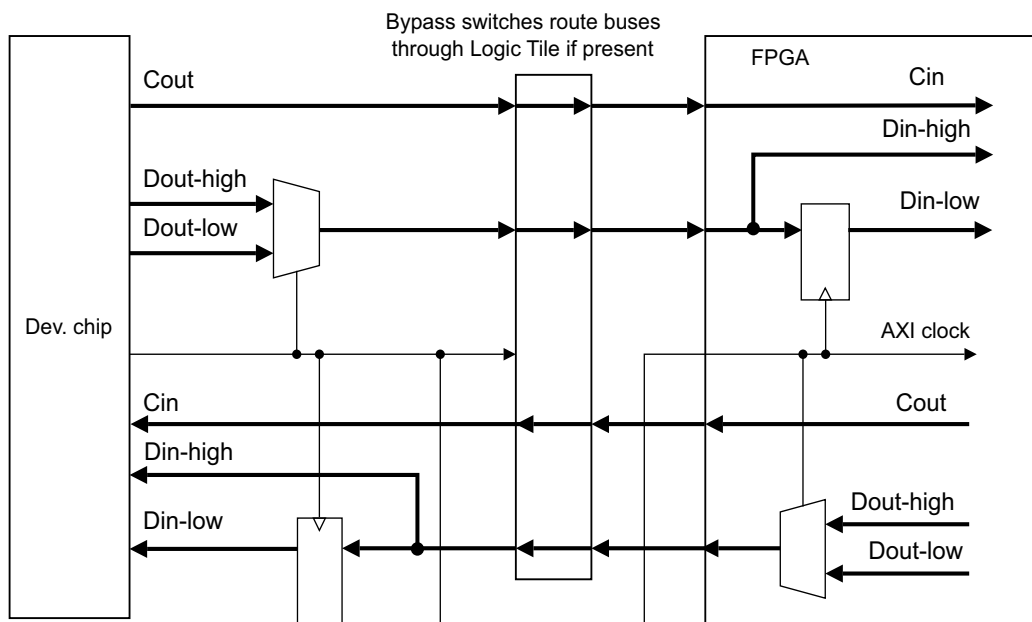


Figure 3-4 AXI master bus multiplexing

If a Logic Tile is connected, the connection between the master and slave is broken and the multiplexed buses are connected to the Logic Tile. The Logic Tile FPGA must provide the routing between the development chip and the FPGA, for example through a CAI.

A PCI bus connects to the FPGA and this can access the slave bus on the development chip because it acts as an AXI master.

3.2.4 Intelligent Energy Management

Note

The *Intelligent Energy Management* (IEM) subsystem uses an *Advanced Power Controller* (APC) provided by a third-party. The APC requires a separate license for the controller and the documentation on the controller registers.

Contact ARM for more information on licensing the APC component and obtaining the documentation required to use the APC with the IEM subsystem.

The development chip has several mechanisms for reducing system power usage:

- reducing the core and RAM supply voltages
- turing off sections of the core that are not used
- changing the operating frequency of the core.

The IEM performance level and PLL controller is responsible for:

- receiving performance requests from the IEC
- sending and monitoring performance requests to the APC and DCG
- configuring the PLLs
- instructing the clock selection block to select a PLL.

The IEM subsystem consists of the:

- *Intelligent Energy Controller* (IEC)
- *Dynamic Clock Generator* (DCG)
- System controller
- *Dynamic Voltage Controller* (DVC).

The IEM block also controls the safe entry and exit from low power modes including StandbyWFI, shutdown and dormant modes. The IEM PLL controller consists of the performance level controller state machine and PLL configuration select blocks (see also *Development chip Dynamic Clock Generator* on page 3-47).

User software running on the ARM1176JZF core, requests the required performance level through the IEC. The IEC communicates with the DCG and DVC to provide the required combination of voltage and clock frequency to satisfy the performance requirements. The IEC, system controller, and DVC, are all APB memory-mapped peripherals.

See also *DCG Fractional Performance Level Mapping Registers* on page 4-18, *Processor Frequency Configuration Register* on page 4-18 and *Advanced Power Controller and Power Management Interface* on page 4-22.

Run mode

This is the normal mode after reset. IEM software only operates in this mode.

The Run Mode Performance Level Controller State Machine receives performance level requests from the IEC and ensures safe movement between performance levels. A state machine ensures that when moving between performance levels, the required PLL has locked, and the IEM subsystem voltage level is adequate.

This state machine controls IEM through all active performance levels. If 0% performance is selected, the system either enters StandbyWFI, Shutdown or Dormant mode depending on system settings.

StandbyWFI mode

StandbyWFI mode is entered whenever the IEC selects 0% performance, and neither SHUTDOWNNXT nor DORMANTNXT flags are set. When entering StandbyWFI mode, no new voltage requests are made to the APC. Voltage is therefore held at the current level prior to requesting 0% performance. For closed loop, the clock to the HPM is not interrupted and closed loop voltage control continues to operate as normal.

Dormant and shutdown modes

In shutdown mode, the whole IEM subsystem is powered down. This includes the ARM1176JZF, L2CC, and ETM11. Shutdown and dormant modes are controlled by setting the SHUTDOWNNXT or DORMANTNXT flag in the system controller.

IEM subsystem permanent shutdown mode

An external master can have full control of the chip because the configuration option is available to completely disable the IEM subsystem. This includes the ARM1176JZF, CoreSight ETM11, and L2CC. Enable permanent IEM subsystem shutdown by setting CFGIEMSHUTDOWN bit (see Table 4-37 on page 4-45). If permanent shutdown is selected, the IEM subsystem is held in reset and input and output clamps are enabled. You can therefore safely power-down the IEM subsystem.

3.3 Development chip peripherals

This section describes peripherals and controllers located in the development chip. It contains the following sections:

- *Memory interface*
- *CLCDC interface* on page 3-18
- *GPIO interface* on page 3-18
- *Interrupt controllers* on page 3-19
- *Synchronous Serial Port, SSP* on page 3-19
- *UART interface* on page 3-20.

3.3.1 Memory interface

Memory access is provided by a *Dynamic Memory Controller* (DMC) and a *Synchronous Static Memory Controller* (SSMC) located in the ARM1176JZF-S development chip. One or more static expansion memory boards can be connected to the memory expansion connector.

Memory (or memory-mapped peripherals) can also be accessed on an optional Logic Tile or PCI card.

———— **Note** ————

The memory at 0x00000000 and 0x3C000000 at boot time is determined by the boot select switches and the remap signals (see *Memory aliasing at reset* on page 3-33).

The region at 0x80000000–0xFFFFFFFF is recommended for accesses to a Logic Tile.

PCI cards must be initialized before use (see *PCI configuration* on page 4-115).

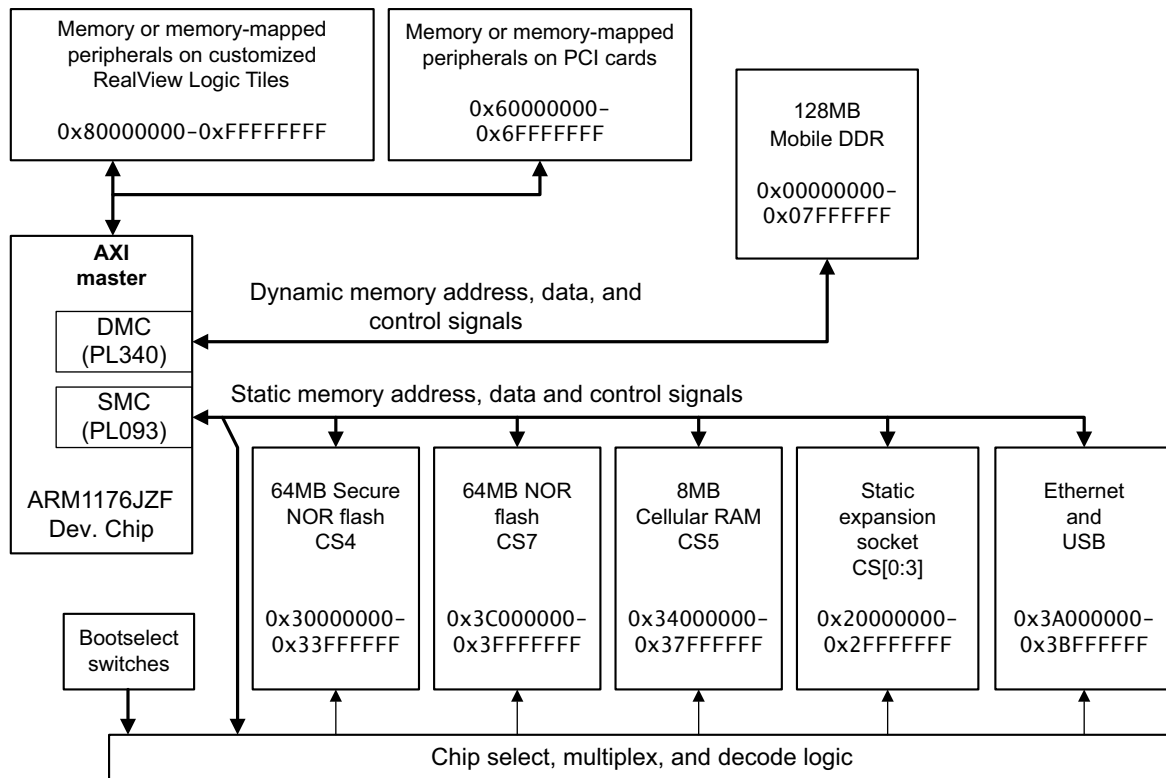


Figure 3-5 Memory devices

3.3.2 CLCDC interface

A PrimeCell *Color LCD controller* (CLCDC) is present in the ARM1176JZF-S development chip.

The PB1176JZF-S provides a display interface with outputs to a DVI Digital/Analog connector for connecting to a CLCD monitor

A DAC converts the rearranged CLCD signals into VGA analog signals.

See *Color LCD Controller, CLCDC* on page 4-32 for interface details.

3.3.3 GPIO interface

The GPIO signals **GPx_[7:0]** from the ARM1176JZF-S development chip are connected to the GPIO connectors.

See also *General Purpose Input/Output, GPIO* on page 4-57 and the *ARM PrimeCell GPIO (PL061) Technical Reference Manual*. See *GPIO interface* on page A-12 for connector pinout information.

3.3.4 Interrupt controllers

The ARM1176JZF-S development chip contains a *Generic Interrupt Controller (GIC)* and a *TrustZone Interrupt Controller (TZIC)*. Two additional GICs are in the FPGA. Figure 3-6 shows the interconnections between the peripherals and the interrupt controllers.

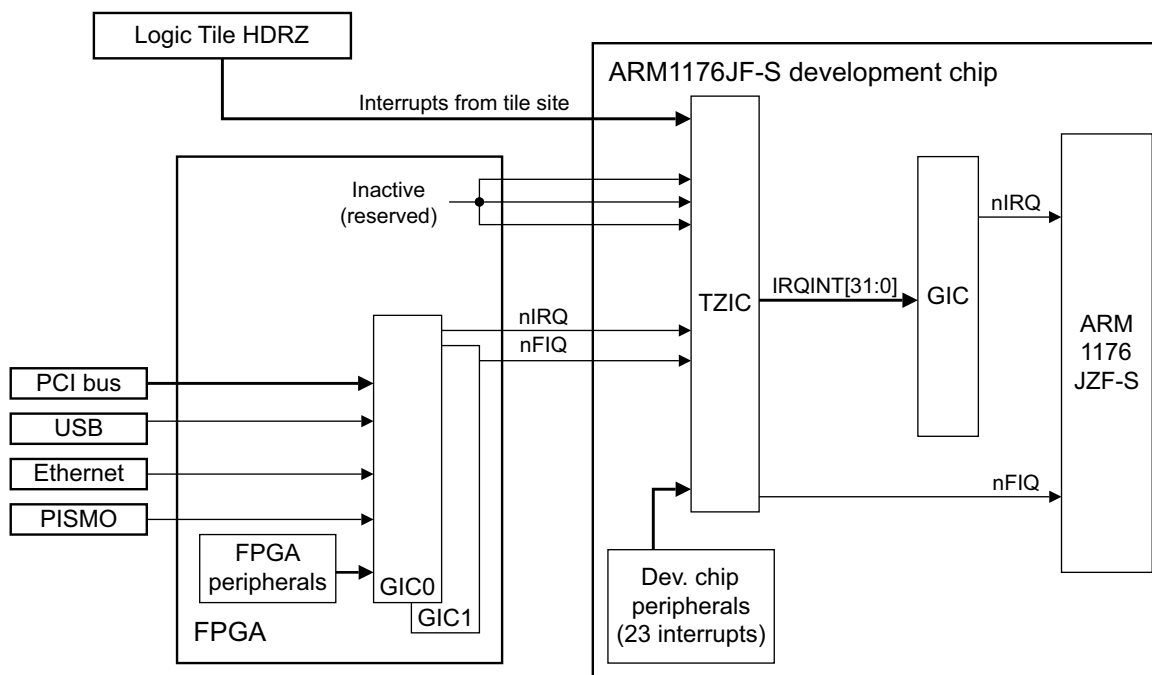


Figure 3-6 Interrupt controller block diagram

For details on the programming model for the interrupt controllers, see *Interrupt controllers in the ARM1176JZF-S development chip* on page 4-58.

3.3.5 Synchronous Serial Port, SSP

The ARM1176JZF-S development chip contains a PrimeCell SSP controller. Use expansion connector J31 to connect to the SSP. The FPGA controls the SSP peripheral chip select.

The SSP functions as a master or slave interface that enables synchronous serial communication with slave or master peripherals having one of the following:

- a Motorola SPI-compatible interface
- a Texas Instruments synchronous serial interface
- a National Semiconductor Microwire interface.

See also *Synchronous Serial Port, SSP* on page 4-124 and the *ARM PrimeCell Synchronous Serial Port Controller (PL022) Technical Reference Manual*.

3.3.6 UART interface

Four UARTs (SER0, SER1, SER2, and SER3) are provided by the ARM1176JZF-S development chip.

A fifth UART, SER4, is implemented with a PrimeCell UART incorporated in the FPGA.

The UARTs have the following features:

- functionally similar to standard 16C550 devices
- port function corresponds to the DTE configuration
- SER0 and SER4 (UART0 and UART4) have full CTS, RTS, DCD, DSR, DTR, and RI modem control signals
- SER1, SER2, and SER3 (UART1, UART2, and UART3) have simple modem control signals CTS and RTS
- programmable baud rates of up to 1.5Mbits per second (the line drivers however, are only guaranteed to 250kbps)
- 16-byte transmit FIFO
- 16-byte receive FIFO
- programmable interrupt.

The signals from the ARM1176JZF-S development chip UARTs and the FPGA UART are converted from logic level to RS232 level by MAX3243E buffers.

See also *UART* on page 4-140 and the *ARM PrimeCell UART (PL011) Technical Reference Manual*.

The signals associated with the UART interface are shown in Table 3-1.

Table 3-1 Serial interface signal assignment

Signal	Description
SERx_TXD	Transmit data
SERx_RTS	Ready to send
SERx_DTR^a	Data terminal ready
SERx_CTS	Clear to send
SERx_DSR^a	Data set ready
SERx_DCD^b	Data carrier detect
SERx_RXD	Receive data
SERx_RI^b	Ring indicator

- a. For UART1, UART2, and UART3, the DTR and DSR signals are connected together and are not input to the ARM1176JZF-S development chip or FPGA.
- b. For UART1, UART2, and UART3, the DCD and RI signals are not connected to the ARM1176JZF-S development chip or FPGA.

3.4 FPGA peripherals

This section describes the peripherals present in the FPGA. It contains the following sections:

- *FPGA architecture* on page 3-23
- *Character LCD controller* on page 3-24
- *Advanced Audio Codec Interface, AACI* on page 3-24
- *Keyboard/Mouse Interface, KMI* on page 3-24
- *Memory Card Interface, MCI* on page 3-25
- *Smart Card interface, SCI* on page 3-25
- *Serial bus interface* on page 3-26
- *User switches and LEDs* on page 3-26
- *USB interface* on page 3-27
- *PCI interface* on page 3-27
- *Ethernet interface* on page 3-29.

3.4.1 FPGA architecture

Figure 3-7 shows the architecture of the FPGA on the PB1176JZF-S.

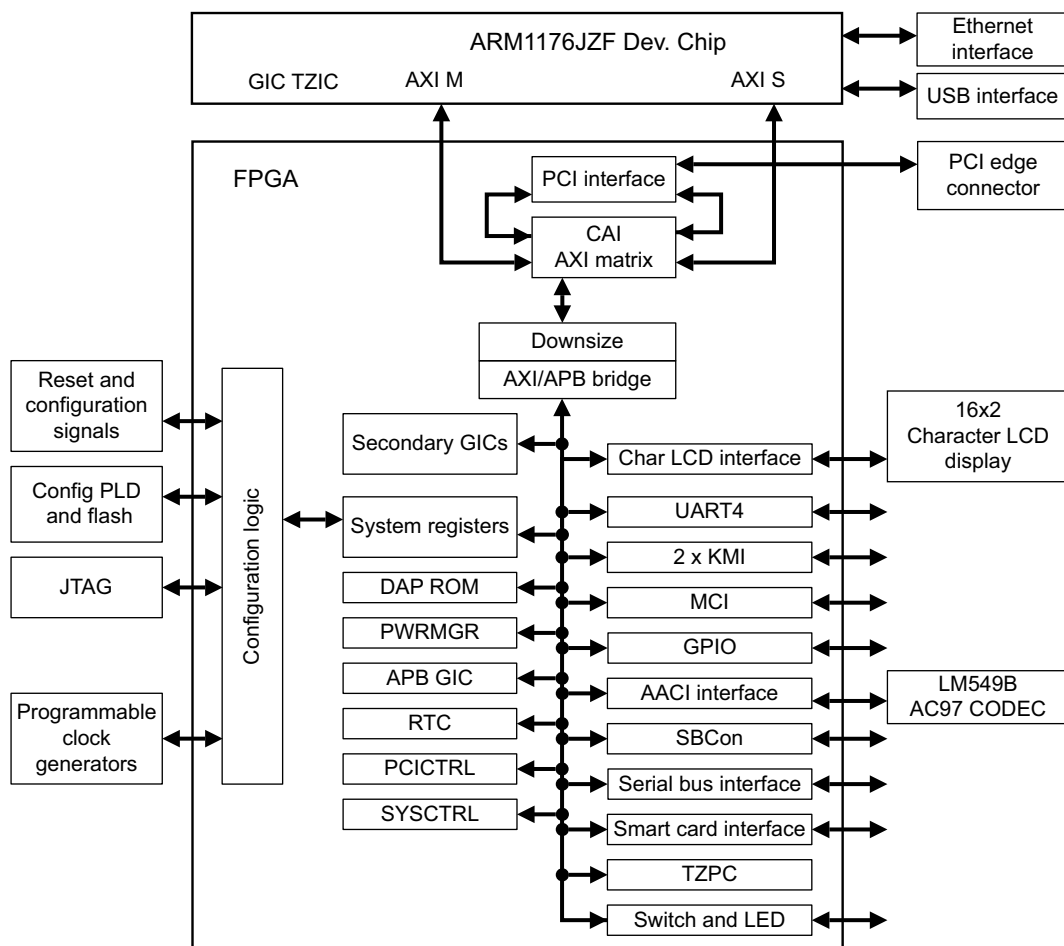


Figure 3-7 FPGA block diagram

3.4.2 Character LCD controller

The FPGA contains a simple controller that provides an interface to a standard HD44780 16 x 2 character LCD alphanumeric display module. See *Character LCD display* on page 4-29 for details of the control registers for the display.

The character display has an 8-bit interface.

LK10 is installed at the factory to match the voltage requirement of the particular display module installed on the board.

3.4.3 Advanced Audio Codec Interface, AACI

The FPGA contains an ARM PrimeCell *Advanced Audio CODEC Interface (AACI)* that provides communication with a CODEC using the AC-link protocol. This section provides a brief overview of the AACI. For detailed information, see *PrimeCell Advanced Audio CODEC Interface (PL041) Technical Reference Manual*.

———— **Note** ————

For a description of the audio CODEC signals, see the LM4549 datasheet available from the National Semiconductor website. See also *Advanced Audio CODEC Interface, AACI* on page 4-27.

The AACI on the PB1176JZF-S connects to a National Semiconductor LM4549 audio CODEC that is compatible with AC'97 Rev 2.1.

Two microphone inputs are present on J4. Only monophonic sound is supported, but microphone channel **CODEC_MIC1** or **CODEC_MIC2** can be selected in software. Solder link LK1 selects passive or active (electret) microphones:

- | | |
|----------------|---|
| Link AB | Active microphone with power on CODEC_MIC1 (tip). Passive microphone on CODEC_MIC2 (not powered).
This is the default configuration. |
| Link BC | Active microphone with power on CODEC_MIC2 (ring). Passive microphone on CODEC_MIC1 (not powered). |
| No link | Passive microphone on CODEC_MIC1 and CODEC_MIC2 . |

3.4.4 Keyboard/Mouse Interface, KMI

The *Keyboard and Mouse Interfaces (KMI)* are implemented with two PrimeCells incorporated into the FPGA.

See also *Keyboard and Mouse Interface, KMI* on page 4-107 and the *ARM PrimeCell PS2 Keyboard Mouse Controller (PL050) Technical Reference Manual*.

3.4.5 Memory Card Interface, MCI

The ARM PrimeCell *Multimedia Card Interface (MCI)* PL180 is an *Advanced Microcontroller Bus Architecture (AMBA)* slave block that connects to the *Advanced Peripheral Bus (APB)*.

The PrimeCell MCI provides all functions specific to the multimedia and secure digital memory card such as the clock generation unit, power management control, and command and data transfer. The interface conforms to *Multimedia Card Specification v2.11* and *Secure Digital Memory Card Physical Layer Specification v0.96*.

See *MultiMedia Card Interfaces, MCI* on page 4-108 and the *ARM PrimeCell Multimedia Card Interface (PL180) Technical Reference Manual* (ARM DDI 0172) for full programming details.

The signals on the PB1176JZF-S connector are shown in *MMC and SD flash card interface* on page A-9.

3.4.6 Smart Card interface, SCI

The ARM PrimeCell *Smart Card Interface (SCI)* PL131 is an *Advanced Microcontroller Bus Architecture (AMBA)* slave block that connects to the *Advanced Peripheral Bus (APB)*.

The PrimeCell Smart Card Interface (SCI) interfaces to an external Smart Card reader. The SCI can autonomously control data transfer to and from the smart card. Transmit and receive data FIFOs are provided to reduce the required interaction between the host system and the peripheral.

You can set the Smart Card interface voltage to operate at 5V, 3.3V or 1.8V by setting jumpers on J34:

- Connect pins AB for 3.3V operation
- Connect pins CB for 5V operation
- omit the link for 1.8V operation.

The default setting is linking pins AB. Both 3.3V and 5V cards function with this setting.

————— Note —————

The Smart Card VCC is switched on and off by the **SCI VCCENx** signal from the PrimeCell.

See also *Smart Card Interface, SCI* on page 4-123, the *SCI PrimeCell PL131 Technical Reference Manual*. The signals on the Smart Card connector and expansion connector are described in *Smart Card interface* on page A-3.

3.4.7 Serial bus interface

The FPGA implements a serial bus interface that identifies the memory expansion modules, read and set the time-of-year clock, and identify displays connected to the DVI Digital/Analog connector.

Each device on the serial bus has its own slave address. The unique address for each slave on the serial bus is shown in Table 3-2.

Table 3-2 Serial interface device addresses

Device	Write address	Read address	Description
PISMO (static memory module)	0xA2	0xA3	Identifies the type of memory on the board and how it is configured.
TOY (DS1338 RTC)	0xD0	0xD1	Reads time data and writes control data to the RTC.
DVI Digital/Analog (external display)	display dependant	display dependant	Reads the capabilities of the external display connected to the DVI Digital/Analog connector. Can control display settings of <i>E-DDC</i> displays.

3.4.8 User switches and LEDs

The FPGA provides a switch and LED register that enables you to read the general-purpose pushbutton switch and the user switches (S6) and light the user LEDs (located next to switch S6). See Figure 2-1 on page 2-3 for the location of the switches and LEDs.

———— **Note** ————

The Boot Monitor reads switches S6-1 and S6-3 to determine start-up settings after reset. See *Boot Monitor configuration* on page 2-8.

Set bits [7:0] in the SYS_LED register at 0x10000008 to illuminate LEDs 7–0. The state of the user switches S6[8:1] is present on bits [7:0] of the SYS_SW register at 0x10000004.

The state of the general-purpose pushbutton S3 can be read from bit 4 of the SYS_MISC register at 0x10000060. Setting bit 3 of SYS_MISC causes a S3 depression to generate a PWRFAIL interrupt. The interrupt can be used to test auto-shutdown code or to awaken the processor from sleep mode. See *Miscellaneous System Control Register, SYS_MISC* on page 4-52.

3.4.9 USB interface

The FPGA provides the bus interface to an external ISP1761 USB controller. Three USB interfaces are provided on the PB1176JZF-S:

- ISP1761 USB port 1 provides an OTG device interface and connects to J18.
- ISP1761 USB ports 2 and 3 can function in either master or slave mode and connect to the dual type A connector J19 (USB2 is the top connector).

The signals on the USB interfaces are listed in *USB interface* on page A-6.

Note

For a full description of the USB controller, see the datasheet for the NXP ISP1761. See *USB interface* on page 4-142 for details of the control register addresses.

Note

The USB Debug interface has a dedicated USB controller and connects to the USB B-Type connector. It is only used for downloading new FPGA images and is not accessible from software running in the development chip.

3.4.10 PCI interface

The PCI subsystem enables you to use PCI expansion cards with the PB1176JZF-S when plugged into the PCI enclosure, or plug into a PC as a card.

PCI bridges pass valid accesses between the PB1176JZF-S and the PCI bus.

The slave bridge connected to the AHB M2 bus recognizes addresses 0x46000000 to 0x6FFFFFFF as being intended for a target within the PCI address space of the memory map, and passes accesses within this region to the PCI bus. The PCI_IMAPx registers define the address translation values for the PCI I/O, PCI configuration, and PCI memory windows.

The PCI_SMAPx registers define the address translation values for PCI accesses to the AHB S bus.

The AHB to PCI bridge supports read and write accesses in both directions, as shown in Figure 3-8.

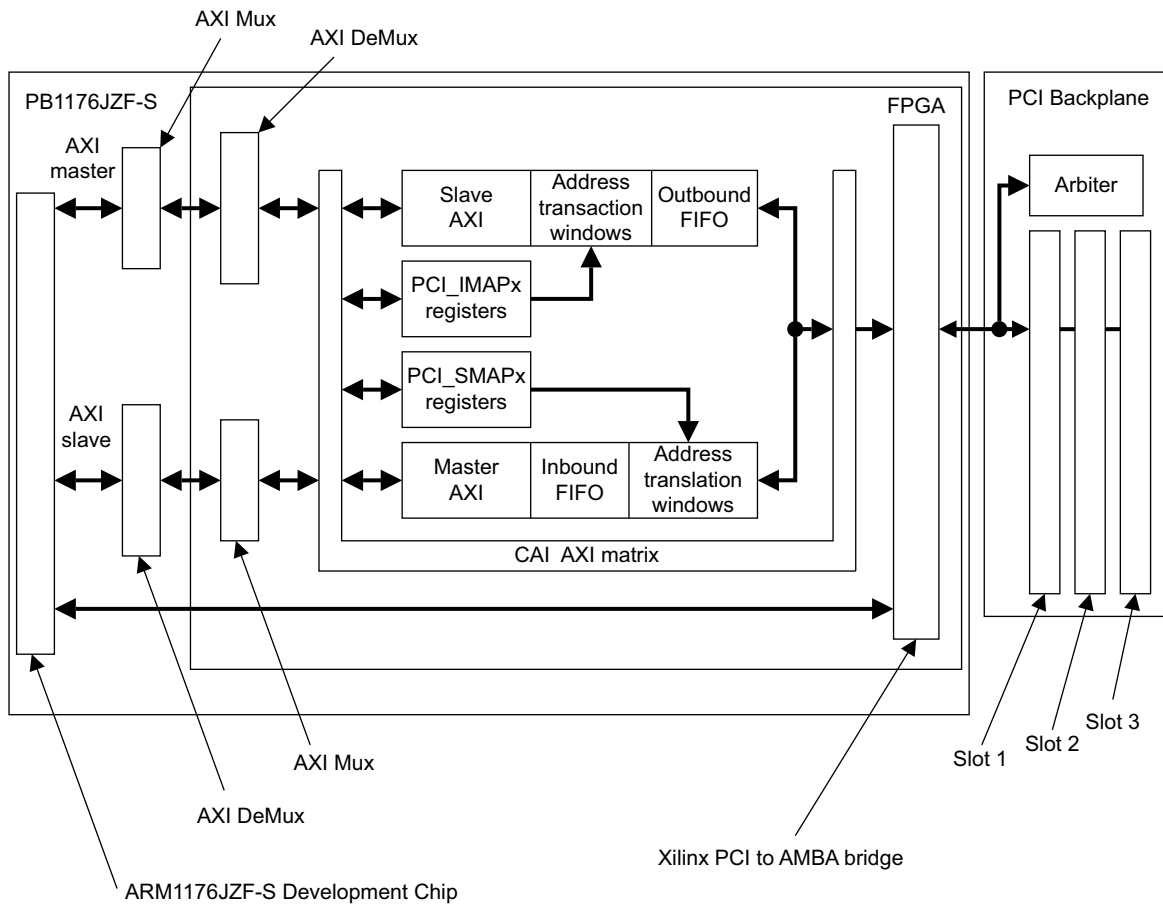


Figure 3-8 PCI bridge

See also and Appendix D *PCI Backplane and Enclosure* and *PCI controller* on page 4-109.

3.4.11 Ethernet interface

The Ethernet interface is implemented with a SMC LAN9118 10/100 Ethernet single-chip MAC and PHY. The device is attached to the static memory bus from the development chip.

The isolating RJ45 connector incorporates two network status LEDs. The function of the LEDs can be set to indicate link, activity, transmit, receive, full duplex, or 10/100 selection. See the data sheet for the LAN9118 for more details on programming the registers.

The SMCS LAN9118 is a fast Ethernet controller that incorporates a *Media ACcess* (MAC) Layer, a *PHYsical* (PHY) layer, and an 8KB dynamically configurable transmit and receive FIFO.

The controller supports dual-speed 100Mbps or 10Mbps and auto configuration. When auto configuration is enabled, the chip is automatically configured for network speed and for full or half-duplex operation.

The controller connects to the ARM1176JZF-S development chip SMC using CS6, which is shared with the USB port.

The LAN9118 is a little-endian device. The default configuration for the system bus is also little-endian.

A serial EEPROM provides the following parameters to the LAN9118 at reset:

- the individual MAC address, that is, the Ethernet MAC address
- *Media Independent Interface* (MII) interface configuration
- register base address.

When the PB1176JZF-S is manufactured, an ARM value for the Ethernet MAC address and the register base address are loaded into the EEPROM. A unique MAC address is programmed at manufacture, but the address can be reprogrammed if required. Reprogramming of the EEPROM is done through LAN9118 Bank 1 (general and control registers).

3.5 FPGA configuration

This section describes how the FPGA image is selected and loaded.

Caution

The 1.5V cell battery provides the **VBATT** backup voltage to the external DS1338 time-of-year clock and FPGA encryption key circuitry within the FPGA. Removing the battery erases the encryption key.

Each board is provided with an encryption key that is unique to the board. The standard image supplied with the board is not encrypted. However, encrypted images might be supplied by ARM in the future. If you are using encrypted images and the key is erased, you must return the board to ARM to have the key reloaded.

The battery is expected to last for approximately 10 years from manufacture of the PB1176JZF-S. To replace the battery:

1. Power on the PB1176JZF-S. If the battery is removed while the board is powered down, the encryption key is erased.
2. Remove the old battery.
3. Insert the new battery and ensure that the positive terminal is facing upwards in the holder.

For details on FPGA components, see *FPGA peripherals* on page 3-22.

Note

The ARM1176JZF-S development chip and FPGA AXI buses on the PB1176JZF-S are shared with the Logic Tile headers. If you are using a Logic Tile, ensure that the tile manages the bus signals correctly.

At power-up the FPGA loads its configuration data from a flash memory device. Parallel data from the flash memory is streamed by the configuration PLD into the configuration ports of the FPGA.

The image loaded into the FPGA is determined by configuration switches S1-6 and S1-7 as described in *FPGA image selection* on page 2-5.

———— **Note** —————

The configuration flash can hold four FPGA images. However, only one FPGA image is provided.

The configuration flash is a separate device and not part of the user flash.

You can use a JTAG debugger or the USB config port and the Progcards utility to reprogram the PLDs, FPGA, and flash if the PB1176JZF-S is placed in configuration mode.

See Appendix H *Loading FPGA Images* and *JTAG debug port and USB config port support* on page 3-51. The PB1176JZF-S is supplied with the configuration PLD and flash image already programmed. The information in the section is provided, however, in case of accidental erasure of the configuration PLD or flash image.

3.6 Reset controller

The reset controller initializes the ARM1176JZF-S development chip, the FPGA, and external controllers as a result of a reset. The PB1176JZF-S can be reset from the following sources:

- power failure
- reset button
- PCI backplane
- Logic Tiles
- JTAG
- software.

Note

Use the RESET pushbutton (**nPBRESET**), the JTAG reset signal (**nSRST**), the PCI backplane reset signal (**P_nRST**), the Logic Tile reset signal (**nSYSPOR** or **nSRST** from the tile), or a software reset to reset the ARM1176JZF-S core. The current ARM1176JZF-S development chip configuration settings are retained. (The effect of these reset sources pushbutton can be modified by setting the reset level flags, see *Reset level* on page 3-33.)

Use the DEV CHIP RECONFIG pushbutton to reset the processor and reload the chip configuration settings from the FPGA configuration registers.

Use the FPGA CONFIG pushbutton to reload the FPGA image without repowering the entire system. The FPGA configuration registers are reloaded with their default values. (Pressing FPGA CONFIG also resets the core and reloads the Logic Tile images.)

3.6.1 Reset level

Table 3-3 lists the default levels of reset that results from external sources.

Table 3-3 Reset sources and effects

External source	Reset level	Hardware nBOARDPOR generated	FPGA reloaded and Dev. Chip configured with default values	Dev. Chip reconfigured from SYS_CFGDATA registers	Reset generated for CPU, memory and peripherals
Power on	0	Yes	Yes	Yes	Yes
FPGA CONFIG pushbutton	1	No	Yes	Yes	Yes
DEV CHIP RECONFIG pushbutton	2	No	No	Yes	Yes
RESET pushbutton or software reset	3	No	No	No	Yes

See *Reset signals* on page C-6 for a description of the reset signals on the Logic Tile headers.

3.6.2 Memory aliasing at reset

Under normal operation, the PB1176JZF-S has dynamic memory located at 0x0. To load the boot code however, non-volatile memory must be remapped to the boot address.

The **CFGREMAP[1:0]** signals control the development chip remapping, as listed in Table 3-4. The remap signals can be indirectly set by writing to the **SYS_CONFIG** registers. The value in the registers is applied to the development chip configuration pins if there is a Dev Chip reset signal. See *Configuration registers SYS_CFGDATAx* on page 4-45.

Table 3-4 CFGREMAP signals

CFGREMAP[1:0]	Description
00	No remaps are active. This is the normal run-time memory map.
01	<p>The AXI pseudo ROM, 16KB, is aliased to address 0x0. For simplicity of address decoding, it is aliased over the bottom 64MB of DMC bank 0. The AXI pseudo ROM is present to emulate the typical hardware configuration of target systems.</p> <p>Note</p> <p>The AXI ROM is always visible at its higher non-aliased address location. This is development-chip specific, and is not the case in a true TZ SoC.</p> <p>The AXI pseudo ROM is loaded from the Debug tools. A reset then boots from it.</p>
10	<p>SMC bank 7 (SC7) is aliased to address 0x0, over the bottom 64MB of DMC bank 0.</p> <p>Note</p> <p>SC7 is always visible at its higher, non-aliased, address location.</p> <p>SC7 can be NOR flash or Secure NOR flash, depending on the position of the configuration switches S7-1 and S7-2. See <i>Boot memory selection</i> on page 2-4.</p>
11	When active, accesses to the bottom 64MB of memory space are directed to the AXI master port. There is no alias.

See also *Boot memory selection* on page 2-4 for a description of using the configuration switches to remap memory at reset.

3.7 Power supply

Warning

The low-voltage regulators become very hot during normal operation.

A heat shield covers the regulators to prevent accidentally touching the regulators.

Do not remove the heat shield.

The PB1176JZF-S can be powered from:

The 12V brick power supply

If used, a nominal 12V level (**VSMP**) is supplied to the low-voltage regulators. The power supply can be toggled on and off by pressing the Power pushbutton. If a link is placed across J47 (FORCE ON), the power is forced on and the Power pushbutton switch has no effect.

Note

A jumper must not be placed across connector J45 (POWER). You can, however, use this connector to attach an external pushbutton if the Power pushbutton is blocked by an attached tile or if the baseboard is mounted inside an enclosure.

The POWER and FORCE ON signals are deactivated if the baseboard is not powered from the 12V input.

If the external voltage is not between 10.8 and 13.2V, the supply is automatically disconnected from the regulators.

The PCI expansion connector

The PCI expansion connector supplies 12V, 5V, and 3.3V.

The external power terminal block

The external power terminal block has connections for 12V, 5V, and 3.3V. The correct voltage must be connected to the corresponding labeled connector on the block.

See Figure 3-1 on page 3-3 for locations of the connectors, jumpers, and pushbuttons.

The following voltage regulators are present on the PB1176JZF-S:

5V The 5V regulator can supply 6A to the board.

The **FUSED1A_5V** supply is taken from the 5V supply after passing through a 1A fuse. This supply is powers devices connected to the keyboard, mouse, USB, and LCD connectors.

A separate 5V analog supply is generated directly from 12V to minimize interference from the digital logic on the 5V supply.

3V3 The 3.3V regulator can supply 6A to the board.

IEM/VDDCORE

The IEM subsystem in the development chip controls an LP5550 IEM programmable power supply that outputs 1.08 to 1.32 volts for **IEM/VDDCORE**.

Caution

The programmable power supply can supply between 1.08 to 1.32 volts, but ARM recommends that the operating voltage should be set at 1.2V.

The IEM subsystem uses a third-party controller that requires a separate license. Contact ARM for more information on licensing if you require that the core voltage is adjustable.

1V2 The 1.2V regulator can supply up to 2A to the development chip peripherals.

The voltage and current for the core, DRAM, and on-chip peripherals can be read by a ADC connected to the PLD.

3.7.1 Reading the core and RAM voltages

The voltage and current monitoring scheme is shown in Figure 3-9. The values from the 8-channel 12-bit ADC are shifted into the FPGA control registers.

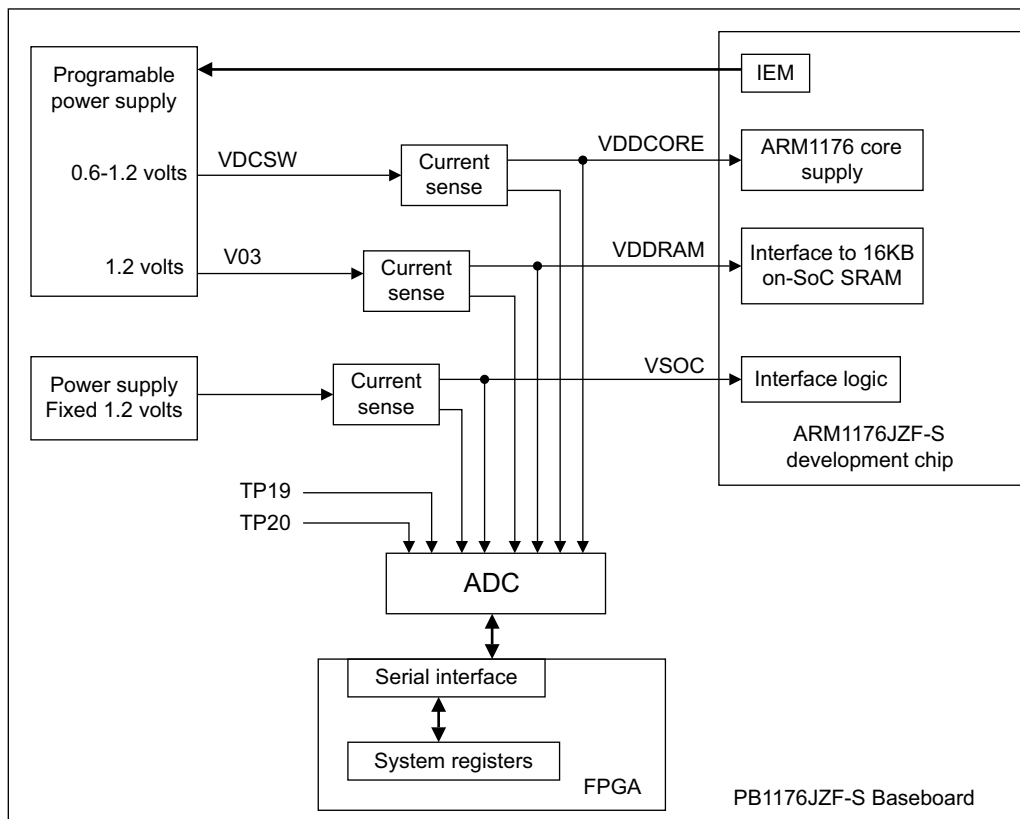


Figure 3-9 Voltage control and voltage and current monitoring

For more information on power control and measurement, see *Intelligent Energy Management* on page 3-15 for details of the development chip Intelligent Energy Management (IEM) control logic.

3.8 Clock architecture

The clock domains for the PB1176JZF-S are shown in Figure 3-10.

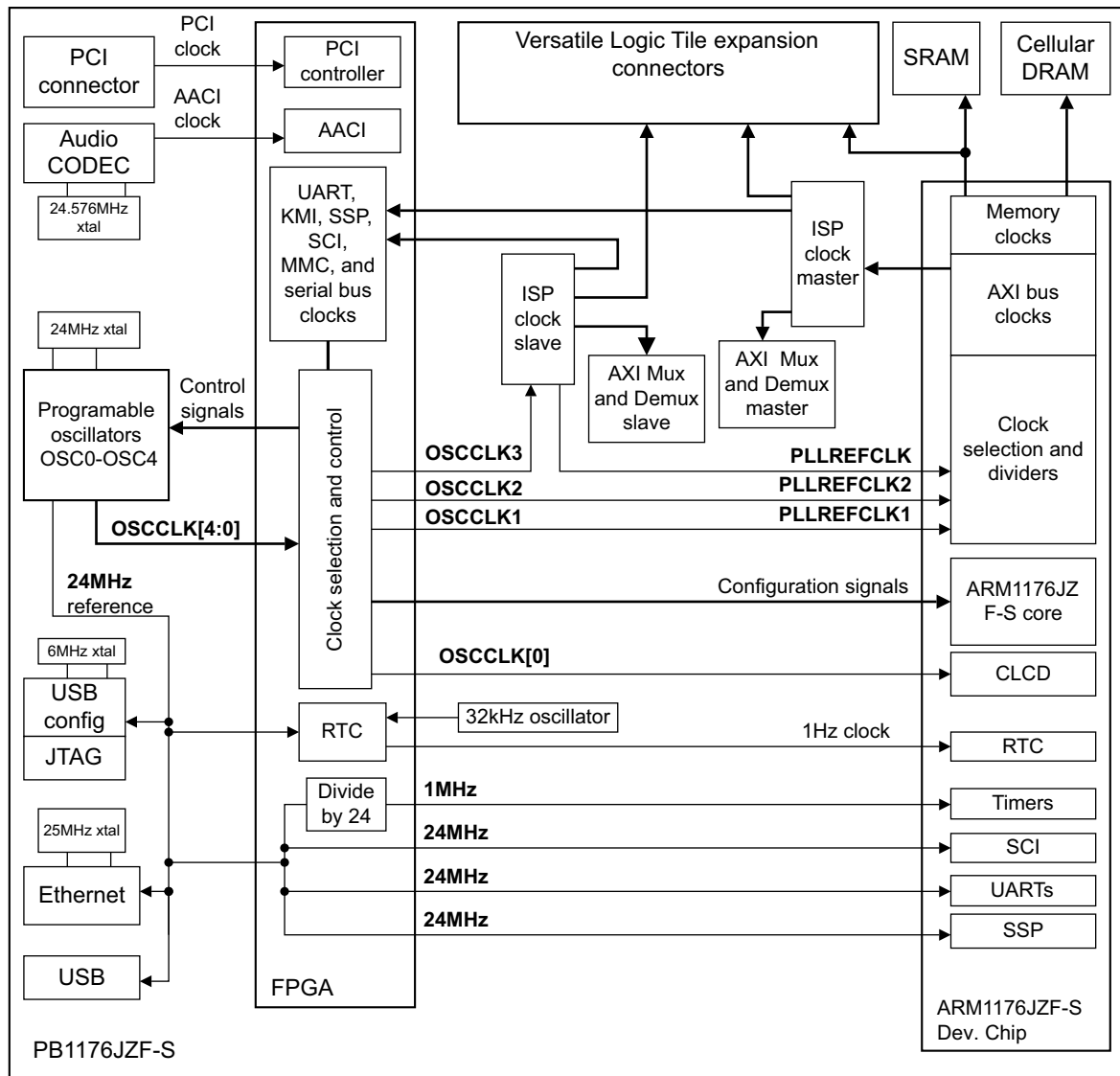


Figure 3-10 Clock architecture for PB1176JZF-S

The following sections describe:

- *FPGA Peripheral clocks*
- *ARM1176JZF-S development chip clocks* on page 3-40
- *ICS307 programmable clock generators* on page 3-48

For details on Logic Tile clocks, see Appendix C *RealView Logic Tile*.

3.8.1 FPGA Peripheral clocks

Table 3-5 lists the memory and peripheral clocks for the PB1176JZF-S FPGA.

Table 3-5 FPGA clocks

Clock signal	Frequency	Description	Source
OSCCLK[3:0]	6–75MHz	References for development chip clocks and FPGA peripherals. (See also <i>ARM1176JZF-S development chip clocks</i> on page 3-40.) The clock values are set by configuration registers in the FPGA. The register contents are automatically sent to the oscillators over a dedicated serial link (see <i>ICS307 programmable clock generators</i> on page 3-48).	Crystal oscillator
AACIBITCLK	12.288MHz	This is the synchronization clock from the audio CODEC. The clock is an input to the AACI PrimeCell.	Crystal oscillator
ETHLCLK	24MHz	ETHLCLK synchronizes data transfers between the external controller and the FPGA. (The Ethernet controller uses a 25MHz crystal for clocking signals to and from the Ethernet connector.)	24MHz reference
REFCLK32K	32.768kHz (fixed)	A 1Hz clock is generated from this signal.	32.768kHz crystal
PCICLK	33MHz	This is the clock from the PCI backplane.	PCI

———— **Note** —————

OSCCLK[4] connects to the FPGA, but is not used by the system.

3.8.2 ARM1176JZF-S development chip clocks

This section describes the clocks used by the ARM1176JZF-S development chip (see Figure 3-11).

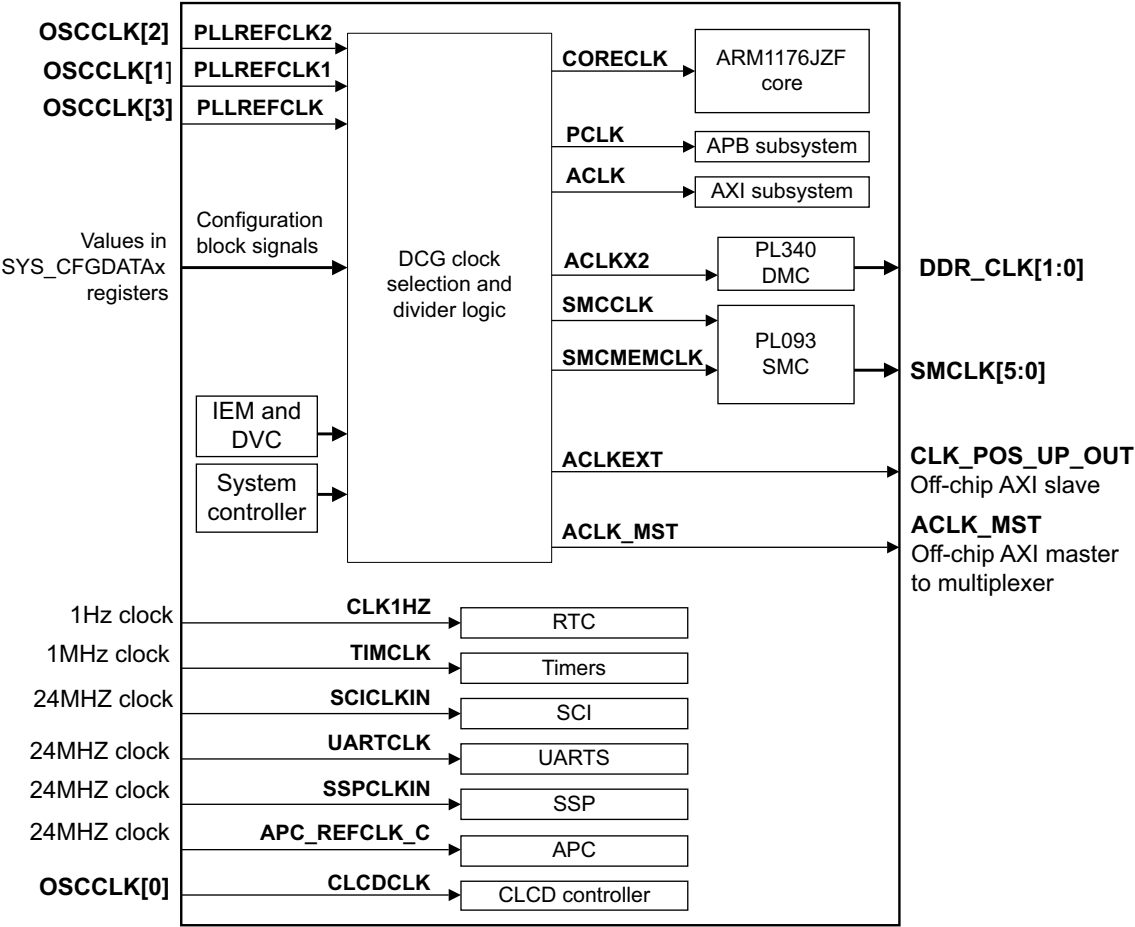


Figure 3-11 Development chip clocks

Table 3-6 on page 3-41 lists the major development chip clock signals.

Table 3-6 ARM1176JZF-S development chip clocks

Clock signal	Frequency	Description	Source
PLLREFCLK	6–75MHz	Reference for the master PLL.	ICS307 OSC3
PLLREFCLK1	6–50MHz	Reference clock for PLL1.	ICS307 OSC1
PLLREFCLK2	6–40MHz	Reference clock for PLL2.	ICS307 OSC2
PLLFIXEDCLK	6–320MHz	Reference clock for internal clock dividers. PLLFIXEDCLK is an internal clock that has a frequency equal to PLLREFCLK times the divider values in ACLKEXTDIVSLV and ACLKDIV .	Internal (PLLREFCLK)
CORECLK	6–320MHz	Core CPU clock. The operating frequency is PLLFIXEDCLK for 100% performance mode. PLLREFCLK1 or PLLREFCLK2 are used by the IEM as the reference in power saving mode.	Internal (PLLREFCLK)
ACLK_MST	1–320MHz	External AXI master clock that drives the AXIM multiplexor and is fed to the FPGA for timing the AXIS demultiplexor. (A programmable divider in the development chip determines the ratio between this clock and ACLK .)	ICS307 OSC3 (PLLREFCLK)
ACLK	3–160MHz	Internal AXI master clock to the on-chip peripherals. (A programmable divider in the development chip determines the ratio between this clock and PLLFIXEDCLK .)	ICS307 OSC3 (PLLREFCLK)
ACLKEXT (CLK_POS_UP_OUT)	6–75MHz	External AXI slave clock to Logic Tile. (Because of the PLL feedback circuit, this clock is at the same frequency as PLLREFCLK .)	ICS307 OSC3 (PLLREFCLK)
DDR_CLK[1:0]	3–320MHz	The dynamic memory clocks from the DMC in the development chip. (ACLKX2 is the internal reference for the memory clocks)	DMC controller
SMCLK[5:0]	3–320MHz	The static memory clocks from the SSMC in the development chip. (SMCMEMCLK is reference for the external static memory clocks)	SSMC controller
TIMCLK	1MHz	The timers use the external 1MHZ clock as reference. (The FPGA contains a divider that generates this from 24MHz.)	24MHz reference clock
CLCDCLK	6–75MHz	Reference for the CLCD controller.	ICS307 OSC0

Table 3-6 ARM1176JZF-S development chip clocks (continued)

Clock signal	Frequency	Description	Source
CLK1HZ	1Hz	The Real Time Clock uses this signal.	24MHz reference clock
UARTCLK	24MHz	The UART reference clock.	24MHz reference clock
SCIREFCLKEXT	24MHz	The clock for PL131 SCI in the development chip can be derived from this input.	24MHz reference clock
SCICLKIN	24MHz	The SCI reference clock.	24MHz reference clock
SSPCLKIN	24MHz	The SSP reference clock.	24MHz reference clock
APC_REFCLK_C	24MHz	Power Management clock reference	24MHz reference clock

Clock generation and divider logic in the development chip

A block diagram of the PLL and divider logic is shown in Figure 3-12.

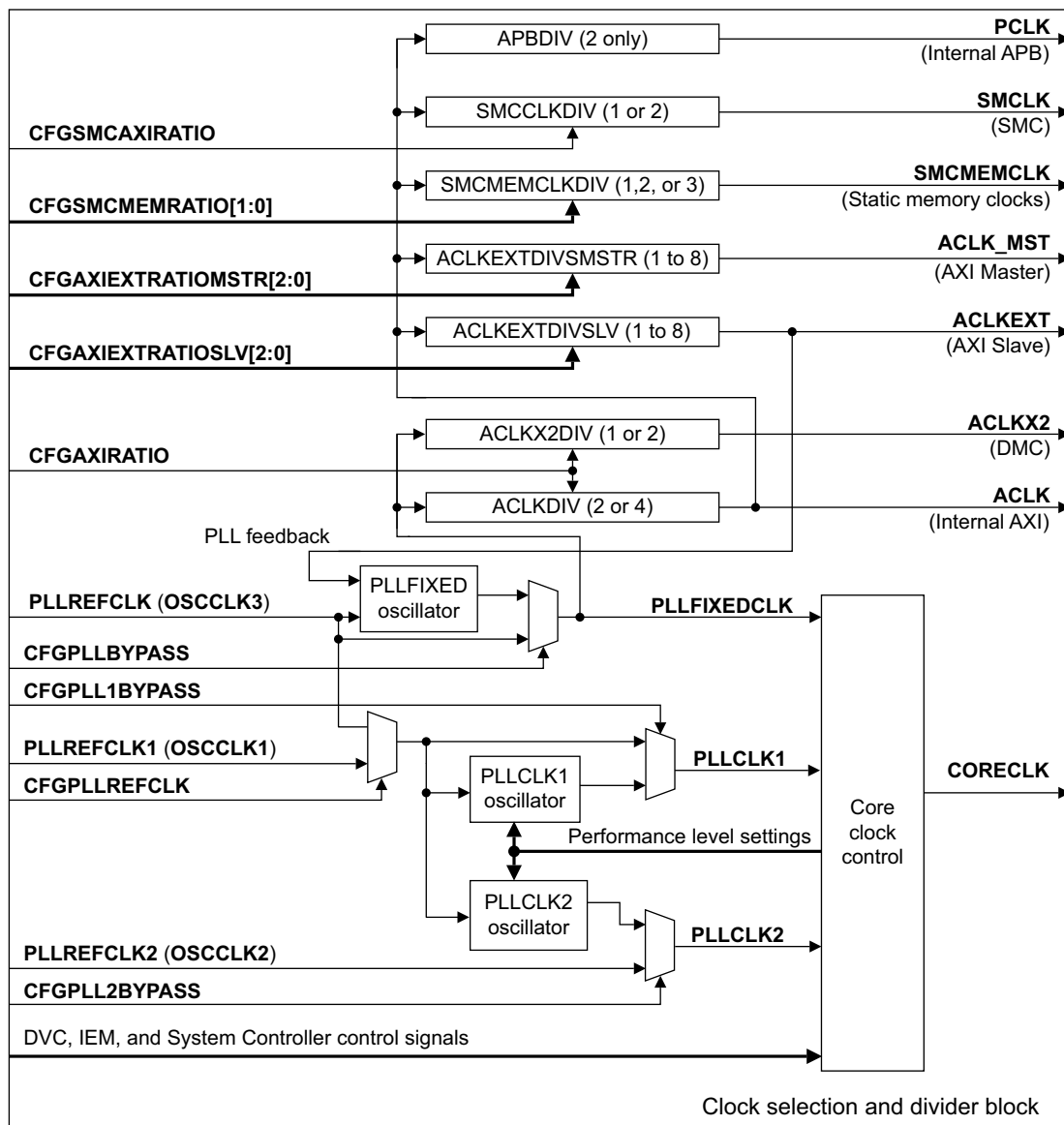


Figure 3-12 DCG clock selection and divider logic

The PLL block contains the three PLLs as shown in Figure 3-12 on page 3-43:

- **PLLFIXED** is configured at reset through the Configuration Block, and generates all fixed clocks in the design. **PLLFIXED** also clocks the IEM subsystem when running in 100% performance mode or when IEM is disabled. **PLLREFCLK** is the fixed reference to the **PLLFIXED** and **ACLKEXT** is the feedback clock.
- **PLL1** and **PLL2** generate clocks for sub-100% performance levels when IEM is enabled. The reference clock for **PLL1** and **PLL2** is determined by the configuration input **CFGPLLREFCLK**. If it is set **LOW**, the reference clock for **PLL1** and **PLL2** is **PLLREFCLK**. If **HIGH**, **PLLREFCLK1** is the reference. The PLL frequency is based on a lookup table that contains divider values and voltage ranges for the different performance level settings.

The development chip contains programmable dividers that generate clock frequencies required by the various subsystems on the chip. The divisors are set by the external configuration signals that are controlled by the chip configuration registers (see *Configuration registers SYS_CFGDATAx* on page 4-45).

———— Note ————

The frequency of **ACLKEXT** is always equal to **PLLREFCLK** if the PLL is not bypassed.

The feedback route to the PLL goes through both the **ACLKEXTDIVSLV** and **ACLKDIV** dividers as shown in Figure 3-12 on page 3-43, so increasing the divisor value for **ACLKEXTDIVSLV** or **ACLKDIV** increases the frequency of **PLLFIXEDCLK** rather than lowering the frequency of **ACLKEXT**.

The frequency of **PLLFIXEDCLK** is therefore:

$$\mathbf{PLLREFCLK} * (\mathbf{ACLKEXTDIVSLV} \text{ divisor}) * (\mathbf{ACLKDIV} \text{ divisor})$$

If a high clock rate is used for **PLLREFCLK** and high divisor values are loaded into **ACLKEXTDIVSLV** and **ACLKDIV**, the resulting high core clock speed might cause unreliable operation.

If **CFGPLLBYPASS** is **HIGH**, the **PLLFIXED** oscillator is bypassed and:

- **PLLFIXEDCLK** is equal to the **PLLREFCLK** input frequency
- the **ACLK** frequency is **PLLREFCLK** divided by the **ACLKDIV** divisor
- the **ACLKEXT** frequency is **ACLK** divided by the **ACLKEXTDIVSLV** divisor.

The clock dividers for the AXI subsystem and memory controllers are:

ACLKDIV This block generates the **ACLK** that provides the clocks and enables for the internal AXI subsystem. The frequency of **ACLK** is:

- **PLLFIXEDCLK** / 2 if **CFGAXIRATIO** = 0
- **PLLFIXEDCLK** / 4 if **CFGAXIRATIO** = 1.

ACLKX2DIV

This block generates the double-rate **ACLKX2** clock required for the PL340 dynamic memory controller. The frequency of **ACLKX2** is:

- **PLLFIXEDCLK** if **CFGAXIRATIO** = 0
- **PLLFIXEDCLK** / 2 if **CFGAXIRATIO** = 1.

The PL340 divides this clock by two internally to regenerate a local AXI clock. Both **ACLKX2DIV** and **ACLKDIV** are controlled by the **CFGAXIRATIO** input so the DMC controller clock is always twice **ACLK**.

APBDIV The APB divide ratio is fixed. The APB **PCLK** frequency is always **ACLK**/2.

ACLKEXTDIVSLV

Generates the **ACLKEXT** clock for the off-chip AXI slave port. It also generates the PLL feedback clock that de-skews the system clock and enables the AXI slave ports to operate synchronously with off-chip devices.

ACLKEXT = **ACLK** / (ACLKEXTDIVSLV divisor)

but since **ACLKEXT** is always equal to **PLLREFCLK**,

ACLK = **PLLREFCLK** * (ACLKEXTDIVSLV divisor)

Table 3-7 ACLKEXTDIVSLV divisor values

CFGAXIEXTRATIOSLV[2:0] input	b000	b001	b010	b011	b100	b101	b110	b111
ACLKEXTDIVSLV divisor	1	2	3	4	5	6	7	8

ACLKEXTDIVSMSTR

Generates the clock and enable for the off-chip AXI master port.

$ACLK_MST = ACLK / (ACLKEXTDIVMSTR \text{ divisor})$

Table 3-8 ACLKEXTDIVMSTR divisor values

CFGAXIEXTRATIOMSTR[2:0] input	b000	b001	b010	b011	b100	b101	b110	b111
ACLKEXTDIVMSTR divisor	1	2	3	4	5	6	7	8

Caution

The same divisor must be used for both ACLKEXTDIVMSTR and ACLKEXTDIVSLV.

The external slave and master buses must operate at the same frequency. If different values are used for the divisors, the system will not function until the baseboard is power cycled and the default divisors are reloaded.

SMCCLKDIV

This block generates the AXI clock for the SMC PL093. The frequency of SMCCLK is:

- ACLK if CFGSMCAXIRATIO = 0
- ACLK / 2 if CFGSMCAXIRATIO = 1.

SMCMEMCLKDIV

This block generates the external memory clock for the SMC PL093:

$SMCMEMCLK = ACLK / (SMCMEMCLKDIV \text{ divisor})$

Table 3-9 SMCMEMCLKDIV divisor values

CFGSMCMEMRATIO[1:0] input	b00	b01	b10
SMCMEMCLKDIV divisor	1	2	3

Default clock divider settings

The default configuration options are:

- PLLREFCLK is 35MHz
(This the default frequency for OSCCLK[3], see ICS307 programmable clock generators on page 3-48 and Oscillator registers, SYS_OSCx on page 4-42.)
- ACLKEXTDIVSLV divisor is 3
(See Configuration registers SYS_CFGDATAx on page 4-45f or more information on system configuration options and defaults.)

- **ACLKDIV** divisor is 2
(**ACLKX2DIV** is automatically set to 1 it shares the **CFGAXIRATIO** signal.)
- **ACLKEXTDIVSMSTR** divisor is 3
- **SMCCLKDIV** divisor is 1
- **SMCMEMCLKDIV** divisor is 3.

The default configuration results in the following frequencies:

- **ACLKEXT**=35MHz
(The slave clock frequency is always equal to the frequency of **PLLREFCLK**.)
- **PLLFIXEDCLK**=210MHz which is $3 * 2 * 35\text{MHz}$
(For normal operation, the clock control selects **PLLFIXEDCLK** as **CORECLK** so this is the frequency of the ARM1176JZF-S core.)
- **ACLK**=105MHz which is **PLLFIXEDCLK** / 2
- **ACLKX2**=210MHz
(**ACLKX2** is always two times **ACLK**, but the signal is divided by two inside the DMC to provide an internal AXI reference clock.)
- **ACLK_MST**=35MHz which is **ACLK** / 3
(This is the frequency of the external AXI master.)
- **SMCCLK**=105MHz which is **ACLK** / 1
- **SMCMEMCLK**=35MHz which is **ACLK** / 3
(This is buffered and provides **SMCLK[5:0]** to the external static memory.)
- **PCLK**=52.5MHz which is **ACLK** / 2 (this is a fixed-ratio divider).

Development chip Dynamic Clock Generator

The DCG generates all clocks, resets, power and clamp signals, and sequencing for the chip. You can use it for IEM or for performance measurements. The DCG consists of three PLLs as shown in Figure 3-12 on page 3-43. One PLL has a fixed frequency at reset, and the other two are variable. The fixed PLL clocks the processor at the 100% performance level, and the variable PLLs are used for all sub 100% performance levels. The fixed PLL is also used for the AXI, APB, and other fixed system clocks.

Two variable PLLs are required to enable the most efficient method of switching between two sub-100% performance levels. For example, if the performance level is currently set at 95%, the system runs on one of the variable PLLs. A request is then

issued to drop to 90%. If there was only one variable PLL, it must be reconfigured to provide the 90% clock. The system must therefore switch to the fixed PLL while waiting for the variable PLL to lock at the new 90% performance frequency. However, the current voltage might not be sufficient to support the fixed PLL 100% performance frequency. Therefore using two variable PLLs allows the system to run at the current performance on one PLL, while the other PLL locks to the new performance level.

The DCG operates in open loop mode and uses fixed supply voltages based on a pre-defined voltage table programmed in the APC1 Open-loop VDD Core Registers.

———— **Note** ————

The DCG IP block typically has both open loop and closed loop operating modes, but only the open loop mode is implemented in the development chip.

The DCG can operate with or without Performance Requirement Optimization. If Performance Requirement Optimization is enabled, the current voltage from the DVC, IECCRNTDVCIDX, and IEC configuration mapping IECCFGDVCIDXMAP, determine if the target frequency on IECTGTDCGIDX can be achieved at the current voltage. If the performance level is achievable, the PLL controller can immediately prepare the PLLs and switch when ready. If the required voltage is not available for the target frequency, the PLL controller switches to the highest available frequency for the current voltage. However, if the current frequency is at the maximum for the current voltage, the PLL controller prepares to switch to the maximum frequency for the next voltage step. This enables maximum performance to be achieved as the voltage level rises.

When switching to a lower performance level, the DCG can switch to the lower performance clock as soon as the PLL is ready. If a new performance target is issued by the IEC before the current target has successfully completed, the new target always overrides the current target.

3.8.3 ICS307 programmable clock generators

Five programmable (6–200 MHz) clocks are supplied to the FPGA by the programmable MicroClock ICS307 clock generators (OSC0–OSC4):

OSCCLK0 This is the reference clock for the CLCDC.

OSC0 uses a 24MHz crystal as its reference. A fixed-frequency 24MHz signal, **REFCLK24MHZ**, is output from OSC0 and used as a reference signal for:

- The input for programmable oscillators OSC1–OSC4.
- the Ethernet controller clock (the Ethernet serial data clock is generated from a 25MHz crystal on the Ethernet controller).

- the USB controller clock
- the USB debug controller clock
- the external peripheral clocks for the SCI, UART, and SSP in the ARM1176JZF-S development chip.
- the input to divide-by-24 logic in the FPGA that produces the 1MHz reference clock for the timers.

OSCCLK1 This is the reference for the ARM1176JZF-S development chip **PLLREFCLK1**. (This clock can be selected by the IEM system to reduce power consumption.)

OSCCLK2 This is the reference for the ARM1176JZF-S development chip **PLLREFCLK2**. (This clock can be selected by the IEM system to reduce power consumption.)

OSCCLK3 This is the reference for the ARM1176JZF-S development chip **PLLREFCLK**. This is the master reference clock used to generate the AXI clocks, APB clock, and the memory controller clocks. (If operating in 100% power mode with IEM off, this is also the reference for the core clock PLL.)

OSCCLK4 This is the reference to the FPGA. (It is not used in the reference implementation.)

The output frequencies of the ICS307s are controlled by divider values loaded into the serial data input pins on the oscillators. The divider values are defined by the SYS_OSCx and SYS_OSCRESETx registers. The data stream and register format is shown in Figure 3-13. See *Oscillator registers*, *SYS_OSCx* on page 4-42 for details on the clock control registers.

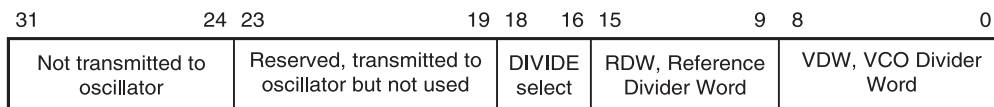


Figure 3-13 Serial data and SYS_OSCx register format

Note

Bit 23 is loaded into the shift register first and bit 0 is loaded last. Data is clocked into the **ICS307DATA** pins of the oscillators on the rising edge of **ICS307CLK**. One of the **ICS307STRB[4:0]** signals is pulsed HIGH to latch the serial data into the divider control register.

You can calculate the oscillator output frequency from the formula:

$$\text{CLKx} = \frac{48 * (\text{VDW} + 8)}{(\text{RDW} + 2) * \text{DIVIDE}} \quad \text{MHz}$$

where:

- VDW** Is the VCO divider word (4 – 511) from SYS_OSCx[8:0]
RDW Is the reference divider word (1 – 127) from SYS_OSCx[15:9]
DIVIDE Is the divide ratio (2 to 10) selected from SYS_OSCx[18:16]:
- b000 selects divide by 10
 - b001 selects divide by 2
 - b010 selects divide by 8
 - b011 selects divide by 4
 - b100 selects divide by 5
 - b101 selects divide by 7
 - b110 selects divide by 3
 - b111 selects divide by 6.

For more information on the ICS clock generator and a frequency calculator, see the ICS web site at www.icst.com. For details of the clock control registers, see *FPGA status and system control registers* on page 4-37.

3.9 Test, configuration, and debug interfaces

The following test and configuration interfaces are located on the PB1176JZF-S:

- JTAG, see *JTAG debug port and USB config port support*
- Logic analyzer, see *Integrated logic analyzer* on page 3-57
- Trace, see *Embedded trace support* on page 3-58
- Configuration switches and status indicators, see *Configuration control* on page 3-13 and *User switches and LEDs* on page 3-26
- Boot Monitor, see Appendix F *Boot Monitor and platform library*.

Note

There are also test points and debug connectors for individual interface circuits. See *Test and debug connections* on page A-16.

3.9.1 JTAG debug port and USB config port support

The PB1176JZF-S supports debugging using embedded or external hardware. The debugging interface can be controlled by:

JTAG hardware

The RealView Debugger for example, use an external interface box, such as RealView ICE to connect to the JTAG connector. If you are using an external JTAG debug tool, the USB config port is disabled.

USB config port

The USB config port is embedded on the PB1176JZF-S and can be used for loading FPGA or PLD images. It cannot, however, be used to debug applications running in the processor core. The PC and the PB1176JZF-S are connected by a standard USB cable.

Note

With reference to the ground pin 20 of the JTAG connector. On the PB1176JZF-S, pin 20 connects to a pull-up resistor and the **nICEDETECT** signal. The USB config port is automatically disabled if a JTAG emulator is connected and **nICEDETECT** is LOW. If you are using third-party debugging hardware, ensure that a ground is present on pin 20 of the JTAG connector.

The PB1176JZF-S has two scan chains:

Debug The **D_x** signals are used for the development chip and synthesized JTAG TAP controllers in the RealView Logic Tile. This is the normal mode of operation (see *JTAG debug (normal) mode* on page 3-53).

Config The **C_x** signals are used to program the FPGA and PLDs. This chain is available in configuration mode (see *JTAG configuration mode* on page 3-54). See also *Integrated logic analyzer* on page 3-57.

The JTAG data paths for debug mode is shown in Figure 3-16 on page 3-53. If the *Integrated Logic Analyzer (ILA)* is used (see Figure 3-15), it is possible to use the configuration chain at the same time as the JTAG device is used for application debugging.

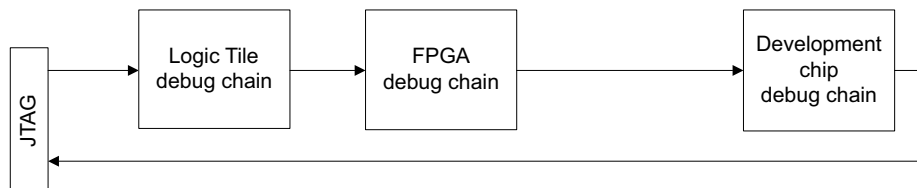


Figure 3-14 JTAG data paths in debug mode

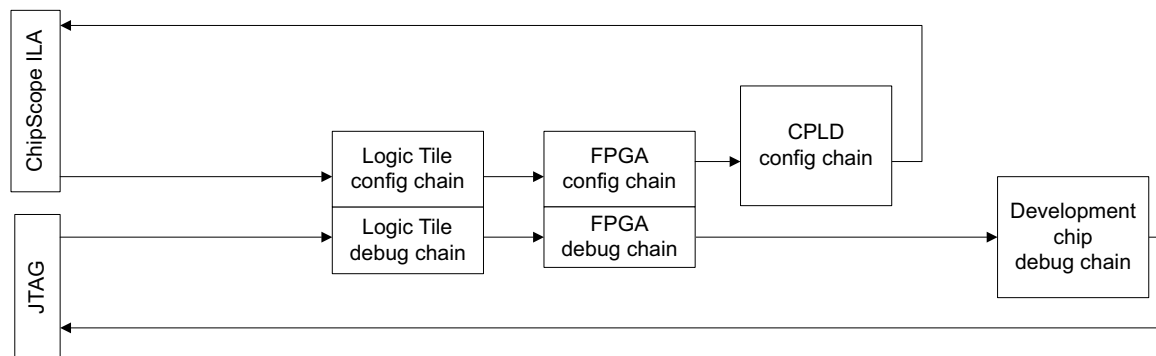


Figure 3-15 JTAG data paths in debug mode with ILA

The JTAG data paths for configuration modes is shown in Figure 3-16 on page 3-53. You can use the Progcards utility to configure the FPGA image from the USB debug connector. If the JTAG port is in use, however, the USB debug interface is disabled.

Note

You can use the ILA to debug a user design in the Logic Tile, using chipscope or other FPGA debug tools.

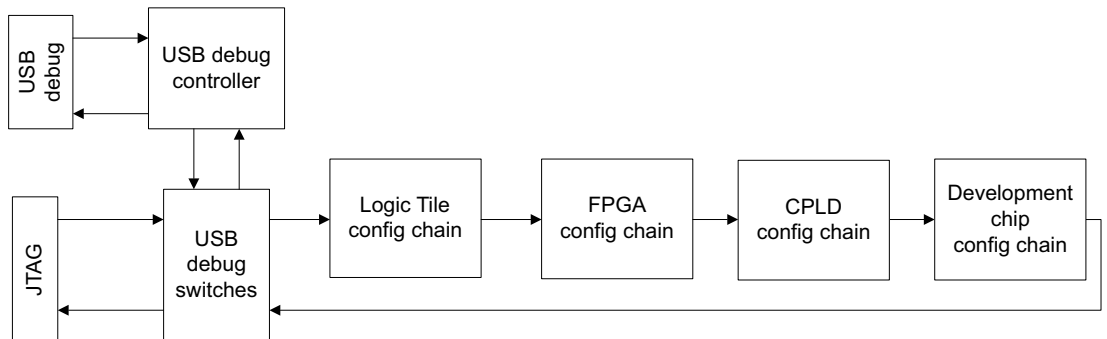


Figure 3-16 JTAG data paths in config mode

JTAG debug (normal) mode

During normal operation and software development, the PB1176JZF-S operates in debug mode. (The CONFIG switch is in the default OFF position, see *Connecting JTAG, Trace, and configuration equipment* on page 2-10.) In debug mode:

- The signal **nCFGEN** to the Logic Tile connector is HIGH
- The CONFIG LED is off on the PB1176JZF-S (and on each tile in the stack)
- The JTAG signals are routed through the ARM1176JZF-S development chip
- The JTAG scan path is rerouted sequentially to:
 - Logic Tile debug scan chain (**D_x** signals) if a tile is connected
 - FPGA debug scan chain (**D_x** signals)
 - ARM1176JZF-S debug unit scan chain.
- A debugger, RealView Debugger for example, controls the scan chain
- The FPGAs are not visible on the scan chain unless they contain debuggable devices. If an ILA is used, the FPGA can be configured at the same time as the JTAG debugger is used with the ARM cores.
- If RealView Logic Tiles are present and have debuggable devices, the **D_x** signals are part of their JTAG scan chain.
- The FPGAs in the system load their images from configuration flash.

JTAG configuration mode

This mode is selected if the CONFIG switch is ON. (See *Connecting JTAG, Trace, and configuration equipment* on page 2-10.) In configuration mode:

- The signal **nCFGEN** to the Logic Tile connector is LOW.
- The CONFIG LED is lit on the PB1176JZF-S (and on each tile in the stack).
- The JTAG scan path is rerouted sequentially to:
 - Logic Tile configuration scan chain (**C_x** signals) if a tile is connected
 - FPGA configuration scan chain (**C_x** signals)
 - Configuration CPLD scan chain
 - ARM1176JZF-S test chip boundary scan chain.
- A configuration utility, ProgCards for example, controls the scan chain.
- If RealView Logic Tiles are present, the **C_x** signals are part of the JTAG scan chain.
- All FPGAs and PLDs in the system (including any devices in a RealView Logic Tile if present) are added into the scan chain.
- The TAP controller in the ARM1176JZF-S development chip is not visible and is replaced by a Boundary Scan TAP controller that is used for board-level production testing.
- This enables the board to be configured or upgraded in the field using JTAG equipment or the onboard USB config port.
- The nonvolatile PLDs devices can be reprogrammed directly by JTAG.
- FPGA images can be loaded from the scan chain.

The FPGAs are volatile. In normal mode, they load their configuration from nonvolatile flash memory. In configuration mode, they can be loaded from either JTAG or the configuration flash memory.

————— Note —————

The configuration flash memory does not have a JTAG port, but it can be programmed using JTAG by loading a flash-loader design into the FPGAs and PLDs. The flash-loader can then transfer data from the JTAG programming utility to the configuration flash.

Caution

Third party JTAG debug equipment may not support this method of programming configuration flash, where possible, you must use ARM RealView ICE or the USB config port.

After configuration you must:

1. switch OFF the CONFIG switch
2. power cycle the development system.

JTAG signals

Table 3-10 provides a description of the JTAG and related signals.

Note

In the description in Table 3-10, the term JTAG equipment refers to any hardware that can drive the JTAG signals to devices in the scan chain. Typically this is RealView ICE, or the embedded USB debug logic.

Table 3-10 JTAG related signals

Name	Description	Function
TDI	Test data in (from JTAG equipment)	TDI and TDO connect each component in the scan chain.
TDO	Test data out (to JTAG equipment)	TDO is the return path of the data input signal TDI . The JTAG components are connected in the return path so that the length of track driven by the last component in the chain is kept as short as possible.
TMS	Test mode select (from JTAG equipment)	TMS controls transitions in the TAP controller state machine.
TCK	Test clock (from JTAG equipment)	TCK synchronizes all JTAG transactions. TCK connects to all JTAG components in the scan chain. Series termination resistors are used to reduce reflections and maintain good signal integrity.

Table 3-10 JTAG related signals (continued)

Name	Description	Function
RTCK	Return TCK (to JTAG equipment)	Some devices sample TCK and delay the time at which a component actually captures data. Using a mechanism called <i>adaptive clocking</i> , the RTCK signal is returned by the core to the JTAG equipment, and the TCK is not advanced until the core has captured the data. In adaptive clocking mode, RealView ICE waits for an edge on RTCK before changing TCK . In a multiple device JTAG chain, the RTCK output from a component connects to the TCK input of the next device in the chain.
nCFGEN	Configuration enable	nCFGEN is an active LOW signal used to put the boards into configuration mode. In configuration mode all FPGAs and PLDs are connected to the scan chain so that they can be configured by the JTAG equipment. (The TAP controller in the PB1176JZF-S is not accessible.)
nSRST	System reset (bidirectional)	nSRST is an active LOW open-collector signal that can be driven by the JTAG equipment to reset the target board. Some JTAG equipment senses this line to determine when a board has been reset by the engineer. This is also used in configuration mode to control the initialization pin (nINIT) on the FPGAs. Though not a JTAG signal, nSRST is described because it can be controlled by JTAG equipment.
nTRST	Test reset (from JTAG equipment)	This active LOW open-collector signal resets the JTAG port and the associated debug circuitry on the ARM1176JZF-S development chip. It is asserted at power-up, and can be driven by the JTAG equipment. This signal is also used in configuration mode to control the programming pin, nPROG , on FPGAs.
DBGRRQ	Debug request (from JTAG equipment)	DBGRRQ is a request for the processor core to enter the debug state. It is provided for compatibility with third-party JTAG equipment.

Table 3-10 JTAG related signals (continued)

Name	Description	Function
DBGACK	Debug acknowledge (to JTAG equipment)	DBGACK indicates to the debugger that the processor core has entered debug mode. It is provided for compatibility with third-party JTAG equipment.
GLOBAL_DONE	FPGA configured	GLOBAL_DONE is an open-collector signal that indicates when FPGA configuration is complete. Although this signal is not a JTAG signal, it does affect nSRST . The GLOBAL_DONE signal is routed between all RealView boards.
nRTCKEN	Return TCK enable	nRTCKEN is an active LOW signal driven by any tile that requires RTCK to be routed back to the JTAG equipment. If nRTCKEN is HIGH, the baseboard drives RTCK LOW. If nRTCKEN is LOW, the baseboard drives the TCK signal back to the JTAG equipment.

The JTAG path chosen depends on whether the system is in configuration mode or debug mode. The CONFIG link controls the **nCFGEN** signal that is routed through the PB1176JZF-S and tile connectors.

3.9.2 Integrated logic analyzer

The ILA connector (J11) enables you to connect a ChipScope compatible analyzer to the configuration scan chain while a JTAG debugger connects to the debug scan chain. This enables you to debug the FPGAs on stacked tiles while examining code on the CPU.

Note

In debug mode:

- the ILA connector is enabled
- the FPGA on the baseboard is excluded from the configuration scan chain.

In configuration mode:

- the ILA connector is disabled
- the FPGA on the baseboard is included in the configuration scan chain.

For more details on the integrated logic analyzer, see the ChipScope details on the Xilinx website (www.xilinx.com).

3.9.3 Embedded trace support

The ARM1176JZF-S development chip incorporates an *ARM11 Embedded Trace Macrocell* (ETM11). This enables you to carry out real-time debugging by connecting external trace equipment to the Trace connectors on the PB1176JZF-S. To trace program flow, the ETM broadcasts branch addresses, data accesses, and status information through the trace port. Later in the debug process, the complete instruction flow can be reconstructed by the RealView Debugger.

———— **Note** —————

Connection of the trace port analyzer is described in *Connecting the Trace Port Analyzer* on page 2-13.

A trace connector is also provided for the Logic Tile. Use the Logic Tile trace connector to either:

- monitor trace activity in a processor implemented in the Logic Tile FPGA
- monitor signal activity on the header connector.

Chapter 4

Programmer's Reference

This chapter describes the memory map and the configuration registers for the peripherals in the ARM1176JZF-S development chip. It contains the following sections:

- *Memory map* on page 4-3
- *ARM1176JZF-S development chip system controller* on page 4-12
- *Advanced Power Controller and Power Management Interface* on page 4-22
- *Advanced Audio CODEC Interface, AACI* on page 4-27
- *Character LCD display* on page 4-29
- *Color LCD Controller, CLCDC* on page 4-32
- *Dynamic Memory Controller, DMC* on page 4-34
- *Ethernet* on page 4-36
- *FPGA status and system control registers* on page 4-37
- *General Purpose Input/Output, GPIO* on page 4-57
- *Interrupt controllers in the ARM1176JZF-S development chip* on page 4-58
- *Interrupt controllers in the FPGA* on page 4-74
- *Level 2 Cache Controller* on page 4-106
- *Keyboard and Mouse Interface, KMI* on page 4-107
- *MultiMedia Card Interfaces, MCI* on page 4-108

- *PCI controller* on page 4-109
- *Real Time Clock, RTC* on page 4-120
- *Serial bus interface* on page 4-121
- *Smart Card Interface, SCI* on page 4-123
- *Synchronous Serial Port, SSP* on page 4-124
- *Synchronous Static Memory Controller, SSMC* on page 4-126
- *System Controller* on page 4-130
- *Timers* on page 4-131
- *TrustZone Protection Controller* on page 4-132
- *USB interface* on page 4-142
- *UART* on page 4-140
- *Watchdog* on page 4-143.

For detailed information on the programming interface for ARM PrimeCell peripherals and controllers, see the appropriate technical reference manual. For the interrupt signals and release versions of ARM IP, see the section of this chapter that describes the peripheral.

4.1 Memory map

The locations for memory, peripherals, and controllers are listed in Table 4-1 on page 4-4 and Figure 4-1 on page 4-11.

There are multiple buses in the ARM1176JZF-S development chip. Not all of the buses can access all of the memory regions.

Note

The VFP coprocessors is not memory-mapped peripherals so it does not appear in the memory map listed in Table 4-1 on page 4-4. See the appropriate technical reference manual for more details.

See *FPGA status and system control registers* on page 4-37 and *Boot Select Register, SYS_BOOTCS* on page 4-51 for details on configuration operations that can be performed after the system has started. See also *Configuration control* on page 3-13 and *Configuration registers SYS_CFGDATAx* on page 4-45 for a description of how the development chip is configured at reset.

On reset, the ARM1176JZF-S development chip begins executing code at address 0x0. This address is normally volatile SDRAM. Remapping enables non-volatile static memory to be decoded for accesses to low memory.

Configuration switch S1 modifies the memory map of static memory at reset. See *Boot memory selection* on page 2-4.

Note

There are two GIC interrupt controllers in the FPGA and a GIC and TrustZone interrupt controller in the development chip. Unless otherwise specified, the interrupt numbers in Table 4-1 on page 4-4 refer to inputs to the GICS in the FPGA. For more information on the interrupt signals, see *Interrupt controllers in the ARM1176JZF-S development chip* on page 4-58.

Table 4-1 Memory map

Peripheral	Location	Interrupt ^a	Address	Size
Dynamic memory controller chip select 0 —— Note —— This is an alias of the memory at 0x08000000-0x0BFFFFFF.	Dev. chip	-	0x00000000– 0x03FFFFFF	64MB
Dynamic memory controller chip select 1 —— Note —— This is an alias of the memory at 0x0C000000-0x0FFFFFFF.	Dev. chip	-	0x04000000– 0x07FFFFFF	64MB
Dynamic memory controller chip select 2	Dev. chip	-	0x08000000– 0x0BFFFFFF	64MB
Dynamic memory controller chip select 3	Dev. chip	-	0x0C000000– 0x0FFFFFFF	64MB
System registers	FPGA APB	-	0x10000000– 0x10000FFF	4KB
System controller	FPGA APB	-	0x10001000– 0x10001FFF	4KB
Reserved (I2C serial bus control)	-	-	0x10002000– 0x10002FFF	4KB
FPGA TrustZone Protection Controller	FPGA APB	-	0x10003000– 0x10003FFF	4KB
Advanced Audio CODEC Interface	FPGA	-	0x10004000– 0x10004FFF	4KB
MCI	FPGA	33	0x10005000– 0x10005FFF	4KB
Keyboard/Mouse Interface 0	FPGA	35	0x10006000– 0x10006FFF	4KB
Keyboard/Mouse Interface 1	FPGA	36	0x10007000– 0x10007FFF	4KB
Character LCD Interface	FPGA	39	0x10008000– 0x10008FFF	4KB

Table 4-1 Memory map (continued)

Peripheral	Location	Interrupt^a	Address	Size
UART 4	FPGA	38	0x10009000– 0x10009FFF	4KB
Reserved for future use	-	-	0x1000A000– 0x1000DFFF	16KB
Smart Card Interface	FPGA	37	0x1000E000– 0x1000EFFF	4KB
Serial Bus Interface	FPGA	-	0x1000F000– 0x1000FFFF	4KB
Reserved	-	-	0x10010000– 0x10010FFF	4KB
Reserved (FPGA timers 0 and 1)	-	-	0x10011000– 0x10011FFF	4KB
Reserved (FPGA timers 2 and 3)	-	-	0x10012000– 0x10012FFF	4KB
Reserved	-	-	0x10013000– 0x10013FFF	4KB
FPGA GPIO 1	FPGA	40	0x10014000– 0x10014FFF	4KB
Reserved (FPGA GPIO 2)	FPGA	41	0x10015000– 0x10015FFF	4KB
Reserved	-	-	0x10016000– 0x10016FFF	4KB
Real Time Clock	FPGA	57	0x10017000– 0x10017FFF	4KB
Reserved	-	-	0x10018000– 0x10018FFF	4KB
PCI controller configuration registers	FPGA	-	0x10019000– 0x10019FFF	4KB
Reserved	-	-	0x1001A000– 0x1001BFFF	8KB
Power Manager	FPGA	-	0x1001C000– 0x1001FFFF	16MB

Table 4-1 Memory map (continued)

Peripheral	Location	Interrupt ^a	Address	Size
Reserved	-	-	0x10020000– 0x1002FFFF	64KB
Reserved	-	-	0x10030000– 0x1003FFFF	64KB
Interrupt Controller (FPGA GIC0 nIRQ)	FPGA APB	Dev. chip 63 (TZ 31)	0x10040000– 0x1004FFFF	64KB
Interrupt Controller (FPGA GIC1 nFIQ)	FPGA APB	Dev. chip 62 (TZ 30)	0x10050000– 0x1005FFFF	64KB
Reserved	-	-	0x10060000– 0x100EFFFF	562KB
DAP ROM	FPGA	-	0x100F0000– 0x100FFFFF	64KB
Development Chip System Controller	Dev. chip APB	-	0x10100000– 0x10100FFF	4KB
Development Chip TrustZone Protection Controller	Dev. chip APB	-	0x10101000– 0x10101FFF	4KB
Development Chip APC	Dev. chip APB	-	0x10102000– 0x10102FFF	4KB
Development Chip IEC	Dev. chip APB	-	0x10103000– 0x10103FFF	4KB
<p>———— Note —————</p> <p>See also <i>DCG Index Mapping Registers</i> on page 4-18 to <i>Processor Frequency Configuration Register</i> on page 4-18.</p>				
Timers 0 and 1	Dev. chip APB	Dev. chip 40 (TZ 8)	0x10104000– 0x10104FFF	4KB
Timers 2 and 3	Dev. chip APB	Dev. chip 41 (TZ 9)	0x10105000– 0x10105FFF	4KB
Timers 4 and 5	Dev. chip APB	Dev. chip 42 (TZ 19)	0x10106000– 0x10106FFF	4KB
Watchdog	Dev. chip APB	Dev. chip 32 (TZ 0)	0x10107000– 0x10107FFF	4KB

Table 4-1 Memory map (continued)

Peripheral	Location	Interrupt ^a	Address	Size
Real Time Clock	Dev. chip APB	Dev. chip 46 (TZ 14)	0x10108000–0x10108FFF	4KB
DMC configuration registers	Dev. chip APB	-	0x10109000–0x10109FFF	4KB
Development chip GPIO 0	Dev. chip APB	Dev. chip 48 (TZ 16)	0x1010A000–0x1010AFFF	4KB
SSP Interface	Dev. chip APB	Dev. chip 49 (TZ 17)	0x1010B000–0x1010BFFF	4KB
UART 0 Interface	Dev. chip APB	Dev. chip 50 (TZ 18)	0x1010C000–0x1010CFFF	4KB
UART 1 Interface	Dev. chip APB	Dev. chip 51 (TZ 19)	0x1010D000–0x1010DFFF	4KB
UART 2 Interface	Dev. chip APB	Dev. chip 52 (TZ 20)	0x1010E000–0x1010EFFF	4KB
UART 3 Interface	Dev. chip APB	Dev. chip 53 (TZ 21)	0x1010F000–0x1010FFFF	4KB
Level 2 Cache Controller configuration registers	Dev. chip	Dev. chip 45 (TZ 13)	0x10110000–0x10110FFF	4KB
Static Memory Controller configuration registers	Dev. chip	-	0x10111000–0x10111FFF	4KB
CLCD configuration registers	Dev. chip	Dev. chip 47 (TZ 15)	0x10112000–0x10112FFF	4KB
Reserved	-	-	0x10113000–0x1011EFFF	48KB
TZIC	Dev. chip	Dev. chip nFIQ	0x1011F000–0x1011FFFF	4KB
GIC CPU interface	Dev. chip	Dev. chip nIRQ	0x10120000–0x10120FFF	4KB
GIC distributor	Dev. chip	-	0x10121000–0x10121FFF	4KB
Reserved	Dev. chip	-	0x10122000–0x1012FFFF	56KB

Table 4-1 Memory map (continued)

Peripheral	Location	Interrupt ^a	Address	Size
CoreSight ROM Table	Dev. chip	-	0x10130000– 0x10130FFF	4KB
CoreSight ETB	Dev. chip	-	0x10131000– 0x10131FFF	4KB
CoreSight ETM11	Dev. chip	-	0x10132000– 0x10132FFF	4KB
CoreSight CTI0	Dev. chip	-	0x10133000– 0x10133FFF	4KB
CoreSight CTI1	Dev. chip	-	0x10134000– 0x10134FFF	4KB
CoreSight TPIU	Dev. chip	-	0x10135000– 0x10135FFF	4KB
Reserved	Dev. chip	-	0x10136000– 0x101FFFFF	79KB
RAM/ROM —— Note ——— 16KB on-SoC SRAM (NVRAM/Pseudo boot-ROM) —————	Dev. chip	-	0x10200000– 0x10203FFF	16KB
Reserved	-	-	0x10204000– 0x102FFFFFF	1MB
RAM (development chip) 512KB on-SoC SRAM (L3 RAM configurable secure region)	Dev. chip	-	0x10300000– 0x1037FFFF	512KB
Reserved	-	-	0x10380000– 0x1FFFFFFF	252MB
SSMC Chip Select 0/7 PISMO	Memory expansion	48	0x20000000– 0x23FFFFFF	64MB
SSMC Chip Select 1 PISMO	Memory expansion	48	0x24000000– 0x27FFFFFF	64MB

Table 4-1 Memory map (continued)

Peripheral	Location	Interrupt ^a	Address	Size
SSMC Chip Select 2 PISMO	Memory expansion	48	0x28000000–0x28FFFFFF	64MB
SSMC Chip Select 3 PISMO	Memory expansion	48	0x2C000000–0x2FFFFFFF	64MB
SSMC Chip Select 4 NOR flash 2	Board	-	0x30000000–0x33FFFFFF	64MB
SSMC Chip Select 5 Cellular RAM (8MB fitted)	Board	-	0x34000000–0x37FFFFFF	64MB
SSMC Chip Select 6 FPGA Configuration flash	Board	-	0x38000000–0x39FFFFFF	32MB
SSMC Chip Select 6 Ethernet	Board	32	0x3A000000–0x3AFFFFFF	16MB
SSMC Chip Select 6 USB	Board	33	0x3B000000–0x3BFFFFFF	16MB
SSMC Chip Select 7 Secure NOR flash 1	Board	-	0x3C000000–0x3FFFFFFF	64MB
Internal RAM and ROM Note 8KB FPGA AXI BOOTROM is available before the system has booted (hard-coded program in FPGA to setup system when no boot monitor present). 256KB FPGA SRAM is available after the system has booted.	FPGA	-	0x40000000–0x40001FFF or 0x40000000–0x4003FFFF	8KB or 256KB
Reserved (Static memory) Note The development chip has internal static memory at 0x10300000–0x1037FFFF and 0x40000000–0x4003FFFF. The SSMC addresses external static memory at 0x20000000–0x37FFFFFF.	-	-	0x40040000–0x5FFFFFFF	512MB

Table 4-1 Memory map (continued)

Peripheral	Location	Interrupt ^a	Address	Size
PCI interface	Expansion PCI bus	44 PCI0 45 PCI1 46 PCI2 47 PCI3	0x60000000– 0x6FFFFFFF	256MB
Reserved	-	-	0x70000000– 0x7FFFFFFF	256MB
RealView Logic Tile expansion (AXI master bus)	Board (RealView Logic Tile headers)	-	0x80000000– 0xFFFFFFFF	2GB
<div><div><div>Note</div></div><div>If a RealView Logic Tile is installed, accesses in this range must be decoded by the tile. This is the recommended address range for placing memory-mapped peripherals in a RealView Logic Tile.</div></div>				

a. Interrupt numbers refer to the FPGA GICs unless otherwise specified. For interrupts to the development chip, the corresponding interrupt to the TZIC is given in parentheses. Interrupt numbers 0–31 are reserved for processor use on all GICs.

Figure 4-1 shows the memory map. Configuration switch S7 modifies the memory map of static memory at reset. The memory map shown is with switches S7-1 and S7-2 set to OFF. (See *Boot memory selection* on page 2-4.)

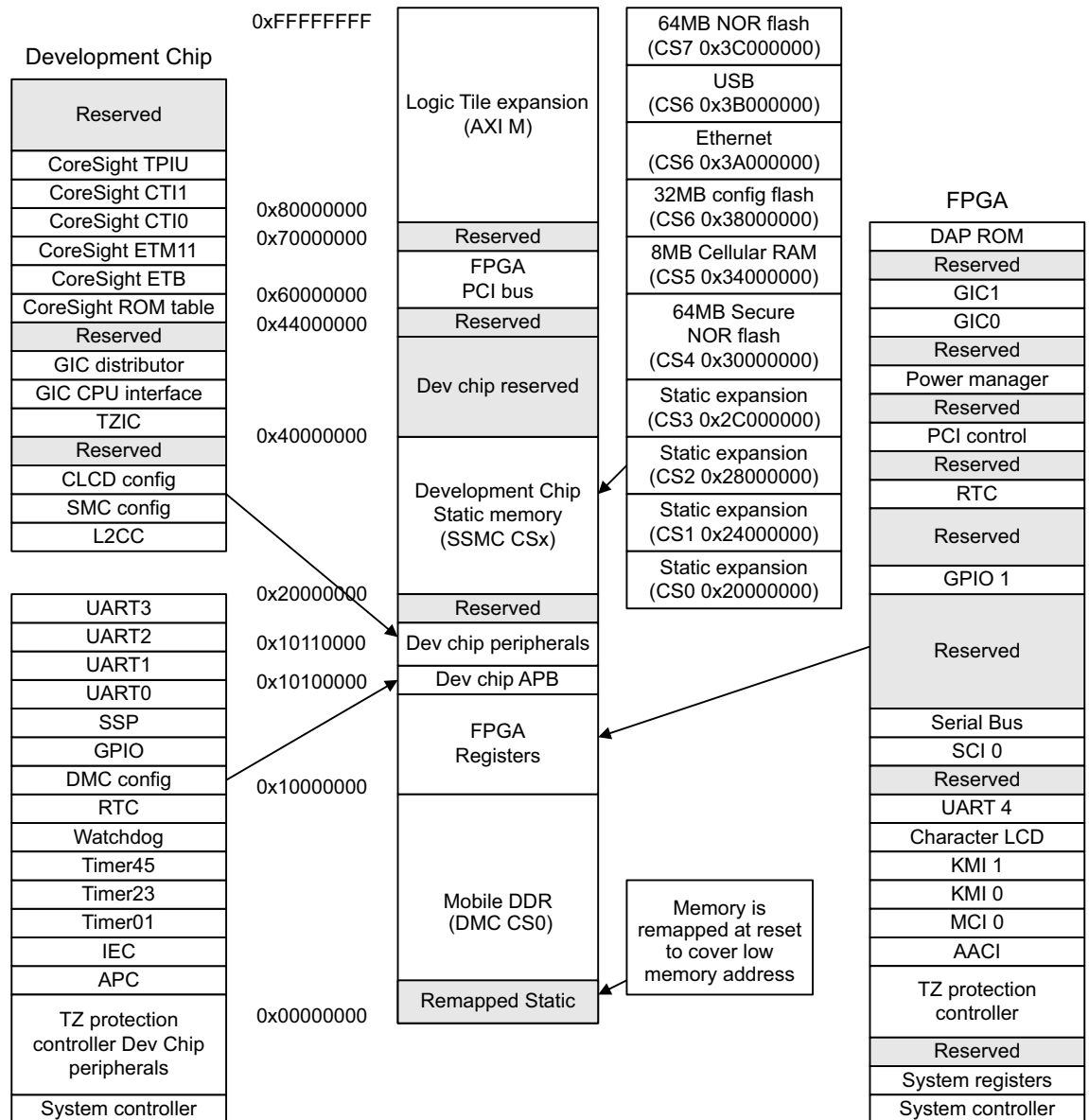


Figure 4-1 Memory map

4.2 ARM1176JZF-S development chip system controller

This section describes the system controller registers located in the development chip. The registers are reset by power-on or by pressing the reset pushbutton.

Table 4-2 Development chip system controller registers

Register	Address	Access	Reset	Description
CoreID	0x10100000	Read only	Variable	Core identification register (the lower four bits are set by the values on the configuration pins)
SoCConfig1	0x10100004	Read/Write	Variable	SoC configuration register (set by values present on the configuration input pins when the chip is reconfigured)
SoCConfig2	0x10100008	Read only	Variable	SoC configuration register (set by values present on the configuration input pins when the chip is reconfigured)
SysControl	0x1010000C	Read/Write	Variable	System controller control register
SysStatus	0x10100010	Read only	Variable	System status register
DCGIDXMAP0	0x10100014	Read/Write	0x00924924	IEC configuration index mapping configuration level 1-8
DCGIDXMAP1	0x10100018	Read/Write	0x00924924	IEC configuration index mapping configuration level 9-16
DCGIDXMAP2	0x1010001C	Read/Write	0x00DADB6D	IEC configuration index mapping configuration level 17-24
DCGIDXMAP3	0x10100020	Read/Write	0x00FFFFB6	IEC configuration index mapping configuration level 25-32
DCGPERFMAP0	0x10100024	Read/Write	0x00000000	Performance level mapping index 1-4
DCGPERFMAP1	0x10100028	Read/Write	0x806A5640	Performance level mapping index 5-8
DVCIDXMAP	0x1010002C	Read/Write	0xFAC688	IEC configuration DVC index map levels 1-8
CFGFREQCPU	0x10100030	Read/Write	0x0004E200	Maximum CPU clock speed, 320MHz
CFGFREQDPM	0x10100034	Read/Write	0x00001D4C	DPM frequency
PLLCFGPERF1	0x10100038	Read/Write	0x00000000	PLL configuration setting for performance level 1
PLLCFGPERF2	0x1010003C	Read/Write	0x00000000	PLL configuration setting for performance level 2

Table 4-2 Development chip system controller registers (continued)

Register	Address	Access	Reset	Description
PLLCFGPERF3	0x10100040	Read/Write	0x00000000	PLL configuration setting for performance level 3.
PLLCFGPERF4	0x10100044	Read/Write	0x00000000	PLL configuration setting for performance level 4.
PLLCFGPERF5	0x10100048	Read/Write	0x00000294	PLL configuration setting for performance level 5. The default is 50% of maximum performance.
PLLCFGPERF6	0x1010004C	Read/Write	0x000002B0	PLL Configuration setting for performance level 6. The default is 67% of maximum performance.
PLLCFGPERF7	0x10100050	Read/Write	0x000002AD	PLL Configuration setting for performance level 7. The default is 81% of maximum performance.
DCGSTATUS	0x10100054	Read only	-	Current DCG system status.
AXIPRIORITY	0x10100060	Read/Write	0x00543210	64-bit AXI arbitration priority.
SMCEXTACMONID	0x10100064	Read/Write	0x812 ID0=010010 ID1=001000	SMC exclusive access monitor ID value.
DLLCalibrate	0x10100068	Read/Write	0x34	DLL update period, in mclk/32 increments.
SCPeriphID0	0x10100FE0	Read only	0x10	Peripheral ID part number LOW 8 bits.
SCPeriphID1	0x10100FE4	Read only	0x18	Peripheral ID part number HIGH 8 bits.
SCPeriphID2	0x10100FE8	Read only	0x04	Peripheral ID designer.
SCPeriphID3	0x10100FEC	Read only	0x00	Peripheral ID configuration.
SCPCellID0	0x10100FF0	Read only	0x0D	Standard PrimeCell ID coding.
SCPCellID1	0x10100FF4	Read only	0xF0	Standard PrimeCell ID coding.
SCPCellID2	0x10100FF8	Read only	0x05	Standard PrimeCell ID coding.
SCPCellID3	0x10100FFC	Read only	0xB1	Standard PrimeCell ID coding.

The following sections describe:

- *System Control register* on page 4-16
- *System Status register* on page 4-17

- *DCG Index Mapping Registers* on page 4-18
- *DCG Fractional Performance Level Mapping Registers* on page 4-18
- *DVC Index Level Mapping Registers* on page 4-18
- *Processor Frequency Configuration Register* on page 4-18
- *PLLCFGPERFx, PLL Configuration Settings Registers* on page 4-18
- *DCG System Status Register* on page 4-19
- *AXI Priority Register* on page 4-20
- *SMC Exclusive Access Monitor ID Register* on page 4-21
- *DLL Calibrate Register* on page 4-21.

4.2.1 SoCConfig1

The SoCConfig1 register (at 0x10100004) holds the values of the remap and PLL configuration signals that are captured at reset from the SoC pins.

Table 4-3 Configuration signals register

Bit	Configuration signal	Description
[31:9]	-	Undefined, SBZ
[8]	CFGCLKSTOPSBWFI	Selects whether the Clock is stopped to the L2CC and ETM during CPU STANDBYWFI State
[7]	CFGIEMSHUTDOWN	Selects the IEM subsystem to be powered down from reset
[6]	CFGIRQSOURCE	Selects the nIRQ, nFIQ source: 0 = external 1 = internal.
[5]	CFGPLLFIXEDDESKEW	Selects external clock feedback path for on chip clock deskew
[4]	CFGPLLFIXEDPLEN	PLL Enable
[3]	CFGPLLFIXEDBYPASSEN	Bypasses VCO
[2:0]	CFGPLLFIXEDN	PLL input divider

4.2.2 SoCConfig2

The SoCConfig2 register (at 0x10100008) holds the values of the PLL configuration signals that are captured at reset from the SoC pins.

Table 4-4 Configuration signals

Bit	Configuration signal	Description
[31:28]	CFGPLLFIXEDM	PLL feedback divider
[27]	CFGPLLFIXEDVCORANGE	Selects VCO range
[26]	CFGPLL2BYPASS	Bypass PLL input
[25]	CFGPLL1BYPASS	Bypass PLL input
[24]	CFGPLLBYPASS	Bypass PLL input
[23]	CFGPLLREFCLK1	Bypass PLL input
[22:21]	CFGSMMWCS7[1:0]	SMC bank 7 data width
[20:19]	CFGSMCMEMRATIO[1:0]	SMC AXI to external memory clock ratio
[18]	CFGSMCAXIRATIO	SMC AXI sync down clock ratio
[17:15]	CFGAXIEXTRATIOMSTR[2:0]	AXI external master clock ratio
[14:12]	CFGAXIEXTRATIOSLV[2:0]	AXI external slave clock ratio
[11]	CFGAXIRATIO	AXI: Core clock ratio
[10]	CFGCP15SDISABLE	TZ write access disable
[9]	CFGUBITINIT	ARMv6 unaligned behavior
[8]	CFGBIGENDINIT	ARMv5 big endian behavior
[7]	CFGVINITHI	High exception vector location
[6]	CFGINITRAM	ITCM at 0x0 for data and instructions at reset
[5:4]	CFGREMAP[1:0]	Defines boot memory map
[3:2]	REMAPSTATUSARM	ARM I and RW remap status
[1]	-	Undefined, SBZ
[0]	REMAPCLR	Remap clear

4.2.3 System Control register

The System Control register (at 0x1010000C) controls system power and performance settings.

Table 4-5 System Control register

Bit	Name	Description
[31:7]	SYSCONTROL	Undefined, SBZ
[6]	DAPMAXPERF	DAP maximum performance request.
[5]	DAPMAXPERFEN	DAP maximum performance request enable.
[4]	USERMAXPERF	Indicates that an external maximum performance request occurred. A rising edge on the SoC WAKEUP input sets this bit, and writing a zero clears it. You cannot set it.
[3]	USERMAXPERFEN	Bit set enables user maximum performance from WAKEUPinput, default. Bit clear disables user maximum performance from WAKEUP input.
[2]	DORMANTNXT	Bit set indicates that dormant mode is entered on next power down.
[1]	SHUTDOWN	Bit set indicates that shutdown mode is entered on next powerdown.
[0]	Closed Loop Enable	Bit set indicates IEM closed loop mode. Bit clear indicates IEMopen loop mode, default.

USERMAXPERF holds the IEM subsystem at maximum performance after a rising edge on the **WAKEUP** input. After a user maximum performance request, software can program a new IEC performance level before it clears USERMAXPERF. If a new IEC performance level is not programmed before USERMAXPERF is cleared, the IEC selects the previous performance level prior to **WAKEUP**.

———— **Note** ————

The *Intelligent Energy Management* (IEM) subsystem uses an *Advanced Power Controller* (APC) provided by a third-party. The APC requires a separate license for the controller and the documentation on the controller registers. Contact ARM for more information on licensing the APC component and obtaining the documentation required to use the APC with the IEM subsystem.

It is important that when returning from shutdown, dormant or standbyWFI power down modes, to write a greater than 0% performance level to the IEC before clearing USERMAXPERF. This is to prevent the IEC trying to re-enter 0% by asserting its sleep interrupt when USERMACPERF is cleared.

Note

To enable USERMAXPERF register bit [3], you must set USERMAXPERFEN HIGH. If re-enabled, USERMAXPERF is not asserted until a rising edge occurs on **WAKEUP**.

At reset, SHUTDOWNNXT = 0, and DORMANTNXT = 0. This indicates that STANDBYWFI is entered if 0% performance is requested.

Note

It is not possible to set both the SHUTDOWNNXT and DORMANTNXT bits. If you attempt to do this, both SHUTDOWNNXT and DORMANTNXT default to their reset values of 0.

4.2.4 System Status register

The System Status Register (at 0x10100010) generate software resets and returns status on debug and power modes.

Table 4-6 System Status register

Bit	Name	Description
[31:12]	-	Undefined, SBZ
[11]	LOCKED	Indicates that software reset request is locked when HIGH, write 0xA05FA05F to unlock
[10]	CSRST	CoreSight reset flag, warm reset
[9]	SOFRST	Software reset flag, warm reset
[8]	WDOGRST	Watchdog reset flag, warm reset
[7]	EXTRST	External reset
[6]	POR	Power-on reset flag
[5]	DORMANT	Dormant mode flag, indicates previous power down mode was dormant
[4]	SHUTDOWN	Shutdown mode flag, indicates previous power down mode was shutdown
[3]	SPIDEN	Secure privilege invasive debug enable

Table 4-6 System Status register (continued)

Bit	Name	Description
[2]	SPNIDEN	Secure privilege non-invasive debug enable
[1]	NIDEN	Non-invasive debug enable to ETM11
[0]	DBGGEN	Debug enable (IDEN)

To issue a software reset, you must first unlock the register by writing 0xA05FA05F. You can then issue a software reset request by writing 0x76543210.

The register is automatically locked when a software reset has been performed, or the incorrect software reset request value is written.

4.2.5 DCG Index Mapping Registers

Four 32-bit registers (at 0x10100014 to 0x10100020) specify the IEC DCG index mappings and are mapped to the IECCFGDCGIDXMAP configuration input.

4.2.6 DCG Fractional Performance Level Mapping Registers

Two 32-bit registers (at 0x10100024 and 0x10100028) specify the IEC fractional performance level mapping and are mapped to the IECCFGDCGPERFMAP configuration input.

4.2.7 DVC Index Level Mapping Registers

The 24-bit DVCIDXMAP register (at 0x1010002C) is directly mapped to the IECCFGDVCIDXMAP configuration input on the IEC.

4.2.8 Processor Frequency Configuration Register

The 24-bit CFGFREQCPU register (at 0x10100030) is directly mapped to the IECCFGFRQCPU configuration input on the IEC.

4.2.9 PLLCFGPERFx, PLL Configuration Settings Registers

The system controller contains seven PLL configuration registers (at 0x10100038 to 0x10100050) to define the PLL configuration settings for performance levels 1-7.

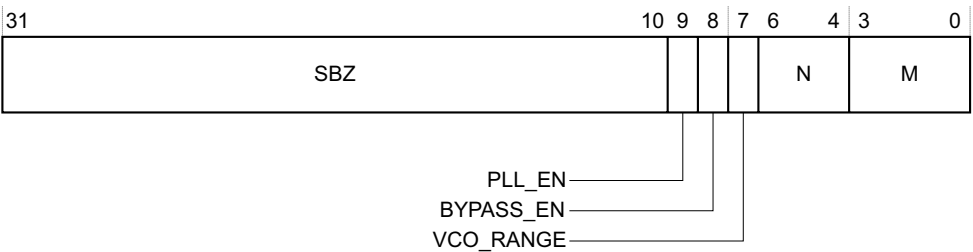


Figure 4-2 PLLCFGPERFx registers

The formula for the PLL frequency is: $F_{out} = F_{ref} * (M / N)$

Table 4-7 PLL Configuration Settings register

Bit	Name	Description
[31:10]	-	Undefined, SBZ
[9]	PLL_EN	Bit set enables PLL for normal operation. Bit clear selects PLL power down mode.
[8]	BYPASS_EN	Bit set bypasses the PLL VCO. Bit clear for normal PLL operation.
[7]	VCO_RANGE	Bit set for clock output > 133MHz. Bit clear for clock output < 133MHz.
[6:4]	N[2:0]	PLL Input divider setting bit 2. The multiplier is 16 for b000.
[3:0]	M[3:0]	Internal feedback clock divider setting bit 3. The divider is 16 for b0000.

Example frequency settings are listed in Table 4-8.

Table 4-8 Example formulas for PLLCFGPERFx registers

Register	Value	Frequency	Formula	Performance
PLLCFGPERF5	0x00000294	160Mhz	40Mhz * (4 / 1)	50%
PLLCFGPERF6	0x000002B0	213Mhz	40Mhz * (16 / 3)	67%
PLLCFGPERF7	0x000002AD	260Mhz	40Mhz * (13 / 2)	81%

4.2.10 DCG System Status Register

The DCGSTATUS register (at 0x10100060) returns the current DCG status.

Note

Reading 0x10100060 returns the DCG status and writing sets the AXI priority.

4.2.11 AXI Priority Register

The AXIPRIORITY register (at 0x10100060) sets the 64-bit AXI arbitration priority.

Table 4-9 AXIPriority register

Bit	Name	Description
[31:23]	-	Undefined, SBZ
[22:20]	AXIPRIORITY	CAI lowest priority slave interface. Reset value is b101.
[19]	-	Undefined, SBZ
[18:16]	-	CAI next highest priority slave interface. Reset value is b100.
[15]	-	Undefined, SBZ
[14:12]	-	CAI next highest priority slave interface. Reset value is b011.
[11]	-	Undefined, SBZ
[10:8]	-	CAI next highest priority slave interface. Reset value is b010.
[7]	-	Undefined, SBZ
[6:4]	-	CAI next highest priority slave interface. Reset value is b001.
[3]	-	Undefined, SBZ
[2:0]	-	CAI highest priority slave interface. Reset value is b000.

4.2.12 SMC Exclusive Access Monitor ID Register

The SMCEXTACMONID register (at 0x10100064) returns the static memory controller exclusive access monitor ID value.

Table 4-10 SMC Exclusive Access Monitor ID register

Bit	Name	Description
[31:14]	-	Undefined, SBZ
[13:8]	SMCEXACMONID	SMC Exclusive Access Monitor ID 1
[7:6]	-	Undefined, SBZ
[5:0]	-	SMC Exclusive Access Monitor ID 0

4.2.13 DLL Calibrate Register

The read-only DLL Calibrate register (at 0x10100068) returns the DLL update period.

Table 4-11 DLL Calibrate Outputs register

Bit	Name	Description
[31:8]	-	Undefined, SBZ
[7:0]	DLLCALIBRATE	DLL calibrate settings

4.3 Advanced Power Controller and Power Management Interface

Control and monitoring of the ARM1176JZF-S development chip voltages are provided by the Advanced Power Controller and the Power Management Interface:

- The interface to the *Advanced Power Controller* is provided by the APC registers in the development chip. The IEM performance level controller can send commands to the APC to control the voltages supplied to the development chip.

———— **Note** ————

The APC requires a separate license for the controller and the documentation on the controller registers. Contact ARM for more information on licensing the APC component and obtaining the documentation required to use the APC with the IEM subsystem.

- The Power Management Interface is a custom peripheral in the FPGA that extends the IEM capabilities of the development chip. It is used as a basic data logger for recording voltage, current, power levels for the development chip and SDRAM.

Table 4-12 Power Management Interface and IEM Interface implementation

Property	Value
Location	IEM controller in development chip and power monitoring registers in FPGA.
Memory base address	0x1001C000 for PMI in FPGA 0x10102000 for APC in development chip.
Interrupt	-
Release version	PMI and APC are custom implementations.
Reference documentation	<i>Power Management Interface registers in the FPGA</i> on page 4-23.

———— **Note** ————

For details of the other IEM subsystem components, see:

- *ARM1176JZF-S development chip system controller* on page 4-12
- *Intelligent Energy Management* on page 3-15.

4.3.1 Power Management Interface registers in the FPGA

The Power Management Interface consists of the memory locations and registers listed in Table 4-13. All registers except PWR_CONTROL are read-only.

Table 4-13 Power Management Interface registers in the FPGA

Register	Address	Description
PWR_CONTROL	0x1001C000	Enables RAM recording of voltage, current, and power.
PWR_VOLTAGE_CTL0	0x1001C010	Present VDDCORE reading
PWR_VOLTAGE_CTL1	0x1001C014	Present VSOC reading
PWR_VOLTAGE_CTL2	0x1001C018	Present VDDRAM reading
PWR_VOLTAGE_CTL3	0x1001C01C	Present TPSENSE reading
PWR_VOLTAGE_CTL4	0x1001C020	Present PWROK reading
PWR_VOLTAGE_AVG0	0x1001C030	Average of VDDCORE over last 1024 readings
PWR_VOLTAGE_AVG1	0x1001C034	Average of VSOC over last 1024 readings
PWR_VOLTAGE_AVG2	0x1001C038	Average of VDDRAM over last 1024 readings
PWR_VOLTAGE_AVG3	0x1001C03C	Average of TPSENSE over last 1024 readings
PWR_MEMA	0x1001C800–0x1001C8FF	Last 512 IEM memreq and corereqs
PWR_MEMB	0x1001C900–0x1001C9FF	Last 512 VDDCORE readings
PWR_MEMC	0x1001CA00–0x1001CAFF	Last 512 VDDCORE power readings
PWR_MEMD	0x1001CB00–0x1001CBFF	Last 512 VSOC readings
PWR_MEME	0x1001CC00–0x1001CEFF	Last 512 VSOC power readings
PWR_MEMF	0x1001CD00–0x1001CDFF	Last 512 VDDRAM readings
PWR_MEMG	0x1001CE00–0x1001CEFF	Last 512 VDDRAM power readings
APC control	0x10102000–0x10102FFF	Reserved

PWR_CONTROL

Setting the RAM Enable bit to 0 stops more data being recorded to the memories. This enables software to fix the history buffers for software analysis.

Table 4-14 PWR_CONTROL

Bits	Access	Description
[31:1]	-	Reserved. Use read-modify-write to preserve value.
[0]	Read/write	Enables cyclic recording of data to mem areas. (power-on reset state is 1)

PWR_VOLTAGE_CTLx

Read the voltage and current for the supplies listed in Table 4-15:

Table 4-15 PWR_READx registers

Register	Address	Description
PWR_VOLTAGE_CTL0	0x10010010	Present VDDCORE reading
PWR_VOLTAGE_CTL1	0x10010014	Present VSOC reading
PWR_VOLTAGE_CTL2	0x10010018	Present VDDRAM reading
PWR_VOLTAGE_CTL3	0x1001001C	Present TPSENSE reading
PWR_VOLTAGE_CTL4	0x10010020	Present PWROK reading

Table 4-16 PWR_READx content

Bits	Access	Description
[31:16]	Read only	Present current level (or TPSENSA voltage if PWR_VOLTAGE_CTL3)
[15:0]	Read only	Present voltage level (or TPSENSB voltage if PWR_VOLTAGE_CTL3)

———— Note —————

The reading from the register is relative and must be converted to an absolute value by the formula:

$$\text{Voltage} = (\text{PWR_VOLTAGE_CTLx} * 18) / 655200$$

PWR_VOLTAGE_AVGx

Read the average voltage and current for the supplies listed in Table 4-15 on page 4-24:

Table 4-17 PWR_AVGx registers

Register	Address	Description
PWR_VOLTAGE_AVG0	0x10010030	Average of VDDCORE over last 1024 readings
PWR_VOLTAGE_AVG1	0x10010034	Average of VSOC over last 1024 readings
PWR_VOLTAGE_AVG2	0x10010038	Average of VDDRAM over last 1024 readings
PWR_VOLTAGE_AVG3	0x1001003C	Average of TPSENSE over last 1024 readings

Table 4-18 PWR_AVGx content

Bits	Access	Description
[31:16]	Read only	Read average current level (or TPSENSA voltage if PWR_VOLTAGE_AVG3)
[15:0]	Read only	Read average voltage level (or TPSENSB voltage if PWR_VOLTAGE_AVG3)

Note

The reading from the register is relative and must be converted to an absolute value by the formula:

$$\text{Voltage} = (\text{PWR_VOLTAGE_AVGx} * 18) / 655200$$

PWR_MEMx

There are seven 512x32bit block RAMs embedded into the power monitor that enable reading the last 512 values. It also records the relative power consumed (voltage * current). This enables very fast software analysis of historical power use.

The RAM at 0x1001C800 records the history of requests from the PowerWise Interface. This enables the additional comparison of historical power use against requests from the IEM (and consequently the correlation between the two). See Table 4-15 on page 4-24:

Table 4-19 PWR_MEMx registers

Register	Address	Description
PWR_MEMA	0x1001C800–0x1001CFFF	Requests from the PowerWise Interface
PWR_MEMB	0x1001D000–0x1001D7FF	Last 512 VDDCORE readings
PWR_MEMC	0x1001D800–0x1001DFFF	Last 512 VDDCORE power readings
PWR_MEMD	0x1001E000–0x1001E7FF	Last 512 VSOC readings
PWR_MEME	0x1001E800–0x1001EFFF	Last 512 VSOC power readings
PWR_MEMF	0x1001F000–0x1001F7FF	Last 512 VDDRAM readings
PWR_MEMG	0x1001F800–0x1001FFFF	Last 512 VDDRAM power readings

Table 4-20 PWR_MEMx content

Bits	Access	Description
[31:16]	Read only	Reserved.
[15:0]	Read only	Voltage or power level

Note

The reading from the register is relative and must be converted to an absolute value by
 $\text{Voltage} = (\text{PWR_MEMx} * 18) / 655200$

4.4 **Advanced Audio CODEC Interface, AACI**

The PrimeCell *Advanced Audio CODEC Interface* (AACI) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-21 AACI implementation

Property	Value
Location	FPGA (the CODEC is an external LM4549)
Memory base address	0x10004000
Interrupt	41 on FPGA GICs
Release version	ARM AACI PL041 r1p0 (modified to one channel and 256 FIFO depth in compact mode and 512 in non-compact mode)
Reference documentation	<i>ARM PrimeCell Advanced Audio CODEC Interface (PL041) Technical Reference Manual</i> and <i>National Semiconductor LM4549 Data Sheet</i> . (See also changed PrimeCell ID listed in Table 4-22 on page 4-28 and <i>Advanced Audio Codec Interface, AACI</i> on page 3-24. on page 3-24)

4.4.1 **PrimeCell Modifications**

The AACI PrimeCell in the PB1176JZF-S has a different FIFO depth than the standard PL041. Therefore, the AACIPeriphID3 register contains the values listed in Table 4-22 on page 4-28.

31	8	7	6	5	3	2	0
Not used				Res.	FIFO depth	Number of channels	

Figure 4-3 AACI ID register

Table 4-22 Modified AACI PeriphID3 register

Bit	Access	Description
[31:8]	-	not used
[7:6]	-	Reserved. Use read-modify-write to preserve value.
[5:3]	Read only	FIFO depth in compact mode b000 8 b001 16 b010 32 b011 64 b100 128 b101 256 b110 512 (default) b111 1024
[2:0]	Read only	number of channels b000 4 b001 1 (default) b010 2 b011 3 b100 4 b101 5 b110 6 b111 7

4.5 Character LCD display

This is a custom peripheral that provides an interface to a standard HD44780 16 x 2 character LCD module.

Table 4-23 Character LCD display implementation

Property	Value
Location	FPGA
Memory base address	0x10008000
Interrupt	39 on FPGA GICs
Release version	Custom logic
Reference documentation	datasheet for the Hitachi HD44780 display (see also <i>Character LCD controller</i> on page 3-24)

———— Note ————

The HD44780 display interface is very slow.

Requests to read or write data or a command to the character LCD are captured and executed later. It is not until 500ns later that the access is completed. Poll access complete flag (bit 0 of CHAR_RAW) or wait for a Char LCD interrupt on SIC7 to check that the last access has completed.

After accepting a command, the character LCD typically requires 37μs to finish processing. Some commands, Return Home for example, take substantially longer (20ms). Poll the busy signal to determine when the display is ready for a new data or command write.

An interrupt signal is generated by the character LCD controller a short time after the raw data is valid. However this interrupt signal is reserved for future use and you must use a polling routine instead of an interrupt service routine.

The control and data registers for the character LCD interface are listed in Table 4-24.

Table 4-24 Character LCD control and data registers

Address	Name	Type	Description
0x10008000	CHAR_COM	Write command, read busy status	<p>A write to this address causes a write to the HD44780 command register some cycles later. A read from this address causes a read from the HD44780 busy register some cycles later.</p> <p>Note</p> <p>The data read from this address is not valid LCD register data. Use the CHAR_RAW and CHAR_RD registers to return LCD register data.</p>
0x10008004	CHAR_DAT	Write data RAM, read data RAM	<p>A write to this address causes a write to the HD44780 data register some cycles later. A read to this address causes a read to the HD44780 data register some cycles later. The data read from this address is not valid LCD register data. Use the CHAR_RAW and CHAR_RD registers to return LCD register data.</p>
0x10008008	CHAR_RD	Read captured data from an earlier read command	<p>Bits [7:0] contain the data from last request read, valid only when bit 0 is set in CHAR_RAW. Bits [31:8] must be ignored.</p>
0x1000800C	CHAR_RAW	Write to reset access complete flag, read to determine if data in CHAR_RD is valid	<p>Bit 8 indicates AccessComplete (write 0 to clear). The bit is set if read data is valid. Bits [31:9] and [7:0] must be ignored.</p>
0x10008010	CHAR_MASK	Write interrupt mask	<p>Set bit 0 to 1 to enable AccessComplete to generate an interrupt on SIC 7.</p>
0x10008014	CHAR_STAT	Read status	<p>Bit 0 is the state of AccessComplete ANDed with the CHAR_MASK</p>

An overview of the commands available is listed in Table 4-25.

Table 4-25 Character LCD display commands

Command	Bit pattern	Description
Clear display	b00000001	Clears entire display and sets display RAM address counter to zero.
Return home	b0000001x	Sets display RAM address counter to zero and returns the cursor to the first character position. Display RAM contents are not erased.
Entry mode set	b000001DS	Sets cursor move direction to increment (<i>D</i> HIGH) or decrement (<i>D</i> LOW). Specifies display shift (<i>S</i> HIGH). This setting affects future display RAM read or write operation.
Display on/off control	b00001DCB	Sets entire display on /off (<i>D</i> HIGH for on) Sets cursor on/off (<i>C</i> HIGH for on) Sets cursor position character blinking on/off (<i>B</i> HIGH for on).
Cursor or display shift	b0001CDxx	Moves cursor (<i>C</i> LOW) or shifts display (<i>C</i> HIGH) right (<i>D</i> HIGH) or left (<i>D</i> LOW) without changing display RAM contents.
Function set	b001LNFxx	Sets interface data length to 8 (<i>L</i> HIGH, the default) or 4 (<i>L</i> LOW). Sets number of display lines to two (<i>N</i> HIGH, the default) or Sets one (<i>N</i> LOW). Sets character font to 5x10 (<i>F</i> HIGH, the default) or 5x8 (<i>F</i> LOW).
Set CGRAM address	b01A44444	Sets character generator RAM address to bA444444. Character generator RAM data is sent and received after this setting.
Set DDRAM address	b1A444444	Sets display RAM address to bA4444444. Display RAM data is sent and received after this setting.

For more details on the character display, see the Hitachi HD44780 datasheet. Example code for accessing the character LCD is provided on the CD as part of the Boot Monitor and Selftest applications. This code is copied to your hard disk during installation, see:

- `install_dir\software\firmware\Platform\source\lcd_dbg.c`
- `install_dir\software\projects\selftest\apcharlcd\apcharlcd.c.`

4.6 Color LCD Controller, CLCDC

The PrimeCell *Color LCD Controller* (CLCDC) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-26 CLCDC implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10112000
Interrupt	47 on development chip GIC (15 on TZIC)
Release version	ARM CLCDC PL111 r0p0-00alp0 (extended to include the hardware cursor from ARM CLCDC PL110 r0p0)
Reference documentation	<i>ARM PrimeCell Color LCD Controller (PL111) Technical Reference Manual</i> For details on the hardware cursor registers, see the <i>ARM926EJ-S Technical Reference Manual</i> . See also address modifications listed in <i>PrimeCell Modifications</i> on page 4-33, <i>Display resolutions and display memory organization</i> on page 4-33, and <i>CLCDC interface</i> on page 3-18)

The following locations are reserved, and must not be used during normal operation:

- locations at offsets 0x030 to 0x1FE are reserved for possible future extensions
- locations at offsets 0x400 to 0x7FF are reserved for test purposes.

4.6.1 PrimeCell Modifications

The register map for the variant of the PL111 used in the ARM1176JZF-S development chip is not the same as the obsolete PL110. The differences are listed in Table 4-27.

Table 4-27 PrimeCell CLCDC register differences

Address (Dev. Chip)	Reset value (Dev. Chip)	Description in PL110 TRM	Difference
0x10110018	0x0	LCDControl, LCD panel pixel parameters	CLCDC TRM lists address as 0x1011001C
0x1011001C	0x0	LCDIMSC, interrupt mask set and clear	CLCDC TRM lists address as 0x10110018
0x10110800– 0x10110C2C	0x0	Not present	Hardware cursor registers from PL111 (see the <i>ARM926EJ-S Technical Reference Manual</i> for details)
0x10110FE0	0x11	CLCDPeriphID0	CLCDC TRM lists value as 0x10
0x10110FE4	0x11	CLCDPeriphID1	CLCDC TRM lists value as 0x11

4.6.2 Display resolutions and display memory organization

Different display resolutions require different data and synchronization timing. Use registers CLCD_TIM0, CLCD_TIM1, CLCD_TIM2, and SYS_OSCCLK0 to define the display timings as listed in Table 4-28.

Table 4-28 Values for different display resolutions

Display resolution	CLCDCLK frequency and SYS_OSCCLK0 register value	CLCD_TIM0 register at 0x10112000	CLCD_TIM1 register 0x10112004	CLCD_TIM2 register at 0x10112008
VGA (640x480) on VGA	25MHz, 0x35C57	0x3F0F4F9C	0x0D030DDF	0x067F3800
SVGA (800x600) on SVGA	36MHz, 0x35C91	0x6F1F4FC4	0x11030E57	0x071F3800
XVGA(1024x768) on XVGA	64MHz, 0x35CF6	0x972F67FC	0x17030EFF	0x07FF3800

Note

The mapping of the 32 bits of pixel data in memory to the RGB display signals depends on the resolution and display mode. Resolutions based on 16 bits per pixel encode two pixels in one 32-bit word.

4.7 Dynamic Memory Controller, DMC

The *Dynamic Memory Controller* (DMC) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-29 DMC implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10109000 (for configuration)
Interrupt	NA
Release version	ARM DMC PL340
Reference documentation	ARM PrimeCell Dynamic Memory Controller (PL340) Technical Reference Manual (see also Memory interface on page 3-17)

The DMC controls the dynamic memory on the PB1176JZF-S.

4.7.1 Register values

Table 4-30 lists the register values for typical operation with 133MHz SDRAM. The HCLK frequency is 105MHz and the SDRAM is organized as four banks of 8MB x 16bit.

———— **Note** —————

The platform.a library contains memory setup routines. See Appendix F *Boot Monitor and platform library*.

Table 4-30 SDRAM register values

Address	Register name	Access	Value	Description
0x10109000	DMC_memc_status	Read/write	-	-
0x10109004	DMC_memc_cmd	Write only	-	-
0x10109008	DMC_direct_cmd	Write only	-	-
0x1010900C	DMC_memory_cfg	Read/write	0x19112	-

Table 4-30 SDRAM register values (continued)

Address	Register name	Access	Value	Description
0x10109010	DMC_refresh_prd	Read/write	0x01C2	-
0x10109014	DMC_cas_latency	Read/write	0x0006	-
0x10109018	DMC_t_dqss	Read/write	0x0001	-
0x1010901C	DMC_t_mrd	Read/write	0x0002	-
0x10109020	DMC_t_ras	Read/write	0x0007	-
0x10109024	DMC_t_rc	Read/write	0x0009	-
0x10109028	DMC_t_rcd	Read/write	0x0003	-
0x1010902C	DMC_t_rfc	Read/write	0x00C9	-
0x10109030	DMC_t_rp	Read/write	0x0003	-
0x10109034	DMC_t_rrd	Read/write	0x0002	-
0x10109038	DMC_t_wt	Read/write	0x0002	-
0x1010903C	DMC_t_wtr	Read/write	0x0001	-
0x10109040	DMC_t_xp	Read/write	0x0003	-
0x10109044	DMC_t_xsr	Read/write	0x000F	-
0x10109048	DMC_t_esr	Read/write	0x0014	-
0x10109100	DMC_id_n_ncfg	Read/write	0x0	-
0x10109200	DMC_chip_n_ncfg	Read/write	0x00F8	-
0x10109300	DMC_user_status	Read only	-	-
0x10109304	DMC_user_config	Write only	-	-
0x10109FE0	DMC_periph_id_n	Read only	-	-
0x10109FF0	DMC_comp_id_n	Read only	-	-

4.8 Ethernet

The Ethernet interface is implemented in an external SMC LAN9118 10/100 Ethernet single-chip MAC and PHY. The internal registers of the LAN9118 are memory-mapped onto the AHB M2 bus and occupy 16 word locations at 0x3A000000.

Table 4-31 Ethernet implementation

Property	Value
Location	Board (LAN9118 chip)
Memory base address	0x3A000000 on SMC CS 6
Interrupt	42 on FPGA GICs
Release version	The FPGA contains a custom interface to the LAN9118 chip
Reference documentation	<i>LAN9118 Data Sheet</i> (see also <i>Ethernet interface</i> on page 3-29).

To access the PHY MII registers, you must implement a synchronous serial connection in software to control the management register in Bank 3. By default, the PHY is set to isolate in the control register. This disables the external interface. See the LAN91C111 application note or to the self test program supplied on the CD for additional information.

When manufactured, an ARM value for the Ethernet MAC address and the register base address are loaded into the EEPROM. The register base address is 0. The MAC address is unique, but can be reprogrammed if required. Reprogramming of the EEPROM is done through Bank 1 (general and control registers).

4.9 FPGA status and system control registers

The PB1176JZF-S status and system control registers enable the processor to determine its environment and to control some on-board operations. The registers, listed in Table 4-32, are located from 0x10000000.

See also *Reset controller* on page 3-32 for a description of the reset logic.

Note

All registers are 32 bits wide and do not support byte writes. Write operations must be word-wide. Bits marked as *reserved* in the following sections must be preserved using read-modify-write operations.

In Table 4-32, the entry for **Reset Level** indicates the highest reset level that modifies its contents:

- Level 1** Pressing the FPGA CONFIG initiates reconfiguration of the FPGA. Registers that have a reset level of 0 are not affected.
- Level 0** The system power on reset (**nSYSPOR**) is a level 0 reset and initializes all registers to their default value. This level reset also resets all registers that have reset level of 1.

Table 4-32 Register map for FPGA System Controller registers

Name	Address	Access ^a	Reset level	Description
SYS_ID	0x10000000	Read only	-	System Identity. See <i>ID Register</i> , <i>SYS_ID</i> on page 4-40.
SYS_SW	0x10000004	Read only	-	Bits [7:0] map to S6 (user switches)
SYS_LED	0x10000008	Read/Write	1	Bits [7:0] map to user LEDs (located next to S6)
SYS_OSC0	0x1000000C	Read/Write Lockable	1	Settings for the ICS307 programmable oscillator chip OSC0. This oscillator provides the CLCDCLKEXT signal source. See <i>Oscillator registers</i> , <i>SYS_OSCx</i> on page 4-42 and <i>ARM1176JZF-S development chip clocks</i> on page 3-40.
SYS_OSC1	0x10000010	Read/Write Lockable	1	Settings for the ICS307 programmable oscillator chip OSC1. This oscillator provides the signal source PLLREFCLK1 .

Table 4-32 Register map for FPGA System Controller registers (continued)

Name	Address	Access ^a	Reset level	Description
SYS_OSC2	0x10000014	Read/Write Lockable	1	Settings for the ICS307 programmable oscillator chip OSC2. This oscillator provides the reference to the AXI bus multiplexer and the signal source PLLREFCLK2 .
SYS_OSC3	0x10000018	Read/Write Lockable	1	Settings for the ICS307 programmable oscillator chip OSC3. This oscillator provides the signal source PLLREFCLK .
SYS_OSC4	0x1000001C	Read/Write Lockable	1	Settings for the ICS307 programmable oscillator chip OSC4. This clock is not used.
SYS_LOCK	0x10000020	Read/Write	1	Write 0xA05F to unlock. See <i>Lock Register</i> , <i>SYS_LOCK</i> on page 4-43.
SYS_100HZ	0x10000024	Read only	0	100Hz counter.
SYS_CFGDATA1	0x10000028	Read/Write Lockable	0	Configuration data to be applied to HDATAM1 pins at power on or when the SDC CONFIG pushbutton is pressed.
SYS_CFGDATA2	0x1000002C	Read/Write Lockable	0	Configuration data to be applied to HDATAM2 pins at power on or when the SDC CONFIG pushbutton is pressed.
SYS_FLAGS	0x10000030	Read only	1	General-purpose flags (reset by any reset). See <i>Flag registers</i> , <i>SYS_FLAGx</i> and <i>SYS_NVFLAGx</i> on page 4-48.
SYS_FLAGSSET	0x10000030	Write	1	Set bits in general-purpose flags.
SYS_FLAGSCLR	0x10000034	Write	1	Clear bits in general-purpose flags.
SYS_NVFLAGS	0x10000038	Read only	0	General-purpose nonvolatile flags (reset only on power up).
SYS_NVFLAGSSET	0x10000038	Write	0	Set bits in general-purpose nonvolatile flags.
SYS_NVFLAGSCLR	0x1000003C	Write	0	Clear bits in general-purpose nonvolatile flags.
SYS_RESETCTL	0x10000040	Read/Write Lockable	0	The reset control register sets reset depth and programmable soft reset.
SYS_PCICTL	0x10000044	Read only	-	Read returns a HIGH in bit [0] if a PCI board is present in the expansion backplane.

Table 4-32 Register map for FPGA System Controller registers (continued)

Name	Address	Access ^a	Reset level	Description
Reserved	0x10000048	Read only	-	Was SYS_MCI on PB926.
SYS_FLASH	0x1000004C	Read/Write	1	Controls write protection of flash devices.
SYS_CLCD	0x10000050	Read/Write	1	Controls LCD power and multiplexing.
Reserved	0x10000054	Read/Write	1	-
SYS_BOOTCS	0x10000058	Read only	-	Contains the settings of the boot switch S1.
SYS_24MHz	0x1000005C	Read only	1	32-bit counter clocked at 24MHz.
SYS_MISC	0x10000060	Read only	1	See <i>Miscellaneous System Control Register, SYS_MISC</i> on page 4-52 for details.
SYS_BUSID	0x10000080	Read/only	1	Shows the BUSID of transaction, indicates master no. See <i>Bus status registers, SYS_BUSID</i> on page 4-53.
SYS_PROCID1	0x10000084	Read/only	1	Shows that the primary processor is an ARM11 See <i>System status registers, SYS_PROCIDx</i> on page 4-54.
SYS_PROCID2	0x10000088	Read/only	1	Shows that there is no directly connected Core Tile. See <i>System status registers, SYS_PROCIDx</i> on page 4-54.
SYS_OSCRESET0	0x1000008C	Read/Write Lockable	0	Value to load into the SYS_OSC0 register if the DEV CHIP RECONFIGURE pushbutton is pressed (APPLYCFGWORD active). At power-on reset, the SYS_OSCRESET0 is loaded with the same default value as used for SYS_OSC0.
SYS_OSCRESET1	0x10000090	Read/Write Lockable	0	Value to load into the SYS_OSC1 register if the DEV CHIP RECONFIGURE pushbutton is pressed (APPLYCFGWORD active). At power-on reset, the SYS_OSCRESET1 is loaded with the same default value as used for SYS_OSC1.
SYS_OSCRESET2	0x10000094	Read/Write Lockable	0	Value to load into the SYS_OSC2 register if the DEV CHIP RECONFIGURE pushbutton is pressed (APPLYCFGWORD active). At power-on reset, the SYS_OSCRESET2 is loaded with the same default value as used for SYS_OSC2.

Table 4-32 Register map for FPGA System Controller registers (continued)

Name	Address	Access ^a	Reset level	Description
SYS_OSCRESET3	0x10000098	Read/Write Lockable	0	Value to load into the SYS_OSC3 register if the DEV CHIP RECONFIGURE pushbutton is pressed (APPLYCFGWORD active). At power-on reset, the SYS_OSCRESET3 is loaded with the same default value as used for SYS_OSC3.
SYS_OSCRESET4	0x1000009C	Read/Write Lockable	0	Value to load into the SYS_OSC4 register if the DEV CHIP RECONFIGURE pushbutton is pressed (APPLYCFGWORD active). At power-on reset, the SYS_OSCRESET4 is loaded with the same default value as used for SYS_OSC4.
SYS_TEST_OSC0	0x100000C0	Read only	1	32-bit counter clocked from ISC307 clock 0.
SYS_TEST_OSC1	0x100000C4	Read only	1	32-bit counter clocked from ISC307 clock 1.
SYS_TEST_OSC2	0x100000C8	Read only	1	32-bit counter clocked from ISC307 clock 2.
SYS_TEST_OSC3	0x100000CC	Read only	1	32-bit counter clocked from ISC307 clock 3.
SYS_TEST_OSC4	0x100000D0	Read only	1	32-bit counter clocked from ISC307 clock 4.

a. If Access is lockable, the register can only be written if SYS_LOCK is unlocked (see *Lock Register*; *SYS_LOCK* on page 4-43).

4.9.1 ID Register, SYS_ID

The SYS_ID register at 0x10000000 is a read-only register that identifies the board manufacturer, board type, and revision. Figure 4-4 shows the bit assignment of the register.

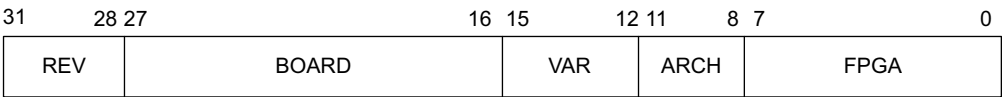


Figure 4-4 ID Register, SYS_ID

Table 4-33 describes the PB1176JZF-S ID Register assignment.

Table 4-33 ID Register, SYS_ID bit assignment

Bits	Access	Name	Description
[31:28]	Read	REV	FPGA revision: 0 = A, F=ALL
[27:16]	Read	BOARD	HBI board design: 0x147 = HBI-0147
[15:12]	Read	VAR	System variant: 0 = A, F=ALL
[11:8]	Read	ARCH	Architecture: 5=Multi-layer AXI
[7:0]	Read	FPGA	FPGA build number

4.9.2 Switch Register, SYS_SW

Use the SYS_SW register at 0x10000004 to read the general purpose (user) switch S6. A value of 1 indicates that the switch is on.



Figure 4-5 SYS_SW

4.9.3 LED Register, SYS_LED

Use the SYS_LED register at 0x10000008 to set the user LEDs. (The LEDs are located next to user switch S6.) Set the corresponding bit to 1 to illuminate the LED.



Figure 4-6 SYS_LED

4.9.4 Oscillator registers, SYS_OSCx

The oscillator registers, SYS_OSC0 to SYS_OSC4 at 0x1000000C–0x1000001C, are read/write registers that control the frequency of the clocks generated by the ICS307 programmable oscillators. A serial interface transfers the values in the registers to the programmable oscillators when a reset occurs.

———— **Note** —————

If the DEV CHIP RECONFIG pushbutton is pressed, the contents of the SYS_OSCRESETx registers are copied into the SYS_OSCx registers before the contents are transmitted to the programmable oscillators. This enables the clock frequencies and the clock divider ratios to be changed at the same time.

Figure 4-7 shows the bit assignment of the registers.

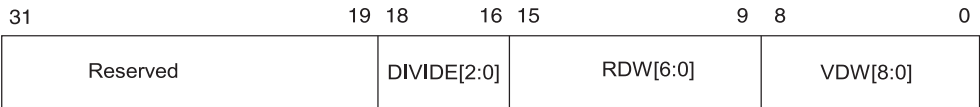


Figure 4-7 Oscillator Register, SYS_OSCx

Table 4-34 lists the details of the SYS_OSCx registers.

Table 4-34 Oscillator Register, SYS_OSCx bit assignment

Bits	Access	Description
[31:19]	Reserved	Use read-modify-write to preserve value.
[18:16]	Read/write	DIVIDE[2:0], output divider select
[15:9]	Read/write	RDW[6:0], reference divider word
[8:0]	Read/write	VDW[8:0], VCO divider word

For more information on bit values, see *ICS307 programmable clock generators* on page 3-48 and *Clock rate restrictions* on page B-4.

Table 4-35 Default values for oscillators

Address	Signal	Default value	Reference for
0x1000000C	OSC_CLK[0]	0x00002C8E	CLCDCLKEXT
0x10000010	OSC_CLK[1]	0x00002CA7	PLLREFCLK1
0x10000014	OSC_CLK[2]	0x00002CA7	PLLREFCLK2
0x10000018	OSC_CLK[3]	0x00002CA7	PLLREFCLK
0x1000001C	OSC_CLK[4]	0x00002C2A	not used

Note

Before writing to a SYS_OSC register, unlock it by writing the value 0x0000A05F to the SYS_LOCK register. After writing the SYS_OSC register, relock it by writing any value other than 0x0000A05F to the SYS_LOCK register.

4.9.5 Lock Register, SYS_LOCK

The SYS_LOCK register at 0x10000020 locks or unlocks access to the following registers:

- Oscillator registers, SYS_OSCx
- Reset values for oscillators, SYS_OSCRESETx.
- Configuration registers, SYS_CFGDATAx
- Reset control register, SYS_RESETCTL

The control registers cannot be modified while they are locked. This mechanism prevents the registers from being overwritten accidentally. The registers are locked by default after a reset. Figure 4-8 shows the bit assignment of the register.

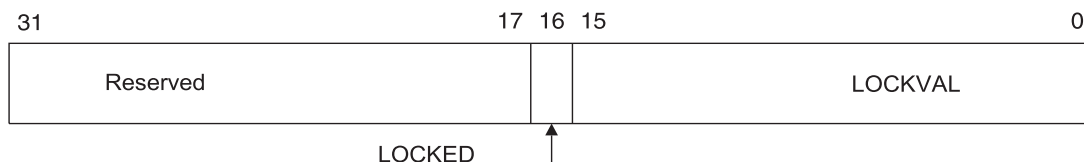


Figure 4-8 Lock Register, SYS_LOCK

Table 4-36 describes the PB1176JZF-S Lock Register bit assignment.

Table 4-36 Lock Register, SYS_LOCK bit assignment

Bits	Access	Description
[31:17]	Reserved.	Use read-modify-write to preserve value.
[16]	Read	LOCKED, this bit indicates if the control registers are locked or unlocked: 0 = unlocked 1 = locked (default).
[15:0]	Read/write	LOCKVAL, write the value 0xA05F to unlock the control registers. Write any other value to this register to lock the registers.

4.9.6 100Hz Counter, SYS_100HZ

The SYS_100HZ register at 0x10000024 is a 32-bit counter incremented at 100Hz. The 100Hz reference is derived from the 32.768KHz crystal oscillator. The register is set to zero by a reset.

4.9.7 Configuration registers SYS_CFGDATAx

The read/write registers SYS_CFGDATA1 (at 0x10000028) and SYS_CFGDATA2 (at 0x1000002C) contain configuration data. See Table 4-37 and Table 4-38 on page 4-47 for the function associated with the register bits.

Note

The values of SYS_CFGDATA1 and SYS_CFGDATA2 are loaded at reset (DEVCHIPPRECONFIG) into the SoC Config registers of the processor.

In a production ASIC, the configuration signals would be tied HIGH or LOW, but they are configurable in the ARM1176JZF-S development chip. This enables you to test different build options.

Table 4-37 SYS-CFGDATA 1 register

Bits	Configuration signal	Reset Value	Description
[31:23]	Not used	-	Reserved for future use.
[22:21]	CFGSMMWCS7[1:0]	b10	SMC bank 7 data width: 00 = 8-bit 01 = 16-bit 10 = 32-bit 11 = undefined.
[20:19]	CFGSMCMEMRATIO[1:0]	b10	SMC AXI to external memory clock ratio: 00 = 1:1 01 = 2:1 10 = 3:1 11 = undefined.
[18]	CFGSMCAXIRATIO	0	SMC AXI sync down clock ratio: 0 = 1:1 1 = 2:1.

Table 4-37 SYS-CFGDATA 1 register (continued)

Bits	Configuration signal	Reset Value	Description
[17:15]	CFGAXIEXTRATIOMSTR[2:0]	b010	AXI external master clock ratio: 000 = 1:1 001 = 2:1 010 = 3:1 011 = 4:1 100 = 5:1 101 = 6:1 110 = 7:1 111 = 8:1.
[14:12]	CFGAXIEXTRATIOSLV[2:0]	b010	AXI external slave clock ratio: 000 = 1:1 001 = 2:1 010 = 3:1 011 = 4:1 100 = 5:1 101 = 6:1 110 = 7:1 111 = 8:1.
[11]	CFGAXIRATIO	0	AXI: Core clock ratio: 0 = 2:1 1 = 4:1.
[10]	CFGCP15SDISABLE	0	TZ write access disable
[9]	CFGUBITINIT	0	ARMv6 unaligned behavior
[8]	CFGBIGENDINIT	0	ARMv5 big endian behavior
[7]	CFGVINITHI	0	High exception vector location
[6]	CFGINITRAM	0	ITCM at 0x0 for data and instructions at reset
[5:4]	CFGREMAP[1:0]	b10	Defines boot memory map: 00 = normal memory 01 = AXI ROM 10 = SMC 11 = AXI master port.
[3:0]	CFGCOREID[3:0]	b0000	LS nibble of core ID[7:0]

Table 4-38 SYS-CFGDATA 2 register

Bits	Configuration signal	Reset Value	Description
[31:18]	Not used	-	Reserved for future use.
[17]	CFGCLKSTOPSBWFI	0	Selects whether the Clock is stopped to the L2CC and ETM during CPU STANDBYWFI State: 0 = clock is left free running 1 = clock is stopped.
[16]	CFGIEMSHUTDOWN	0	Selects the IEM subsystem to be powered down from reset: 0 = functional 1 = shutdown.
[15]	CFGIRQSOURCE	1	Selects the nIRQ, nFIQ source: 0 = external 1 = internal.
[14]	CFGPLLFIXEDDESKEW	1	Selects external clock feedback path for on chip clock deskew
[13]	CFGPLLFIXEDPLEN	1	PLL Enable
[12]	CFGPLLFIXEDBYPASSEN	0	Bypass VCO
[11:9]	CFGPLLFIXEDN	b001	PLL input divider. ———— Caution ————— Do not modify. Use only the default value of b001. ————
[8:5]	CFGPLLFIXEDM	b0001	PLL feedback divider. ———— Caution ————— Do not modify. Use only the default value of b0001. ————
[4]	CFGPLLFIXEDVCORANGE	1	Selects VCO range: 1 >133MHz 0 <133MHz.
[3]	CFGPLL2BYPASS	0	Bypass PLL2 (used by IEM subsystem)

Table 4-38 SYS-CFGDATA 2 register (continued)

Bits	Configuration signal	Reset Value	Description
[2]	CFGPLL1BYPASS	0	Bypass PLL1 (used by IEM subsystem)
[1]	CFGPLLBYPASS	0	Bypass PLLFIXED (typically the main reference generator, PLLREFCLK is used directly for the core clock instead of the PLL output PLLFIXEDCLK .)
[0]	CFGPLLREFCLK	0	Use PLLREFCLK as the input reference for PLL1 and PLL2

4.9.8 Flag registers, SYS_FLAGx and SYS_NVFLAGx

The registers shown in Table 4-39 provide two 32-bit register locations containing general-purpose flags. You can assign any meaning to the flags.

Table 4-39 Flag registers

Register name	Address	Access	Reset by	Description
SYS_FLAGS	0x10000030	Read	Reset	Flag register
SYS_FLAGSSET	0x10000030	Write	Reset	Flag Set register
SYS_FLAGSCLR	0x10000034	Write	Reset	Flag Clear register
SYS_NVFLAGS	0x10000038	Read	POR	Nonvolatile Flag register
SYS_NVFLAGSSET	0x10000038	Write	POR	Nonvolatile Flag Set register
SYS_NVFLAGSCLR	0x1000003C	Write	POR	Nonvolatile Flag Clear register

The PB1176JZF-S provides two distinct types of flag registers:

- The SYS_FLAGS Register is cleared by a normal reset, such as a reset caused by pressing the reset button.
- The SYS_NVFLAGS Register retains its contents after a normal reset and is only cleared by a *Power-On Reset* (POR).

Flag and Nonvolatile Flag Registers

The SYS_FLAGS and SYS_NVFLAGS registers contain the current state of the flags.

Flag and Nonvolatile Flag Set Registers

The SYS_FLAGSSET and SYS_NVFLAGSSET registers are used to set bits in the SYS_FLAGS and SYS_NVFLAGS registers:

- write 1 to SET the associated flag
- write 0 to leave the associated flag unchanged.

Flag and Nonvolatile Flag Clear Registers

Use the SYS_FLAGSCLR and SYS_NVFLAGSCLR registers to clear bits in SYS_FLAGS and SYS_NVFLAGS:

- write 1 to CLEAR the associated flag
- write 0 to leave the associated flag unchanged.

4.9.9 Reset Control Register, SYS_RESETCTL

The SYS_RESETCTL register at 0x10000040 sets reset depth and programmable soft reset, see *Reset controller* on page 3-32 and *Reset level* on page 3-33. The register bits are shown in Figure 4-9 and the function of the register bits are listed in Table 4-40. You must unlock the register (see *Lock Register, SYS_LOCK* on page 4-43) before the register contents can be modified.

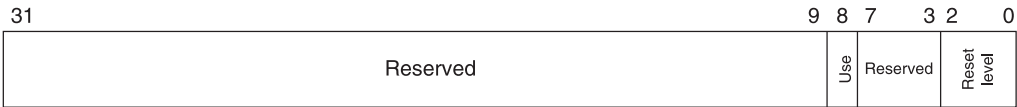


Figure 4-9 SYS_RESETCTL

Table 4-40 Reset level control

Bits	Access	Description
[31:9]	-	Reserved.
[8]	Read/Write	Set to 1 to force a soft reset.
[7:3]	-	Reserved.
[2:0]	Read/Write	Sets the depth of a soft reset: 1=SYSRST (reset Logic Tile) 2=PLLLLOCK (reset PLL) 4=PBRESET (board reset, same as pressing reset button)

4.9.10 PCI Control Register, SYS_PCICTL

The SYS_PCICTL register at 0x10000044 returns status on the PCI bus as listed in Table 4-41:

Table 4-41 PCI bus status

Bits	Access	Description
[31:2]	Read only	Reserved.
[1]	Read only	Reserved. ———— Note ————— On the RealView Platform Baseboard for ARM926EJ-S, this bit was PCICONTROLIN signal and indicated that 66MHz mode was enabled. The PB1176JZF-S only supports 33MHz operation.
[0]	Read only	Status of P_DETECT pin.

See Appendix D *PCI Backplane and Enclosure*, *PCI controller* on page 4-109, and *PCI interface* on page 3-27 for more information on the PCI backplane.

4.9.11 Flash Control Register, SYS_FLASH

Bit 0 of the SYS_FLASH register at 0x1000004C controls write protection of NOR flash devices. The function of the register bits are shown in Table 4-42.

Table 4-42 Flash control

Bits	Access	Description
[31:1]	-	Reserved. Use read-modify-write to preserve value.
[0]	Read/write	Disables writing to flash if LOW (power-on reset state is LOW)

4.9.12 CLCD Control Register, SYS_CLCD

The SYS_CLCD register at 0x10000050 controls LCD power and multiplexing and controls the interface to the touchscreen.



Figure 4-10 SYS_CLCD

Table 4-43 SYS_CLCD register

Bits	Access	Description
[31:13]	-	Reserved. Use read-modify-write to preserve value.
[12:8]	Read	Reserved to maintain compatibility with CLCDID[4:0] detection.
[7]	Read/write	SSP expansion chip select (SSPnCS). If LOW, the chip select on the SSP expansion connector is active. See <i>Synchronous Serial Port, SSP</i> on page 3-19.
[6:0]	-	Reserved. Use read-modify-write to preserve value.

4.9.13 Boot Select Register, SYS_BOOTCS

This read-only SYS_BOOTCS register at 0x10000058 returns the settings of the S1 configuration switches. The function of the register bits are shown in Table 4-44. If a switch is ON, the corresponding signal is 1. See also *Memory map* on page 4-3 and *Configuration control* on page 3-13.



Figure 4-11 SYS_BOOTCS

Table 4-44 BOOT configuration switches

Bits	Access	Description
[31:3]	-	Reserved. Use read-modify-write to preserve value.
[2:0]	Read	Static boot memory select switch S1[2:0]

4.9.14 24MHz Counter, SYS_24MHZ

The SYS_24MHZ register at 0x1000005C provides a 32-bit count value. The count increments at 24MHz frequency from the 24MHz crystal reference output **REFCLK24MHZ** from OSC0. The register is set to zero by a reset.

4.9.15 Miscellaneous System Control Register, SYS_MISC

The SYS_MISC register at 0x10000060 provides miscellaneous status and control signals as shown in Table 4-45.



Figure 4-12 SYS_MISC

Table 4-45 SYS_MISC

Bits	Access	Description
[31:25]	-	Reserved. Use read-modify-write to preserve value.
[24]	Read/write	Override. Set to 1 to use bits [23:20] to control debug instead of switch S7[3].
[23]	Read/write	Secure Privilege Invasive Debug Enable (SPIDEN signal).
[22]	Read/write	Secure Privilege Non-Invasive Debug Enable (SPNIDEN signal).
[21]	Read/write	Non-Invasive Debug Enable (NIDEN signal).
[20]	Read/write	Debug Enable (DBGEN signal).
[19:5]	-	Reserved. Use read-modify-write to preserve value.
[4]	Read	GP PUSHSWITCH state. If pressed, the value is 1. (See <i>User switches and LEDs</i> on page 3-26.)
[3]	Read/write	Suspend Enable. Set HIGH to enable the GP PUSHSWITCH to toggle the PWRFAIL pin on ARM1176JZF-S development chip. The PWRFAIL pin is not connected to any power-fail logic, but the pin can be used to test application code that must respond to a power failure.

Table 4-45 SYS_MISC (continued)

Bits	Access	Description
[2]	Read/write	FPGA remap control (FPGA_REMAP). Default is 1. When set to 1, AXI FPGA BOOTROM/SRAM at physical address 0x40000000 is mapped in the FPGA to address 0x00000000. When set to 0, the ARM1176JZF-S development chip at physical address 0x00000000 is mapped in the FPGA to address 0x00000000. This allows transfers from the Logic Tile to the FPGA at address 0x00000000 to pass through the FPGA into the ARM1176JZF-S development chip SDRAM.
[1]	Read	RTCOUNT signal from the external DS1338 real-time clock. This 32kHz signal can be used as a timer.
[0]	Read	nTILEDET signal. Pulled LOW if a RealView Logic Tile connects to the expansion headers.

4.9.16 Bus status registers, SYS_BUSID

The bus status register at 0x10000080 returns the ID of the bus the access was made with.

For AXI busses the AXI port used to create the read appends its own ID bits for forwarded accesses from the matrix. This value is returned on a read. This enables you to determine through software which master the software is executing on, as each bus matrix that the access passes through adds additional ID information. If the top bits are 0, then the master must be either the only master, or the primary master through any bus matrices. A non-zero value indicates that some other masters are in the system that must instead be considered the primary master.

This register returning the RID bits onto the RDATA bus. Because there is a bus matrix inside the FPGA between the HDRX bus (six ID bits), and a local master (PCI), there are usually seven ID bits in use inside the FPGA.

Although this board typically only runs software on the ARM1176JZF-S, this register is maintained to enable software compatibility with the Emulation Baseboard and to enable operating multi-core systems without the requirement to change the baseboard FPGA image.

Table 4-46 SYS_BUSID

Bits	Access	Description
[31:7]	Read only	Reserved. Use read-modify-write to preserve value.
[6:0]	Read only	Returns bus ID.

4.9.17 System status registers, SYS_PROCIDx

The system status registers, SYS_PROCID1 and SYS_PROCID2, return information about the configuration of the baseboard.

Table 4-47 System status registers

Name	Address	Access	Description
SYS_PROCID1	0x10000084	Read only	Indicates that the processor is an ARM11
SYS_PROCID2	0x10000088	Read only	Indicates that there is no directly connected Core Tile

4.9.18 Oscillator reset registers, SYS_OSCRESETx

The oscillator reset registers, SYS_OSCRESET0 to SYS_OSCRESET4, at 0x1000008C–0x1000009C, are read/write registers that control the frequency of the clocks generated by clock generators OSC0, OSC1, OSC2, OSC3, and OSC4 if the DEV CHIP RECONFIG pushbutton is pressed.

Figure 4-13 shows the bit assignment of the registers.

31	19	18	16	15	9	8	0
Reserved				DIVIDE[2:0]	RDW[6:0]		VDW[8:0]

Figure 4-13 Oscillator Register, SYS_OSCRESETx

———— Note ————

Before writing to a SYS_OSCRESETx register, unlock it by writing the value 0x0000A05F to the SYS_LOCK register (see *Lock Register, SYS_LOCK* on page 4-43). After writing the SYS_OSCRESETx register, relock it by writing any value other than 0x0000A05F to the SYS_LOCK register.

For more information on bit values, see *ICS307 programmable clock generators* on page 3-48 and *Oscillator registers, SYS_OSCx* on page 4-42.

———— Note ————

At power-on reset (**nSYSPOR**), the SYS_OSCRESETx are loaded with the same default values used for SYS_OSCx.

The values of the SYS_OSCRESETx values can be changed after powering on. Pushing the DEV CHIP RECONFIG pushbutton loads the values of the SYS_OSCRESETx registers into the SYS_OSCx registers and loads the programmable oscillators with the new values.

4.9.19 Oscillator test registers, SYS_TEST_OSCx

The oscillator test registers, SYS_TEST_OSC0 to SYS_TEST_OSC4, provide 32-bit count values. The count increments at frequency of the corresponding ICS307 programmable oscillator. The registers are set to zero by a reset.

Table 4-48 Oscillator test registers

Name	Address	Access	Description
SYS_TEST_OSC0	0x100000C0	Read only	Counter clocked from clock 0
SYS_TEST_OSC1	0x100000C4	Read only	Counter clocked from clock 1
SYS_TEST_OSC2	0x100000C8	Read only	Counter clocked from clock 2
SYS_TEST_OSC3	0x100000CC	Read only	Counter clocked from clock 3
SYS_TEST_OSC4	0x100000D0	Read only	Counter clocked from clock 4

4.10 General Purpose Input/Output, GPIO

The PrimeCell *General Purpose Input/Output* (GPIO) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-49 GPIO implementation

Property	Value
Location	ARM1176JZF-S development chip and FPGA
Memory base address	0x1010A000 for GPIO 0 (development chip) 0x10014000 for GPIO 1 (FPGA) 0x10015000 for GPIO 2 (FPGA) ^a
Interrupt	48 on dev. chip GIC for GPIO 0 (16 on TZIC) 40 on FPGA GICs for GPIO 1 41 on FPGA GICs for GPIO 2 ^a
Release version	ARM GPIO PL061 r1p0
Reference documentation	<i>ARM PrimeCell GPIO (PL061) Technical Reference Manual</i> (see also <i>GPIO interface</i> on page 3-18)

a. The signals from GPIO 2 in the FPGA are not connected to the expansion connector. This GPIO is reserved for future use.

4.11 Interrupt controllers in the ARM1176JZF-S development chip

The development chip has the following interrupt controllers:

TrustZone Interrupt Controller (TZIC)

The *TrustZone Interrupt Controller (TZIC)* is an AMBA3 compliant SoC peripheral that is developed, tested, and licensed by ARM Limited. The TZIC is located in the development chip. See *Development chip TrustZone Interrupt Controller*.

Generic Interrupt Controllers (GIC)

The GIC used on the PB11J6JZF-S are pre-release versions of the PL390 *Generic Interrupt Controller (GIC)*. The GICs are AMBA compliant SoC peripherals.

The GIC in the ARM1176JZF-S development chip accepts interrupts from peripherals located in the development chip and generates the **nIRQ** signal to the processor. See *Development chip GIC* on page 4-70.

For details on the registers in the GIC, see *GIC Distribution register* on page 4-77, *GIC CPU Interface* on page 4-100, and *GIC reserved register addresses* on page 4-105.

———— **Note** —————

There also two GICs in the FPGA that accept interrupts from peripherals located in the FPGA and generate interrupts to inputs 31 and 30 of the TZIC in the ARM1176JZF-S development chip. See *Interrupt controllers in the FPGA* on page 4-74.

4.11.1 Development chip TrustZone Interrupt Controller

This section describes the registers in the ARM1176JZF-S development chip TrustZone Interrupt controller.

Table 4-50 TZIC implementation in development chip

Property	Value
Location	ARM1176JZF-S development chip
Memory base addresses	0x1011F000
Interrupt inputs	See Table 4-71 on page 4-72.

Table 4-50 TZIC implementation in development chip (continued)

Property	Value
Interrupt output	TZIC output is connected to the development chip CPU nFIQ input.
Release version	Custom implementation of the ARM SP890 TZIC.
Reference documentation	This section.

Table 4-51 summarizes the registers in base offset order.

Table 4-51 TZIC register summary

Name	Offset	Type	Reset value	Description
TZICFIQStatus	0x000	RO	0x00000000	See <i>FIQ status register</i> on page 4-60
TZICRawIntr	0x004	RO	-	See <i>Raw interrupt status register</i> on page 4-60
TZICIntSelect	0x008	R/W	0x00000000	See <i>Interrupt select register</i> on page 4-61
TZICFIQEnable	0x00C	R/W	0x00000000	See <i>FIQ enable register</i> on page 4-61
TZICFIQENClear	0x010	WO	-	See <i>FIQ enable clear register</i> on page 4-61
TZICFIQBypass	0x014	R/W	0x00000000	See <i>FIQ bypass register</i> on page 4-63
TZICProtection	0x018	R/W	0x00000000	See <i>Protection register</i> on page 4-63
TZICLock	0x01C	WO	-	See <i>Lock enable register</i> on page 4-64
TZICLockStatus	0x020	RO	0x00000001	See <i>Lock status register</i> on page 4-64
Test registers	0x300- 0x310	-	-	Reserved. Do not use.
TZICPeriphID0	0xFE0	RO	0x00000090	See <i>Peripheral identification registers TZICPeriphIDx</i> on page 4-65
TZICPeriphID1	0xFE4	RO	0x00000018	
TZICPeriphID2	0xFE8	RO	0x00000004	
TZICPeriphID3	0xFEC	RO	0x00000000	

Table 4-51 TZIC register summary (continued)

Name	Offset	Type	Reset value	Description
TZICPCellID0	0xFF0	RO	0x0000000D	See <i>TZICPCellID0 Register</i> on page 4-68
TZICPCellID1	0xFF4	RO	0x000000F0	
TZICPCellID2	0xFF8	RO	0x00000005	
TZICPCellID3	0xFFC	RO	0x000000B1	

FIQ status register

The read-only TZICFIQStatus Register has a reset value of 0x00000000. It provides the status of the interrupts after FIQ masking. Table 4-52 lists the register bit assignments.

Table 4-52 TZICFIQStatus Register bit assignments

Bits	Name	Function
[31:0]	FIQStatus	Shows the status of the interrupts after masking by the TZICFIQIntEnable and TZICFIQIntEnClear Registers. A HIGH bit indicates that the interrupt is active, and generates an nFIQ interrupt to the processor.

Raw interrupt status register

The read-only TZICRawIntr Register provides the status of the source interrupts, and software interrupts, to the interrupt controller. Table 4-53 lists the register bit assignments.

Table 4-53 TZICRawIntr Register bit assignments

Bits	Name	Function
[31:0]	RawIntr	Shows the status of the interrupts before masking by the TZICFIQIntEnable and TZICFIQIntEnClear Registers. A HIGH bit indicates that the interrupt is active before masking.

Interrupt select register

The read-write TZICIntSelect Register has a reset value of 0x00000000. It selects whether you can use the corresponding input source to generate a FIQ interrupt or whether it passes through to **TZICIRQOUT**. Table 4-54 lists the register bit assignments.

Table 4-54 TZICIntSelect Register bit assignments

Bits	Name	Function
[31:0]	IntSelect	<p>Selects whether the interrupt source generates an FIQ interrupt or passes straight through to TZICIRQOUT.</p> <p>0 = interrupt passes through to TZICIRQOUT</p> <p>1 = interrupt is available for FIQ generation.</p>

FIQ enable register

The read/write TZICFIQEnable Register has a reset value of 0x00000000. It enables the corresponding FIQ-selected input source. This interrupt source can then generate an FIQ interrupt. Table 4-55 lists the register bit assignments.

Table 4-55 TZICFIQEnable Register bit assignments

Bits	Name	Function
[31:0]	FIQEnable	<p>Enables the FIQ-selected interrupt lines, allowing the interrupts to reach the processor. Read:</p> <p>0 = interrupt disabled</p> <p>1 = interrupt enabled.</p> <p>You can only enable the interrupt using this register. You must use the TZICFIQEnClear Register to disable the interrupt enable.</p> <p>Write:</p> <p>0 = no effect</p> <p>1 = interrupt enabled.</p> <p>Resetting disables all interrupts. There is 1 bit of the register for each interrupt source.</p>

FIQ enable clear register

The write-only TZICFIQEnClear Register clears bits in the TZICFIQEnable Register. See *FIQ enable register*. Table 4-56 on page 4-62 lists the register bit assignments.

Table 4-56 TZICFIQEnClear Register bit assignments

Bits	Name	Function
[31:0]	FIQEnClear	Clears bits in the TZICFIQEnable Register. Writing a HIGH clears the corresponding bit in the TZICFIQEnable Register. Writing a LOW has no effect.

FIQ bypass register

The read/write TZICFIQBypass Register has a reset value of 0x00000000. It enables **nNSFIQIN** to be routed directly to nFIQ. By doing this, it bypasses all internal TZIC logic.

Figure 4-14 shows the register bit assignments.

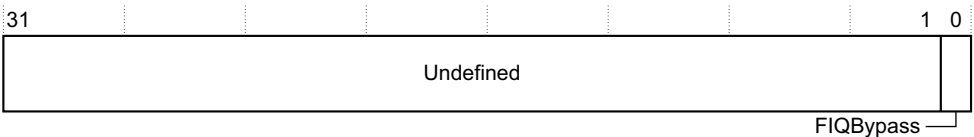


Figure 4-14 TZICFIQBypass Register bit assignments

Table 4-57 lists the register bit assignments.

Table 4-57 TZICFIQBypass Register bit assignments

Bits	Name	Function
[31:1]	-	Read undefined. Write as zero.
[0]	FIQBypass	Enables nNSFIQIN to route directly to nFIQ. 0=No Bypass 1=Bypass.

Protection register

The read/write TZICProtection Register has a reset value of 0x00000000. It enables or disables protected register access, stopping register accesses when the processor is in user-mode.

Figure 4-15 shows the register bit assignments.

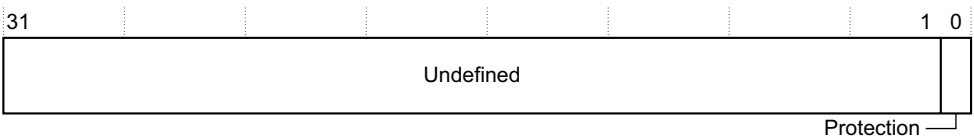


Figure 4-15 TZICProtection Register bit assignments

Table 4-58 lists the register bit assignments.

Table 4-58 TZICProtection Register bit assignments

Bits	Name	Function
[31:1]	-	Read undefined. Write as zero.
[0]	Protection	Enables or disables protected register access: 0 = protection mode disabled 1 = protection mode enabled. When enabled, you can only make privileged mode accesses (reads and writes) to the TZIC. You can only access this register in privileged mode, even when protection mode is disabled.

Lock enable register

The write-only TZICLock Register enables or disables all other register write access. You must write the access code to this register before you can modify any other register. To disable access, you must write any other value to the register. The register protects the TZIC from spurious writes. The Lock bit in the TZICLockStatus Register indicates the status of the lock. See *FIQ status register* on page 4-60. Table 4-59 lists the register bit assignments.

Table 4-59 TZICLock Register bit assignments

Bits	Name	Function
[31:0]	Lock	To enable access to the other registers in the TZIC, you must write the correct access code of 0x0ACCE550 to this register. To disable access to the other TZIC registers, you must write any other value than 0x0ACCE550 to this register.

Lock status register

The read-only TZICLockStatus Register provides the lock status of the TZIC registers.

Figure 4-16 shows the register bit assignments.

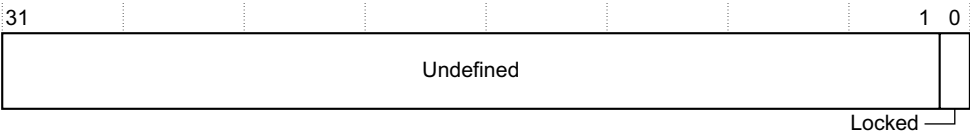


Figure 4-16 TZICLockStatus Register bit assignments

Table 4-60 lists the register bit assignments.

Table 4-60 TZICLockStatus Register bit assignments

Bits	Name	Function
[31:1]	-	Read undefined.
[0]	Locked	Shows the locked status of the TZIC: 0 = Access to the TZIC is not locked 1 = Access to the TZIC is locked (reset). You can unlock the access using the TZICLock Register.

Peripheral identification registers *TZICPeriphIDx*

The read-only TZICPeriphID0-3 Registers are four 8-bit registers that span address locations 0xFE0 to 0xFEC. You can treat the registers conceptually as a single 32-bit register.

Figure 4-17 shows the register bit assignments of the TZICPeriphID0-3 registers.

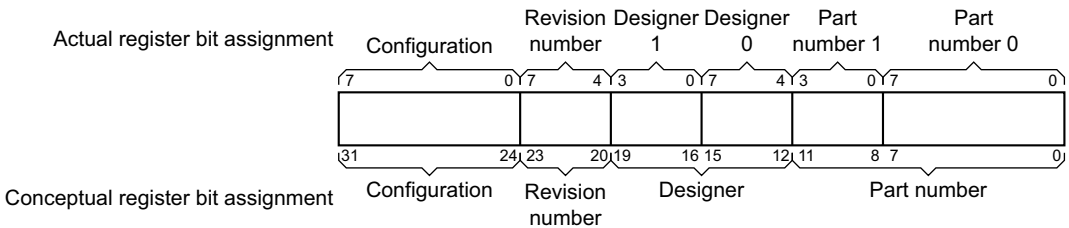


Figure 4-17 TZICPeriphID0-3 registers bit assignments

Table 4-61 lists the peripheral identification registers bit assignments.

Table 4-61 TZICPeriphID0-3 Register bit assignments

Bits	Name	Function
[31:24]	Configuration	Configuration option of the peripheral. The configuration value is 0.
[23:20]	Revision number	Revision number of the peripheral. The revision number starts from 0, and the value is revision independent.
[19:12]	Designer	Identification of the designer. ARM Limited is 0x41 (ASCII A).
[11:0]	Part number	Identification of the peripheral. Use the three-digit product code 0x890 for TZIC.

The read-only TZICPeriphID0 Register is hard-coded and the register fields register determine the reset value.

Figure 4-18 shows the register bit assignments.

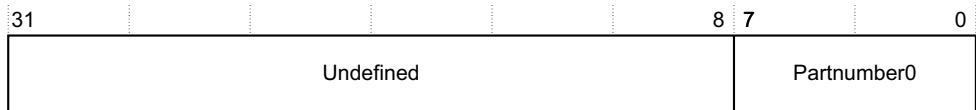


Figure 4-18 TZICPeriphIDO Register bit assignments

Table 4-62 lists the register bit assignments.

Table 4-62 TZICPeriphID0 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:0]	Partnumber0	These bits read back as 0x90

See also:

- *TZICPeriphD1 Register*
- *TZICPeriphD2 Register* on page 4-67
- *TZICPeriphD3 Register* on page 4-67.

TZICPeriphID1 Register

The read-only TZICPeriphID1 Register is hard-coded and the fields within the register determine the reset value.

Figure 4-19 shows the register bit assignments.

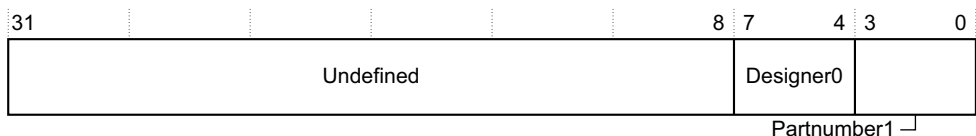


Figure 4-19 TZICPeriphID1 Register bit assignments

Table 4-63 lists the register bit assignments.

Table 4-63 TZICPeriphID1 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:4]	Designer0	These bits read back as 0x1
[3:0]	Partnumber1	These bits read back as 0x8

TZICPeriphID2 Register

The read-only TZICPeriphID2 Register is hard-coded and the fields within the register determine the reset value.

Figure 4-20 shows the register bit assignments.

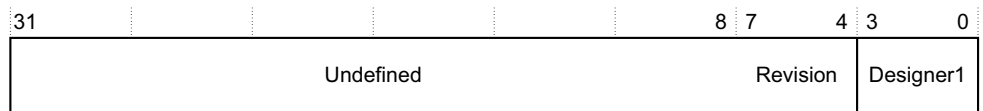


Figure 4-20 TZICPeriphID2 Register bit assignments

Table 4-64 lists the register bit assignments.

Table 4-64 TZICPeriphID2 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:4]	Revision	These bits read back as the revision number and can be between 0 and 15
[3:0]	Designer1	These bits read back as 0x4

TZICPeriphID3 Register

The read-only TZICPeriphID3 Register is hard-coded and the fields within the register determine the reset value.

Figure 4-21 on page 4-68 shows the register bit assignments.

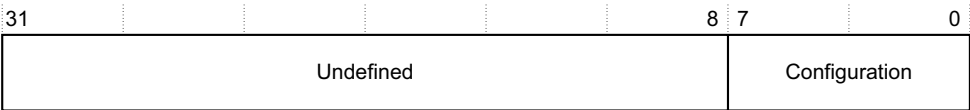


Figure 4-21 TZICPeriphID3 Register bit assignments

Table 4-65 lists the register bit assignments.

Table 4-65 TZICPeriphID3 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:0]	Configuration	These bits read back as 0x00

TZICPCellID0 Register

The read-only TZICPCellID0-3 registers are four 8-bit registers that span address locations 0xFF0 to 0xFFC. You can treat the registers conceptually as a single 32-bit register. This register acts as a standard cross-peripheral identification system. Figure 4-22 shows the register bit assignments.

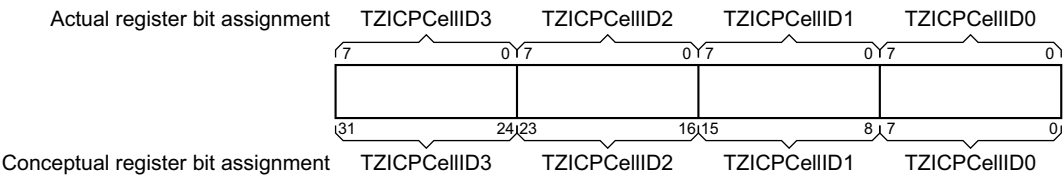


Figure 4-22 TZICPCellID0-3 Registers bit assignments

The read-only TZICPCellID0 Register is hard-coded and the fields within the register determine the reset value. Table 4-66 lists the register bit assignments.

Table 4-66 TZICPCellID0 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:0]	TZICPCellID0	These bits read back as 0x00

See also:

- *TZICPCellID1 Register*
- *TZICPCellID2 Register*
- *TZICPCellID3 Register*.

TZICPCellID1 Register

The read-only TZICPCellID1 Register is hard-coded and the fields within the register determine the reset value. Table 4-67 lists the register bit assignments.

Table 4-67 TZICPCellID1 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:0]	TZICPCellID1	These bits read back as 0xF0

TZICPCellID2 Register

The read-only TZICPCellID2 Register is hard-coded and the fields within the register determine the reset value. Table 4-68 lists the register bit assignments.

Table 4-68 TZICPCellID2 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:0]	TZICPCellID2	These bits read back as 0x05

TZICPCellID3 Register

The read-only TZICPCellID3 Register is hard-coded and the fields within the register determine the reset value. Table 4-69 lists the register bit assignments.

Table 4-69 TZICPCellID3 Register bit assignments

Bits	Name	Function
[31:8]	-	Read undefined
[7:0]	TZICPCellID3	These bits read back as 0xB1

4.11.2 Development chip GIC

There is one GIC in the development chip. Table 4-70 lists the details for the GIC in the development chip.

Table 4-70 GIC implementation in development chip

Property	Value
Location	ARM1176JZF-S development chip
Memory base addresses	0x10120000 (GIC CPU interface) 0x10121000 (GIC distribution interface)
Interrupt inputs	See Table 4-71 on page 4-72.
Interrupt output	Development chip GIC nIRQ output is connected to the development chip CPU nIRQ input <div>Note</div> The development chip TZIC nFIQ output is connected to the development chip CPU nFIQ input.
Release version	Pre-release implementation of the ARM PL390 GIC.
Reference documentation	For more information on the GIC registers, see <i>GIC Distribution register</i> on page 4-77, <i>GIC CPU Interface</i> on page 4-100, and <i>GIC reserved register addresses</i> on page 4-105.

4.11.3 Development chip interrupt signals

In the development chip, Secure interrupt sources can be routed to the **nFIQ** input on the core, and non-secure sources can be routed to the **nIRQ** input on the core. To enable the routing, a TZIC is implemented to control routing to the TZIC or non-secure-IC logic as appropriate for the application.

All interrupt sources, on-chip and off-chip, are routed to the TZIC, enabling an entirely dynamic interrupt configuration to be defined as part of the secure boot process. It is the responsibility of the end user to ensure that a secure interrupt is generated only by a securely decoded peripheral in a secure system design.

By default, the majority of PB1176JZF-S interrupts trigger **nIRQ** events through the GIC chain. However, in a TrustZone aware system implementation, the **nFIQ** can be considered a security interrupt, and consequently very flexible interrupt handling is available.

The TZIC on the ARM1176JZF-S development chip is capable of overriding designated interrupt source(s) from reaching the GIC, and generating an **nFIQ** instead of the **nIRQ** for the overridden interrupt source.

When an interrupt, either **nIRQ** or **nFIQ**, occurs in a TrustZone aware software system, it is handled in one of three vector tables:

- one is associated with the Normal World exception vector usage
- one is associated with the Secure World exception vector usage
- one is associated with the Secure World Monitor Mode exception vector usage.

To a non-TrustZone aware software system, this handling defaults to the previous ARM exception handling setup and capabilities.

A CP15 security control register can designate whether a given **nFIQ** or **nIRQ** is handled in the current operating world, or causes the exception to be handled by the Monitor Mode exception table. This enables Monitor Mode code to control routing of **nFIQ** and **nIRQ** to the correct operating World, either Secure or Normal.

Normally you use **nFIQ** as the Secure interrupt, because it is possible for the Secure World to block masking of the **nFIQ** by the Normal World. The Secure World cannot do the same for the **nIRQ**.

———— Note ————

This routing is under software control, a system might choose to deploy the **nFIQ** for its own purposes, rather than as a secure world interrupt.

Examples of interrupt handling are:

An interrupt occurs while the core is in the correct world.

- **nIRQ** or **nFIQ** occurs while core is running in World A
- **nIRQ** or **nFIQ** is designated for handling by World A
- Exception vectors through that World A exception table
- World A ISR handles interrupt.

An interrupt occurs while the core is in the wrong world.

- **nIRQ** or **nFIQ** occurs while core is running in World A
- **nIRQ** or **nFIQ** is designated for handling by World B
- Exception uses the Monitor mode exception table
- Monitor Mode code transfers state information so core can start safely in world B
- Monitor code returns to execution in World B
- Exception vectors through that World B exception table
- World B ISR handles interrupt.

The interrupt map for the development chip interrupt controllers is shown in Table 4-71.

Table 4-71 Interrupt signals to development chip interrupt controllers

Interrupt	GIC source	TZIC source	Description
EXT INT SOURCE[8]	63	31	FPGA GIC0 (FPGA nIRQ)
EXT INT SOURCE[7]	62	30	FPGA GIC1 (FPGA nFIQ)
EXT INT SOURCE[6]	61	29	FPGA Reserved
EXT INT SOURCE[5]	60	28	FPGA Reserved
EXT INT SOURCE[4]	59	27	FPGA Reserved
EXT INT SOURCE[3]	58	26	Logic Tile Z198
EXT INT SOURCE[2]	57	25	Logic Tile Z197
EXT INT SOURCE[1]	56	24	Logic Tile Z196
EXT INT SOURCE[0]	55	23	Logic Tile Z195
CS_IRQ	54	22	-
UART_3	53	21	UARTs
UART_2	52	20	
UART_1	51	19	
UART_0	50	18	
SSP	49	17	Synchronous Serial Port
GPIO0	48	16	GPIO
CLCDC	47	15	Color LCD Controller
RTC	46	14	Real Time Clock
L2CC	45	13	Level 2 Cache Controller
IEC	44	12	Intelligent Energy management Controller
APC	43	11	-

Table 4-71 Interrupt signals to development chip interrupt controllers (continued)

Interrupt	GIC source	TZIC source	Description
Timers_4/5	42	10	Timers
Timers_2/3	41	9	
Timers_0/1	40	8	
Core PMU IRQ	39	7	-
Reserved	38	6	-
Reserved	37	5	-
Reserved	36	4	-
Comms TX	35	3	Debug interrupts
Comms RX	34	2	
Software interrupt	33	1	-
Watchdog	32	0	-
Reserved	0-31	-	Reserved for use by processor

4.12 Interrupt controllers in the FPGA

There are two GICs in the FPGA. Table 4-72 lists the details of the GICs in the FPGA.

Table 4-72 GIC implementation in FPGA

Property	Value
Location	FPGA
Memory base addresses	GIC0 CPU interface 0x10040000 GIC0 Distributor 0x10041000 GIC1 CPU interface 0x10050000 GIC1 Distributor 0x10051000
Interrupt inputs	See Table 4-73 on page 4-75.
Interrupt output	GIC0 nIRQ to input 31 and GIC1 nFIQ to input 30 of the TZIC on the development chip
Release version	Pre-release implementation of the ARM PL390 GIC
Reference documentation	<i>See FPGA interrupt signals and Development chip interrupt signals</i> on page 4-70 The GICs in the FPGA are the same as the GICs in the development chip except that the development chip GIC has 64 interrupt sources and the FPGA GICs have 32 interrupt sources. A summary of the registers in the FPGA GICs is provided in Table 4-74 on page 4-77. For more information on the GIC registers, see <i>GIC Distribution register</i> on page 4-77, <i>GIC CPU Interface</i> on page 4-100, and <i>GIC reserved register addresses</i> on page 4-105.

See the following sections for more information on the interrupt signals and the GIC controllers:

- *FPGA interrupt signals*
- *GIC Distribution register* on page 4-77
- *GIC CPU Interface* on page 4-100
- *GIC reserved register addresses* on page 4-105.

4.12.1 FPGA interrupt signals

The bit assignments for the two GIC interrupt controllers in the FPGA are listed in Table 4-73 on page 4-75. Each bit corresponds to an interrupt source. Use the bit to enable or disable the interrupt or to check the interrupt status.

Note

The primary and secondary interrupt controllers in the FPGA (GIC0 and GIC1) share interrupt inputs, but the interrupt outputs are routed differently:

- GIC0 generates an **nIRQ** which corresponds to development chip EXT INT SOURCE[8] and TZIC Source 31.
 - GIC1 generates an **nFIQ** which corresponds to development chip EXT INT SOURCE[7] and TZIC Source 30.
-

Table 4-73 Interrupt signals to FPGA primary and secondary GICs

Interrupt	Interrupt source	Description
63	Reserved	Logic Tile
62	Reserved	Logic Tile
61	Reserved	FPGA
60	Reserved	FPGA
59	Reserved	FPGA
58	Reserved	FPGA
57	RTC	Real Time Clock
56	Reserved	FPGA
55	Reserved	FPGA
54	Reserved	FPGA
53	Reserved	FPGA
52	DoC IRQ (Reserved)	FPGA
51	AACI	Audio CODEC controller
50	Reserved	FPGA
49	Reserved	FPGA

Table 4-73 Interrupt signals to FPGA primary and secondary GICs (continued)

Interrupt	Interrupt source	Description
48	PISMO	Reserved for memory expansion. (Not driven by standard static memory expansion board.)
47	PCI3	Interrupt 3 triggered from external PCI bus
46	PCI2	Interrupt 2 triggered from external PCI bus
45	PCI1	Interrupt 1 triggered from external PCI bus
44	PCI0	Interrupt 0 triggered from external PCI bus
43	USB	USB controller
42	ETHERNET	Ethernet controller
41	GPIO2	GPIO controller
40	GPIO1	GPIO controller
39	Character LCD	Character LCD
38	UART4	UART in FPGA
37	SCI	Smart Card Interface
36	KMI1	Activity on mouse port
35	KMI0	Activity on keyboard port
34	Reserved	Unused. This was MCI[1] on the Emulation Baseboard
33	MCI	Multimedia Card Interface
32	Reserved	FPGA

4.12.2 GIC Distribution register

This section describes the GIC Distributor registers:

- *Summary of GIC Distribution registers*
- *Distributor Register Control Register* on page 4-78
- *Interrupt Controller Type Register* on page 4-79
- *Interrupt Set-Enable Registers* on page 4-80
- *Interrupt Clear-Enable Registers* on page 4-81
- *Interrupt Set-Pending Registers* on page 4-83
- *Interrupt Clear-Pending Registers* on page 4-84
- *Active Bit Registers* on page 4-86
- *Interrupt Priority Registers* on page 4-86
- *Interrupt CPU Target Registers* on page 4-90
- *Interrupt Configuration Registers* on page 4-93
- *Software Interrupt Register* on page 4-99.

See *Interrupt controllers* on page 3-19 for a description of interrupt signal routing.

Note

The GIC in the development chip has 64 interrupt source inputs, but interrupts 0–31 are reserved for use by the processor.

The GICs in the FPGA each have only 32 interrupt source inputs (32–64). Interrupt inputs 0–31 are not used. The interrupt inputs are shared by both FPGA GICs.

Summary of GIC Distribution registers

Table 4-74 lists the Distribution registers in the FPGA GICs.

Table 4-74 FPGA Register summary

Register name	Base offset	Type	Width	Reset	Description
IrqControllerType	0x004	Read/Write	8	00000001	Interrupt controller type register
IrqEnSet0	0x100	Read/Write	32	0000FFFF	Irq 0 to 31 set-enable register (reserved)
IrqEnSet1	0x104	Read/Write	32	00000000	Irq 32 to 63 set-enable register
IrqEnClr0	0x180	Read/Write	32	0000FFFF	Irq 0 to 31 clear-enable register (reserved)
IrqEnClr1	0x184	Read/Write	32	00000000	Irq 32 to 63 clear-enable register
IrqPenSet0	0x200	Read/Write	32	00000000	Irq 0 to 31 set-pending register (reserved)

Table 4-74 FPGA Register summary (continued)

Register name	Base offset	Type	Width	Reset	Description
IrqPenSet1	0x204	Read/Write	32	00000000	Irq 32 to 63 set-pending register
IrqPenClr0	0x280	Read/Write	32	00000000	Irq 0 to 31 clear-pending register (reserved)
IrqPenClr1	0x284	Read/Write	32	00000000	Irq 32 to 63 clear-pending register
IrqActiveBit0	0x300	Read Only	32	00000000	Irq 0 to 31 active bit register (reserved)
IrqActiveBit1	0x304	Read Only	32	00000000	Irq 32 to 63 active bit register
IrqPriority0	0x400	Read/Write	16	00000000	Irq 0 to 3 priority register (reserved)
IrqPriority1	0x404	Read/Write	16	00000000	Irq 4 to 7 priority register (reserved)
IrqPriority2	0x408	Read/Write	16	00000000	Irq 8 to 11 priority register (reserved)
IrqPriority3	0x40C	Read/Write	16	00000000	Irq 12 to 15 priority register (reserved)
IrqPriority4	0x410	Read Only	16	00000000	Irq 16 to 19 priority register (reserved)
IrqPriority5	0x414	Read Only	16	00000000	Irq 20 to 23 priority register (reserved)
IrqPriority6	0x418	Read Only	16	00000000	Irq 24 to 27 priority register (reserved)
IrqPriority7	0x41C	Read Only	16	00000000	Irq 28 to 31 priority register (reserved)
IrqPriority8	0x420	Read/Write	16	00000000	Irq 32 to 35 priority register
IrqPriority9	0x424	Read/Write	16	00000000	Irq 36 to 39 priority register
IrqPriority10	0x428	Read/Write	16	00000000	Irq 40 to 43 priority register
IrqPriority11	0x42C	Read/Write	16	00000000	Irq 44 to 47 priority register

Distributor Register Control Register

Figure 4-23 shows the bit assignments for this register.

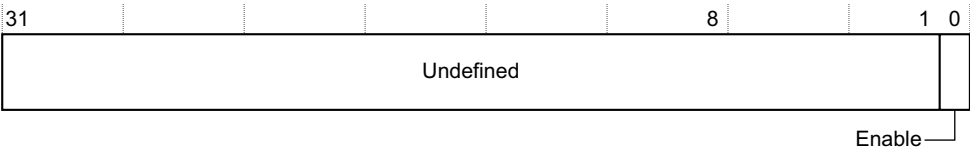


Figure 4-23 Distributor Register Control Register bit assignments

Table 4-75 lists the bit assignments for the register at offset 0x000.

Table 4-75 Distributor Register Control Register bit assignments

Bits	Name	Type	Function
[31:1]	-	Read/Write	Undefined, SBZ.
[0]	Enable	Read/Write	Distributor enable. If this bit is 0, no interrupts are sent out of the distributor. Disabling the distributor while there are pending interrupts might give rise to spurious interrupts as a result of the inherent timing race between the disabling of the interrupt and the CPU response to pending interrupts.

Interrupt Controller Type Register

Figure 4-24 shows the bit assignments for this register.

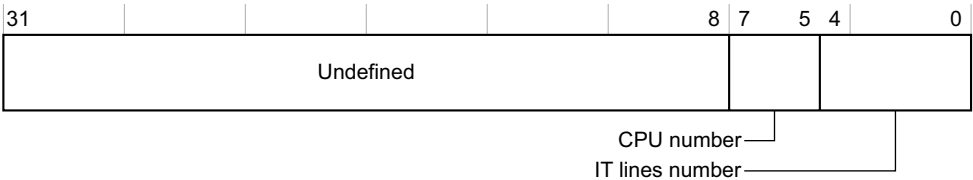


Figure 4-24 Interrupt Controller Type Register bit assignments

Table 4-76 lists the bit assignments for the register at offset 0x004.

Table 4-76 Interrupt Controller Type Register bit assignments

Bits	Name	Type	Function
[31:8]		Read/Write	Undefined, SBZ
[7:5]	CPU number	Read/Write	CPU number encoding for the ARM1176 development chip is:000: System contains 1 CPU.
[4:0]	IT lines number	Read/Write	IT lines number encoding for the GIC in the ARM1176 development chip is as follows:00001: 64 interrupts support, 32 interrupt lines support.

You can use the number of IT lines to determine which sets of registers in the Distributor register map are populated. In the ARM1176JZF core, IT lines is hard-coded to 5'b00001, indicating 64 interrupt sources.

The CPU number is encoded as:
000 System contains 1 CPU.

- 001** System contains 2 CPUs.
- 010** System contains 3 CPUs.
- 011** System contains 4 CPUs.
- 0xx** Reserved for future extension.

———— **Note** ————

The CPU number indicates the number of CPUs in the system. The CPU number for the ARM 1176JZF development chip is always 1.

Interrupt Set-Enable Registers

These registers control an enable bit for each interrupt in the interrupt distributor.

The GIC in the development chip supports 64 interrupts:

- 32 software interrupts
- 32 hardware interrupts.

Figure 4-25 shows the bit assignments for Interrupt Set-Enable Register 0.

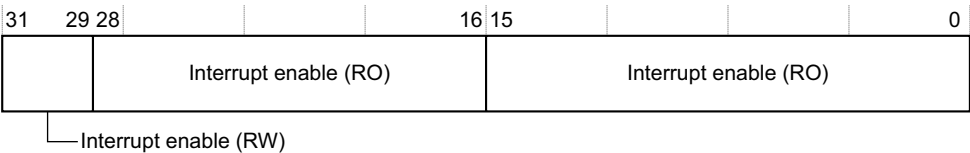


Figure 4-25 Interrupt Set-Enable Register 0 bit assignments

Table 4-77 lists the bit assignments for Interrupt Set-Enable Register 0 at offset 0x100.

Table 4-77 Interrupt Set-Enable Register 0 bit assignments

Bits	Name	Type	Function
[31:29]	Interrupt enable	Read/Write	Bit 31 is for the legacy nIRQ pin. Bit 30 is for a private watchdog in an MPCore system and is not used in this SoC. Bit 29 is for a private timer in an MPCore system and is not used in this SoC.
[28:16]	Interrupt enable	Read Only	Undefined interrupts, read as 0.
[15:0]	Interrupt enable	Read Only	Interrupts 0 to 15 are inter-processor, or reserved for software use. Read as 1.

Figure 4-26 shows the bit assignments for Interrupt Set-Enable Register 1.

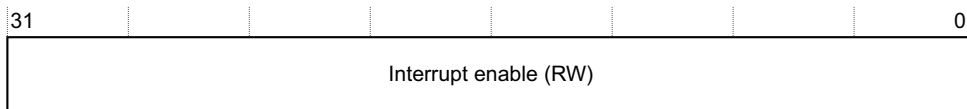


Figure 4-26 Interrupt Set-Enable Register 1 bit assignments

Table 4-78 lists the bit assignments for Interrupt Set-Enable Register 1 at offset 0x104.

Table 4-78 Interrupt Set-Enable Register 1 bit assignments

Bits	Name	Type	Function
[31:0]	Interrupt enable	Read/Write	Writing a 1 sets the interrupt enable bit and so, the interrupt is transmitted to the targeted CPU.

In these registers, writing a 1 sets the corresponding interrupt enable bit, and a read reads back a 1. When this is set, you can only clear it by using the Enable-Clear Register. In other words, writing a 0 to the Set-Enable Register does not write a 0 to the corresponding interrupt enable bit.

The values read in the Set-Enable Registers, for a particular range of interrupts, represent currently enabled interrupts. Non-present interrupts, depending on the Interrupt Number field of the Interrupt Controller Type Register related fields are read as zero, and writing to these fields has no effect.

Interrupt Clear-Enable Registers

These registers control an enable bit for each interrupt in the interrupt distributor. There can be up to eight Clear-Enable registers. Because the GIC in the ARM1176JZF Development Chip only supports 64 interrupts, it has two such registers and the rest are unused.

Figure 4-27 shows the bit assignments for this register.

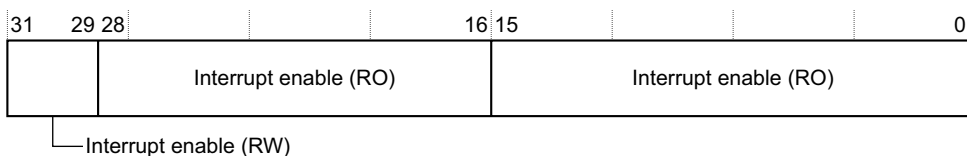


Figure 4-27 Interrupt Clear-Enable Register 0 bit assignments

Table 4-79 lists the bit assignments for the register at offset 0x180.

Table 4-79 Interrupt Clear-Enable Register 0 bit assignments

Bits	Name	Type	Function
[31:29]	Interrupt enable	Read/Write	Writing a 1 clears the interrupt enable bit and it reads a 0. Bit 31 is for the legacy nIRQ pin. Bit 30 is for a private watchdog in an MPCore system and is not used in this SoC. Bit 29 is for a private timer in an MPCore system and is not used in this SoC.
[28:16]	Interrupt enable	Read Only	Undefined interrupts, read as 0.
[15:0]	Interrupt enable	Read Only	Interrupts 0 to 15 are inter-processor or reserved for software use. Read as 0.

Figure 4-28 shows the bit assignments for Interrupt Clear-Enable Register 1.

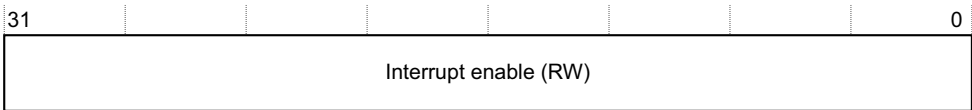


Figure 4-28 Interrupt Clear-Enable Register 1 bit assignments

Table 4-80 lists the bit assignments for the Interrupt Clear-Enable Register 1 at offset 0x184.

Table 4-80 Interrupt Clear-Enable Register 1 bit assignments

Bits	Name	Type	Function
[31:0]	Interrupt enable	Read/Write	Writing a 1 clears the interrupt enable bit and it reads a 0.

Writing a 1 clears the corresponding interrupt enable bit and a read reads back a 0. When cleared, you can only set this bit by using the Set-Enable Register. In other words, writing a 1 to the Clear-Enable Register does not write a 1 to the corresponding interrupt enable bit.

The values read in the Clear-Enable Registers, for a particular range of interrupts, represent currently enabled interrupts. Non-present interrupts, depending on the Interrupt number field of the Interrupt Controller Type Register, related fields are read as zero and writing to these fields has no effect.

Interrupt Set-Pending Registers

These registers indicate the interrupts that are currently in pending state, bit read as 1, or to force some interrupts to enter pending state by overriding event detection on interrupt lines. Each set register is used for 32 interrupts therefore, the ARM1176 development chip uses two such registers.

Figure 4-41 on page 4-96 shows the bit assignments for Interrupt Set-Pending Register 0.

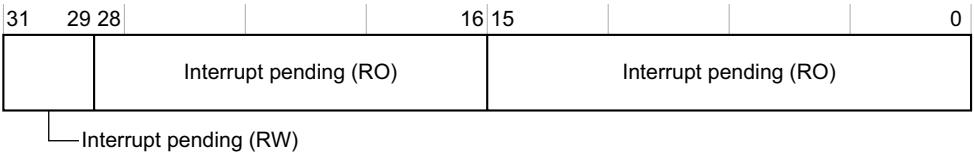


Figure 4-29 Interrupt Set-Pending Register 0 bit assignments

Table 4-81 lists the bit assignments for the Interrupt Set-Pending Register 0 at offset 0x200.

Table 4-81 Interrupt Set-Pending Register 0 bit assignments

Bits	Name	Type	Function
[31:29]	Interrupt pending	Read/Write	Writing 1 sets the interrupt pending bit and the corresponding interrupt enters pending state. Bit 31 is for the legacy nIRQ pin. Bit 30 is for private watchdog in an MPCore system and is not used in this SoC. Bit 29 is for private timer in an MPCore system and is not used in this SoC.
[28:16]	Interrupt pending	Read Only	Undefined interrupts, read as 0.
[15:0]	Interrupt pending	Read Only	Writing to IT0 to IT15 has not effect. Only the Software Interrupt Register can trigger these interrupts.

Figure 4-30 shows the bit assignments for Interrupt Set-Pending Register 1.

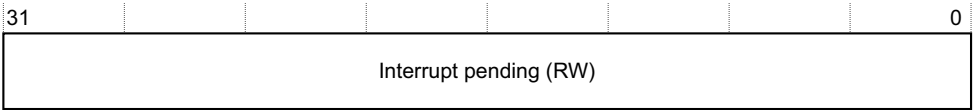


Figure 4-30 Interrupt Set-Pending Register 1 bit assignments

Table 4-82 lists the bit assignments for Interrupt Set-Pending Register 1 at offset 0x204.

Table 4-82 Interrupt Set-Pending Register 1 bit assignments

Bits	Name	Type	Function
[31:0]	Interrupt pending	Read/Write	Writing 1 sets the interrupt pending bit and the corresponding interrupt enters pending state

Note

- You can only perform reads and writes by enabling the distributor through the distributor control register. described in *Distributor Register Control Register* on page 4-78.
- For read status, you must set interrupt targets in the CPU targets registers, corresponding to hardware IRQs 32-63.

Writing a 1 to a bit through the Set-Pending Register means that the corresponding interrupt enters pending state. Writing a 1 sets the corresponding interrupt pending bit and a read reads back a 1. When set, you can only clear this bit using the Clear-Pending Register. Writing a 0 to the Set-Pending Register does not write a 0 to the corresponding interrupt pending bit.

Note

All RESERVED interrupts, spurious interrupts, and non-present interrupts, depending on the Interrupt Number field of the Interrupt Controller Type Register, and related fields are read as zero and writing to these fields has no effect.

The values read in the Set-Pending and Clear-Pending registers for the same interrupts range are the same. They both represent current pending interrupts. If a bit is read as 1, it implies that the interrupt is pending for at least one CPU.

Interrupt Clear-Pending Registers

These registers either determine that the registers that are currently in pending state and the bit is read as 1, or they force pending interrupts to return to the inactive state. Each set register is used for 32 interrupts. The ARM1176 Development Chip uses two such registers. The remaining ones are unused.

Figure 4-31 on page 4-85 shows the bit assignments for Interrupt Clear-Pending Register 0.

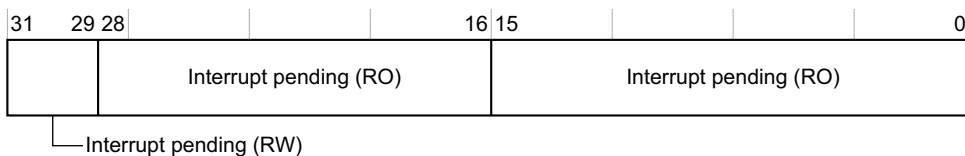
**Figure 4-31 Interrupt Clear-Pending Register 0 bit assignments**

Table 4-83 lists the bit assignments for Interrupt Clear-Pending Register 0 at offset 0x280.

Table 4-83 Interrupt Clear-Pending Register 0 bit assignments

Bits	Name	Type	Function
[31:29]	Interrupt pending	Read/Write	Writing a 1 clears the interrupt enable bit and the corresponding interrupt enters pending state. A read returns a 0. Bit 31 is for the legacy nIRQ pin. Bit 30 is for private watchdog in an MPCore system and is not used in this SoC. Bit 29 is for private timer in an MPCore system and is not used in this SoC.
[28:16]	Interrupt pending	Read Only	Undefined interrupts, read as 0.
[15:0]	Interrupt pending	Read Only	Writing to bits corresponding to IT0 to IT15 has no effect. Only the Software Interrupt Register can trigger these interrupts.

Figure 4-32 shows the bit assignments for Interrupt Clear-Pending Register 1.

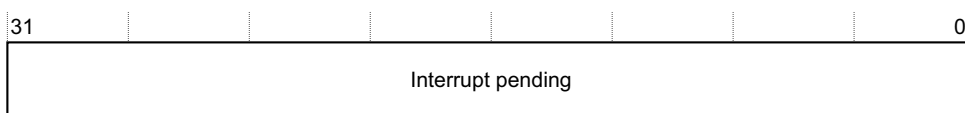
**Figure 4-32 Interrupt Clear-Pending Register 1 bit assignments**

Table 4-84 lists the bit assignments for Interrupt Clear-Pending Register 1 at offset 0x284.

Table 4-84 Interrupt Clear-Pending Register 1 bit assignments

Bits	Name	Type	Function
[31:0]	Interrupt pending	Read/Write	Writing a 1 clears the interrupt enable bit and the corresponding interrupt enters pending state. A read returns a 0.

Writing a 1 clears the corresponding interrupt pending bit and a read reads back a 0. When cleared, you can only set this bit by using the Enable-Set Register. In other words, writing a 1 to the Enable-Clear Register does not write a 1 to the corresponding interrupt enable bit.

Note

All RESERVED interrupts, spurious interrupts, and non-present interrupts, depending on the Interrupt number field of the Interrupt Controller Type Register, and related fields are read as zero and writing to these fields has no effect.

The values read in the Pending-Set and Pending-Clear registers for the same interrupts range are the same, and represent current pending interrupts. If a bit is read as 1, it implies that the interrupt is pending.

Active Bit Registers

The Active Bit Register enables the software to find out the interrupts that are currently active, bit read as 1. They are read-only registers and writes to these registers are ignored. Because each register only handles 32 interrupts, there are two such registers in the chip.

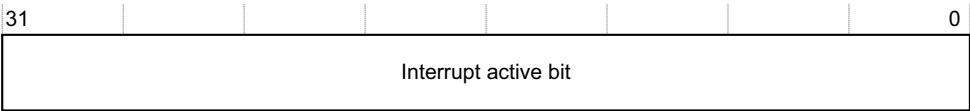


Figure 4-33 Active Bit Register 0 and 1 bit assignments

Table 4-85 lists the bit assignments for the registers at offset 0x200–0x304.

Table 4-85 Active Bit Register 0 and 1 bit assignments

Bits	Name	Type	Function
[31:0]	Interrupt active bit	Read Only	Bit reads as 1: Corresponding interrupt is active Bit reads as 0: Corresponding interrupt is inactive

Interrupt Priority Registers

These registers store the individual interrupt priority and 16 levels of priority are supported.

Because each register sets the priority of four interrupts, there are 16 such registers in the ARM1176 Development Chip. You can set the priority for each interrupt by writing a value between 0x0-0xF to the corresponding bits for the interrupts in the registers described in this section. An interrupt with priority 0x0 has the highest priority, and an interrupt with priority 0xF is the lowest priority.

———— **Note** —————

You must never set the priority for an interrupt equal to the Priority Mask Register under normal operation. This is because the CPU interface does a strict comparison between the pending interrupt priority and the priority mask set in the Priority Mask Register. See *GIC reserved register addresses* on page 4-105. Because of this, if the priority mask is set to 0xF, interrupts of priority 0xF are not executed.

For interrupts with equal priority, the interrupt with the lowest ID is handled first, the interrupt with the second lowest ID is handled second, and the interrupt with the third lowest ID is handled third. If the two interrupts have the same ID, this can be the case for software interrupts, the lowest CPU source ID is executed first.

Figure 4-34 shows the bit assignments for Interrupt Priority Register 0-3.

31	28	27	24	23	20	19	16	15	12	11	8	7	4	3	0
Priority N+3				SBZ				Priority N+1				Priority N			

Figure 4-34 Interrupt Priority Register 0-3 bit assignments

Table 4-86 lists the bit assignments for Interrupt Priority Register 0-3 at offset 0x400–0x40C.

Table 4-86 Interrupt Priority Register 0-3 bit assignments

Bits	Name	Type	Function
[31:28]	Priority N+3	Read/Write	Interrupt priority
[27:24]	SBZ		
[23:20]	Priority N+2		
[19:16]	SBZ		
[15:12]	Priority N+1		
[11:8]	SBZ		
[7:4]	Priority N		
[3:0]	SBZ		

Figure 4-35 shows the bit assignments for the Interrupt Priority Register 4-6 registers.

31	28	27	24	23	20	19	16	15	12	11	8	7	4	3	0
Priority N+3		SBZ		Priority N+2		SBZ		Priority N+1		SBZ		Priority N		SBZ	

Figure 4-35 Interrupt Priority Register 4-6 bit assignments

Table 4-87 lists the bit assignments for the Interrupt Priority Register 4-6 registers at offset 0x410–0x418.

Table 4-87 Interrupt Priority Register 4-6 bit assignments

Bits	Name	Type	Function
[31:28]	Priority N+3	Read Only	Interrupt priority
[27:24]	SBZ		
[23:20]	Priority N+2		
[19:16]	SBZ		
[15:12]	Priority N+1		
[11:8]	SBZ	Read Only	Interrupt priority
[7:4]	Priority N		
[3:0]	SBZ		

Figure 4-36 shows the bit assignments for the Interrupt Priority Register 7-15 registers.

31	28	27	24	23	20	19	16	15	12	11	8	7	4	3	0
Priority N+3		SBZ		Priority N+2		SBZ		Priority N+1		SBZ		Priority N		SBZ	

Figure 4-36 Interrupt Priority Register 7-15 bit assignments

Table 4-88 lists the bit assignments for the Interrupt Priority Register 7-15 registers at offset 0x41C–0x43C.

Table 4-88 Interrupt Priority 7-15 Register bit assignments

Bits	Name	Type	Function
[31:28]	Priority N+3	Read/Write	Interrupt priority
[27:24]	SBZ		
[23:20]	Priority N+2		
[19:16]	SBZ		
[15:12]	Priority N+1		
[11:8]	SBZ		
[7:4]	Priority N		
[3:0]	SBZ		

Interrupt CPU Target Registers

These registers store the list of CPUs that each interrupt is sent to if the event defined by the Interrupt Controller Type Register occurs. Each bit in the Interrupt CPU Targets Register refers to one CPU. For the ARM1176JZF Development Chip, only one core is relevant. These registers are ignored in the case of software triggered interrupts.

This section describes the format of interrupt Interrupt CPU Targets Registers. Because each register is used for four interrupts, there are 16 registers in the development chip.

Figure 4-37 shows the bit assignments for the Interrupt CPU Target Registers 0-6 registers.

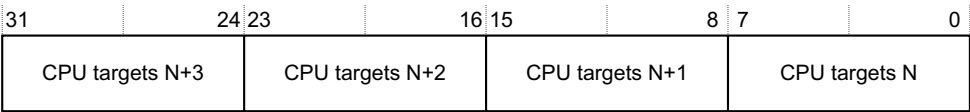


Figure 4-37 Interrupt CPU Target Registers 0-6 bit assignments

Table 4-89 lists the bit assignments for the Interrupt CPU Target Registers 0-6 registers at 0x800–0x818.

Table 4-89 Interrupt CPU Target Registers 0-6 bit assignments

Bits	Name	Type	Function
[31:24]	CPU targets N+3 ^a	Read Only	Store list of CPUs that are sent interrupts
[23:16]	CPU targets N+2		
[15:8]	CPU targets N+1		
[7:0]	CPU targets N		

a. Only one cpu is active and it is always CPU0.

Figure 4-38 shows the bit assignments for the Interrupt CPU Target Register 7 at 0x81C.

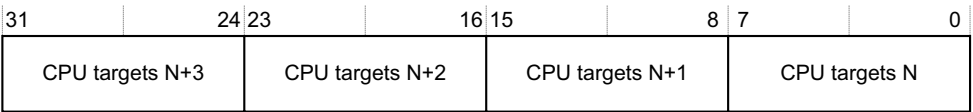


Figure 4-38 Interrupt CPU Target Register 7 bit assignments

Table 4-90 lists the Interrupt CPU Target Register 7 bit assignments.

Table 4-90 Interrupt CPU Target Register 7 bit assignments

Bits	Name	Type	Function
[31:24]	CPU targets N+3 ^a	Read Only	Store list of CPUs that are sent interrupts
[23:16]	CPU targets N+2		
[15:8]	CPU targets N+1		
[7:0]	CPU targets N		

a. Only one cpu is active and it is always CPU0.

This register is for interrupts IT28, IT29, IT30, and IT31.

Note

For IT29, IT30 and IT31, values read in corresponding fields depend on the accessing CPU because these interrupt sources are private:

- For CPU 0: CPU targets 29, 30 and 31 are read as 0x1. Writes are ignored.

In the particular implementation of the GIC in the ARM1176JZF Development Chip, there is only one CPU, CPU 0. The reset value of the CPU Target Register 8 is 0x01010100.

Figure 4-39 shows the bit assignments for the Interrupt CPU Target Register 8-15 registers.

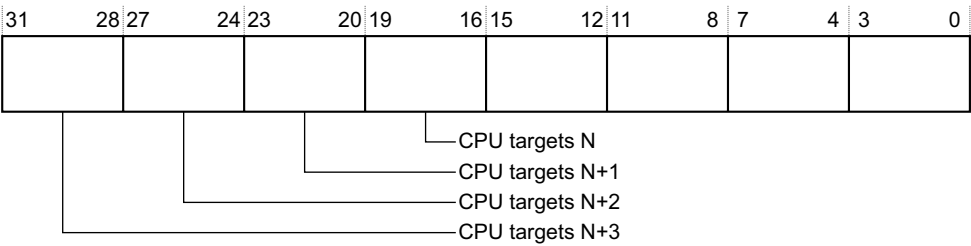


Figure 4-39 Interrupt CPU Target Register 8-15

Table 4-91 lists the bit assignments for the registers at 0x820–0x83C. These bits correspond to a hardware interrupt. The reset value of these bits is 0.

Table 4-91 Interrupt CPU Target Register 8-15 bit assignments

Bits	Name	Type	Function
[31:28]	CPU targets N+3	Read Only ^a	Store the list of CPUs that interrupts are sent to
[27:24]	CPU targets N+2		
[23:20]	CPU targets N+1		
[19:16]	CPU targets N		
[15:12]	-		
[11:8]	-		
[7:4]	-		
[3:0]	-		

a. For bits assigned to registers 0x820 to 0x83c, only bits [0], [8], [16] and [24] are RW. The others are R0.

Interrupt Configuration Registers

Interrupt Configuration Registers define the interrupt line event that it is considered active and the software model. There can be up to 16 interrupt configuration registers.

Because each register handles only 16 interrupts, the ARM1176JZF Development Chip uses four such registers.

Note

IT0 to IT31 and IT1023 are special interrupts for each individual CPU:

- IT0 to IT15 are defined as inter-processor interrupts
- IT16 to IT28 are reserved
- IT29 is defined as private timer interrupt
- IT30 is defined as private watchdog interrupt, if in Timer mode
- IT31 is defined as legacy **nIRQ** pin
- IT1023 is defined as the spurious interrupt.

Corresponding fields are all read as 00 and write accesses to these fields are ignored for all interrupts except for the inter-processor interrupts, IT0 to IT15. You can configure IPI software models and apply them to the interrupts sent from the writing CPU.

These interrupts are aliased. An additional field in the Interrupt Acknowledge Register specifies the requesting processor.

Figure 4-40 shows the bit assignments for the Interrupt Configuration Register 0.

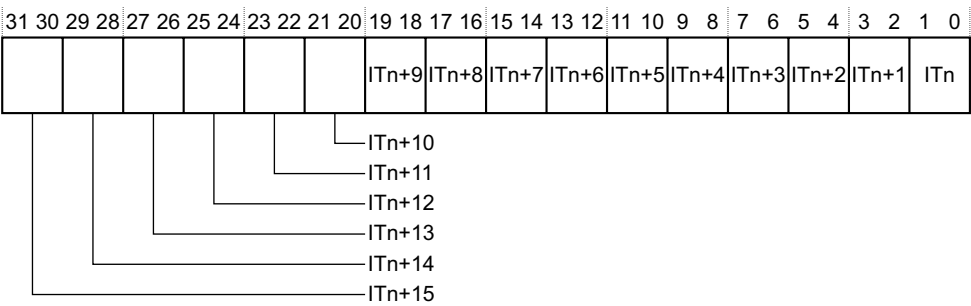


Figure 4-40 Interrupt Configuration Register 0 bit assignments

Table 4-92 lists the bit definition for the register at 0xC00.

Table 4-92 Interrupt Configuration Register 0 bit definition

Bits	Name	Type	Function
[31:30]	ITn+15	Read/Write	Configure software model for all 16 IPIs
[29:28]	ITn+14		
[27:26]	ITn+13		
[25:24]	ITn+12		
[23:22]	ITn+11		

Table 4-92 Interrupt Configuration Register 0 bit definition (continued)

Bits	Name	Type	Function
[21:20]	ITn+10	Read/Write	Configure software model for all 16 IPIs
[19:18]	ITn+9		
[17:16]	ITn+8		
[15:14]	ITn+7		
[13:12]	ITn+6		
[11:10]	ITn+5		
[9:8]	ITn+4		
[7:6]	ITn+3		
[5:4]	ITn+2		
[3:2]	ITn+1		
[1:0]	ITn		

You can configure the software model of the interrupts applied to in this register, but not the edge and level configuration. The testmask of this register, for example, for PMAP testing, is 0x55555555.

Table 4-94 and Table 4-94 list the encoding for the individual ITn bits.

Table 4-93 IT[0] interrupt definition encoding

ITn[0]	Description
0	Interrupt line uses the N-NN software model
1	Interrupt line uses the 1-N software model

Table 4-94 IT[1] interrupt definition encoding

ITn[1]	Description
0	Interrupt line is considered as level HIGH active
1	Interrupt line is considered as rising edge sensitive

Figure 4-41 on page 4-96 shows the bit assignments for the Interrupt Configuration Register 1.

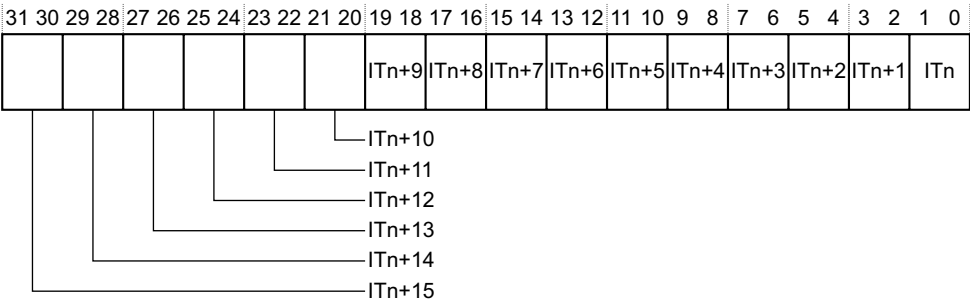


Figure 4-41 Interrupt Configuration Register 1 bit assignments

Table 4-95 lists the bit assignments for the register at 0xC04

Table 4-95 Interrupt Configuration Register 1 bit assignments

Bits	Name	Type	Function
[31:30]	ITn+15	Read Only	Configuration for IDs 16-28 and internal IRQs, 29, 30, and 31
[29:28]	ITn+14		
[27:26]	ITn+13		
[25:24]	ITn+12		
[23:22]	ITn+11		
[21:20]	ITn+10		
[19:18]	ITn+9		
[17:16]	ITn+8		
[15:14]	ITn+7		
[13:12]	ITn+6		
[11:10]	ITn+5		
[9:8]	ITn+4		
[7:6]	ITn+3		
[5:4]	ITn+2		
[3:2]	ITn+1		
[1:0]	ITn		

This register is reserved for IDs 16-28 and internal IRQs, 29, 30, and 31. This register is read-only and you cannot configure it.

Figure 4-42 shows the bit assignments for Interrupt Configuration Register 2-3.

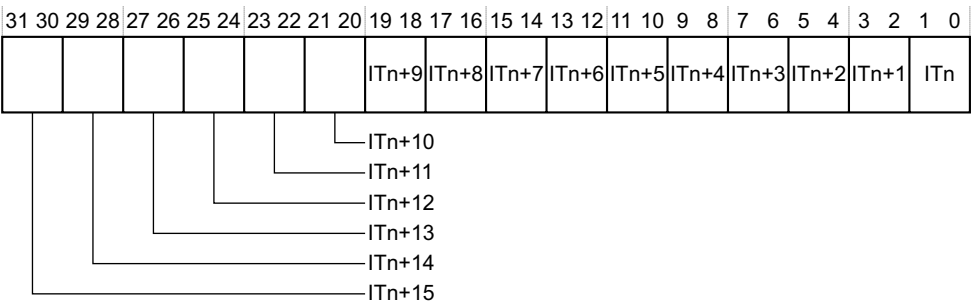


Figure 4-42 Interrupt Configuration Register 2-3 bit assignments

Table 4-96 lists the bit definition for the registers at 0xC08–0xC1C.

Table 4-96 Interrupt Configuration Register 2-3 bit definition

Bits	Name	Type	Function
[31:30]	ITn+15	Read/Write	Configure software model and edge and level for IDs 32-47, and 48-63
[29:28]	ITn+14		
[27:26]	ITn+13		
[25:24]	ITn+12		
[23:22]	ITn+11		
[21:20]	ITn+10		
[19:18]	ITn+9		
[17:16]	ITn+8		
[15:14]	ITn+7		
[13:12]	ITn+6		
[11:10]	ITn+5	RW	Configure software model and edge and level for IDs 32-47, and 48-63
[9:8]	ITn+4		
[7:6]	ITn+3		
[5:4]	ITn+2		
[3:2]	ITn+1		
[1:0]	ITn		

These two registers support hardware IRQs of ID 32-47, and 48-63. You can fully configure them.

Software Interrupt Register

The Software Interrupt Register is a write-only register that triggers an interrupt, identified by its own ID, to a list of CPUs. Figure 4-43 shows the bit assignments for this register.

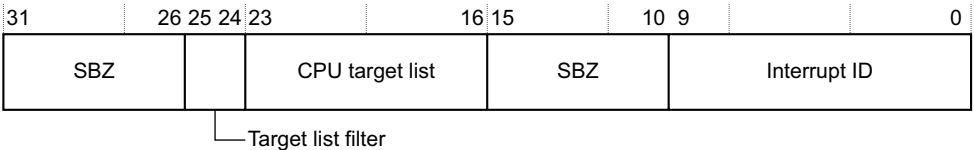


Figure 4-43 Software Interrupt Register bit assignments

Table 4-97 lists the bit definition for the registers at 0xF00.

Table 4-97 Software Interrupt Register bit definition

Bits	Name	Type	Function
[31:26]	SBZ	Write Only	Trigger specific interrupt---
[25:24]	Target list filter ^a		
[23:16]	CPU target list ^a		
[15:10]	SBZ		
[9:0]	Interrupt ID		Interrupt identifier

a. Allowed values that trigger an interrupt on CPU0 are:
target list filter = 0x00 and bit [0] of CPU target set
target list filter = 0x10.

The CPU target list can be different from the one defined in the CPU Target List Register for the specified interrupt ID.

The Target List filter definition is:

- 00: Interrupt sent to CPUs listed in CPU Target List
- 01: CPU target list is ignored, interrupt is sent to all but the requesting CPU
- 10: CPU target list is ignored, interrupt is sent to the requesting CPU only
- 11: Reserved.

Note

If you attempt to trigger an interrupt with an ID larger than the number of supported interrupts, or that references a CPU that is not present, there can be unpredictable effects in the interrupt distributor.

4.12.3 GIC CPU Interface

The CPU Interface registers are described in this section:

- *GIC CPU Interface register summary* on page 4-101
- *Control register* on page 4-101
- *Priority Mask register* on page 4-101
- *Binary Point register* on page 4-102
- *Interrupt Acknowledge Register* on page 4-103
- *End of Interrupt (EOI) Register* on page 4-104
- *Running Interrupt Register* on page 4-104
- *Highest Pending Interrupt Register* on page 4-104.

Note

For the GIC in the development chip, the interrupt controller output goes to the **nIRQ** input of the CPU.

For the GICs in the FPGA, the output does not connect directly to the CPU:

- The **nIRQ** output of FPGA GIC0 goes to development chip GIC input 63 and TZIC input 31.
 - The **nFIQ** output of FPGA GIC1 goes to development chip GIC input 62 and TZIC input 30.
-

GIC CPU Interface register summary

Table 4-98 shows the CPU interface registers.

Table 4-98 CPU interface registers

Name	Offset	Type	Width	Reset	Description
Control	0x000	Read/Write	1	0x00000000	Control register
PriorityMask	0x004	Read/Write	4	0x00000000	Priority Mask register
BinaryPoint	0x008	Read/Write	3	0x00000003	Binary Point register
IrqAck	0x00C	Read Only	13	0x000003FF	Interrupt Ack register
EndIrq	0x010	Write Only	13	-	End of Interrupt (EOI) register
RunningPriority	0x014	Read Only	4	0x000000FF	Running Priority register
HighestPendingIrq	0x018	Read Only	13	0x000003FF	Highest Pending Interrupt register

Control register

Table 4-99 shows bit assignments for the CPU Interface Control register.

Table 4-99 CPU Interface Control register bit assignments

Bits	Name	Type	Function
31:1	-	Read/Write	Reserved. SBZ
0	Enable	Read/Write	Enable

Priority Mask register

Use the Priority Mask to prevent interrupts from being sent to the CPU. The CPU interface asserts an interrupt request to the CPU if, and only if, the priority of the highest pending interrupt sent by the interrupt distributor is strictly higher than the mask value set in the Priority Mask Register.

Note

The GICs in theFPGA do not connect directly to the CPU. The Mask register for FPGA GICs controls whether or not the interrupt inputs on the development chip TZIC and GIC are active.

One consequence of the strict comparison is that lowest priority interrupt will never cause the assertion of interrupt request to the CPU. This allows an extra level of interrupt enabling. Although an interrupt can be pending, it will never be seen by the CPU. Table 4-100 shows bit assignments for the Priority Mask register.

Table 4-100 Priority Mask Register bit assignments

Bits	Name	Type	Function
7:4	Priority Mask	Read/Write	Used to determine if the CPU interface asserts an interrupt request to CPU, if and only if the priority of the highest pending interrupt sent by the interrupt distributor is strictly higher than the mask set in this register.

Binary Point register

Binary point register is used to specify a certain number of bits to ignore in the priority comparison made in the CPU interface for pre-emption stack. Table 4-101 shows bit assignments for the Binary Pointer register.

Table 4-101 Binary Pointer Register bit assignments

Bits	Name	Type	Function
31:3	SBZ/UNP	Read/Write	-
2:0	Binary Point	Read/Write	If this is set, ignore bits in priority comparison made in CPU interface for pre-emption stack.

Table 4-102 shows the meanings for Binary Point values:

Table 4-102 Binary Point value meanings

Value	Meaning
000	Bits [7:1] of the priority are used to determine pre-emption
001	Bits [7:2] of the priority are compared for pre-emption.
010	Bits [7:3] of the priority are compared for pre-emption.
011	Bits [7:4] of the priority are compared for pre-emption.
100	Bits [7:5] of the priority are compared for pre-emption.

Table 4-102 Binary Point value meanings (continued)

Value	Meaning
101	Bits [7:6] of the priority are compared for pre-emption.
110	Bits [7:7] of the priority are compared for pre-emption.
111	No pre-emption is performed. All bits of the priority are used for prioritization.

You can restrict the lowest value to any value from 0 to 4. If you attempt to specify a value less than the set minimum, the minimum value is used. This value can be read back to enable software discovery. At reset, the register takes its minimum supported value.

Interrupt Acknowledge Register

The Interrupt Acknowledge Register is a read-only register used by the CPU to determine the ID of the interrupt asserted by the CPU interface. Table 4-103 shows bit assignments for the Interrupt Acknowledge Register.

Table 4-103 Interrupt Acknowledge Register bit assignments

Bits	Name	Type	Function
31:13	SBZ/RAZ	Read Only	-
12:10	CPU source ID		CPU source ID value. Depends on Interrupt ID field: <ul style="list-style-type: none"> If Interrupt ID field is 0 to 15, contains ID of the CPU that requested the IPI. In all other cases, CPU source ID field is read as zero. This can be ignored.
9:0	Interrupt ID		Interrupt identifier

End of Interrupt (EOI) Register

This write-only register is used when the software finishes handling an interrupt. Table 4-104 shows bit assignments for the EOI Register.

Table 4-104 End of Interrupt Register bit assignments

Bits	Name	Type	Function
31:13	SBZ/RAZ	Write Only	-
12:10	CPU source ID		CPU source ID value. Depends on Interrupt ID field: <ul style="list-style-type: none">If Interrupt ID field is 0 to 15, contains ID of the CPU that requested the IPI.In all other cases, CPU source ID field is read as zero. This can be ignored.
9:0	Interrupt ID		Interrupt identifier

Running Interrupt Register

This read-only register contains the priority level of the currently running interrupts on the CPU. Table 4-105 shows bit assignments for the Running Interrupt Register.

Table 4-105 Running interrupt Register bit assignments

Bits	Name	Type	Function
31:8	SBZ/UNP	Read Only	-
7:4	Priority		Indicates priority level of the current running interrupt.
3:0	SBZ		-

When no interrupt is running, defined as acknowledged by reading acknowledge register but not ended by writing to EOI register, the priority value read is 0xFF.

Highest Pending Interrupt Register

The Highest Pending Interrupt Register contains the Interrupt ID and CPU ID of the Highest Pending Interrupt for this CPU. If no interrupt is pending, the Interrupt ID returned is 0x3FF. This indicates a spurious interrupt.

The format of the register is the same as the Interrupt Acknowledge Register.
Table 4-106 shows bit assignments for the Highest Pending Interrupt Register.

Table 4-106 Highest Pending interrupt Register bit assignments

Bits	Name	Type	Function
31:13	SBZ/RAZ	Write Only	-
12:10	CPU Source ID		CPU source ID value. Depends on Interrupt ID field: <ul style="list-style-type: none">• If Interrupt ID field is 0 to 15, contains ID of the CPU that requested the IPI.• In all other cases, CPU source ID field is read as zero. This can be ignored.
9:0	Interrupt ID		Interrupt identifier

4.12.4 GIC reserved register addresses

The offset of any particular register from the base address is fixed. Some register locations are reserved, and you must not used them during normal operation.

Registers corresponding to interrupts 0–31 are reserved for use by the processor.

Registers at the following locations are not used in this implementation of the GIC distributor:

- 0x008
- 0x0FF
- 0x108- 0x17C
- 0x188 - 0x1FF
- 0x208 - 27C
- 0x288 - 0x2FF
- 0x308 - 0x3FF
- 0x440 - 0x7FF
- 0x840 - 0xBFF
- 0xC10 - 0xDFF.

4.13 Level 2 Cache Controller

The L2CC has 128KB of unified cache that is clocked 1:1 with the core I and R/D buses.

Table 4-107 L2CC implementation in development chip

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10110000
Interrupt	45 on development chip GIC (13 TZIC)
Release version	ARM L220 (pre-release version)
Reference documentation	<i>L220 Cache Controller Technical Reference Manual</i>

4.14 Keyboard and Mouse Interface, KMI

The ARM PrimeCell PS2 *Keyboard/Mouse Interface* (KMI) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited. KMI0 is used for keyboard input and KMI1 is used for mouse input.

Table 4-108 KMI implementation

Property	Value
Location	FPGA
Memory base address	0x10006000 KMI 0 (keyboard) 0x10007000 KMI 1 (mouse)
Interrupt	35 on FPGA GICs for KMI 0 36 on FPGA GICs for KMI 1
Release version	ARM KMI PL050 r1p0
Reference documentation	<i>ARM PrimeCell Keyboard Mouse Controller (PL050) Technical Reference Manual</i> (see also <i>Keyboard/Mouse Interface, KMI</i> on page 3-24)

4.15 MultiMedia Card Interfaces, MCI

The PrimeCell *Multimedia Card Interface* (MCI) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-109 MCI implementation

Property	Value
Location	FPGA
Memory base address	0x10005000
Interrupt	33 on FPGA GICs for MCI
Release version	ARM MCI PL180 r1p0
Reference documentation	ARM PrimeCell Multimedia Card Interface (PL180) Technical Reference Manual.

4.16 PCI controller

The PCI controller is implemented in the FPGA and controls the interface to the PCI bus.

Table 4-110 PCI controller implementation

Property	Value
Location	FPGA
Memory base address	<ul style="list-style-type: none"> 0x10019000 map and control registers 0x60000000–0x60FFFFFF Self configuration region 0x61000000–0x61FFFFFF PCI configuration region 0x62000000–0x62FFFFFF PCI I/O 0x63000000–0x63FFFFFF PCI memory region 0 0x64000000–0x67FFFFFF PCI memory region 1 0x68000000–0x6FFFFFFF PCI memory region 2
Interrupt	<p>No interrupts from PCI controller</p> <p>47on FPGA GICs for external PCI slot number 3</p> <p>46 on FPGA GICs for external PCI slot number 2</p> <p>45 on FPGA GICs for external PCI slot number 1</p> <p>44 on FPGA GICs for external PCI slot number 0</p> <p>———— Note —————</p> <p>The PB1176JZF-S cannot generate an interrupt to the PCI bus. This is a departure from the PCI bus specification.</p>
Release version	Custom logic (Xilinx)
Reference documentation	<i>PCI v2.2 Specification</i> (see the PCI SIG web site at www.pcisig.com) See also Table 4-112 on page 4-110, <i>PCI interface</i> on page 3-27, and Appendix D <i>PCI Backplane and Enclosure</i>)

The PCI slave bridge connected to AXI M recognizes addresses 0x60000000 to 0x6FFFFFFF as being intended for a target within the PCI address space of the memory map, and passes accesses within this region to the PCI bus. The PCI master bridge connected to the PCI bus passes accesses to the AXI S bus.

There are windows that provide access from the AXI master bus to the PCI expansion bus are listed in Table 4-111.

Table 4-111 PCI bus memory map for AXI M bridge

Usage	Size	AXI master address
PCI self config	16MB	0x60000000-0x60FFFFFF
PCI config	16MB	0x61000000-0x61FFFFFF
PCI I/O	16MB	0x62000000-0x62FFFFFF
PCI memory region 0	16MB	0x63000000-0x63FFFFFF
PCI memory region 1	256MB	0x64000000-0x67FFFFFF
PCI memory region 2	256MB	0x68000000-0x6FFFFFFF

4.16.1 Control registers

The SYS_PCICTL, PCI_SELFID, and PCI_FLAGS control the operation of the PCI bus and provide status information. The PCI_IMAPx and PCI_SMAPx registers define the address translation values for the PCI I/O, PCI configuration, and PCI memory windows. See Table 4-112.

Table 4-112 PCI controller registers

Address	Name	Access	Description
0x10000044	SYS_PCICTL	R/W	Read returns a HIGH in bit 0 if a PCI board is present in the expansion backplane. (See <i>PCI Control Register, SYS_PCICTL</i> on page 4-50.)
0x10019000	PCI_IMAP0	R/W	Translates address bits [31:24] from baseboard to PCI region 0.
0x10019004	PCI_IMAP1	R/W	Translates address bits [31:26] from baseboard to PCI region 1.
0x10019008	PCI_IMAP2	R/W	Translates address bits [31:27] from baseboard to PCI region 2.
0x1001900C	PCI_SELFID	R/W	Slot location of the PB1176JZF-S.
0x10019010	PCI_FLAGS	R/W	Master and target abort flags
0x10019014	PCI_SMAP0	R/W	Translates address bits [31:28] from PCI to baseboard region 0.
0x10019018	PCI_SMAP1	R/W	Translates address bits [31:28] from PCI to baseboard region 1.
0x1001901C	PCI_SMAP2	R/W	Translates address bits [31:28] from PCI to baseboard region 2.

PCI_IMAPx registers

The registers remap high-order memory address bits for the PCI regions. Figure 4-44 shows the PCI_IMAP2 register contains 0x8 and this is used for the four high bits of the PCI address bus.

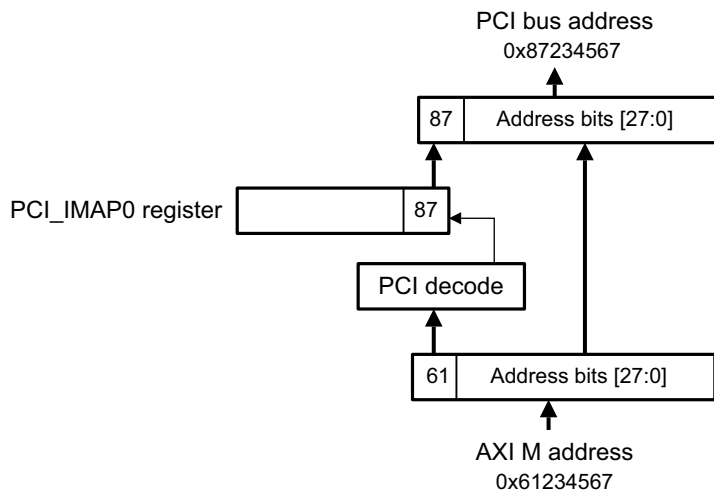


Figure 4-44 AXI M to PCI mapping

The map register formats are listed in Table 4-118 on page 4-114, Table 4-114, and Table 4-115 on page 4-112.

Table 4-113 PCI_IMAP0 register format

Bits	Description
[31:10]	Reserved. Use read-modify-write to preserve value.
[9:0]	Contains the value to use for bits [31:24] of the PCI address for accesses to this region.

Table 4-114 PCI_IMAP1 register format

Bits	Description
[31:7]	Reserved. Use read-modify-write to preserve value.
[6:0]	Contains the value to use for bits [31:26] of the PCI address for accesses to this region.

Table 4-115 PCI_IMAP2 register format

Bits	Description
[31:6]	Reserved. Use read-modify-write to preserve value.
[5:0]	Contains the value to use for bits [31:27] of the PCI address for accesses to this region.

PCI_SELFID register

Writing the slot location of the PB1176JZF-S into this register enables normal configuration accesses to return information on the PB1176JZF-S. That is, normal configuration accesses to this slot position are converted automatically into self configuration accesses.

Figure 4-45 shows the register bit assignments.



Figure 4-45 PCI_SELFID register

Table 4-116 lists the register bit assignments.

Table 4-116 PCI_SELFID register format

Bits	Description
[31:5]	Reserved. Use read-modify-write to preserve value.
[4:0]	Contains the slot location of the PB1176JZF-S on the PCI backplane.

Copyright © 2007-2011 ARM Limited. All rights reserved.
Non-Confidential

4-113

Bits	Description
[31:2]	Reserved.
[1]	Target abort flag. The bit value is the same as bit 38 of the Command Status Register in the Xilinx PCI controller. This bit position is reserved for future use.
[0]	Master abort flag. The bit value is the same as bit 39 of the Command Status Register in the Xilinx PCI controller. This bit is HIGH if an error occurred while the PB1176JZF-S was operating as a master.

PCI_SMAPx registers

The map registers provide memory address bits [31:28] of the AXI slave bus for PCI accesses as shown in Figure 4-47. In this example, PCI_SMAP2 contains 0x2 and this is used for the high bits for the AXI slave address bus.

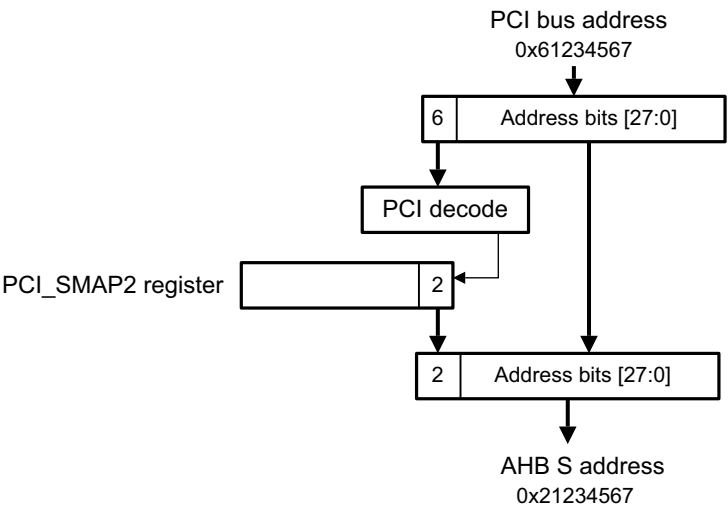


Figure 4-47 PCI to AXI S mapping

Figure 4-48 shows the register bit assignments.



Figure 4-48 PCI_SMAPx register

Table 4-118 lists the register bit assignments.

Table 4-118 PCI_SMAPx register format

Bits	Description
[31:4]	Reserved. Use read-modify-write to preserve value.
[3:0]	Contains the value to use for bits [31:28] of the AXI address when the PCI accesses the slave port.

4.16.2 PCI configuration

This section describes how to configure the PCI controllers on the PB1176JZF-S and any PCI cards attached to the PCI backplane.

Locating the self-config header table

The slot positions for PCI cards are numbered from 11 to 31. The numbering is based on the address bit that connects to the **IDSEL** line. The base address for the PCI configuration header is determined as follows:

$$0x60000000 + ((\text{slot position}) \ll 11)$$

For example, if the PB1176JZF-S is put into slot C where PCI address bit 29 is connected to the **IDSEL** signal, then the base address for the PB1176JZF-S header table is at memory location:

$$0x60000000 + (29 \ll 11) = 0x6000E800$$

The self-configuration addresses for the slot A, B, and C in the PCI backplane are listed in Table 4-119.

Table 4-119 PCI backplane configuration header addresses (self-config)

Slot	Address connected to IDSEL	Configuration header memory
C	29	0x6000E800–0x6000E83F
B	30	0x6000F000–0x6000F03F
A	31	0x6000F800–0x6000F83F

The base address for normal configuration is 0x61000000. The normal configuration addresses for the slot A, B, and C in the PCI backplane are listed in Table 4-119.

Table 4-120 PCI backplane configuration header addresses (normal configuration)

Slot	Address connected to IDSEL	Configuration header memory
C	29	0x6100E800–0x6100E83F
B	30	0x6100F000–0x6100F03F
A	31	0x6100F800–0x6100F83F

The contents of the PCI configuration header is listed in Table 4-121. The default values are those of the PB1176JZF-S.

Table 4-121 PCI configuration space header

Address offset	Configuration word function	Default value
+0x00	Device ID Vendor ID	0x0300 0x10EE
+0x04	Status Command	0x0220 0x0000
+0x08	Class Code Rev ID	0x0B40 0x0000
+0x0C	BIST (Reserved in PB1176JZF-S) Header Type Lat. timer Line Size (Reserved in PB1176JZF-S)	0x00 0x00 0x00 0x00
+0x10	Base Address Register 0 (I/O bytes)	0x00000001
+0x14	Base Address Register 1 (memory)	0x00000008
+0x18	Base Address Register 2 (memory)	0x00000008
+0x1C	Base Address Register 3 (reserved in PB1176JZF-S)	-
+0x20	Base Address Register 4 (reserved in PB1176JZF-S)	-
+0x24	Base Address Register 5 (reserved in PB1176JZF-S)	-
+0x28	Cardbus CIS Pointer (reserved in PB1176JZF-S)	-
+0x2C	Subsystem ID Subsystem Vendor ID	0x0000 0x0000
+0x30	Expansion ROM Base Address (Reserved in PB1176JZF-S)	-
+0x34	Unused (Reserved in PB1176JZF-S) CapPtr	0x0000 0x0000
+0x38	(Reserved in PB1176JZF-S)	-
+0x3C	Max_Lat Min_Gnt Interrupt PinInterrupt line	0x00 0x00 0x01 0xFF

The PCI backplane uses the top 3 bits of PCI address to determine whether that slot must respond to configuration cycles. When the PB1176JZF-S generates PCI configuration cycles by accessing the 0x60000000 or 0x61000000 region, the only one of the PCI cards responds.

See the PCI v2.2 specification for more information on the configuration space header.

Configuring the PCI interface

To configure a PCI card in the expansion bus, first find the memory location that maps the PB1176JZF-S into the system:

1. Scan addresses $0x60000000 + (n < 11)$ to locate the PCI slot holding the PB1176JZF-S. The slot range for n is 11 to 31. If you are using the horizontal slot on the PCI expansion backplane, n is 29.
2. Write the value of n that indicates the slot position into the PCI_SELFID register.
3. Set bit 2 of the Command/Status Register (at offset $+0x04$) to enable the PB1176JZF-S to be initiator on the system. This enables initiator transfers.
4. Because the PCI_SELFID register now holds the slot number for the PB1176JZF-S, scanning the normal configuration space at $0x61000000$ reveals all PCI cards in the backplane.

Perform normal configuration cycles on other slot positions to see what else is on the bus. Instead of the self config area at $0x60000000$, use memory locations in Config area $0x61000000 + (n < 11)$, where n is 11 to 31. That is, scan:

$0x61005800$, $0x61006000$, $0x61006800$, and the next address until $0x6100f800$.

5. The accesses return $0xFFFFFFFF$ if the slot is empty, or the device and vendor id for card present. (For the PB1176JZF-S, the device/vendor id is $0x030010EE$.)

If a card is present, read the base address registers to determine how much and what type of memory is required by each of target boards found in the system.

6. Write to the base address registers in the header table to setup the PCI memory map and tell each target the PCI memory addresses they must respond to (see Table 4-121 on page 4-116).
7. Set the PCI control registers at $0x10019000$ appropriately so an access to one of the three memory regions causes a PCI access to the correct PCI memory location.

Note

An example of PCI scanning and configuration is provided as an example on the CD.

Limitations of the PCI interface

The following limitations apply to the PCI interface present on the PB1176JZF-S:

- The interface is 32-bit only.
- The initiator creates only single reads and writes. This is quite inefficient and results in low performance. It does, however, simplify the logic in the FPGA and enables 66MHz performance.
- The target issues a retry response for reads until the data is ready.
- The target issues a retry response for reads or writes when the fifo is full (target has a 512 deep FIFO, initiator fifo is 16 deep)
- If another master accesses the PB1176JZF-S and it responds with '*retry*' or '*disconnect without data*', then this access must repeated before any other master accesses to the PB1176JZF-S.
- The PB1176JZF-S breaks up burst transfers. It typically completes the first cycle and then responds with '*disconnect without data*'. The initiator must then retry with the address that responded with the disconnect.
- The AXI to AHB bridge that is used on the FPGA does not support sparse burst transfers. That is, bursts where the WSTRB[7:0] lines are not all 1 for every beat in the burst. See, *PrimeCell Infrastructure AMBA 3 AXI to AMBA 2 AHB Bridges (BP137) Technical Overview*.
- Only three out of five configuration base registers are usable.
- Cardbus CIS Pointer and Expansion ROM configuration registers are not implemented.
- There is no support for BIST.
- The PB1176JZF-S cannot generate an interrupt to the PCI bus.

———— **Note** ————

This is a departure from the PCI bus specification.

- The target only responds to some of the sixteen PCI bus commands, and initiator only creates six of the cycle types (see Table 4-122 on page 4-119).

Table 4-122 PCI bus commands supported

Command code	Name	Supported on target	Supported on initiator
b0000	Interrupt Acknowledge	Ignored	Not available
b0001	Special Cycle	Ignored	Not available
b0010	I/O read	Yes	Yes
b0011	I/O write	Yes	Yes
b0100	Reserved	Ignored	Not available
b0101	Reserved	Ignored	Not available
b0110	Memory Read	Yes	Yes
b0111	Memory Write	Yes	Yes
b1000	Reserved	Ignored	Not available
b1001	Reserved	Ignored	Not available
b1010	Configuration Read	Yes	Yes
b1011	Configuration Write	Yes	Yes
b1100	Memory Read Multiple	Yes	Not available
b1101	Dual Address Cycle	Ignored	Not available
b1110	Memory Read Line	Yes	Not available
b1111	Memory Write Invalidate	Yes	Not available

4.17 Real Time Clock, RTC

The PrimeCell *Real Time Clock Controller* (RTC) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

A counter in the RTC is incremented every second. The RTC can therefore be used as a basic alarm function or long time-base counter.

The current value of the clock can be read at any time or the RTC can be programmed to generate an interrupt after counting for a programmed number of seconds. The interrupt can be masked by writing to the interrupt match set or clear register.

Table 4-123 RTC implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10108000 (development chip)
Interrupt	46 on development chip GIC (14 on TZIC)
Release version	ARM RTC PL031 r1p0
Reference documentation	<i>ARM PrimeCell Real Time Clock Controller (PL031) Technical Reference Manual</i>

———— **Note** ————

There is also a separate *Time-Of-Year* (TOY) RTC implemented in an external DS1338 chip on the PB1176JZF-S. The external TOY RTC is connected to interrupt 25 on the FPGA GICs. The external RTC can be accessed by the serial bus interface (see *Serial bus interface* on page 4-121). For details on the programming interface to the Time-of-Year RTC, see the datasheet for the Maxim DS1338 integrated circuit.

4.18 Serial bus interface

A serial bus interface is implemented in the FPGA. The registers shown in Table 4-125 control the serial bus and provides access to control signals on the two memory expansion boards and to the time-of-year clock.

Table 4-124 Serial bus implementation

Property	Value
Location	FPGA
Memory base address	0x10002000
Interrupt	NA
Release version	Custom logic
Reference documentation	<i>Serial bus interface</i> on page 3-26, Appendix E <i>Memory Expansion Boards</i> , and the datasheet for the Dallas Maxim DS1338 Real Time Clock.

Table 4-125 Serial bus register

Address	Name	Access	Description
0x10002000	SB_CONTROL	Read only	Read serial control bits: Bit [0] is SCL Bit [1] is SDA
0x10002000	SB_CONTROLS	Write	Set serial control bits: Bit [0] is SCL Bit [1] is SDA
0x10002004	SB_CONTROLC	Write	Clear serial control bits: Bit [0] is SCL Bit [1] is SDA

Note

SDA is an open-collector signal that is used for sending and receiving data. Set the output value HIGH before reading the current value.

Software must manipulate the **SCL** and **SDA** bits directly to access the data in the three devices. The pre-defined eight-bit device addresses are listed in Table 4-126. See the `\firmware\examples` directory on the CD for example code for reading the memory expansion EEPROM.

Table 4-126 Serial bus device addresses

Device	Write address	Read address
Dynamic expansion EEPROM	0xA0	0xA1
Static expansion EEPROM	0xA2	0xA3
Time-of-year clock	0xD0	0xD1

4.19 Smart Card Interface, SCI

The PrimeCell *Smart Card Interface* (SCI) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-127 SCI implementation

Property	Value
Location	FPGA
Memory base address	0x1000E000
Interrupt	37 on FPGA GICs
Release version	ARM SCI PL131 r1p0
Reference documentation	<i>SCI PrimeCell PL131 Technical Reference Manual</i> (see also <i>Smart Card interface, SCI</i> on page 3-25)

The following key parameters are programmable:

- Smart Card clock frequency and communication baud rate
- protocol convention
- card activation and deactivation time
- check for maximum time for first character of *Answer To Reset* (ATR) reception
- check for maximum duration of ATR character stream
- check for maximum time for receipt of first character of data stream
- check for maximum time permitted ed between characters
- character and block guard time
- transmit and receive character retry and FIFO level
- clock start and stop time and inactive level.

See the self-test software that is supplied on the CD accompanying the PB1176JZF-S for a example of detecting a SIM card response to a reset.

4.20 Synchronous Serial Port, SSP

The PrimeCell *Synchronous Serial Port* (SSP) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-128 SSP implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x1010B000.
Interrupt	49 on dev. chip GIC (17 on TZIC)
Release version	ARM SSP PL022 r1p2
Reference documentation	<i>ARM PrimeCell Synchronous Serial Port Controller (PL022) Technical Reference Manual</i> (see also <i>Synchronous Serial Port, SSP</i> on page 3-19)

The SSP functions as a master or slave interface that enables synchronous serial communication with slave or master peripherals having one of the following:

- a Motorola SPI-compatible interface
- a Texas Instruments synchronous serial interface
- a National Semiconductor Microwire interface.

In both master and slave configurations, the PrimeCell SSP performs:

- parallel-to-serial conversion on data written to a transmit FIFO
- serial-to-parallel conversion and FIFO buffering of received data.

Interrupts are generated to:

- request servicing of the transmit and receive FIFO
- inform the system that a receive FIFO over-run has occurred
- inform the system that data is present in the receive FIFO.

The SSP controller can be shared with the following resources:

- If the LCD adaptor board is fitted with a touch screen, the controller interfaces to the SSP port to provide touch screen, keypad, LCD bias and analogue inputs. See the LCD adaptor board TSCI appendix for more details.

Note

Use the SYS_CLCD register to control the SSP chip selects. See *CLCD Control Register, SYS_CLCD* on page 4-50.

- An offboard SSP device, such as an EEPROM, can be connected to expansion header J29. If you connect both the LCD adaptor board and the off board SSP device at the same time, ensure the correct SSP interface protocol is used when communicating with each device.
- Synthesized SSP peripherals in a RealView Logic Tile FPGA can be connected using the RealView Logic Tile expansion connectors. Disable the buffer with the RealView Logic Tile HDRY signal **YL62 (nDRVINEN1)** to avoid conflicts with the LCD adaptor board and expansion header.

4.21 Synchronous Static Memory Controller, SSMC

The PrimeCell *Synchronous Static Memory Controller* (SSMC) is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-129 SSMC implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10111000
Interrupt	NA
Release version	ARM SSMC PL093 r0p4
Reference documentation	ARM PrimeCell Static Memory Controller (PL093) Technical Reference Manual, Memory map on page 4-3, and Memory interface on page 3-17

The following key parameters are programmable for each SSMC memory bank:

- external memory width, 8, 16, or 32-bit
- burst mode operation
- write protection
- external wait control enable
- external wait polarity
- write WAIT states for static RAM devices
- read WAIT states for static RAM and ROM devices
- initial burst read WAIT state for burst devices
- subsequent burst read WAIT state for burst devices
- read byte lane enable control
- bus turn-around (idle) cycles
- output enable and write enable output delays.

———— **Note** ————

To enable write access to the NOR flash (static chip select 1), set bit 0 of SYS_FLASH to HIGH. The default at power-on reset is LOW.

4.21.1 Register values

Table 4-130 to Table 4-134 on page 4-128 lists the register values for the SSMC for typical operation of static memory devices and with a 35MHz system clock.

Note

The platform.a library contains memory setup routines. See *Building an application with the platform library* on page F-10.

Table 4-130 Register values for NOR2

Address	Name of SSMC register	Value	Description
0x10111000	SMBIDCYR0	0x0	Idle Cycle Control Register for bank 0
0x10111004	SMBWSTRDR0	0x4	Read Wait State Control Reg bank 0
0x10111008	SMBWSTWRR0	0x2	Write Wait State Control Reg Bank 0
0x1011100C	SMBWSTOENR0	0x1	Output Enable Assertion Delay 0
0x10111010	SMBWSTWENR0	0x1	Write Enable Assertion Delay 0
0x10111014	SMBCR0	0x303011	Control Register for memory bank 0
0x1011101C	SMBWSTBRDR0	0x0	Burst Read Wait state Control Reg 0

Table 4-131 Register values for Intel flash, standard async read mode, no bursts

Address	Name of SSMC register	Value	Description
0x101110E0	SMBIDCYR7	0x0	Idle Cycle Control Register for bank 1
0x101110E4	SMBWSTRDR7	0x4	Read Wait State Control Reg bank 1
0x101110E8	SMBWSTWRR7	0x3	Write Wait State Control Reg Bank 1
0x101110EC	SMBWSTOENR7	0x0	Output Enable Assertion Delay 1
0x101110F0	SMBWSTWENR7	0x1	Write Enable Assertion Delay 1
0x101110F4	SMBCR7	0x303021	Control Register for memory bank 1
0x101110FC	SMBWSTBRDR7	0x0	Burst Read Wait state Control Reg 1

Table 4-132 Register values for Intel flash, async page mode

Address	Name of SSMC register	Value	Description
0x101110E0	SMBIDCYR7	0x0	Idle Cycle Control Register for bank 1
0x101110E4	SMBWSTRDR7	0x4	Read Wait State Control Reg bank 1
0x101110E8	SMBWSTWRR7	0x3	Write Wait State Control Reg Bank 1
0x101110EC	SMBWSTOENR7	0x0	Output Enable Assertion Delay 1
0x101110F0	SMBWSTWENR7	0x1	Write Enable Assertion Delay 1
0x101110F4	SMBCR7	0x303521	Control Register for memory bank 1
0x101110FC	SMBWSTBRDR7	0x0	Burst Read Wait state Control Reg 1

Table 4-133 Register values for Samsung SRAM

Address	Name of SSMC register	Value	Description
0x10111040	SMBIDCYR2	0x0	Idle Cycle Control Register for bank 2
0x10111044	SMBWSTRDR2	0x2	Read Wait State Control Reg bank 2
0x10111048	SMBWSTWRR2	0x2	Write Wait State Control Reg Bank 2
0x1011104C	SMBWSTOENR2	0x0	Output Enable Assertion Delay 2
0x10111050	SMBWSTWENR2	0x1	Write Enable Assertion Delay 2
0x10111054	SMBCR2	0x303021	Control Register for memory bank 2
0x1011105C	SMBWSTBRDR2	0x0	Burst Read Wait state Control Reg 2

Table 4-134 Register values for Spansion BDS640

Address	Name of SSMC register	Value	Description
0x10111060	SMBIDCYR3	0x0	Idle Cycle Control Register for bank 3
0x10111064	SMBWSTRDR3	0x3	Read Wait State Control Reg bank 3
0x10111068	SMBWSTWRR3	0x2	Write Wait State Control Reg Bank 3

Table 4-134 Register values for Spansion BDS640 (continued)

Address	Name of SSMC register	Value	Description
0x1011106C	SMBWSTOENR3	0x0	Output Enable Assertion Delay 3
0x10111070	SMBWSTWENR3	0x1	Write Enable Assertion Delay 3
0x10111074	SMBCR3	0x303021	Control Register for memory bank 3
0x1011107C	SMBWSTBRDR3	0x0	Burst Read Wait state Control Reg 3

Table 4-135 Register values for Spansion LV256

Address	Name of SSMC register	Value	Description
0x10111080	SMBIDCYR4	0x0	Idle Cycle Control Register for bank 4
0x10111084	SMBWSTRDR4	0x4	Read Wait State Control Reg bank 4
0x10111088	SMBWSTWRR4	0x3	Write Wait State Control Reg Bank 4
0x1011108C	SMBWSTOENR4	0x1	Output Enable Assertion Delay 4
0x10111090	SMBWSTWENR4	0x1	Write Enable Assertion Delay 4
0x10111094	SMBCR4	0x303121	Control Register for memory bank 4
0x1011109C	SMBWSTBRDR4	0x1	Burst Read Wait state Control Reg 4

4.22 System Controller

The system controller is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited.

Table 4-136 System controller implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10100000
Interrupt	NA
Release version	Custom implementation
Reference documentation	See <i>FPGA status and system control registers</i> on page 4-37.
<div>———— Note ————</div> <div>Bit 8 of the System controller register at 0x101E000 controls remapping of static memory devices to address 0x0. See also <i>Memory map</i> on page 4-3.</div>	

The system controller in the ARM1176JZF-S development chip provides an interface to control the operation of the chip.

The system controller supports the following functionality:

- a system mode control state machine
- crystal and PLL control, system/peripheral clock control and status
- definition of system response to interrupts
- reset status capture and soft reset generation
- Watchdog and timer module clock enable generation
- remap control
- general purpose peripheral control registers.

———— **Note** ————

There are also system control registers in the FPGA. See *FPGA status and system control registers* on page 4-37.

4.23 Timers

The Dual-Timer module is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited. There are three Dual-Timer modules present in the ARM1176JZF-S development chip.

Table 4-137 Timer implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10104000 for Timer 0/1 0x10105000 for Timer 2/3 0x10106000 for Timer 4/5.
Interrupt	42 on dev. chip GIC for Timers 4/5 (10 on TZIC) 41 on dev. chip GIC for Timers 2/3 (9 on TZIC) 40 on dev. chip GIC for Timers 0/1 (8 on TZIC)
Release version	ARM Dual-Timer SP804 r1p0-02ltd0
Reference documentation	<i>ARM PrimeCell Timer Module (SP804) Technical Reference Manual</i>

The features of the Dual-Timer module are:

- Two 32/16-bit down counters with free-running, periodic and one-shot modes.
- Common clock with separate clock-enables for each timer gives flexible control of the timer intervals.
- Interrupt output generation on timer count reaching zero.
- Identification registers that uniquely identify the Dual-Timer module. These can be used by software to automatically configure itself.

The timers are clocked by a 1MHz source that is divided down in the FPGA from the fixed 24MHz reference clock.

Note

The SP804 can normally select between two reference clocks (**TIMCLK** and **REFCLK**) by setting the timing reference select bit in the system controller register. However only the 1MHz **TIMCLK** reference is available on the PB1176JZF-S, so the timing reference select bit must be set to 1.

4.24 TrustZone Protection Controller

TrustZone protection is implemented in the development chip and the FPGA.

The yellow TRUSTZONE LED is illuminated as an indicator of extended AXI master transactions from the development chip or tile site that are secure into the FPGA.

Table 4-138 TrustZone Protection Controller implementation

Property	Value
Location	One in FPGA and one in development chip.
Memory base address	0x10003000 FPGA 0x10101000 development chip.
Interrupt	Controls secure interrupts, see <i>Interrupt controllers in the ARM1176JZF-S development chip</i> on page 4-58.
Release version	ARM BP147 TZPC.
Reference documentation	<i>FPGA TrustZone Protection Controller registers and Development Chip TrustZone Protection Controller registers</i> on page 4-135. See also <i>PrimeCell Infrastructure AMBA3 TrustZone Protection Controller (BP147) Technical Overview</i> .

———— **Note** —————

For details of the TrustZone Interrupt Controller on the development chip, see *Development chip interrupt signals* on page 4-70.

4.24.1 FPGA TrustZone Protection Controller registers

A TrustZone Protection Controller is present on the APB bus to enable individual control of the TrustZone protection bits to all of the APB slaves in the FPGA. Each TrustZone Protection Controller has three registers to read, set, or clear the bits. Setting the protection bit disables protection.

The TZPCDECPROT_x registers in the FPGA TrustZone Protection Controller are listed in Table 4-139.

Table 4-139 FPGA TrustZone Protection Controller registers

Register	Address	Access	Description
TZPCDECPROT0Stat	0x10003800	Read-only	Read status bits for devices listed in Table 4-140 on page 4-134.
TZPCDECPROT0Set	0x10003804	Write	Set status bits and disable protection for devices listed in Table 4-140 on page 4-134. If a bit is set to 1 in this register, the corresponding bit in the security status is set and non-secure access is enabled. Bits set to 0 do not affect the status.
TZPCDECPROT0Clr	0x10003808	Write	Clear bits and enable protection. If a bit is set to 1 in this register, the corresponding bit in the security status is cleared and non-secure access is blocked. Bits set to 0 do not affect the status.
TZPCDECPROT1Stat	0x1000380C	Read-only	Read status bits for devices listed in Table 4-141 on page 4-134.
TZPCDECPROT1Set	0x10003810	Write	Set status bits and disable protection. Bit values have the same effect as described for TZPCDECPROT0Set.
TZPCDECPROT1Clr	0x10003814	Write	Clear bits and enable protection. Bit values have the same effect as described for TZPCDECPROT0Clr.
TZPCDECPROT2Stat	0x10003818	Read-only	Read security status for devices listed in Table 4-142 on page 4-135.
TZPCDECPROT2Set	0x1000381C	Write	Set status bits and disable protection. Bit values have the same effect as described for TZPCDECPROT0Set.
TZPCDECPROT2Clr	0x10003820	Write	Clear bits and enable protection. Bit values have the same effect as described for TZPCDECPROT0Clr.
TZPCDECPROT3Stat	0x10003824	Read-only	Reserved.
TZPCDECPROT3Set	0x10003828	Write	Reserved.
TZPCDECPROT3Clr	0x1000382C	Write	Reserved.

FPGA TZPCDECPROT0 register

The peripherals controlled by TZPCDECPROT0 are listed in Table 4-140:

Table 4-140 FPGA TZPCDECPROT0x bit assignment

Bits	Access	Description
[31:8]	Read/write	Reserved
[7]	Read/write	KMI1
[6]	Read/write	KMI0
[5]	Read/write	MMCI
[4]	Read/write	AACI
[3]	Read/write	TZ Protection Controller on FPGA.
[2]	Read/write	Serial bus
[1]	Read/write	Sys Control
[0]	Read/write	Sys Registers

FPGA TZPCDECPROT1 register

The peripherals controlled by TZPCDECPROT1 are listed in Table 4-141:

Table 4-141 FPGA TZPCDECPROT1x bit assignment

Bits	Access	Description
[31:8]	Read/write	Reserved
[7]	Read/write	RTC
[6]	Read/write	GPIO2
[5]	Read/write	GPIO1
[4]	Read/write	TIMER23
[3]	Read/write	TIMER01
[2]	Read/write	SCI
[1]	Read/write	UART4
[0]	Read/write	CHARLCD

FPGA TZPCDECPROT2 register

The peripherals controlled by TZPCDECPROT2 are listed in Table 4-142:

Table 4-142 FPGA TZPCDECPROT2 register

Bits	Access	Description
[31:4]	Read/write	Reserved
[3]	Read/write	DAP ROM Table. Not implemented.
[2]	Read/write	GIC0
[1]	Read/write	Power Monitor
[0]	Read/write	PCI Controller

4.24.2 Development Chip TrustZone Protection Controller registers

A TrustZone Protection Controller implemented inside the development chip controls secure or non-secure access for internal RAM and the slaves and masters on the PL300 interconnect. The development chip TZPC registers are listed in Table 4-143:

Table 4-143 Development chip TrustZone Protection Controller registers

Register	Access	Address	Description
TZPCR0SIZE	Read/Write	0x10101000	Protection for internal RAM on dev. chip.
TZPCDECPROT0Stat	Read-only	0x10101800	Security status for slaves and masters listed in Table 4-144 on page 4-137.
TZPCDECPROT0Set	Write	0x10101804	Set status bits and disable protection. If a bit is set to 1 in this register, the corresponding bit in the security status is set and non-secure access is allowed. Bits set to 0 do not affect the status.
TZPCDECPROT0Clr	Write	0x10101808	Clear bits and enable protection. If a bit is set to 1 in this register, the corresponding bit in the security status is cleared and non-secure access is blocked. Bits set to 0 do not affect the status.
TZPCDECPROT1Stat	Read-only	0x1010180C	Read security status for slaves and masters listed in Table 4-145 on page 4-138.

Table 4-143 Development chip TrustZone Protection Controller registers (continued)

Register	Access	Address	Description
TZPCDECPROT1Set	Write	0x10101810	Set status bits and disable protection. Bit values have the same effect as described for TZPCDECPROT0Set.
TZPCDECPROT1Clr	Write	0x10101814	Clear bits and enable protection. Bit values have the same effect as described for TZPCDECPROT0Clr.
TZPCDECPROT2Stat	Read-only	0x10101818	Read security status for slaves and masters listed in Table 4-146 on page 4-139.
TZPCDECPROT2Set	Write	0x1010181C	Set status bits and disable protection. Bit values have the same effect as described for TZPCDECPROT0Set.
TZPCDECPROT2Clr	Write	0x10101820	Clear bits and enable protection. Bit values have the same effect as described for TZPCDECPROT0Clr.

TZPCR0SIZE register

Security for the internal RAM in the development chip is managed by the TZPCR0SIZE register.

The R0SIZE signals from the TZPC are connected directly to the TrustZone Memory Adapter for the on-chip 512KB RAM and define the secure RAM regions in 4KB increments from the RAM base address of 0x10300000:

- there is no secure region if all of the TZPCR0SIZE bits are clear
- the first 4KB of RAM is secure if you set TZPCR0SIZE to 0x00000001.
- the entire 512KB RAM is secure if you set bits[9:0] of TZPCR0SIZE to a value greater than or equal to 0x000000FF.

At reset, the entire RAM space is defined as secure.

Region R0 in Figure 4-49 on page 4-137 is the secure region for the internal RAM. Region R1 is non-secure and exists in the remaining region to the end of the memory block.

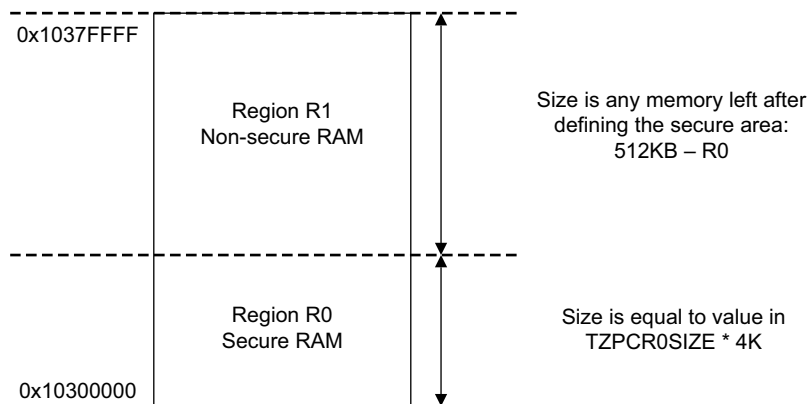


Figure 4-49 Secure and non-secure internal RAM

TZPCDECPROT0x registers

The peripherals controlled by the TZPCDECPROT0x registers are listed in Table 4-144:

Table 4-144 Development chip TZPCDECPROT0x bit assignment

Bits	Access	Description
[15]	Read/write	UART3
[14]	Read/write	UART2
[13]	Read/write	UART1
[12]	Read/write	UART0
[11]	Read/write	SSP
[10]	Read/write	GPIO
[9]	Read/write	DMC Configuration Port
[8]	Read/write	RTC
[7]	Read/write	Watchdog
[6]	Read/write	Timers 4/5
[5]	Read/write	Timers 2/3
[4]	Read/write	Timers 0/1

Table 4-144 Development chip TZPCDECPROT0x bit assignment (continued)

Bits	Access	Description
[3]	Read/write	IEC
[2]	Read/write	APC
[1]	Read/write	SBZ (unused)
[0]	Read/write	System Controller

TZPCDECPROT1x registers

The peripherals controlled by the TZPCDECPROT1x registers are listed in Table 4-145:

Table 4-145 Development chip TZPCDECPROT1x bit assignment

Bits	Access	Description
[15:4]	Read/write	SBZ (Reserved)
[13]	Read/write	AXI ROM
[12]	Read/write	AXI Master Port
[11:8]	Read/write	DMC Chip Select 3–0
<div>———— Note ————</div> <div>Because the DMC chip select pins are aliased, securing a block of the dynamic memory requires clearing both the chip select and the aliased chip select.</div> <div>For example, clear both bit 10 and bit 8 to 1 to secure the lower block of memory.</div>		
[7:0]	Read/write	SMC Chip Select 7–0

Set the corresponding bit to disable protection for the associated peripheral or bus.

TZPCDECPROT2x registers

The peripherals controlled by the TZPCDECPROT2x registers are listed in Table 4-146:

Table 4-146 Development chip TZPCDECPROT2

Bits	Access	Description
[15:5]	Read/write	SBZ (Reserved)
[7]	Read/write	Trust Zone Interrupt Controller
[6]	Read/write	CLCD Configuration Port
[5]	Read/write	CLCD Master Port
[4]	Read/write	AXI Slave Port
[3:0]	Read/write	AXI Master Port 3–0. Exported off chip

4.25 UART

The PrimeCell UART is an AMBA compliant SoC peripheral that is developed, tested, and licensed by ARM Limited. There are three UARTs in the ARM1176JZF-S development chip and one UART is in FPGA. The 24MHz reference clock to the UARTs come from the crystal oscillator that is part of OSC0.

Table 4-147 UART implementation

Property	Value
Location	ARM1176JZF-S development chip for UART 0-3 FPGA for UART4.
Memory base address	0x1010C000 for UART0 0x1010D000 for UART1 0x1010E000 for UART2 0x1010F000 for UART3 0x10009000 for UART4
Interrupt	50 on dev. chip GIC for UART0 (18 on TZIC) 51 on dev. chip GIC for UART1 (19 on TZIC) 52 on dev. chip GIC for UART2 (20 on TZIC) 53 on dev. chip GIC for UART3 (21 on TZIC) 38 on FPGA GICs for UART4
Release version	ARM UART PL011 r1p3
Reference documentation	ARM PrimeCell UART (PL011) Technical Reference Manual (see also UART interface on page 3-20).

You can program the following key parameters:

- communication baud rate, integer, and fractional parts
- number of data and stop bits
- parity mode
- FIFO enable and FIFO trigger levels
- UART or IrDA protocol
- hardware flow control.

4.25.1 PrimeCell Modifications

The PrimeCell UART varies from the industry-standard 16C550 UART device as follows:

- receive FIFO trigger levels are 1/8, 1/4, 1/2, 3/4, and 7/8
- the internal register map address space, and the bit function of each register differ
- the deltas of the modem status signals are not available
- 1.5 stop bits not available (1 or 2 stop bits only are supported)
- no independent receive clock.

4.26 USB interface

The USB interface is provided by an external NXP ISP1761 USB 2.0 controller that provides a standard USB host controller and an *On-The-Go* (OTG) dual role device controller. The USB host has one or two downstream ports. The OTG can function as either a host or slave device.

Table 4-148 USB implementation

Property	Value
Location	Board (an ISP1761 chip).
Memory base address	0x3B000000 on static CS6, the registers in the ISP1761 are memory-mapped into the static memory area.
Interrupt	43 on FPGA GICs
Release version	Custom interface in FPGA to external ISP1761 controller
Reference documentation	<i>NXP ISP1761 Data Sheet</i> (see also <i>USB interface</i> on page 3-27 and test program supplied on the CD).

The ISP1761 has the following features:

- fully compliant to the USG On-The-Go specification
- configurable number of downstream and upstream hosts or functions
- USB host is USB 2.0 compliant and supports 12Mb/s and 1.5Mb/s
- programmable interrupts
- 4KB on-chip RAM.

The ISP1761 register base addresses are shown in Table 4-149.

Table 4-149 USB controller base address

Address	Description
0x3B020000	Chip-level register bank
0x3B020080	Host controller register bank
0x3B020100	Function controller register bank

4.27 Watchdog

The PrimeCell Watchdog module is an AMBA compliant SoC peripheral developed, tested and licensed by ARM Limited. The Watchdog module consists of a 32-bit down counter with a programmable timeout interval that has the capability to generate an interrupt and a reset signal on timing out. It is intended to be used to apply a reset to a system in the event of a software failure.

Note

The Watchdog counter is disabled if the core is in debug state.

Table 4-150 Watchdog implementation

Property	Value
Location	ARM1176JZF-S development chip
Memory base address	0x10107000
Interrupt	32 on dev. chip GIC (0 on TZIC)
Release version	ARM WDOG SP805 r2p0
Reference documentation	<i>ARM PrimeCell Watchdog Controller (SP805) Technical Reference Manual</i>

The following Watchdog module parameters are programmable:

- interrupt generation enable/disable
- interrupt masking
- reset signal generation enable/disable
- interrupt interval.

Appendix A

Signal Descriptions

This appendix provides a summary of signals present on the PB1176JZF-S connectors. It contains the following sections:

- *Synchronous Serial Port interface* on page A-2
- *Smart Card interface* on page A-3
- *UART interface* on page A-5
- *USB interface* on page A-6
- *Audio CODEC interface* on page A-7
- *MMC and SD flash card interface* on page A-9
- *CLCD DVI display interface* on page A-11
- *GPIO interface* on page A-12
- *Keyboard and mouse interface* on page A-13
- *Ethernet interface* on page A-14
- *RealView Logic Tile header connectors* on page A-15
- *Test and debug connections* on page A-16.

For more information on connectors used on the PB1176JZF-S, see the parts list spreadsheet in the CD schematics directory.

A.1 Synchronous Serial Port interface

Figure A-1 shows the signals on the expansion SSP interface connector J29.

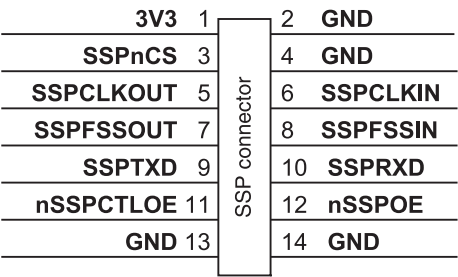


Figure A-1 SSP expansion interface

The signals associated with the SSP are shown in Table A-1.

Table A-1 SSP signal assignment

Signal name	Description
SSPCLKOUT	Clock output from controller
SSPCLKIN	Clock input to controller
nSSPCTLOE	Control output enable control
nSSPOE	Data output enable control
SSPFSSOUT	Frame sync output
SSPFSSIN	Frame sync input
SSPTXD	Data output
SSPRXD	Data input
SSPnCS	Chip select

A.2 Smart Card interface

The PB1176JZF-S contains a Smart Card SIM socket.

The signals associated with the SCI connector J33 are listed in Table A-2.

Table A-2 Smartcard connector signal assignment

Pin	Signal	Description
1	SC_VCC	Card power (1.8V, 3.3V, or 5V)
2	SC_RST	Reset to card
3	SC_CLK	Clock to or from card
4	NC	-
5	GND	Ground
6	SC_VCC	Card power (1.8V, 3.3V, or 5V)
7	SC_IO	Serial data to or from the card
8	NC	-
SW1	nSCIDTECT	Card detect signal from switch in socket (not present on J25 and J26)

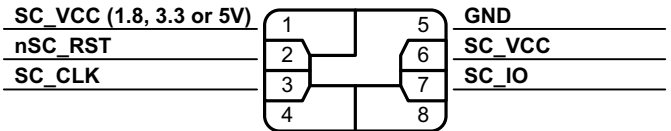


Figure A-2 Smartcard contacts assignment

Figure A-2 shows the signal assignment of a Smart Card. Pins 4 and 8 are not connected and are omitted on some cards.

The SIM card is inserted into the SIM card socket with the contacts face down.

Table A-3 lists the signals on the SCI expansion connector. The signals on the expansion connector are use 3.3V logic levels. The **SCIVCCEN** signal disables the signals and power supply to SCI connector J33.

Table A-3 Signals on SCI expansion connector

Pin	Signal name
1	Ground
2	SCIFCB
3	SCIDATA
4	nSCIDETECT
5	SC_VCC (card power)
6	nSCICARDRST (reset)
7	SCICLK (clock)
8	NC

GND	1	5	SC_VCC
SCIFCB	2	6	nSCICARDRST
SCIDATA	3	7	SCICLK
nSCIDETECT	4	8	NC

Figure A-3 SCI expansion connector J29

A.3 UART interface

The PB1176JZF-S provides five serial transceivers. All use 9-pin D-type male connectors except for UART3 (J28) that uses a standard 10-pin 2.54mm header connector.

Figure A-4 shows the D-type connector and Table A-4 shows the signal assignment for the D-type and header connectors. The pinout shown in Figure A-4 is configured as a *Data Communications Equipment* (DCE) device.

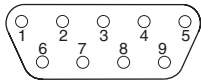


Figure A-4 Serial connector for J26A, J26B, J27A, and J27B

Table A-4 Serial plug signal assignment

Pin	UART0 J26A (top)	UART1 J26B (bottom)	UART2 J27A (top)	UART3 J28 (10-pin header)	UART4 J27B (bottom)
1	SER0_DCD	NC	NC	NC	NC
2	SER0_RX	SER1_RX	SER2_RX	SER3_DSR	SER4_RX
3	SER0_TX	SER1_TX	SER2_TX	SER3_RX	SER4_TX
4	SER0_DTR	SER1_DTR ^a	SER2_DTR ^a	SER3_RTS ^a	SER4_DTR
5	SER0_GND	SER1_GND	SER2_GND	SER3_TX	SER4_GND
6	SER0_DSR	SER1_DSR	SER2_DSR	SER3_CTS	SER4_DSR
7	SER0_RTS	SER1_RTS ^a	SER2_RTS ^a	SER3_DTR ^a	SER4_RTS
8	SER0_CTS	SER1_CTS	SER2_CTS	NC	SER4_CTS
9	SER0_RI	NC	NC	GND	NC
10	-	-	-	NC	-

a. The signals **SER1_DTR**, **SER2_DTR**, and **SER3_DTR** are connected to the corresponding **SER1_DSR**, **SER2_DSR**, and **SER3_DSR** signals. These signals cannot be set or read under program control.

A.4 USB interface

USB2 and USB3 provide USB host interfaces and connect through the type A connector J19.

USB1 provides an OTG interface and connects through the OTG connector J18.

———— **Note** ————

For a full description of the USB signals see the datasheet for the TransDimension ISP1761 USB controller.

Figure A-5 shows the USB connectors.

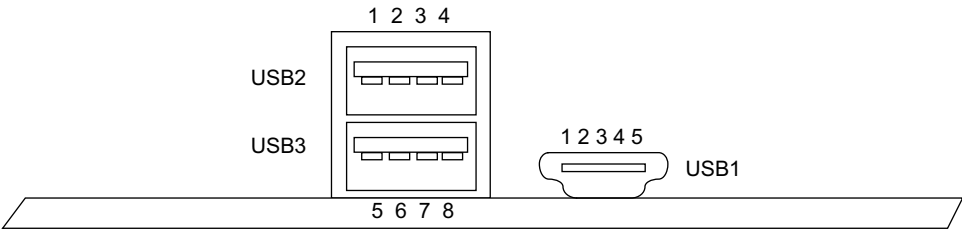


Figure A-5 USB interfaces

Table A-5 USB signals

Pin	J18 USB OTG	J19 dual USB
1	VBUSP1 (power)	VBUSP2 (power)
2	DM1	DM3
3	DP1	DP3
4	ID	GND2
5	GND1	VBUSP3
6	-	DM2
7	-	DP2
8	-	GND3

A.5 Audio CODEC interface

The PB1176JZF-S provides three jack connectors that enable you to connect to the microphone and auxiliary inputs, and line level output on the CODEC. Figure A-6 shows the pinouts of the sockets.

Note
A link on the board enables bias voltage to be applied to the microphone (see *Advanced Audio Codec Interface, AACI* on page 3-24).

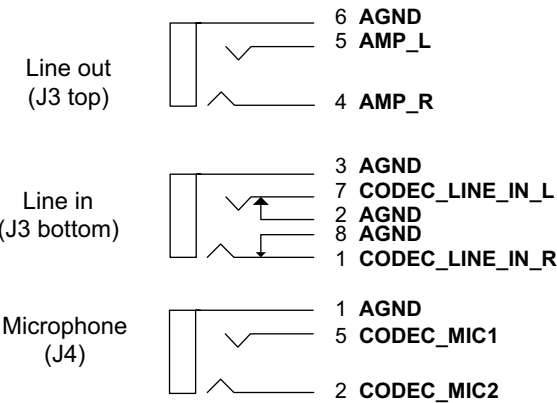


Figure A-6 Audio connectors

The signals associated with the audio CODEC interface are also assigned to connector J45, the AACI expansion socket pins, as shown in Table A-6.

Table A-6 Audio CODEC expansion connector signals

Pin number	Signal name	Description
1	AACIBITCLK	Clock from the CODEC to the AACI
2	AACISYNC	Frame synchronization signal from the AACI
3	AACISDATAIN	Serial data from the CODEC to the AACI

Table A-6 Audio CODEC expansion connector signals (continued)

Pin number	Signal name	Description
4	AACI_RESET	Reset signal from the AACI to the CODEC
5	AACISDATAOUT	Serial data from the AACI to the CODEC
6	GND	Signal ground

Figure A-7 shows the pinouts of the AACI expansion connector.

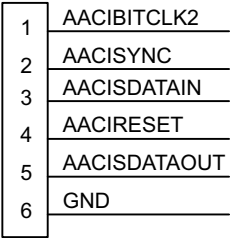


Figure A-7 AACI expansion connector

A.6 MMC and SD flash card interface

The MMC/SD card sockets provides nine pins that connect to the card when it is inserted into the socket. Figure A-8 shows the pin numbering and signal assignment. In addition, the socket contains switches that are operated by card insertion and provide signaling on the **nCARDIN** and **WPROT** signals.

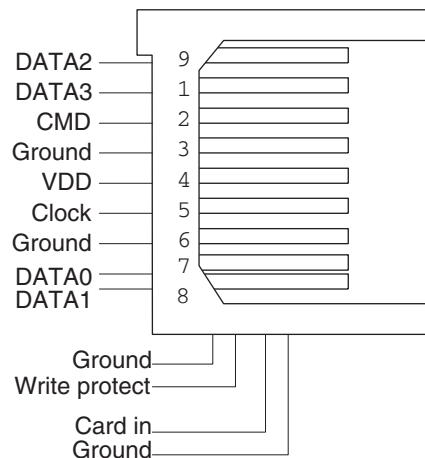


Figure A-8 MMC/SD card socket pin numbering

The MMC card uses seven pins, but the SD card uses all nine pins. The additional pins are located as shown in Figure A-8 with pin 9 next to pin 1 and pins 7 and 8 spaced more closely together than the other pins. Figure A-9 shows an MCI card, with the contacts face up.

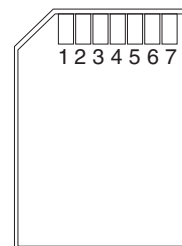


Figure A-9 MMC card

Table A-7 lists the signal assignments.

Table A-7 Multimedia Card interface signals

Pin	Signal	Function SD widebus mode	Function MCI
1	MCIDATA3	Data	Chip select
2	MCICMD	Command/response	Data in
3	GND	Ground	Ground
4	MCIVDD	Supply voltage	Supply voltage
5	MCICLK	Clock	Clock
6	GND	Ground	Ground
7	MCIDATA0	Data 0	Data out
8	MCIDATA1	Data 1	NC
9	MCIDATA2	Data 2	NC
10 (DET A)	CARDIN	Card insertion detect	Card insertion detect
11 (DET B)	WPROT	Write protect status	Write protect status

Insert and remove the card as follows:

- Insertion

Insert the card into the socket with the contacts face down. Cards are normally labeled on the top surface with an arrow to indicate correct insertion.
- Removal

Remove the card by gently pressing it into the socket. It springs back and can be removed. Removing the card in this way ensures that the card detection switches within the socket operate correctly.

A.7 CLCD DVI display interface

The DVI Digital/Analog connector (J21) is shown in Figure A-10. The connector signals are listed in Table A-8. A Digital to Analog Converter (DAC) converts the digital CLCD data and synchronization signals into the analogue VGA signals.

Table A-8 DVI Digital/Analog connector signals

Pin	Signal	Pin	Signal	Pin	Signal
1	TX2_NEG	9	TX1_NEG	17	TX0_NEG
2	TX2_POS	10	TX1_POS	18	TX0_POS
3	D2_D4_SHIELD	11	D1_D3_SHIELD	19	D0_D5_SHIELD
4	NC	12	NC	20	NC
5	NC	13	NC	21	NC
6	DVISCL_C	14	5V_FUSED_DVI	22	DIV_CLK_SHIELD
7	DVISDA_C	15	GND	23	TXC_POS
8	VSYNC	16	DVI_HOTPLUG	24	TXC_NEG
C1	A_RED	-	VGA_GND	C3	A_BLUE
C2	A_GREEN	-	-	C4	A_HSYNC

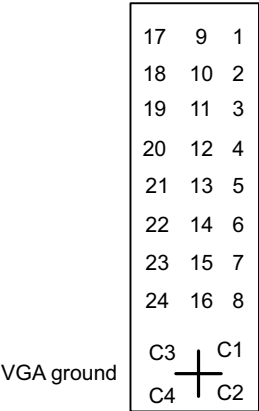


Figure A-10 DVI Digital/Analog connector

A.8 GPIO interface

One eight-bit *General Purpose Input/Output* (GPIO) controller is incorporated into the ARM1176JZF-S development chip and one is implemented in the FPGA. The signals on the GPIO connector are shown in Figure A-11.

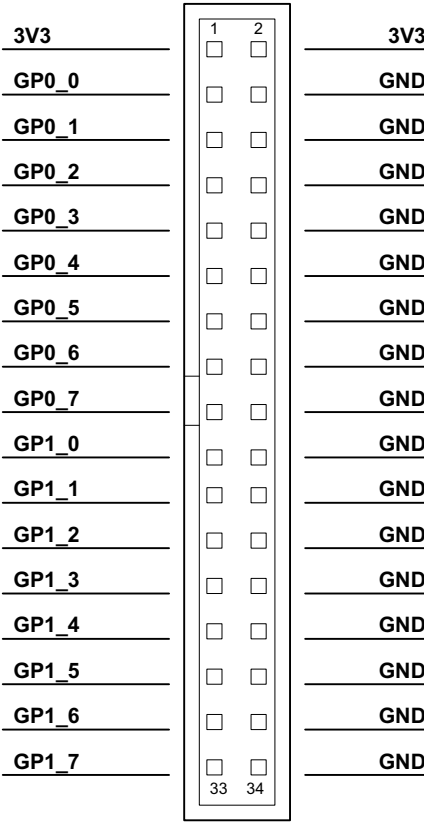


Figure A-11 GPIO connector

Note

Each data pin has an on-board 10KΩ pullup resistor to 3.3V.

A.9 Keyboard and mouse interface

The pinout of the KMI connectors J35 and J36 is shown in Figure A-12.

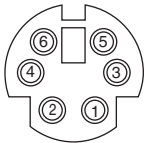


Figure A-12 KMI connector

Table A-9 shows signals on the KMI connectors.

Table A-9 Mouse and keyboard port signal descriptions

Pin	Keyboard (KMI0, J36)		Mouse (KMI1, J35)	
	Signal	Function	Signal	Function
1	KDATA	Keyboard data	MDATA	Mouse Data
2	NC	Not connected	NC	Not connected
3	GND	Ground	GND	Ground
4	5V	Fused 5V	5V	Fused 5V
5	KCLK	Keyboard clock	MCLK	Mouse clock
6	NC	Not connected	NC	Not connected

A.10 Ethernet interface

The RJ45 Ethernet connector J5 is shown in Figure A-13.

LEDA (green) and LEDB (yellow) are connected to the LAN9118 controller. The function of the LEDs is determined by registers in the controller. Typical usage would be to monitor transmit activity and packet detection.

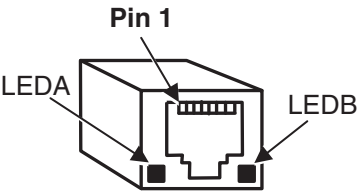


Figure A-13 Ethernet connector J5

The signals on the Ethernet cable are shown in Table A-10.

Table A-10 Ethernet signals

Pin	Signal
1	TX +
2	TX –
3	RX +
4	NC
5	NC
6	RX –
7	NC
8	NC

A.11 RealView Logic Tile header connectors

These headers enable the connection of a RealView Logic Tile to the PB1176JZF-S. Figure A-14 shows the pin numbers and power-blade usage of the HDRX, HDRY, and HDRZ headers. See Appendix C *RealView Logic Tile* for details of the RealView Logic Tile connectors.

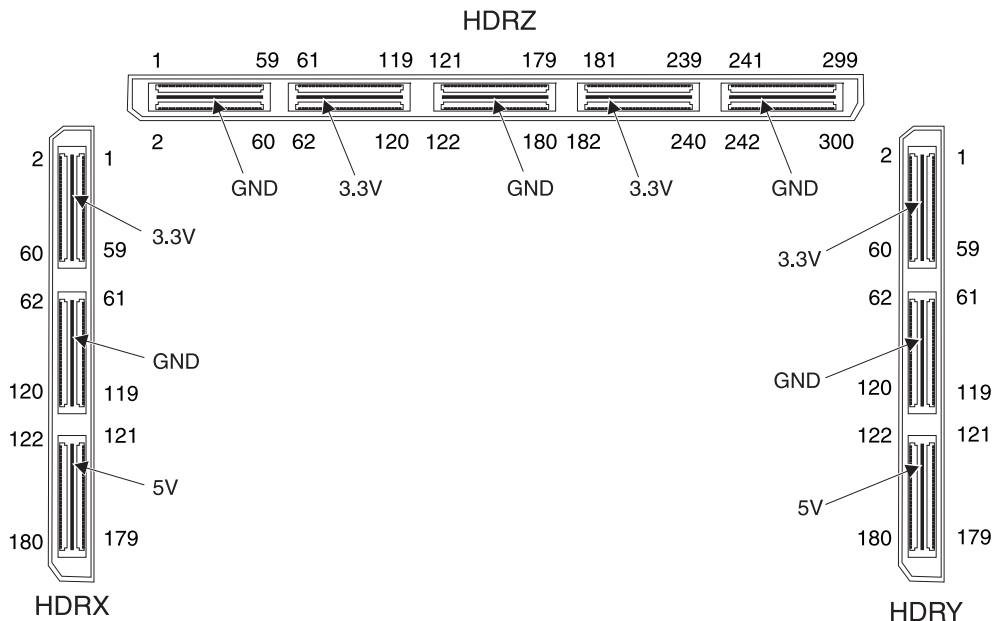


Figure A-14 RealView Logic Tile HDRX, HDRY, and HDRZ pin numbering

A.12 Test and debug connections

The PB1176JZF-S provides the test points and connectors shown in Figure A-15.

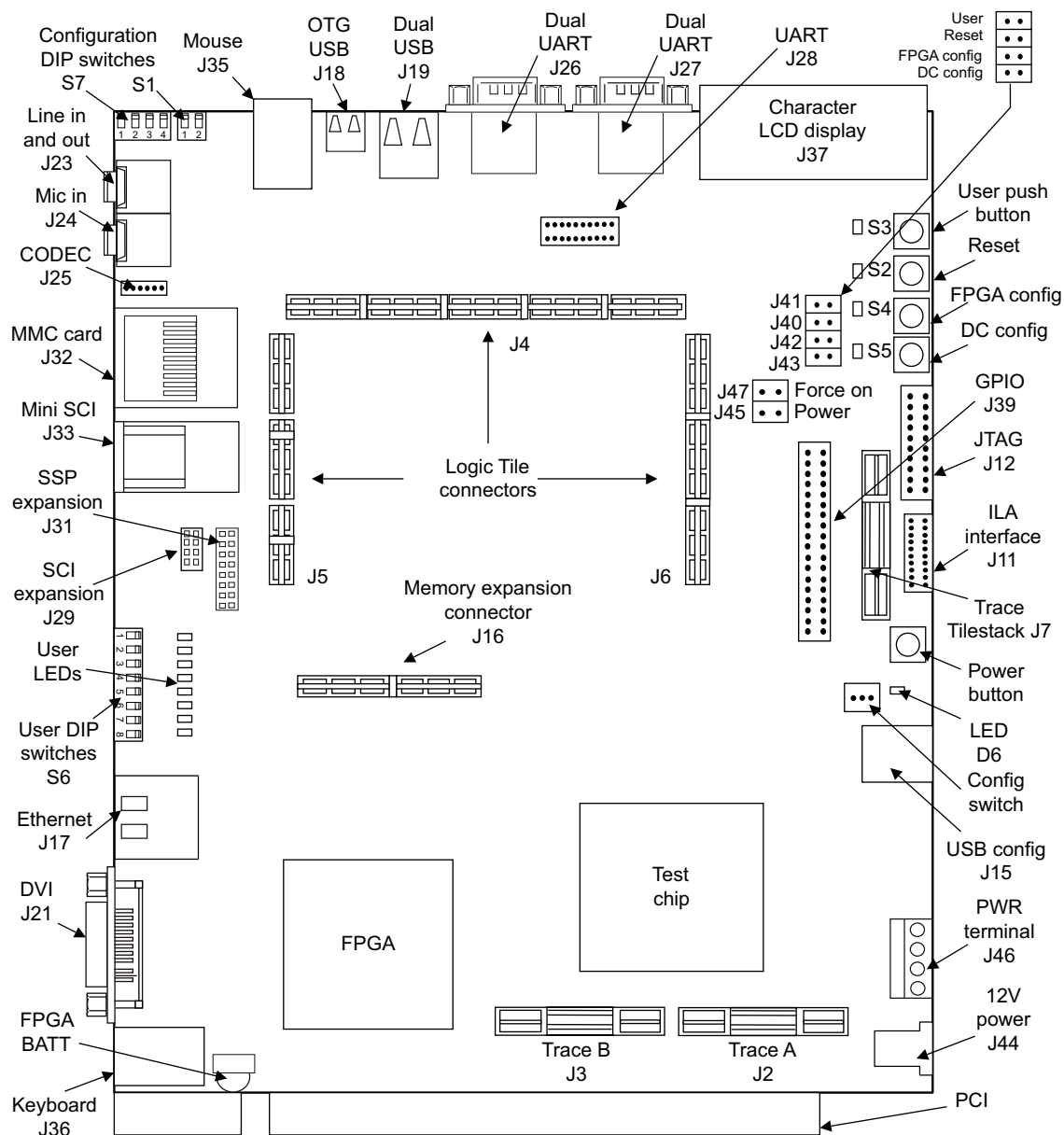


Figure A-15 Test points and debug connectors

This section contains the following subsections:

- *JTAG*
- *USB debug port*
- *Trace connector pinout* on page A-18
- *Integrated logic analyzer* on page A-21.

A.12.1 JTAG

Figure A-16 shows the pinout of the JTAG connector J12 and Table 3-10 on page 3-55 provides a description of the JTAG and related signals. All JTAG active HIGH input signals have pull-up resistors (DGBRQ is active LOW and has a pull-down resistor).

———— **Note** ————

The term JTAG equipment refers to any hardware that can drive the JTAG signals to devices in the scan chain. Typically this is RealView ICE, although hardware from other suppliers can also be used to debug ARM processors.

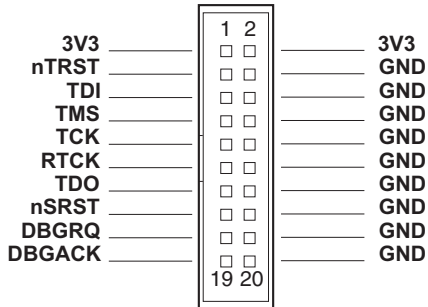


Figure A-16 JTAG connector J12

A.12.2 USB debug port

Figure A-17 on page A-18 shows the signals on the USB debug connector J15. **USBDP** and **USBDM** are the positive and negative USB data signals. The USB debug port can be used to load new images into the PB1176JZF-S FPGA or into FPGAs on attached Logic Tiles.

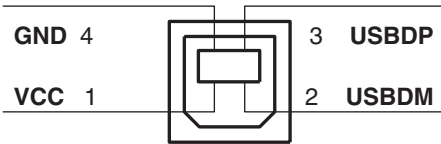


Figure A-17 USB debug connector J15

A.12.3 Trace connector pinout

The Mictor connector that is used for trace signals is shown in Figure A-18.

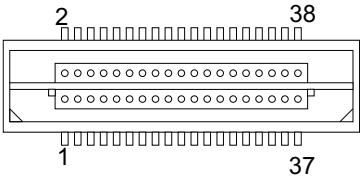


Figure A-18 AMP Mictor connector

Table A-11 and Table A-12 on page A-19 lists the pinouts of the development chip trace connectors.

Table A-11 Trace connector J2

Channel	Pin	Pin	Channel
5VDC	1	2	Not connected
GND	3	4	Not connected
GND	5	6	TRACECLK
NC	7	8	NC
NC	9	10	NC
NC	11	12	3V3
NC	13	14	3V3
NC	15	16	TRACEDATA7
NC	17	18	TRACEDATA6
NC	19	20	TRACEDATA5

Table A-11 Trace connector J2 (continued)

Channel	Pin	Pin	Channel
NC	21	22	TRACEDATA4
TRACEDATA15	23	24	TRACEDATA3
TRACEDATA14	25	26	TRACEDATA2
TRACEDATA13	27	28	TRACEDATA1
TRACEDATA12	29	30	GND
TRACEDATA11	31	32	GND
TRACEDATA10	33	34	3V3
TRACEDATA9	35	36	TRACECTL
TRACEDATA8	37	38	TRACEDATA0

Table A-12 Trace connector J3

Channel	Pin	Pin	Channel
5VDC	1	2	Not connected
GND	3	4	Not connected
GND	5	6	TRACECLK
NC	7	8	NC
NC	9	10	NC
NC	11	12	3V3
NC	13	14	3V3
NC	15	16	TRACEDATA23
NC	17	18	TRACEDATA22
NC	19	20	TRACEDATA21
NC	21	22	TRACEDATA20
TRACEDATA31	23	24	TRACEDATA19
TRACEDATA30	25	26	TRACEDATA18

Table A-12 Trace connector J3 (continued)

Channel	Pin	Pin	Channel
TRACEDATA29	27	28	TRACEDATA17
TRACEDATA28	29	30	GND
TRACEDATA27	31	32	GND
TRACEDATA26	33	34	3V3
TRACEDATA25	35	36	GND
TRACEDATA24	37	38	TRACEDATA16

Table A-13 lists the pinouts of the Logic Tile trace connector J7. The Logic Tile trace connector is not restricted to use only as a trace connector. The connector can be used to monitor any signals that are implemented on the specified header pins.

Table A-13 Logic Tile trace connector J7

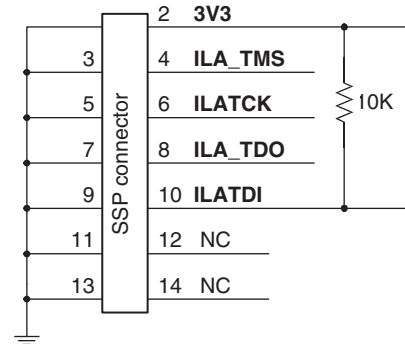
Channel	Pin	Pin	Channel
NC	1	2	Not connected
GND	3	4	Not connected
Y178	5	6	Y179
Y177	7	8	Y168
Y152	9	10	Y167
Y151	11	12	Y166
Y150	13	14	Y165
Y149	15	16	Y164
Y148	17	18	Y163
Y147	19	20	Y162
Y146	21	22	Y161
Y176	23	24	Y160
Y175	25	26	Y159
Y174	27	28	Y158

Table A-13 Logic Tile trace connector J7 (continued)

Channel	Pin	Pin	Channel
Y173	29	30	Y157
Y172	31	32	Y156
Y171	33	34	Y155
Y170	35	36	Y154
Y169	37	38	Y153

A.12.4 Integrated logic analyzer

Figure A-19 shows the signals on the integrated logic analyzer connector J11. Use an embedded logic analyzer to debug FPGA designs and software at the same time. For more information, see the documentation supplied with your analyzer. (The ChipScope product is described on the Xilinx web site at www.xilinx.com.)

**Figure A-19 Integrated logic analyzer connector J11**

Appendix B

Specifications

This appendix contains the specification for the PB1176JZF-S. It contains the following sections:

- *Electrical specification* on page B-2
- *Clock rate restrictions* on page B-4
- *Mechanical details* on page B-5.

B.1 Electrical specification

This section provides details of the voltage and current characteristics for the PB1176JZF-S.

B.1.1 Bus interface characteristics

Table B-1 shows the PB1176JZF-S electrical characteristics.

Table B-1 PB1176JZF-S electrical characteristics				
Symbol	Description	Min	Max	Unit
DC IN	DC input voltage	9	15	V
12V	Supply voltage from terminal or PCI	11.4	12.6	V
3V3	Supply voltage (interface signals)	3.1	3.5	V
5V	Supply voltage	4.75	5.25	V
V _{IH}	High-level input voltage	2.0	3.6	V
V _{IL}	Low-level input voltage	0	0.8	V
V _{OH}	High-level output voltage	2.4	-	V
V _{OL}	Low-level output voltage	-	0.4	V
C _{IN}	Capacitance on any input pin	-	5	pF

B.1.2 Current requirements

This section lists the current requirements of the PB1176JZF-S.

Powered from DC IN

Table B-2 shows the current requirements at room temperature and nominal voltage powered from the DC IN connector.

Table B-2 Current requirements from DC IN (12V)	
System	DC IN
Standalone	0.8A
RealView Logic Tile	1A

Powered from J34 or PCI bus

Table B-3 shows the current requirements if the board is powered from the terminal connector or the PCI bus. The maximum value refers to loading by additional RealView Logic Tiles or the custom implementations of the CLCD interface.

Table B-3 Current requirements from terminal connector

System	3.3V in	5V in	12V in
Standalone	1.5A	0.5A	0.2A
RealView Logic Tiles ^a	0.5A	0.8A	-

a. For example, the LT-XC2V4000+ RealView Logic Tile draws 0.5A from the 3.3V supply.

Loading on supply voltage rails

Table B-4 lists the maximum current load that can be placed on the supply voltage rails.

Table B-4 Maximum current load on supply voltage rails

System	3.3V	5V	12V
Supplied from DC IN (12V at 3A) 36W	2A 6.6W	1.5A 7.5W	3A 36W
Supplied from J34 or PCI (12V at 3A, 5V at 3A, and 3.3V at 3A)	3A	3A	3A

Use Table B-4 together with Table B-2 on page B-2 or Table B-3 to calculate how much current capacity is available from the voltage rails for external loads such as RealView Logic Tiles.

B.2 Clock rate restrictions

The default clock rates for reliable operation are:

CPU 210MHz

AXI/MDDR 105MHz

External AXI 35MHz

If you have added one or more RealView Logic Tiles, you might discover that you have to reduce these clock rates.

———— **Caution** ————

The ICS307 programmable oscillators OSC0, OSC1, OSC2, OSC3, and OSC4 can be programmed to deliver very high clock signals (200MHZ). The only ARM1176JZF-S development chip clock input that can function at this frequency is **PLLCLKEXT**.

Also, the settings for VCO divider, output divider, and output select values are interrelated and must be set correctly. Some combinations of settings do not result in stable operation. For more information on the ICS clock generator and a frequency calculator, see the ICS web site at www.icst.com.

B.3 Mechanical details

Figure B-1 shows the mechanical outline of the PB1176JZF-S.

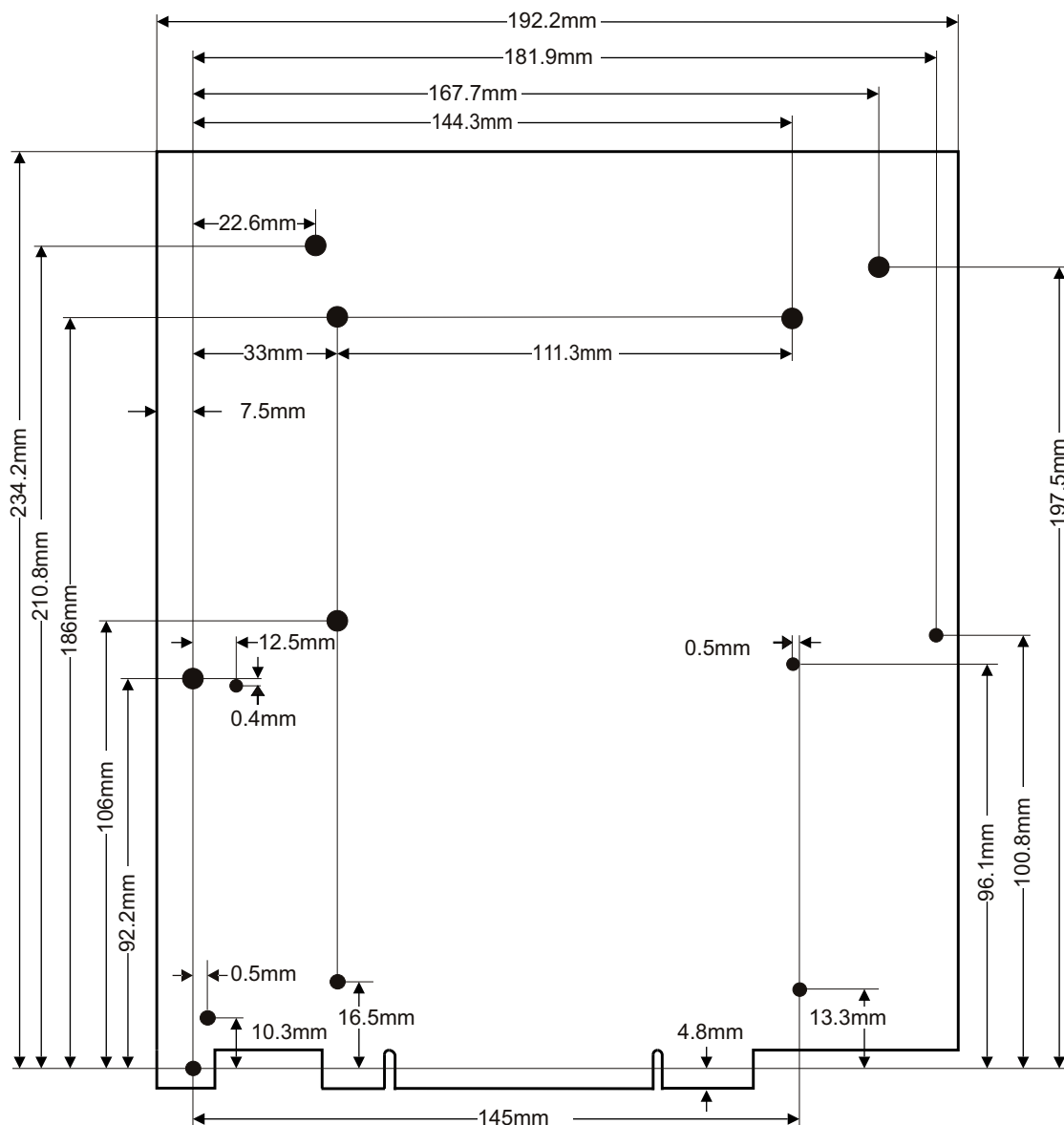


Figure B-1 Baseboard mechanical details

Appendix C

RealView Logic Tile

This appendix describes the signals present on the RealView Logic Tile expansion headers. It contains the following sections:

- *About the RealView Logic Tile* on page C-2
- *Signals on the tile header connectors* on page C-7.

———— **Note** —————

For more information on using the RealView Logic Tile, see the user guide for your tile.

—————

C.1 About the RealView Logic Tile

The ARM RealView Logic Tiles, for example the LT-XC2V6000 and LTXC4V160, enable developing AMBA AXI peripherals or custom logic.

Caution

The PB1176JZF-S or attached RealView Logic Tile can be damaged by improper use:

- The PB1176JZF-S recommended limit is two.
When stacking tiles ensure that the power source can maintain the required voltage at the top tile when supplying maximum current to the system. If necessary, use a separate bench supply or power the system from a PCI backplane. See *Current requirements from terminal connector* on page B-3 for more details.
 - The FPGA signals on a RealView Logic Tile and the PB1176JZF-S are fully programmable. Ensure that there are no clashes between the signals on the tiles or with the signals from the PB1176JZF-S.
The FPGA can be damaged if several pins configured as outputs are connected together and attempt to output different logic levels.
 - The RealView Logic Tile mounted on the PB1176JZF-S must use the default 3.3V signal levels.
-

The following section describes:

- *Variable I/O levels*
- *AXI buses* on page C-3
- *JTAG* on page C-4.

C.1.1 Variable I/O levels

All HDRX, HDRY, and HDRZ connector signals on the PB1176JZF-S are fixed at 3.3V I/O signalling level.

The I/O voltage on a RealView Logic Tile (**VCCO1** and **VCCO2**) can be changed by removing resistors on the tile and supplying the I/O voltage from either the tile above or the tile below in a tile stack. However, all signals from the PB1176JZF-S to a RealView Logic Tile use 3.3V I/O levels and all signals from a RealView Logic Tile to the PB1176JZF-S must use 3.3V I/O levels.

The 5V supply on the headers is to power voltage converters that might be present on the Logic Tile.

C.1.2 AXI buses

The AXI master and slave data signals are multiplexed to reduce the number of pins used on the tile headers:

- The PB1176JZF-S development chip AXI master connects to HDR Y.
- The PB1176JZF-S FPGA AXI slave bus connects to HDR X.

———— **Note** ————

If a Logic Tile is not fitted, the multiplexed PB1176JZF-S development chip master connects directly to the FPGA slave by smart switches.

If a Logic Tile is fitted, the direct connection is disabled and an AXI master and slave interface must be implemented in the tile FPGA to pass accesses from the development chip to the PB1176JZF-S FPGA slave.

- The PB1176JZF-S development chip AXI sideband bus signals are connected to HDR Z.

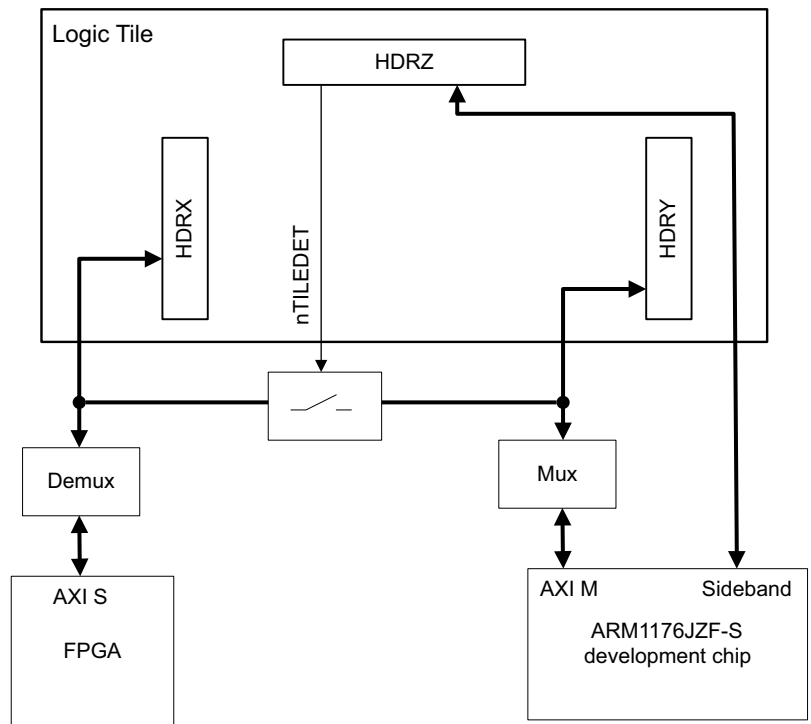


Figure C-1 AXI busses on Logic Tile

C.1.3 JTAG

The JTAG signals for the FPGA on the RealView Logic Tile are shown in Figure C-2. If a tile is connected to the baseboard, the **nTILE_DET** signal is grounded and the JTAG signals and AXI bus are routed through the tile.

There is not a JTAG connector on the RealView Logic Tile. Use the JTAG or USB debug connector on the baseboard to program the configuration flash in the RealView Logic Tile to directly load the RealView Logic Tile FPGA image.

The **nCFGEN** signal is controlled by the CONFIG jumper on the baseboard and selects debug or configuration mode for the tile FPGA and PLD. If the Logic Tile does not implement a debuggable core, the FPGA must interconnect the input and output D_ signals. For more information on JTAG signals and the difference between debug and configuration mode, see *JTAG debug port and USB config port support* on page 3-51.

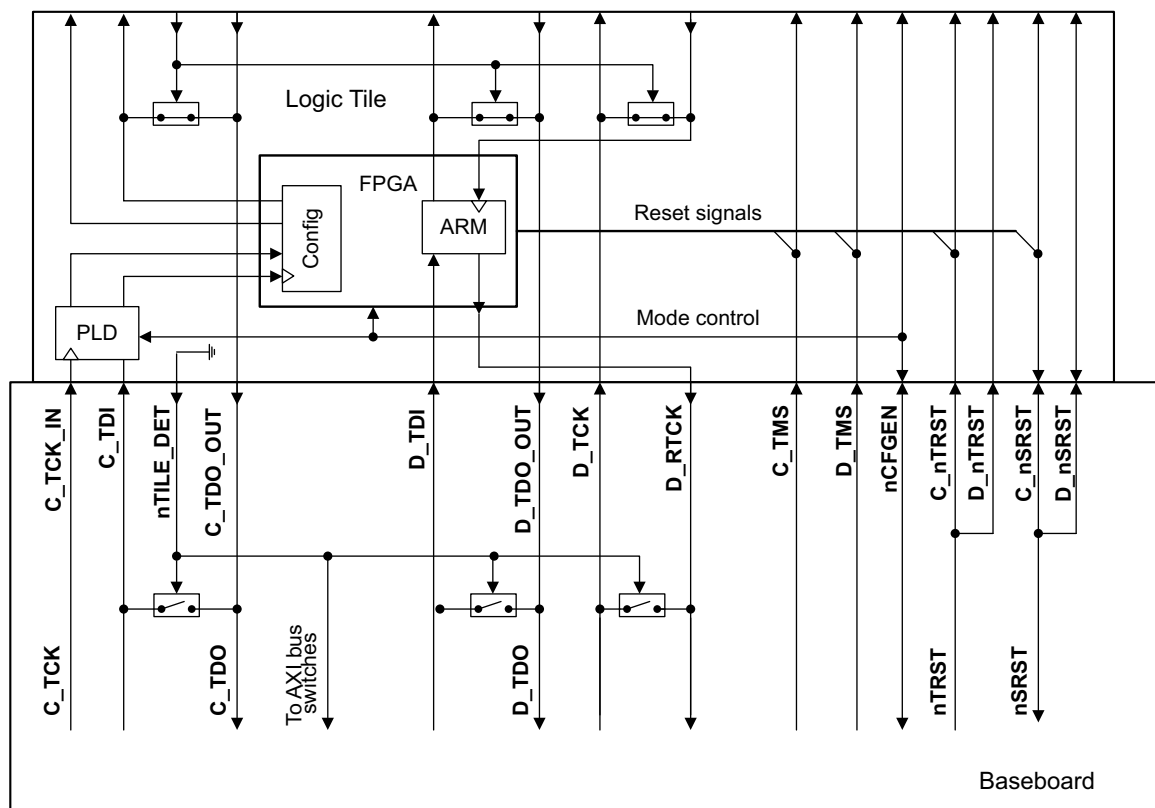


Figure C-2 JTAG signals to Logic Tiles

C.1.4 RealView Logic Tile clocks

Table C-1 lists the RealView Logic Tile clocks. See the user guide for your Logic Tile for more information on using clocks.

Each tile can receive or generate the shared **CLK_GLOBAL** signal depending on the state of the tile signal **CLK_GLOBAL_EN**:

- If LOW, the local tile signal **CLK_GLOBAL_OUT** is driven onto **CLK_GLOBAL** and to the **CLK_GLOBAL_IN** input of the FPGAs on the tile.
- If HIGH, the external **CLK_GLOBAL** signal goes to the **CLK_GLOBAL_IN** input of the FPGAs on the tile.

Note

Some of the standard RealView Logic Tile clocks, **CLK_NEG_DN_IN** for example, are not used. Ensure that your RealView Logic Tile configuration is compatible with the clock sources you are using from the PB1176JZF-S.

Table C-1 RealView Logic Tile clock signals

Tile signal	Direction	Description
CLK_UP_THRU	To tile	From PB1176JZF-S AXI Master multiplexor logic
CLK_OUT_PLUS1	To tile	From PB1176JZF-S AXI Slave multiplexor to RealView Logic Tile.
CLK_OUT_PLUS2	To tile	From PB1176JZF-S AXI Slave multiplexor to RealView Logic Tile.
CLK_GLOBAL	I/O	Global clock connected to all RealView Logic Tiles (reserved for future use).
CLK_NEG_DN_IN	From tile	To PB1176JZF-S FPGA (reserved for future use).
CLK_POS_DN_IN	From tile	To PB1176JZF-S FPGA (reserved for future use).
CLK_NEG_UP_OUT	To tile	FPGA clock to RealView Logic Tile (reserved for future use).
CLK_POS_UP_OUT	To tile	development chip clock to RealView Logic Tile (reserved for future use).
CLK_IN_PLUS1	From tile	To PB1176JZF-S FPGA (reserved for future use).
CLK_IN_PLUS2	From tile	To PB1176JZF-S FPGA (reserved for future use).
CLK_DN_THRU	-	Not connected

C.1.5 Reset signals

Table C-2 describes reset signals.

Table C-2 Reset signal descriptions

Name	Function
nBOARDPOR	This signal is generated on the baseboard and initiates the configuration of the baseboard FPGA, development chip, and PLDs. This signal is also used to generate the JTAG reset signals at power on.
Logic Tile LOCAL_DONE	This signal is generated on the Logic Tile and indicates that FPGA on the Logic Tile has been configured.
GLOBAL_DONE	This is an open-collector configuration signal that goes HIGH when the baseboard and all attached Logic Tiles have finished configuring and released their LOCAL_DONE signal. The system is held in reset until this signal goes HIGH. The length of time GLOBAL_DONE is LOW depends on the system configuration.
nSYSPOR	Power-on reset signal from the baseboard that initializes the reset level state machine after GLOBAL_DONE goes HIGH.

Reset timing

Figure C-3 shows the power-on reset sequence.

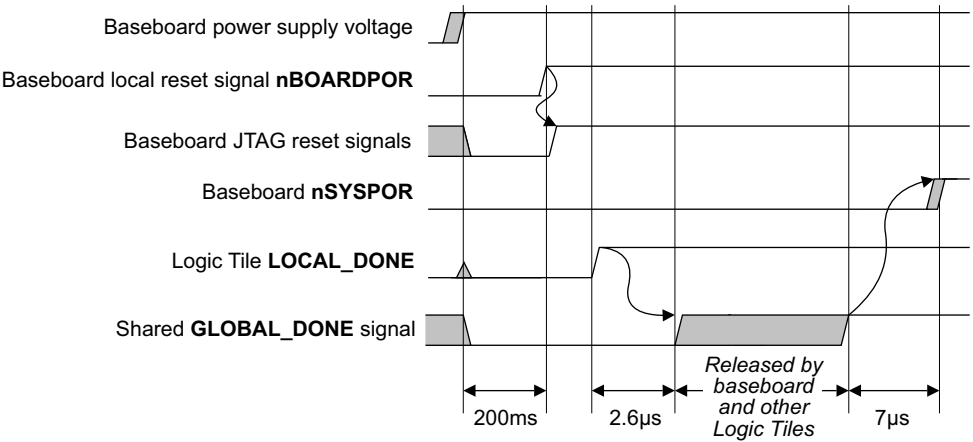


Figure C-3 Power-on reset and configuration timing

C.2 Signals on the tile header connectors

This section gives an detailed listing of the RealView Logic Tile header connectors on the PB1176JZF-S.

There are three headers on the top and bottom of the tile. The HDRX and HDRY headers are 180-way and the HDRZ connectors are 300-way.

Figure C-4 shows the pin numbers and power-blade usage of the HDRX, HDRY, and HDRZ headers on the PB1176JZF-S tile headers. See *RealView Logic Tile header connectors* on page A-15 for details of the signals on the PB1176JZF-S header connectors.

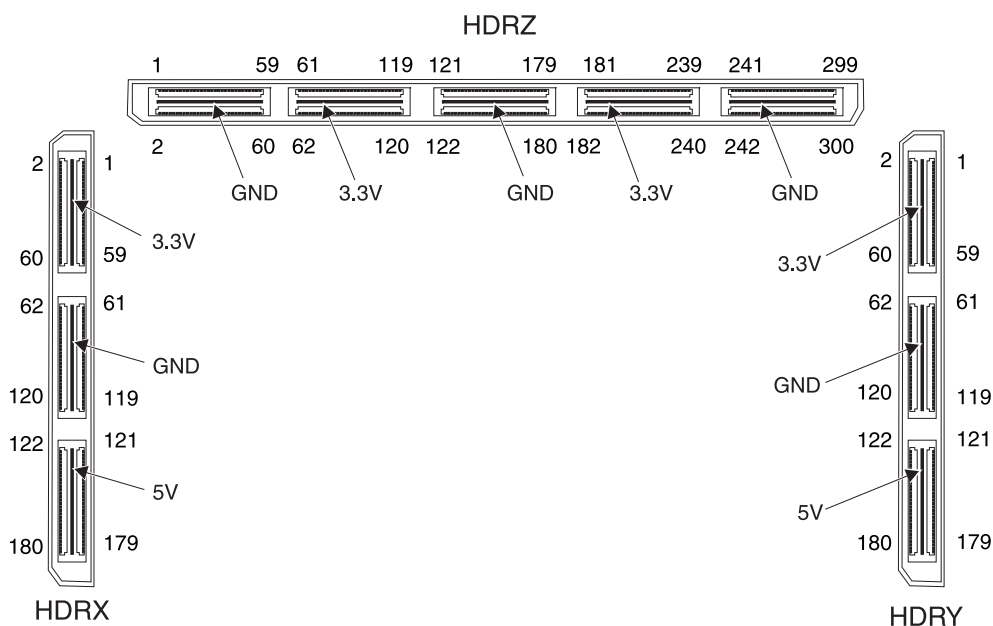


Figure C-4 HDRX, HDRY, and HDRZ pin numbering

The following section describes:

- *HDRX signals*
- *HDRY signals* on page C-14
- *HDRZ* on page C-20.

C.2.1 HDRX signals

Table C-3 on page C-8 describes the signals on the HDRX header pins. For a description of the signals see the *AMBA 3 AXI Protocol* (ARM IHI 0022).i

Table C-3 HDRX signals

Baseboard signals	X Bus	Even pins	Odd pins	X Bus	Baseboard signals
ARADDR12 / ARADDR28	X89	2	1	X90	ARADDR13 / ARADDR29
ARADDR11 / ARADDR27	X88	4	3	X91	ARADDR14 / ARADDR30
ARADDR10 / ARADDR26	X87	6	5	X92	ARADDR15 / ARADDR31
ARADDR9 / ARADDR25	X86	8	7	X93	ARID0 / ARID2
ARADDR8 / ARADDR24	X85	10	9	X94	ARID1 / ARID3
ARADDR7 / ARADDR23	X84	12	11	X95	ARLEN0 / ARLEN2
ARADDR6 / ARADDR22	X83	14	13	X96	ARLEN1 / ARLEN3
ARADDR5 / ARADDR21	X82	16	15	X97	ARSIZE0 / ARSIZE1
ARADDR4 / ARADDR20	X81	18	17	X98	ARID4 / ARPROT2
ARADDR3 / ARADDR19	X80	20	19	X99	ARPROT0 / ARPROT1
ARADDR2 / ARADDR18	X79	22	21	X100	ARBURST0 / ARBURST1
ARADDR1 / ARADDR17	X78	24	23	X101	ARLOCK0 / ARLOCK1
ARADDR0 / ARADDR16	X77	26	25	X102	ARCACHE0 / ARCACHE2
BREADY	X76	28	27	X103	ARCACHE1 / ARCACHE3
BVALID	X75	30	29	X104	ARVALID / b0 ^a
BRESP0 / BRESP1	X74	32	31	X105	ARREADY

Table C-3 HDRX signals (continued)

Baseboard signals	X Bus	Even pins	Odd pins	X Bus	Baseboard signals
BID4 / (not connected)	X73	34	33	X106	RDATA0 / RDATA32
BID1 / BID3	X72	36	35	X107	RDATA1 / RDATA33
BID0 / BID2	X71	38	37	X108	RDATA2 / RDATA34
AWREADY	X70	40	39	X109	RDATA3 / RDATA35
AWVALID / b0 ^b	X69	42	41	X110	RDATA4 / RDATA36
AWCACHE1 / AWCACHE3	X68	44	43	X111	RDATA5 / RDATA37
AWCACHE0 / AWCACHE2	X67	46	45	X112	RDATA6 / RDATA38
AWLOCK0 / AWLOCK1	X66	48	47	X113	RDATA7 / RDATA39
AWBURST0 / AWBURST1	X65	50	49	X114	RDATA8 / RDATA40
AWPROT0 / AWPROT1	X64	52	51	X115	RDATA9 / RDATA41
ARM_nRESET (not connected)	X63	54	53	X116	RDATA10 / RDATA42
AWID4 / AWPROT2	X62	56	55	X117	RDATA11 / RDATA43
AWSIZE0 / AWSIZE1	X61	58	57	X118	RDATA12 / RDATA44
AWLEN1 / AWLEN3	X60	60	59	X119	RDATA13 / RDATA45
AWLEN0 / AWLEN2	X59	62	61	X120	RDATA14 / RDATA46

Table C-3 HDRX signals (continued)

Baseboard signals	X Bus	Even pins	Odd pins	X Bus	Baseboard signals
AWID1 / AWID3	X58	64	63	X121	RDATA15 / RDATA47
AWID0 / AWID2	X57	66	65	X122	RDATA16 / RDATA48
AWADDR15 / AWADDR31	X56	68	67	X123	RDATA17 / RDATA49
AWADDR14 / AWADDR30	X55	70	69	X124	RDATA18 / RDATA50
AWADDR13 / AWADDR29	X54	72	71	X125	RDATA19 / RDATA51
AWADDR12 / AWADDR28	X53	74	73	X126	RDATA20 / RDATA52
AWADDR11 / AWADDR27	X52	76	75	X127	RDATA21 / RDATA53
AWADDR10 / AWADDR26	X51	78	77	X128	RDATA22 / RDATA54
AWADDR9 / AWADDR25	X50	80	79	X129	RDATA23 / RDATA55
AWADDR8 / AWADDR24	X49	82	81	X130	RDATA24 / RDATA56
AWADDR7 / AWADDR23	X48	84	83	X131	RDATA25 / RDATA57
AWADDR6 / AWADDR22	X47	86	85	X132	RDATA26 / RDATA58
AWADDR5 / AWADDR21	X46	88	87	X133	RDATA27 / RDATA59
AWADDR4 / AWADDR20	X45	90	89	X134	RDATA28 / RDATA60
AWADDR3 / AWADDR19	X44	92	91	X135	RDATA29 / RDATA61

Table C-3 HDRX signals (continued)

Baseboard signals	X Bus	Even pins	Odd pins	X Bus	Baseboard signals
AWADDR2 / AWADDR18	X43	94	93	X136	RDATA30 / RDATA62
AWADDR1 / AWADDR17	X42	96	95	X137	RDATA31 / RDATA63
AWADDR0 / AWADDR16	X41	98	97	X138	RID0 / RID2
WREADY	X40	100	99	X139	RID1 / RID3
WVALID / b0^c	X39	102	101	X140	RRESP0 / RRESP1
WLAST / WID4	X38	104	103	X141	RLAST / RID4
WSTRB3 / WSTRB7	X37	106	105	X142	RVALID / (not connected)
WSTRB2 / WSTRB6	X36	108	107	X143	RREADY
WSTRB1 / WSTRB5	X35	110	109	X144	X144
WSTRB0 / WSTRB4	X34	112	111	X145	X145
WID1 / WID3	X33	114	113	X146	X146
WID0 / WID2	X32	116	115	X147	X147
WDATA31 / WDATA63	X31	118	117	X148	X148
WDATA30 / WDATA62	X30	120	119	X149	X149
WDATA29 / WDATA61	X29	122	121	X150	X150
WDATA28 / WDATA60	X28	124	123	X151	X151
WDATA27 / WDATA59	X27	126	125	X152	X152

Table C-3 HDRX signals (continued)

Baseboard signals	X Bus	Even pins	Odd pins	X Bus	Baseboard signals
WDATA26 / WDATA58	X26	128	127	X153	X153
WDATA25 / WDATA57	X25	130	129	X154	X154
WDATA24 / WDATA56	X24	132	131	X155	X155
WDATA23 / WDATA55	X23	134	133	X156	X156
WDATA22 / WDATA54	X22	136	135	X157	X157
WDATA21 / WDATA53	X21	138	137	X158	X158
WDATA20 / WDATA52	X20	140	139	X159	X159
WDATA19 / WDATA51	X19	142	141	X160	X160
WDATA18 / WDATA50	X18	144	143	X161	X161
WDATA17 / WDATA49	X17	146	145	X162	X162
WDATA16 / WDATA48	X16	148	147	X163	X163
WDATA15 / WDATA47	X15	150	149	X164	X164
WDATA14 / WDATA46	X14	152	151	X165	X165
WDATA13 / WDATA45	X13	154	153	X166	X166
WDATA12 / WDATA44	X12	156	155	X167	X167

Table C-3 HDRX signals (continued)

Baseboard signals	X Bus	Even pins	Odd pins	X Bus	Baseboard signals
WDATA11 / WDATA43	X11	158	157	X168	X168
WDATA10 / WDATA42	X10	160	159	X169	X169
WDATA9 / WDATA41	X9	162	161	X170	X170
WDATA8 / WDATA40	X8	164	163	X171	X171
WDATA7 / WDATA39	X7	166	165	X172	X172
WDATA6 / WDATA38	X6	168	167	X173	X173
WDATA5 / WDATA37	X5	170	169	X174	X174
WDATA4 / WDATA36	X4	172	171	X175	X175
WDATA3 / WDATA35	X3	174	173	X176	X176
WDATA2 / WDATA34	X2	176	175	X177	X177
WDATA1 / WDATA33	X1	178	177	X178	X178
WDATA0 / WDATA32	X0	180	179	X179	X179

- a. These are AXI **ARVALID/ARID5** signals. b0 indicates that for the **ARID5** phase of the controlling clock signal, **ARID5** is always set to logic level zero.
- b. These are AXI **AWVALID/AWID5** signals. b0 indicates that for the **AWID5** phase of the controlling clock signal, **AWID5** is always set to logic level zero.
- c. These are AXI **WVALID/WID5** signals. b0 indicates that for the **WID5** phase of the controlling clock signal, **WID5** is always set to logic level zero.

C.2.2 HDRY signals

Table C-4 lists the signals on the HDRY header pins. For a description of the signals see the *AMBA 3 AXI Protocol* (ARM IHI 0022).

Some of the HDRY signals are present on the Logic Tile trace connector, see *Trace connector pinout* on page A-18 for details.

Table C-4 HDRY signals

Baseboard signals	Y Bus	Even pins	Odd pins	Baseboard signals	Y Bus
ARADDR13 / ARADDR29	Y90	2	1	Y89	ARADDR12 / ARADDR28
ARADDR14 / ARADDR30	Y91	4	3	Y88	ARADDR11 / ARADDR27
ARADDR15 / ARADDR31	Y92	6	5	Y87	ARADDR10 / ARADDR26
ARID0 / ARID2	Y93	8	7	Y86	ARADDR9 / ARADDR25
ARID1 / ARID3	Y94	10	9	Y85	ARADDR8 / ARADDR24
ARLEN0 / ARLEN2	Y95	12	11	Y84	ARADDR7 / ARADDR23
ARLEN1 / ARLEN3	Y96	14	13	Y83	ARADDR6 / ARADDR22
ARSIZE0 / ARSIZE1	Y97	16	15	Y82	ARADDR5 / ARADDR21
ARID4 / ARPROT2	Y98	18	17	Y81	ARADDR4 / ARADDR20
ARPROT0 / ARPROT1	Y99	20	19	Y80	ARADDR3 / ARADDR19
ARBURST0 / ARBURST1	Y100	22	21	Y79	ARADDR2 / ARADDR18
ARLOCK0 / ARLOCK1	Y101	24	23	Y78	ARADDR1 / ARADDR17

Table C-4 HDRY signals (continued)

Baseboard signals	Y Bus	Even pins	Odd pins	Baseboard signals	Y Bus
ARCACHE0 / ARCACHE2	Y102	26	25	Y77	ARADDR0 / ARADDR16
ARCACHE1 / ARCACHE3	Y103	28	27	Y76	BREADY
ARVALID / b0 ^a	Y104	30	29	Y75	BVALID
ARREADY	Y105	32	31	Y74	BRESP0 / BRESP1
RDATA0 / RDATA32	Y106	34	33	Y73	BID4 / (not connected)
RDATA1 / RDATA33	Y107	36	35	Y72	BID1 / BID3
RDATA2 / RDATA34	Y108	38	37	Y71	BID0 / BID2
RDATA3 / RDATA35	Y109	40	39	Y70	AWREADY
RDATA4 / RDATA36	Y110	42	41	Y69	AWVALID / b0 ^b
RDATA5 / RDATA37	Y111	44	43	Y68	AWCACHE1 / AWCACHE3
RDATA6 / RDATA38	Y112	46	45	Y67	AWCACHE0 / AWCACHE2
RDATA7 / RDATA39	Y113	48	47	Y66	AWLOCK0 / AWLOCK1
RDATA8 / RDATA40	Y114	50	49	Y65	AWBURST0 / AWBURST1
RDATA9 / RDATA41	Y115	52	51	Y64	AWPROT0 / AWPROT1
RDATA10 / RDATA42	Y116	54	53	Y63	ARM_nRESET (not connected)
RDATA11 / RDATA43	Y117	56	55	Y62	AWID4 / AWPROT2

Table C-4 HDRY signals (continued)

Baseboard signals	Y Bus	Even pins	Odd pins	Baseboard signals	Y Bus
RDATA12 / RDATA44	Y118	58	57	Y61	AWSIZE0 / AWSIZE1
RDATA13 / RDATA45	Y119	60	59	Y60	AWLEN1 / AWLEN3
RDATA14 / RDATA46	Y120	62	61	Y59	AWLEN0 / AWLEN2
RDATA15 / RDATA47	Y121	64	63	Y58	AWID1 / AWID3
RDATA16 / RDATA48	Y122	66	65	Y57	AWID0 / AWID2
RDATA17 / RDATA49	Y123	68	67	Y56	AWADDR15 / AWADDR31
RDATA18 / RDATA50	Y124	70	69	Y55	AWADDR14 / AWADDR30
RDATA19 / RDATA51	Y125	72	71	Y54	AWADDR13 / AWADDR29
RDATA20 / RDATA52	Y126	74	73	Y53	AWADDR12 / AWADDR28
RDATA21 / RDATA53	Y127	76	75	Y52	AWADDR11 / AWADDR27
RDATA22 / RDATA54	Y128	78	77	Y51	AWADDR10 / AWADDR26
RDATA23 / RDATA55	Y129	80	79	Y50	AWADDR9 / AWADDR25
RDATA24 / RDATA56	Y130	82	81	Y49	AWADDR8 / AWADDR24
RDATA25 / RDATA57	Y131	84	83	Y48	AWADDR7 / AWADDR23
RDATA26 / RDATA58	Y132	86	85	Y47	AWADDR6 / AWADDR22

Table C-4 HDRY signals (continued)

Baseboard signals	Y Bus	Even pins	Odd pins	Baseboard signals	Y Bus
RDATA27 / RDATA59	Y133	88	87	Y46	AWADDR5 / AWADDR21
RDATA28 / RDATA60	Y134	90	89	Y45	AWADDR4 / AWADDR20
RDATA29 / RDATA61	Y135	92	91	Y44	AWADDR3 / AWADDR19
RDATA30 / RDATA62	Y136	94	93	Y43	AWADDR2 / AWADDR18
RDATA31 / RDATA63	Y137	96	95	Y42	AWADDR1 / AWADDR17
RID0 / RID2	Y138	98	97	Y41	AWADDR0 / AWADDR16
RID1 / RID3	Y139	100	99	Y40	WREADY
RRESP0 / RRESP1	Y140	102	101	Y39	WVALID / b0^c
RLAST / RID4	Y141	104	103	Y38	WLAST / WID4
RVALID / (not connected)	Y142	106	105	Y37	WSTRB3 /WSTRB7
RREADY	Y143	108	107	Y36	WSTRB2 /WSTRB6
Y144	Y144	110	109	Y35	WSTRB1 /WSTRB5
Y145	Y145	112	111	Y34	WSTRB0 /WSTRB4
Y146	Y146	114	113	Y33	WID1 / WID3
Y147	Y147	116	115	Y32	WID0 / WID2
Y148	Y148	118	117	Y31	WDATA31 / WDATA63
Y149	Y149	120	119	Y30	WDATA30 / WDATA62

Table C-4 HDRY signals (continued)

Baseboard signals	Y Bus	Even pins	Odd pins	Baseboard signals	Y Bus
Y150	Y150	122	121	Y29	WDATA29 / WDATA61
Y151	Y151	124	123	Y28	WDATA28 / WDATA60
Y152	Y152	126	125	Y27	WDATA27 / WDATA59
Y153	Y153	128	127	Y26	WDATA26 / WDATA58
Y154	Y154	130	129	Y25	WDATA25 / WDATA57
Y155	Y155	132	131	Y24	WDATA24 / WDATA56
Y156	Y156	134	133	Y23	WDATA23 / WDATA55
Y157	Y157	136	135	Y22	WDATA22 / WDATA54
Y158	Y158	138	137	Y21	WDATA21 / WDATA53
Y159	Y159	140	139	Y20	WDATA20 / WDATA52
Y160	Y160	142	141	Y19	WDATA19 / WDATA51
Y161	Y161	144	143	Y18	WDATA18 / WDATA50
Y162	Y162	146	145	Y17	WDATA17 / WDATA49
Y163	Y163	148	147	Y16	WDATA16 / WDATA48
Y164	Y164	150	149	Y15	WDATA15 / WDATA47

Table C-4 HDRY signals (continued)

Baseboard signals	Y Bus	Even pins	Odd pins	Baseboard signals	Y Bus
Y165	Y165	152	151	Y14	WDATA14 / WDATA46
Y166	Y166	154	153	Y13	WDATA13 / WDATA45
Y167	Y167	156	155	Y12	WDATA12 / WDATA44
Y168	Y168	158	157	Y11	WDATA11 / WDATA43
Y169	Y169	160	159	Y10	WDATA10 / WDATA42
Y160	Y170	162	161	Y9	WDATA9 / WDATA41
Y171	Y171	164	163	Y8	WDATA8 / WDATA40
Y172	Y172	166	165	Y7	WDATA7 / WDATA39
Y173	Y173	168	167	Y6	WDATA6 / WDATA38
Y174	Y174	170	169	Y5	WDATA5 / WDATA37
Y175	Y175	172	171	Y4	WDATA4 / WDATA36
Y176	Y176	174	173	Y3	WDATA3 / WDATA35
Y177	Y177	176	175	Y2	WDATA2 / WDATA34
Y178	Y178	178	177	Y1	WDATA1 / WDATA33
Y179	Y179	180	179	Y0	WDATA0 / WDATA32

- a. These are AXI **ARVALID/ARID5** signals. b0 indicates that for the **ARID5** phase of the controlling clock signal, **ARID5** it is always set to logic level zero.
- b. These are AXI **AWVALID/AWID5** signals. b0 indicates that for the **AWID5** phase of the controlling clock signal, **AWID5** it is always set to logic level zero.
- c. These are AXI **WVALID/WID5** signals. b0 indicates that for the **WID5** phase of the controlling clock signal, **WID5** it is always set to logic level zero.

C.2.3 HDRZ

Table C-5 lists the signals on the HDRZ header pins. See the user guide for the fitted Logic Tile for the tile-specific HDRZ upper (U) and HDRZ lower (L) signal listing.

Signals on HDRZ that are not connected to the baseboard are indicated by NC in Table C-5 (for example **Z[255:224]**).

Signals **Z[233:199]** are connected to the FPGA and are reserved for future expansion and must not be driven by the Logic Tile.)

Signals **Z[198:128]** are connected to the ARM1176JZF-S development chip.
(Z[128:172] are test signal outputs and must not be driven by the Logic Tile.
Z[198:173] are interrupt inputs.)

Table C-5 HDRZ signals

Baseboard signals	Even pins	Odd pins	Baseboard signals
NC (Z255)	2	1	Reserved (Z128)
NC (Z254)	4	3	Reserved (Z129)
NC (Z253)	6	5	Reserved (Z130)
NC (Z252)	8	7	Reserved (Z131)
NC (Z251)	10	9	Reserved (Z132)
NC (Z250)	12	11	Reserved (Z133)
NC (Z249)	14	13	Reserved (Z134)
NC (Z248)	16	15	Reserved (Z135)
NC (Z247)	18	17	Reserved (Z136)
NC (Z246)	20	19	Reserved (Z137)
NC (Z245)	22	21	Reserved (Z138)
NC (Z244)	24	23	Reserved (Z139)

Table C-5 HDRZ signals (continued)

Baseboard signals	Even pins	Odd pins	Baseboard signals
NC (Z243)	26	25	Reserved (Z140)
NC (Z242)	28	27	Reserved (Z141)
NC (Z241)	30	29	Reserved (Z142)
NC (Z240)	32	31	Reserved (Z143)
NC (Z239)	34	33	Reserved (Z144)
NC (Z238)	36	35	Reserved (Z145)
NC (Z237)	38	37	Reserved (Z146)
NC (Z236)	40	39	Reserved (Z147)
NC (Z235)	42	41	Reserved (Z148)
NC (Z234)	44	43	Reserved (Z149)
Z233 MBTYPE1	46	45	Reserved (Z150)
Z232 MBTYPE0 (MBTYPE[1:0] is b01 for PB1176)	48	47	Reserved (Z151)
Reserved (Z231 FPGA USER)	50	49	Reserved (Z152)
Z230 PLDCLK	52	51	Reserved (Z153)
Z229 PLDRESET	54	53	Reserved (Z154)
Z228 PLDD0	56	55	Reserved (Z155)
Z227 PLDD1	58	57	Reserved (Z156)
Z226 DATACTL2	60	59	Reserved (Z157)
Z225 DATACTL1	62	61	Reserved (Z158)
Z224 DATACTL0 (Z[230:224] are reserved for Logic Tile PLD configuration by the baseboard)	64	63	Reserved (Z159)
Reserved (Z223 FPGA USER)	66	65	Reserved (Z160)
Reserved (Z222 FPGA USER)	68	67	Reserved (Z161)
Reserved (Z221 FPGA USER)	70	69	Reserved (Z162)

Table C-5 HDRZ signals (continued)

Baseboard signals	Even pins	Odd pins	Baseboard signals
Reserved (Z220 FPGA USER)	72	71	Reserved (Z163)
Reserved (Z219 FPGA USER)	74	73	Reserved (Z164)
Reserved (Z218 FPGA USER)	76	75	Reserved (Z165)
Reserved (Z217 FPGA USER)	78	77	Reserved (Z166)
Reserved (Z216 FPGA USER)	80	79	Reserved (Z167)
Reserved (Z215 FPGA USER)	82	81	Reserved (Z168)
Reserved (Z214 FPGA USER)	84	83	Reserved (Z169)
Reserved (Z213 FPGA USER)	86	85	Reserved (Z170)
Reserved (Z212 FPGA USER)	88	87	Reserved (Z171)
Reserved (Z211 FPGA USER)	90	89	Reserved (Z172)
Reserved (Z210 FPGA USER)	92	91	Z173 INTSOURCE0
Reserved (Z209 FPGA USER)	94	93	Z174 INTSOURCE1
Reserved (Z208 FPGA USER)	96	95	Z175 INTSOURCE2
Reserved (Z207 FPGA USER)	98	97	Z176 INTSOURCE3
Reserved (Z206 FPGA USER)	100	99	Z177 INTSOURCE4
Reserved (Z205 FPGA USER)	102	101	Z178 INTSOURCE5
Reserved (Z204 FPGA USER)	104	103	Z179 INTSOURCE6
Reserved (Z203 FPGA USER)	106	105	Z180 INTSOURCE7
Reserved (Z202 FPGA USER)	108	107	Z181 INTSOURCE8
Reserved (Z201 FPGA USER)	110	109	Z182 INTSOURCE9
Reserved (Z200 FPGA USER)	112	111	Z183 INTSOURCE10
Reserved (Z199 FPGA USER)	114	113	Z184 INTSOURCE11
Z198 EXTINTSOURCE3	116	115	Z185 INTSOURCE12
Z197 EXTINTSOURCE2	118	117	Z186 INTSOURCE13

Table C-5 HDRZ signals (continued)

Baseboard signals	Even pins	Odd pins	Baseboard signals
Z196 EXTINTSOURCE1	120	119	Z187 INTSOURCE14
Z195 EXTINTSOURCE0	122	121	Z188 INTSOURCE15
Z194 INTSOURCE21	124	123	Z189 INTSOURCE16
Z193 INTSOURCE20	126	125	Z190 INTSOURCE17
Z192 INTSOURCE19	128	127	Z191 INTSOURCE18
CLK_POS_DN_IN	130	129	nSRST
CLK_NEG_DN_IN	132	131	D_nTRST
CLK_POS_UP_OUT	134	133	D_TDO_IN
CLK_NEG_UP	136	135	D_TDI
GND (CLK_UP_THRU)	138	137	D_TCK_OUT
CLK_OUT_PLUS1	140	139	D_TMS_OUT
CLK_OUT_PLUS2	142	141	D_RTCK
CLK_IN_PLUS2	144	143	C_nSRST
CLK_IN_PLUS1	146	145	C_nTRST
Z182 (CLK_DN_THRU)	148	147	C_TDO_IN
CLK_GLOBAL	150	149	C_TDI
FPGA_IMAGE	152	151	C_TCK_OUT
nSYSPOR	154	153	C_TMS_OUT
nSYSRST	156	155	nTILE_DET
NC (nRTCKEN)	158	157	nCFGEN
NC (SPARE12 reserved)	160	159	GLOBAL_DONE
NC (SPARE10 reserved)	162	161	NC (SPARE11 reserved)
NC (SPARE8 reserved)	164	163	NC (SPARE9 reserved)
NC (SPARE6 reserved)	166	165	NC (SPARE7 reserved)

Table C-5 HDRZ signals (continued)

Baseboard signals	Even pins	Odd pins	Baseboard signals
NC (SPARE4 reserved)	168	167	NC (SPARE5 reserved)
NC (SPARE2 reserved)	170	169	NC (SPARE3 reserved)
NC (SPARE0 reserved)	172	171	NC (SPARE1 reserved)
NC (Z64)	174	173	NC (Z63)
NC (Z65)	176	175	NC (Z62)
NC (Z66)	178	177	NC (Z61)
NC (Z67)	180	179	NC (Z60)
NC (Z68)	182	181	NC (Z59)
NC (Z69)	184	183	NC (Z58)
NC (Z70)	186	185	NC (Z57)
NC (Z71)	188	187	NC (Z56)
NC (Z72)	190	189	NC (Z55)
NC (Z73)	192	191	NC (Z54)
NC (Z74)	194	193	NC (Z53)
NC (Z75)	196	195	NC (Z52)
NC (Z76)	198	197	NC (Z51)
NC (Z77)	200	199	NC (Z50)
NC (Z78)	202	201	NC (Z49)
NC (Z79)	204	203	NC (Z48)
NC (Z80)	206	205	NC (Z47)
NC (Z81)	208	207	NC (Z46)
NC (Z82)	210	209	NC (Z45)
NC (Z83)	212	211	NC (Z44)
NC (Z84)	214	213	NC (Z43)

Table C-5 HDRZ signals (continued)

Baseboard signals	Even pins	Odd pins	Baseboard signals
NC (Z85)	216	215	NC (Z42)
NC (Z86)	218	217	NC (Z41)
NC (Z87)	220	219	NC (Z40)
NC (Z88)	222	221	NC (Z39)
NC (Z89)	224	223	NC (Z38)
NC (Z90)	226	225	NC (Z37)
NC (Z91)	228	227	NC (Z36)
NC (Z92)	230	229	NC (Z35)
NC (Z93)	232	231	NC (Z34)
NC (Z94)	234	233	NC (Z33)
NC (Z95)	236	235	NC (Z32)
NC (Z96)	238	237	NC (Z31)
NC (Z97)	240	239	NC (Z30)
NC (Z98)	242	241	NC (Z29)
NC (Z99)	244	243	NC (Z28)
NC (Z100)	246	245	NC (Z27)
NC (Z101)	248	247	NC (Z26)
NC (Z102)	250	249	NC (Z25)
NC (Z103)	252	251	NC (Z24)
NC (Z104)	254	253	NC (Z23)
NC (Z105)	256	255	NC (Z22)
NC (Z106)	258	257	NC (Z21)
NC (Z107)	260	259	NC (Z20)
NC (Z108)	262	261	NC (Z19)

Table C-5 HDRZ signals (continued)

Baseboard signals	Even pins	Odd pins	Baseboard signals
NC (Z109)	264	263	NC (Z18)
NC (Z110)	266	265	NC (Z17)
NC (Z111)	268	267	NC (Z16)
NC (Z112)	270	269	NC (Z15)
NC (Z113)	272	271	NC (Z14)
NC (Z114)	274	273	NC (Z13)
NC (Z115)	276	275	NC (Z12)
NC (Z116)	278	277	NC (Z11)
NC (Z117)	280	279	NC (Z10)
NC (Z118)	282	281	NC (Z9)
NC (Z119)	284	283	NC (Z8)
NC (Z120)	286	285	NC (Z7)
NC (Z121)	288	287	NC (Z6)
NC (Z122)	290	289	NC (Z5)
NC (Z123)	292	291	NC (Z4)
NC (Z124)	294	293	NC (Z3)
NC (Z125)	296	295	NC (Z2)
NC (Z126)	298	297	NC (Z1)
NC (Z127)	300	299	NC (Z0)

Appendix D

PCI Backplane and Enclosure

This appendix describes the PCI backplane and enclosure. It contains the following sections:

- *Connecting the PB1176JZF-S to the PCI enclosure* on page D-2
- *Backplane hardware* on page D-6
- *Connectors* on page D-10.

For details on configuring the PCI controller and PCI expansion cards, see *PCI controller* on page 4-109.

D.1 Connecting the PB1176JZF-S to the PCI enclosure

This section describes how to configure the PCI backplane and connect the PB1176JZF-S to the PCI enclosure.

To use the PB1176JZF-S with the PCI backplane and enclosure:

1. Configure the PB1176JZF-S as described in *Setting up the PB1176JZF-S* on page 2-2.

———— **Caution** ————

Do not connect power to the PB1176JZF-S yet.

————

2. Connect RVI to the board, or use the USB debug port. See *Connecting JTAG, Trace, and configuration equipment* on page 2-10.

———— **Note** ————

The JTAG connection on the PB1176JZF-S does not connect to the PCI backplane. Use the PB1176JZF-S JTAG for debugging applications.

There is also a JTAG socket on the PCI backplane. Only use this connector if you are reprogramming the PAL on the PCI backplane.

————

3. Set the configuration switches on the PCI backplane. See *Setting the backplane configuration switches* on page D-4.
4. If you are using an external display, either:
 - Connect the cable from the display to the DVI Digital/Analog connector on the PB1176JZF-S.
 - If you are using a VGA card in the PCI bus, connect the VGA display to the VGA connector on the PCI card. You must provide the interface code for the PCI display card.
5. Slide the PB1176JZF-S into the PCI connector on the side of the enclosure. Figure D-1 on page D-3 illustrates an PB1176JZF-S mounted in the PCI backplane in the supplied enclosure.
6. Apply power to the PCI enclosure.

———— **Caution** ————

Do not connect power to the screw terminals or to the power socket on the PB1176JZF-S.

————

7. Execute the initialization code to setup the PCI address-mapping registers (see *PCI controller* on page 4-109)

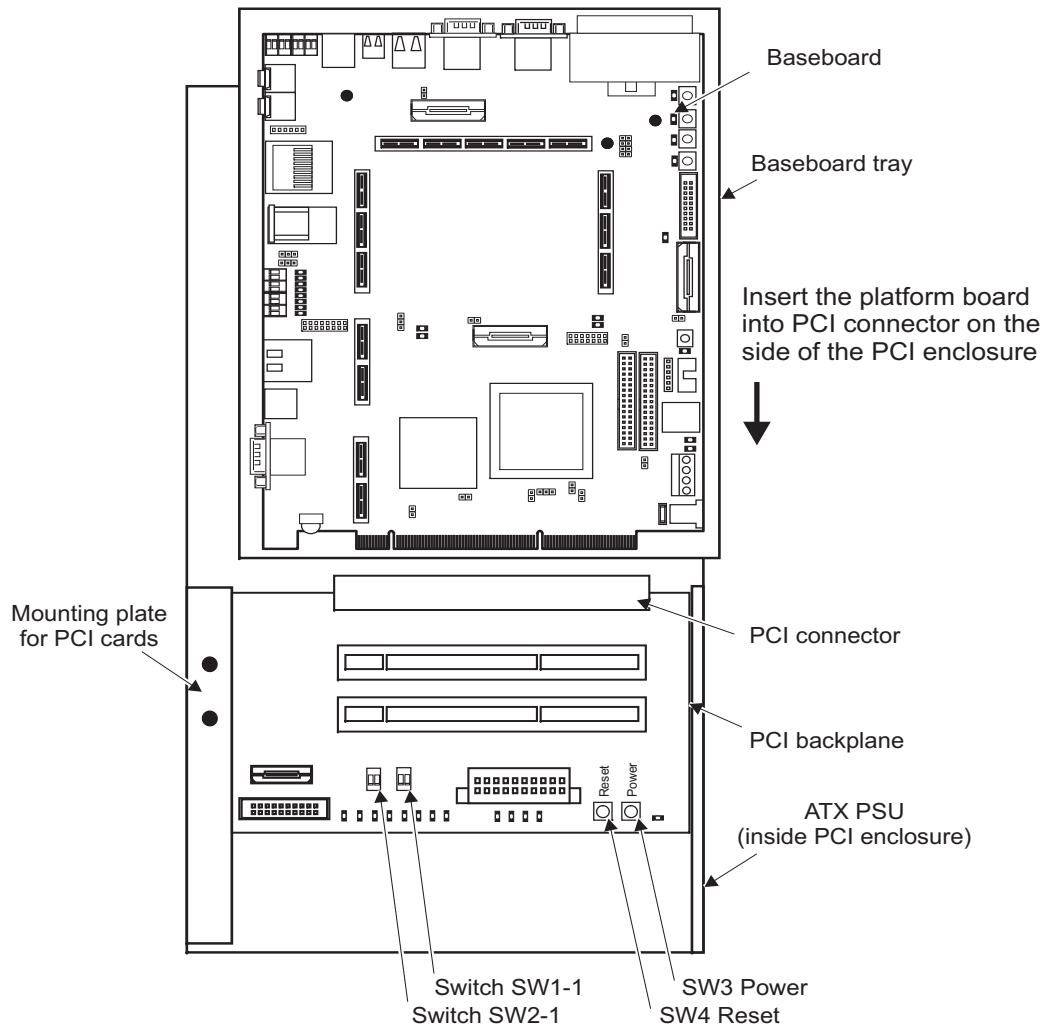


Figure D-1 Installing the platform board into the PCI enclosure

D.1.1 Setting the backplane configuration switches

There are four control switches on the PCI backplane board as shown in Figure D-3 on page D-6. The switches are arranged into two switch blocks, SW1 and SW2.

SW1-1 and SW1-2 control clock rate:

- SW1-1** SW1-1 positions are labeled **Manual** and **Auto** and select between manual or automatic clock selection:
- In **Manual** position, the clock is determined by the settings of the manual clock select switch SW1-2.
 - In **Auto** position, the clock rate is determined by the capabilities of the PCI cards installed. The default rate is 33MHz. If however all PCI cards are capable of functioning at 66MHz, the clock rate automatically increases to 66MHz.
- SW1-2** SW1-2 positions are labeled **Man1** and **Man2** and determine the clock rate when SW1-1 is in the **Manual** position. **Man1** selects low frequency (10MHz) and **Man2** selects high frequency (50MHz).

Switches SW2-1 and SW2-2 control the PCI backplane JTAG scan chain:

- SW2-1** Switch positions for SW2-1 are labeled **omitPLD** and **incPLD** and omits or includes the PLD on the PCI backplane from the PCI scan chain.
- SW2-2** Switch positions for SW2-2 are labeled **omitPCI** and **incPCI** and omit or include the PCI sockets in the PCI scan chain. If a PCI card is not present in a socket, the socket is bypassed by an automatic switch.
- If a PCI card does not support JTAG, place a jumper across the **TDI** and **TDO** signals for that card or place insulating tape over the **nPRSNT** pins on the socket.
- The JTAG scan chain on the PB1176JZF-S does not extend to the PCI backplane.

There are also two connectors on the board that can be connected to external switches:

- J6** This connector is paralleled with SW3 and permits control of the power from a front-panel switch.
- J7** This connector is paralleled with SW4 and enables a front-panel switch to reset the PCI arbiter on the backplane and reset all of the PCI cards.

Note

Front panel switches are not provided as part of the PCI enclosure.

D.1.2 Connecting two PB1176JZF-S boards

Figure D-2 shows two PB1176JZF-S boards and a VGA controller connected to the PCI backplane. The PCI controller in the top PB1176JZF-S is operating as a PCI bus slave and the PCI controller in the bottom PB1176JZF-S is operating as a PCI bus master. The VGA card is also operating as a slave.

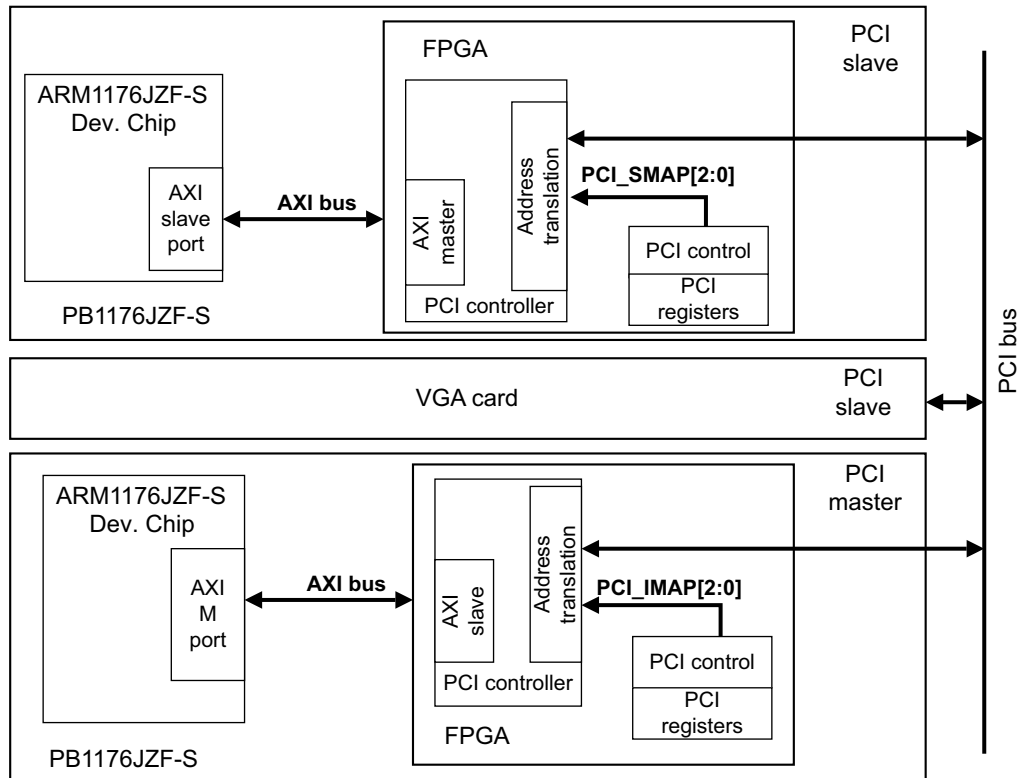


Figure D-2 Multiple boards on PCI bus

Note

You can only plug the PB1176JZF-S into a PC PCI motherboard that uses 64-bit sockets (3.3V signal levels).

Only 32-bit PCI expansion cards, however, can be used in the PCI enclosure.

D.2 Backplane hardware

The mechanical layout for the PCI backplane is shown in Figure D-3.

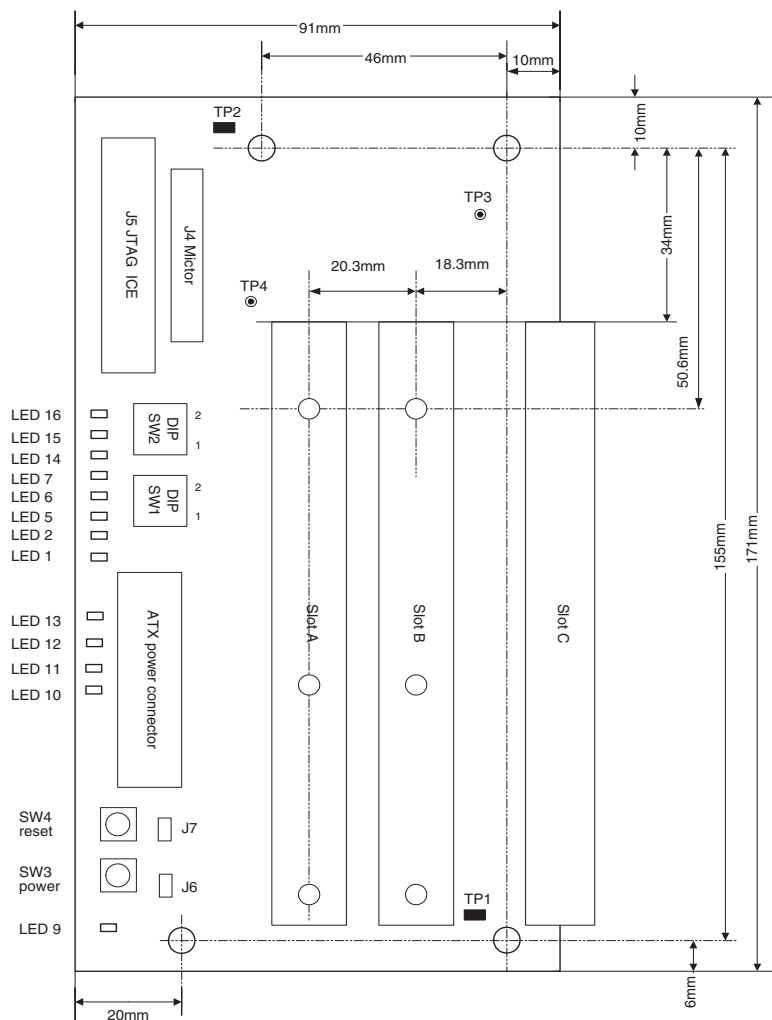


Figure D-3 PCI backplane

The PCI backplane mechanical layout complies to PCI Specification v2.3 for a two slot short card system board.

The switches, indicators, and test points for the PCI backplane are listed in Table D-1, Table D-2 on page D-8, and Table D-3 on page D-8.

Table D-1 LED indicators

LED	Signal	Description
1	MAN1nMAN2	This LED illuminates to indicate Man2 clock selection
2	MANnAUTO	This LED illuminates to indicate Auto clock selection
5	CLK33ACTIVE	This LED illuminates to indicate 33MHz bus speed.
6	CLK66ACTIVE	This LED illuminates to indicate 66MHz bus speed.
7	CLK133ACTIVE	This LED is used for manufacturing tests.
9	PSON	Power supply on/off indicator. The LED is illuminated when the unit is off (standby).
10	3V3	Power supply voltage present
11	5V	Power supply voltage present
12	12V	Power supply voltage present
13	-12V	Power supply voltage present
14	PCI_nPRSNT1A and PCI_nPRSNT2A	This LED illuminates to indicate PCI card present and enabled in slot A.
15	PCI_nPRSNT1B and PCI_nPRSNT2B	This LED illuminates to indicate PCI card present and enabled in slot B.
16	PCI_nPRSNT1C and PCI_nPRSNT2C	This LED illuminates to indicate PCI card present and enabled in slot C. (This is the slot for the PB1176JZF-S.)

Table D-2 Configuration switches

Switch	Signal	Description
SW1-1	MAN1nMAN2	Determines the clock rate when SW1[1] is in the Manual position. See <i>Setting the backplane configuration switches</i> on page D-4.
SW1-2	MANnAUTO	Selects between manual (ON) or automatic (OFF) clock selection
SW2-1	nINCPLD	Omits (ON) or includes (OFF) the PLD in the scan chain.
SW2-2	TESTnEN	Omits (ON) or includes (OFF) the PCI sockets in the scan chain.

Table D-3 Power and reset switches

Switch	Signal	Description
SW3	PSON	Power on/off pushbutton. Pressing the switch toggles the power between on and standby. SW3 signals are also connected to J6 and this enables the use of an external front-panel switch.
SW4	SYSTEM_nRESET	System reset pushbutton. Pressing the switch generates a reset to the PCI arbiter on the backplane and all of the PCI cards. SW4 signals are also connected to J7 and this enables the use of an external front-panel switch.

Table D-4 Test points

Test point	Signal	Description
TP1	GND	Ground
TP2	GND	Ground
TP3	TCLK	JTAG clock
TP4	PCI CLK	PCI clock

D.2.1 JTAG signals

The JTAG signal flow is shown in Figure D-4.

Note

The JTAG chain on the PCI expansion board is independent of the JTAG chain on the PB1176JZF-S.

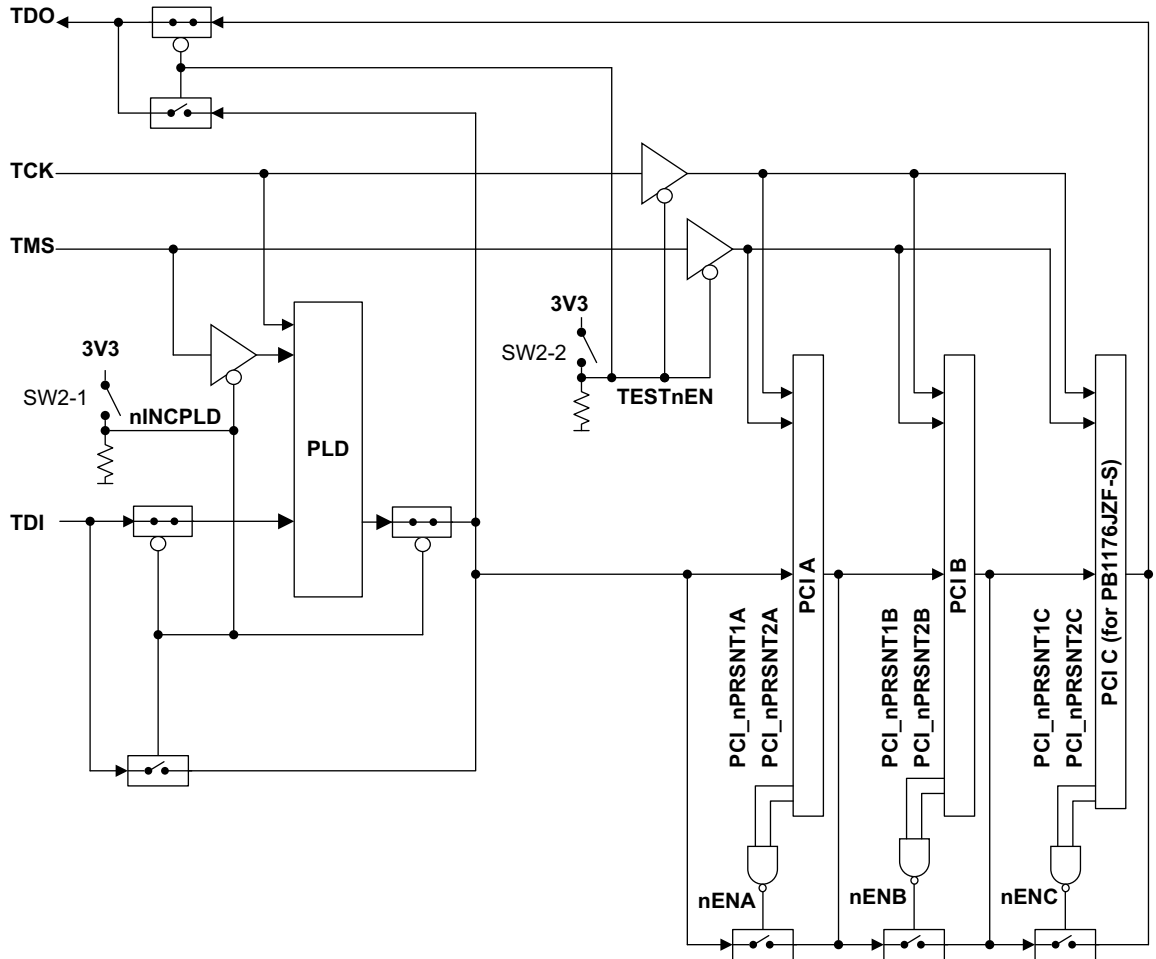


Figure D-4 JTAG signal flow on the PCI backplane

D.3 Connectors

This section describes the connectors present on the PCI backplane.

- *Power connector*
- *Logic analyzer connector* on page D-11
- *JTAG connector* on page D-12.

D.3.1 Power connector

The power connector is a standard ATX style connector as used in PCs. The pinout for the connector is listed in Table D-5.

Table D-5 ATX power connector

Signal	Pin	Pin	Signal
3V3	1	11	3V3
3V3	2	12	−12V
GND	3	13	GND
5V	4	14	nPSON
GND	5	15	GND
5V	6	16	GND
GND	7	17	GND
PWOK	8	18	NC
ATX5VSB	9	19	5V
12V	10	20	5V

D.3.2 Logic analyzer connector

Figure D-5 and Table D-6 show the pinout of the Mictor connector J4. You can use this connector to monitor PCI signals on the backplane.

————— **Note** —————

Agilent (formerly HP) and Tektronix label these connectors differently, but the assignments of signals to physical pins is appropriate for both systems and pin 1 is always in the same place.

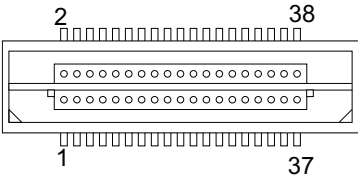


Figure D-5 AMP Mictor connector J4

Table D-6 Mictor connector pinout

Channel	Pin	Pin	Channel
No connect	1	2	No connect
GND	3	4	No connect
PCI_CLKE	5	6	No connect
PCI_nIRDY	7	8	No connect
PCI_nTDRY	9	10	No connect
PCI_nINTD	11	12	No connect
PCI_nINTC	13	14	SYSTEM_nRESET
PCI_nINTB	15	16	PCI_PAR64
PCI_nINTA	17	18	PCI_nSERR
PCI_nGNTC	19	20	PCI_nPERR
PCI_nGNTB	21	22	PCI_nACK64
PCI_nGNTA	23	24	PCI_nREQ64
PCI_nREQC	25	26	PCI_M66EN

Table D-6 Mictor connector pinout (continued)

Channel	Pin	Pin	Channel
PCI_nREQB	27	28	PCI_nRST
PCI_nREQA	29	30	PCI_nSTOP
SPARE4	31	32	PCI_nDEVSEL
SPARE3	33	34	PCI_nFRAME
SPARE2	35	36	PCI_nLOCK
SPARE1	37	38	PCI_PAR

D.3.3 JTAG connector

The signals on the JTAG connector J5 are shown in Figure D-6.

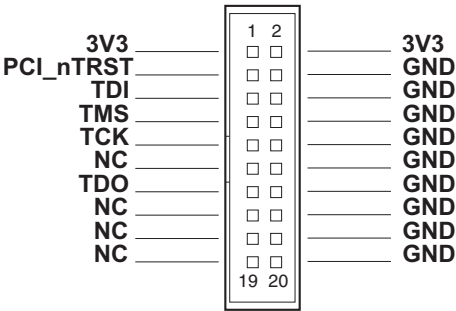


Figure D-6 PCI expansion board JTAG connector J5

Appendix E

Memory Expansion Boards

This appendix describes expansion memory modules for the PB1176JZF-S. It contains the following sections:

- *About memory expansion* on page E-2
- *Fitting a memory board* on page E-4
- *Connector pinout* on page E-5.

E.1 About memory expansion

Only static memory expansion is supported by the PB1176JZF-S. You can stack static memory expansion boards on the PB1176JZF-S using the PISMO™ connector provided. There are five chip select signals available on the PISMO connector, each of these can select 64MB of SRAM. The distribution of the chip select signals is determined by the expansion memory boards themselves.

The block diagram for typical memory board is shown in Figure E-1.

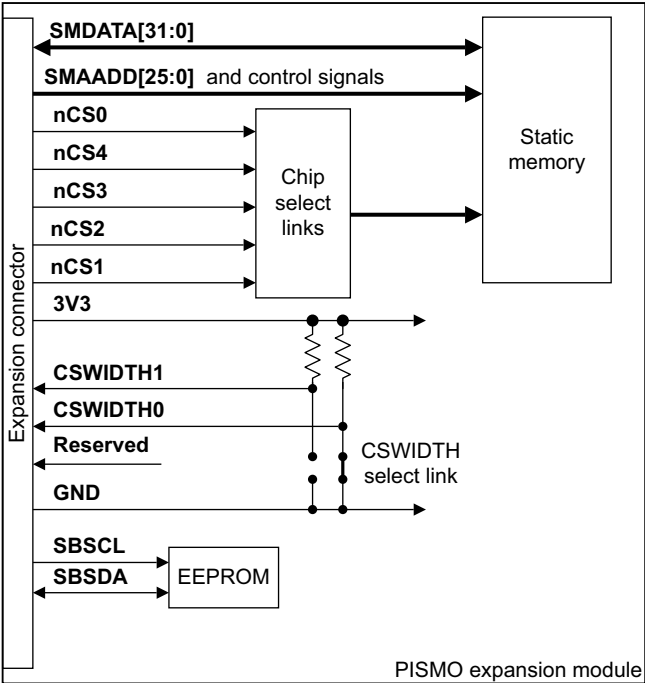


Figure E-1 Static memory board block diagram

Note

Figure E-1 on page E-2 is only a typical example of a PISMO static memory expansion board, different expansion boards might have different features.

See the documentation provided with your memory board for details on specific signals and link options.

The PB1176JZF-S supports static memory modules compliant to the *Platform Independent Storage MOdule* (PISMO) specification Version 1.0. General information and specifications are available from the PISMO website: www.pismoworld.org.

E.1.1 Operation without expansion memory

You can operate the PB1176JZF-S without a memory expansion board connected because it has 8MB of pseudo SRAM, 128MB of SDRAM, and 128MB of NOR flash permanently fitted.

E.1.2 Memory board configuration

The PISMO memory module includes a configuration EEPROM that can be read from the PB1176JZF-S to identify the type of memory on the board and how it is configured. This information can be used by the application or operating system to initialize the memory space. For details of the EEPROM data structure and information elements see the *PISMO Specification Version 1.0*.

Note

1V8 to 3V3 cards are supported.

E.2 Fitting a memory board

To install a memory expansion board:

1. Ensure that the PB1176JZF-S is powered down.
2. Align the memory expansion board with the PISMO connector on the PB1176JZF-S. See *About the PB1176JZF-S* on page 1-2 for the location of the PISMO connector.
3. Press the module into the connector.
4. Stack additional modules as required (up to five modules may be stacked) using the mating connectors on the PISMO memory modules.

E.3 Connector pinout

This section describes the connector present on the expansion memory board.

Caution

The pinout and naming in Table E-1 are valid for the *PISMO Version 1.0* specification.

The PB1176JZF-S memory expansion port is not compatible with the *PISMO2 Version 1.0* specification.

E.3.1 Expansion connector

The static memory expansion board uses 120-way Samtec connector as shown in Figure E-2. The connector pinout is shown in Table E-1.

Note

The numbering of pins on the connector is for the connector as viewed from below.

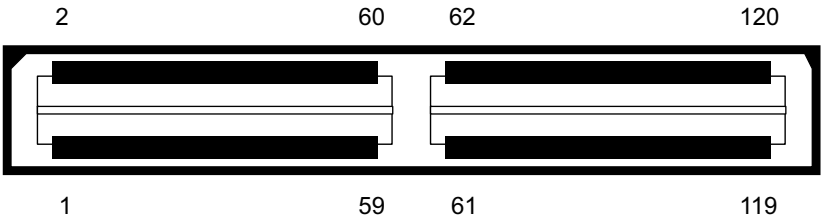


Figure E-2 Samtec QSH 120-way static expansion connector

Table E-1 Static memory connector signals

Pin No.	Signal	Pin No.	Signal
1	DATA[0]	2	3V3
3	DATA[1]	4	3V3
5	DATA[2]	6	3V3
7	DATA[3]	8	3V3
9	DATA[4]	10	VDDIO ^a
11	DATA[5]	12	VDDIO ^a

Table E-1 Static memory connector signals (continued)

Pin No.	Signal	Pin No.	Signal
13	DATA[6]	14	VDDIO ^a
15	DATA[7]	16	VDDIO ^a
17	DATA[8]	18	1V8
19	DATA[9]	20	1V8
21	DATA[10]	22	1V8
23	DATA[11]	24	1V8
25	DATA[12]	26	NC
27	DATA[13]	28	Reserved, not driven
29	DATA[14]	30	Reserved, not driven
31	DATA[15]	32	Reserved, not driven
33	DATA[16]	34	5V
35	DATA[17]	36	5V
37	DATA[18]	38	5V
39	DATA[19]	40	5V
41	DATA[20]	42	Reserved, not driven
43	DATA[21]	44	Reserved, not driven
45	DATA[22]	46	Reserved, not driven
47	DATA[23]	48	Reserved, not driven
49	DATA[24]	50	Reserved, not driven
51	DATA[25]	52	Reserved, not driven
53	DATA[26]	54	Reserved, not driven
55	DATA[27]	56	Reserved, not driven
57	DATA[28]	58	Reserved, not driven
59	DATA[29]	60	Reserved, not driven

Table E-1 Static memory connector signals (continued)

Pin No.	Signal	Pin No.	Signal
61	DATA[30]	62	SBSCL , E2PROM serial interface clock (3.3V signal level)
63	DATA[31]	64	SBSDA , E2PROM serial interface data (3.3V signal level)
65	ADDR[0]	66	nRESET
67	ADDR[1]	68	nBOARDPOR , asserted on hardware power cycle
69	ADDR[2]	70	nFLWP , flash write protect. Drive HIGH to write to flash.
71	ADDR[3]	72	nEARLYRESET , Reset signal. Differs from nRESET in that it is not delayed by nWAIT .
73	ADDR[4]	74	nWAIT , Wait mode input from external memory controller. Pulled HIGH if not used.
75	ADDR[5]	76	nBURSTWAIT , Synchronous burst wait input. The external device uses this to delay a synchronous burst transfer if LOW. Pulled HIGH if not used.
77	ADDR[6]	78	CANCELWAIT , If HIGH, this signal enables the system to recover from an externally waited transfer that has taken longer than expected to finish. Pulled LOW if not used.
79	ADDR[7]	80	nCS[4]
81	ADDR[8]	82	nCS[3]
83	ADDR[9]	84	nCS[2]
85	ADDR[10]	86	nCS[1]
87	ADDR[11]	88	Reserved, not driven
89	ADDR[12]	90	Reserved, not driven
91	ADDR[13]	92	Reserved, not driven

Table E-1 Static memory connector signals (continued)

Pin No.	Signal	Pin No.	Signal
93	ADDR[14]	94	Reserved, not driven
95	ADDR[15]	96	nCS[0]
97	ADDR[16]	98	nBUSY , Indicates that memory is not ready to be released from reset. If LOW, this signal holds nRESET active.
99	ADDR[17]	100	nIRQ
101	ADDR[18]	102	nWEN
103	ADDR[19]	104	nOEN
105	ADDR[20]	106	nBLS[3] , Byte Lane Select for bits [31:24]
107	ADDR[21]	108	nBLS[2] , Byte Lane Select for bits [23:16]
109	ADDR[22]	110	nBLS[1] , Byte Lane Select for bits [15:8]
111	ADDR[23]	111	nBLS[0] , Byte Lane Select for bits [7:0]
113	ADDR[24]	114	CSWIDTH[0] , Indicates bus width for fitted part. Not routed through stackable boards.
115	ADDR[25]	116	CSWIDTH[1] , Indicates bus width for fitted part. Not routed through stackable boards.
117	ADDRVALID , Indicates that the address output is stable during synchronous burst transfers	118	CLK[1]
119	BAA , Burst Address Advance. Used to advance the address count in the memory device	120	CLK[0]

a. VDDIO is the data voltage to host. This is not routed through stackable boards

Appendix F

Boot Monitor and platform library

This appendix describes using the Boot Monitor and platform library provided with the PB1176JZF-S. It contains the following sections:

- *About the Boot Monitor* on page F-2
- *About the platform library* on page F-3
- *Using the baseboard Boot Monitor and platform library* on page F-4.

F.1 About the Boot Monitor

This is the standard ARM application that runs when the system is booted. It is built with the ARM platform library.

Note

Any application that is built using the ARM platform library (or handles its own initialization) can replace the Boot Monitor.

The Boot Monitor supports the following functions:

- general file operations
- MMC and SD card utilities. This performs FAT16 format up to 2GB.
- board configuration
- programming images into flash memory
- loading and running another application
- a semihost server that handles standard ARM semihosting SVC calls.

F.2 About the platform library

The ARM platform library handles the system initialization and re-targets the standard C library. To achieve this, it provides a basic I/O subsystem that supports simple device drivers.

Included with the platform library there is a simple terminal driver, UART, PS/2 keyboard and LCD drivers and support for semihosting I/O.

F.3 Using the baseboard Boot Monitor and platform library

The baseboard Boot Monitor is a collection of tools and utilities designed as an aid to developing applications on the baseboard.

When the Boot Monitor starts on reset, the following actions are performed:

- the memory controllers are initialized
- a stack is set up in memory
- Boot Monitor code is copied into DRAM
- Boot memory remapping is reset
- C library I/O routines are remapped and redirected depending on the settings of User Switches 2 and 3 (S6-2 and S6-3 on the baseboard).
- if Boot Monitor configuration switch User Switch 1 (S6-1 on the baseboard) is ON, the current boot script, if any, is run.

Note

The boot monitor defaults to booting in secure mode after reset.

Caution

The firmware must match the system configuration or the results might be unpredictable. See the application note for your configuration for details of software or firmware that is specific to the combination of baseboard and tiles that you are using.

The following section describes:

- *Boot Monitor configuration switches* on page F-5
- *Running the Boot Monitor* on page F-6
- *Loading Boot Monitor into NOR flash* on page F-7
- *Redirecting character output to hardware devices* on page F-8
- *Using a boot script to run an image automatically* on page F-8
- *Rebuilding the Boot Monitor or platform library* on page F-9
- *Building an application with the platform library* on page F-10
- *Building an application that uses semihosting* on page F-13
- *Loading and running an application from NOR flash* on page F-13
- *Running an image from MMC or SD card* on page F-15
- *Using the Network Flash Utility* on page F-15.

F.3.1 Boot Monitor configuration switches

The Boot Monitor application is typically loaded into the NOR flash memory and selected to run at power on. Follow the instructions in *Loading Boot Monitor into NOR flash* on page F-7 for details of loading the boot flash with the image from the Versatile CD.

The setting of S6-1 determines how the Boot Monitor starts after a reset:

- S6-1 OFF** A prompt is displayed enabling you to enter Boot Monitor commands.
- S6-1 ON** The Boot Monitor executes a boot script that has been loaded into a *Multimedia* (MMC) or *Secure Digital* (SD) card. If a boot script is not present, the Boot Monitor prompt is displayed.

The boot script can execute any Boot Monitor commands. It typically selects and runs an application image that has been stored in either NOR flash memory or on the MMC or SD card. You can store one or more code images in flash memory and use the boot script to start an image at reset. Use the SET BOOTSCRIPT command to set the boot script file name from the Boot Monitor.

Output and input of text from STDIO for both applications and Boot Monitor I/O depends on the setting of S6-2 and S6-3 as listed in Table F-1.

Table F-1 STDIO redirection

S6-2	S6-3	Output	Input	Description
OFF	OFF	UART0 or console	UART0 or console	STDIO autodetects whether to use semihosting I/O or a UART. If a debugger is connected and semihosting is enabled, STDIO is redirected to the debugger console window. Otherwise, STDIO goes to UART0.
OFF	ON	UART0	UART0	STDIO is redirected to UART0. This occurs even under semihosting.
ON	OFF	VGA/DVI	Keyboard	STDIO is redirected to the VGA/DVI and keyboard. This occurs even under semihosting.
ON	ON	VGA/DVI	UART0	STDIO output is redirected to the VGA/DVI and input is redirected to the UART. This occurs even under semihosting.

S6-2 and S6-3 do not affect file I/O operations performed under semihosting. Semihosting operation requires a debugger and a JTAG interface device. See *Redirecting character output to hardware devices* on page F-8 for more details on I/O.

Note

Switches S6-4 to S6-8 are not used by the Boot Monitor and are available for user applications.

If a different loader program is present at the boot location, the function of the entire S6 switch bank is implementation dependent.

F.3.2 Running the Boot Monitor

To run Boot Monitor and have it display a prompt to a terminal connected to UART0, set switches S6-1 to S6-3 to OFF and reset the system. Standard input and output functions use UART0 by default. The default setting for UART0 is 38400 baud, 8 data bits, no parity, 1 stop bit. There is no hardware or software flow control. Use these values to configure a terminal application on your PC to communicate with the Boot Monitor.

Note

If the Boot Monitor has been accidentally deleted from flash memory, see *Rebuilding the Boot Monitor or platform library* on page F-9 for information on loading the monitor.

Boot Monitor commands

See Appendix G *Boot Monitor Commands* for details of the available commands in Version 4 of the Boot Monitor.

Commands are accepted in uppercase or lowercase. The Boot Monitor accepts abbreviations of commands if the meaning is not ambiguous. For example, for QUIT, you can type QUIT, QUI, QU, Q, quit, qui, qu, or q.

Optional parameters for commands are indicated by []. For example DIRECTORY [*directory*] indicates that the DIRECTORY command can take an optional parameter to specify which directory to list the contents of. If no parameter is supplied, the default is used (in this case, the current directory).

Type HELP at the Boot Monitor prompt to display a full list of the available commands.

F.3.3 Loading Boot Monitor into NOR flash

If the flash becomes corrupt and the board no longer runs the Boot Monitor, the Boot Monitor must be reprogrammed into flash.

Because the debugger does not initialize DRAM, the Boot Monitor image cannot be loaded and run directly. Boot from the AXI expansion memory as described in Table 2-1 on page 2-4. This procedure automatically configures the DRAM:

1. Power off the board.
2. Set the configuration switches:
 - Set all S6 switches to OFF
 - Set S7-2 switch to ON
 - Set S7-1, 3, and 4 to OFF.
3. Connect a cable from the JTAG device (RealView ICE for example) to the JTAG box header.
4. Power on the board.
5. DRAM is now initialized by booting from AXI expansion memory and the memory is remapped. To load Boot Monitor into flash:
 - a. From the debugger, load and execute the file `Boot_Monitor.axf`
 - b. at the Boot Monitor prompt enter:


```
>FLASH
```

Erase any images already in Flash using the `ERASE IMAGE` command.

```
Flash> WRITE IMAGE path\Boot_Monitor_platform.axf
```

where *path* is the *path* to the version of the Boot Monitor that is being loaded and *platform* is the name of the target system.
6. Loading the image into flash takes a few minutes to complete. Wait until the prompt is displayed again before proceeding.
7. Turn the board off.
8. Set S7-2 to OFF.
9. Turn the board back on.

Boot Monitor starts automatically.

F.3.4 Redirecting character output to hardware devices

The redirection of character I/O is carried out within the Boot Monitor platform library routines in `retarget.c` and `boot.s`. During startup, the platform library executes a *SuperVisor Call* (SVC). If the image is being executed without a debugger (or the debugger is not capturing semihosting calls) the value returned by this SVC is `-1`, otherwise the value returned is positive. The platform library uses the return value to determine the hardware device used for outputting from the C library I/O functions. (Redirection is through a SVC to the debugger console or directly to a hardware device)

Supported devices for character output are:

- `:UART-0` (default destination if debugger is not capturing semihosting calls)
- `:UART-1`
- `:UART-2`
- `:UART-3`
- `:CHARLCD`.

The `STDIO` calls are redirected within `retarget.c`. Redirection depends on the setting of switches S6-2 and S6-3, see *Boot Monitor configuration switches* on page F-5 for details.

F.3.5 Using a boot script to run an image automatically

Use a boot script to run an image automatically after power-on:

1. Create a boot script in a MMC or SD Card from the Boot Monitor by typing:
 - if your image is in MMC or SD Card:
`M:\> CREATE myscript.txt; put any startup code here RUN
 path\file_name`
 - if your image is in NOR flash:
`M:\> CREATE myscript.txt; put any startup code here FLASH RUN
 file_name.`
2. Press **Ctrl-Z** to indicate the end of the boot script and return to the Boot Monitor prompt.

———— **Note** ————

RVD does not support **Ctrl-Z** when creating a boot script using the debugger. You must instead type `+++` on a new line to indicate the end of a boot script.

—————

3. Verify the file was entered correctly by typing:
`M:\>TYPE myscript.txt`
 The contents of the file is displayed to the currently selected output device.

4. Specify the boot script to use at reset from the Boot Monitor by typing:
M:\>SET BOOTSCRIPT myscript.txt
5. Set S6-1 ON to instruct the Boot Monitor to run the boot script at power on.
6. Reset the platform. The Boot Monitor runs and executes the boot script myscript.txt. In this case, it relocates the image *file_name* and executes it.

F.3.6 Rebuilding the Boot Monitor or platform library

All firmware components are built using either RVDS running under either Windows or Unix/Linux:

- For Windows, ARM RVDS can be used to rebuild the library.
Use a CodeWarrior project file to rebuild the library. The RVDS make utility is not supported.
- GNUmake is available for UNIX and Linux.
If you are using GNUmake to rebuild the Boot Monitor, set your default directory to *install_directory/Firmware/Boot_Monitor* and type make from a command shell.
To rebuild the platform library component, set your default directory to *install_directory/Firmware/platform* and type make from a command shell.

After rebuilding the Boot Monitor, load it into NOR flash, see *Loading Boot Monitor into NOR flash* on page F-7.

After rebuilding the platform library, you can link platform.a from the target build subdirectories with your application (see *Building an application with the platform library* on page F-10).

Build options

You can specify the following build options after the make command:

- BIG_ENDIAN=1/0, defining image endianness (Default 0, little endian)
- THUMB=1/0, defining image state (Default 0, ARM)
- DEBUG=1/0, defining optimization level (Default 0, optimized code)
- VFP=1/0, defines VFP support (Default 0, no VFP support).

————— Note —————

The Boot Monitor must be built as a simple image. Scatter loading is not supported.

The build options define the subdirectory in the Builds directory that contains the compile and link output:

<Debug>_<State>_<Endianness>_Endian + more component specific options

For example, Release_ARM_Little_Endian or Debug_Thumb_Big_Endian.

The makefile creates a directory called Builds if it is not already present. The Builds directory contains subdirectories for the specified make options (for example, Debug_ARM_Little_Endian). To delete the objects and images for all targets and delete the Builds directory, type `make clean all`.

F.3.7 Building an application with the platform library

The platform library on the CD provides all required initialization code to bring the baseboard up from reset. The library is used by the Boot Monitor, but it can be used by an application independent of the other code in the Boot Monitor.

Note

It is not necessary to build your application with the platform library. You can instead let the boot monitor run at power on and remap the memory. After the remap has finished, you can load a typical application built with RVDS that is linked at address `0x8000` and uses semihosting.

The platform library supports:

- remapping of boot memory
- DRAM initialization
- UARTs
- Time-of-Year clock
- output to the character LCD display
- C library system calls.

To build an image that uses the I/O and memory control features present in the platform library:

1. Write the application as normal. There must be a `main()` routine in the application. Linking an application with the platform requires that the application is built using RVCT V2.1 or greater. If you are using RVCT V2.0 or ADS it is not possible to link the application with the platform library, however an application can still utilize the hardware on the board through semihosting.

2. Link the application against the Boot Monitor platform library file `platform.a`. The file `platform.a` is in one of the target build subdirectories (`install_dir\software\firmware\Platform\Builds\target_build`). Choose the `Builds` subdirectory that matches your application. For example, `Release_ARM_Little_Endian` for ARM code. If the subdirectory does not exist, see *Rebuilding the Boot Monitor or platform library* on page F-9 for details on rebuilding `platform.a`.

———— **Note** ————

If you are not using the `platform.a` library, you must provide your own initialization and I/O routines.

You can also build the platform library functionality directly into your application without building the platform code as a separate library. This might be useful, for example, if you are using an IDE to develop your application.

See the `filelist.txt` file in the `software` directory for more details on software included on the CD. The `selftest` directory, for example, contains source files that can be used as a starting point for your own application.

3. If required, select the link time selection for the platform library options.

Platform selection uses special symbols in your application:

From C `#pragma import(_platform_option_XXXXX)`

From assembler `IMPORT _platform_option_XXXXX`

The platform options are listed in Table F-2.

Table F-2 platform library options

Option	Description
<code>_platform_option_no_cache</code>	Stops the cache from being enabled by default
<code>_platform_option_no_lcd_kbd</code>	Disables LCD & Keyboard support and stops the driver code from being loaded
<code>_platform_option_no_mmu</code>	Stops the MMU from being initialized by default.

4. Scatter loading is supported for applications using the platform library, however the scatter file must follow Example F-1 on page F-12. The execution regions `INIT` and `SDRAM` must be present, the execution regions `ITCM` and `DTCM` are optional, if they are present, the relevant *Tightly Coupled Memory* (TCM) is enabled and the base address is set to the address supplied in the scatter file. The

sys_vectors.o object must be located at address zero. Additional execution regions, such as one for the SSRAM, can be added. An example scatter loading application can be found in the examples directory.

Example F-1 Scatter loading

```

LR_ROOT 0x8000
{
    INIT +0 FIXED
    {
        sys_boot.o (!!!_platform_area_boot, +FIRST)
        *(+R0)
    }
    SDRAM +0
    {
        *(+RW,+ZI)
    }
    ITCM 0x0
    {
        sys_vectors.o(_platform_area_vectors, +FIRST)
        'application code'.o(+R0)
    }
    DTCM 0x08000000
    {
        'application code'.o(+RW,+ZI)    }
}

```

5. To run the image from RAM, load the image with a debugger and execute as normal. The image uses the procedure described in *Redirecting character output to hardware devices* on page F-8 to redirect standard I/O either to the debugger or to be handled by the application itself.

See *Loading and running an application from NOR flash* on page F-13 for more information on running from flash.

Note

If the platform library encounters a fatal error, all the user LEDs flash at a one-second interval and an error message is output on UART-0.

F.3.8 Building an application that uses semihosting

The boot monitor handles semihosting SWIs the same as a debugger handles SWIs. This enables an image that is not linked against with the platform library to be loaded into flash memory and have the boot monitor manage the I/O.

All I/O using `stdio()`, for example `printf()`, uses the same devices as the boot monitor console (either UART-0 or the Keyboard/LCD depending on the Boot Monitor configuration switch settings). File functions access the flash and character I/O devices using the mechanisms described in *Redirecting character output to hardware devices* on page F-8. For example, open the character LCD by using the special file name: `CHARLCD`.

There are no specific tools requirements. Images built with RealView tools must run if they are built to use semihosting. This means that an image built using the tool kit defaults can be loaded onto the baseboard and run.

F.3.9 Loading and running an application from NOR flash

To run an image from NOR flash:

1. Build the application as described in *Building an application with the platform library* on page F-10 and specify a link address suitable for flash. There are the following options for selecting the address:

Load region in flash

The image is linked so that its load region, though not necessarily its execution region, is in flash. The load region specified when the image was linked is used as the location in flash and the `FLASH_ADDRESS` option is ignored. If the blocks in flash are not free, the command fails. Use the `FLASH RUN` command to run the image.

Load region not in flash and image location not specified

The image is programmed into the first available contiguous set of blocks in flash that is large enough to hold the image. Use the `FLASH LOAD` and then the `FLASH RUN` commands to load and run the image.

Load region not in flash, but image stored at a specified flash address

Use the `FLASH_ADDRESS` option to specify the location of the image in flash. If the option is not used, the image is programmed into the first available contiguous set of blocks in flash that is large enough to hold the image. Use the `FLASH LOAD` or `FLASH RUN` commands to load and run the image.

Note

Images with multiple load regions are not supported.

If the image is loaded into flash, but the FLASH RUN command relocates code to DRAM for execution, the execution address must not be in the top 4MBytes of DRAM because the Boot Monitor uses this.

2. The image must be programmed into flash using the Boot Monitor. Flash support is implemented in the Boot Monitor image.

Run the Boot Monitor image from the debugger and enter the flash subsystem, type FLASH at the prompt:

```
>FLASH  
flash>
```

3. The command used to program the image depends on the type of image:
 - The entry point and load address for ELF images are taken from the image itself. To program the ELF image into flash, use the following command line:

```
flash> WRITE IMAGE elf_file_name NAME name FLASH_ADDRESS address
```

- The entry point and load address for ELF images are taken from the command line options. To program a binary image into flash, use the following command line:

```
flash> WRITE BINARY image_file_name NAME name FLASH_ADDRESS address1  
LOAD_ADDRESS address2 ENTRY_POINT address3
```

Note

name is a short name for the image. If the NAME option is not used at the command prompt, then *name* is derived from the file name.

4. The image is now in flash and can be run by the Boot Monitor. At the prompt, type:

```
flash> RUN name
```

F.3.10 Running an image from MMC or SD card

To run an image from the MMC or SD card:

1. Build and link the application as described in *Loading and running an application from NOR flash* on page F-13.

———— **Note** ————

Images with multiple load regions are not supported.

The image must have an execution region in RAM or DRAM.

The execution address must not be in the top 4MBytes of DRAM because the Boot Monitor uses this area.

2. The image must be programmed into MMC or SD card using the Boot Monitor.

Connect a debugger and use semihosting to load the file:

```
>COPY C:\software\elf_file_name file_name
```

3. To run the image manually, from the debugger, or terminal connected to UART0, type:

```
>RUN file_name
```

F.3.11 Using the Network Flash Utility

This utility uses the TFTP protocol to access files over the Ethernet network. You can use this utility to program files into flash.

To connect to a server and program a file to flash:

1. Start the NFU utility from the debugger console:
 - a. Set the on setting the Boot Monitor configuration switches to force the console to use either UART-0 or the LCD and keyboard. (See *Boot Monitor configuration switches* on page F-5 for details.)

———— **Note** ————

The debugger console cannot be used because the semihosted console I/O is blocking.

- b. Start the NFU utility.

———— **Note** ————

It typically takes several seconds for NFU start. Do not enter any commands until the prompt is displayed.

- 2. Use the DHCP protocol to get an IP address by entering:
manage dhcpc start
- 3. Use the map command to map a drive letter to the TFTP server. For example to access a file on a TFTP server with the IP address 192.168.0.1, use:
manage map n: 192.168.0.1
- 4. After the drive letter has been mapped, use the normal Boot Monitor command on the remote file by specifying the drive letter. For example, to write a file to DOC, enter:
flash write image n:/hello.axf

NFU commands

The NFU supports a subset of the standard Boot Monitor commands and adds a new MANAGE sub-menu.

The NFU commands are listed in Table F-3.

Table F-3 NFU commands

Command	Action
CD <i>directory path</i>	Change directory
CONVERT BINARY <i>binary_file</i> LOAD_ADDRESS <i>address</i> [ENTRY_POINT <i>address</i>]	Provides information to the system that is required by the RUN command to execute a binary file. A new file with name <i>binary_file</i> is produced, but with an .exe file extension.
COPY <i>file1 file2</i>	Copy <i>file1</i> to <i>file2</i> . For example, to copy the leds code from the PC to the flash enter: COPY C:\software\projects\examples\rvds2.0\leds.axf leds.axf <div><div>Note</div>Remote file access requires semihosting. Use a debugger connection to provide semihosting.</div>
CREATE <i>filename</i>	Create a new file in the flash by inputting text. Press Ctrl-Z to end the file.
DELETE <i>filename</i>	Delete <i>file</i> from flash.
DIRECTORY [<i>directory</i>]	List the files in a directory. Files that only accessible from semihosting cannot be listed.

Table F-3 NFU commands (continued)

Command	Action
EXIT	Exit the NFU. The processor is held in a tight loop until it is interrupted by a JTAG debugger.
FLASH	Enter the flash file system for the NOR flash on the baseboard. See Table G-5 on page G-7 for NOR flash commands.
HELP	Lists the NFU commands.
M:	Change drive.
MANAGE	Enter the network management sub-menu. See Table F-4 for MANAGE commands.
MKDIR <i>directory path</i>	Create a new directory.
QUIT	Alias for EXIT. Exit the Boot Monitor.
RENAME <i>old_name new_name</i>	Rename flash file named <i>old_name</i> to <i>new_name</i> .
RMDIR <i>directory path</i>	Remove a directory.
SDCARD	Enter the SD card subsystem.
TYPE <i>filename</i>	Display the flash file <i>filename</i> .

The MANAGE sub-menu listed in Table F-4 contains the network management commands.

Entering MANAGE on the command line means that all future commands (until EXIT is entered) are commands from the MANAGE sub-menu.

A single command can be executed by entering MANAGE followed by the command. For example, MANAGE DHCP START gets a IP address from the DHCP server. The next command entered must be from an NFU command.

Table F-4 NFU MANAGE commands

Command	Action
ARP [-a]	Display <i>Address Resolution Protocol</i> host table.
ARP -s <i>hostname</i>	Add static entry to ARP table.
ARP -d <i>hostname</i>	Delete static entry from ARP table.

Table F-4 NFU MANAGE commands (continued)

Command	Action														
DHCPC START <i>ifname</i>	Use <i>Dynamic Host Configuration Protocol</i> (DHCP) to start a connection with the network interface <i>ifname</i> .														
DHCPC RELEASE <i>ifname</i>	Use DHCP to release the connection with the network interface <i>ifname</i> .														
DHCPC SIZEOF	Returns information on the size of the DHCP packet.														
DHCP INFORM <i>ifname ip_address</i>	Uses the DHCP protocol send information to the server located at <i>ip_address</i> with the network interface <i>ifname</i> .														
EXIT	Exit the MANAGE sub-menu. The commands listed in Table F-3 on page F-16 can be entered at the NFU prompt.														
HELP	Lists the NFU MANAGE commands.														
IFCONFIG	Displays the IP settings that are used for communications with the server.														
IFCONFIG [<i>ifname ip_address</i>]	Displays the current IP address if <i>ip_address</i> is not supplied. Otherwise, the current IP address for the interface <i>ifname</i> is set to <i>ip_address</i> .														
IFCONFIG [<i>ifname [option]</i>]	Configures the IP interface <i>ifname</i> . The value for <i>option</i> can be: <table> <tr> <td>netmask <i>maskvalue</i></td><td>set the netmask</td></tr> <tr> <td>dstaddr <i>address</i></td><td>set the destination IP address</td></tr> <tr> <td>mtu <i>n</i></td><td>set the maximum transfer unit</td></tr> <tr> <td>up</td><td>activate the interface</td></tr> <tr> <td>down</td><td>shutdown the interface</td></tr> </table>	netmask <i>maskvalue</i>	set the netmask	dstaddr <i>address</i>	set the destination IP address	mtu <i>n</i>	set the maximum transfer unit	up	activate the interface	down	shutdown the interface				
netmask <i>maskvalue</i>	set the netmask														
dstaddr <i>address</i>	set the destination IP address														
mtu <i>n</i>	set the maximum transfer unit														
up	activate the interface														
down	shutdown the interface														
MAP <i>drive address</i>	Maps the IP address specified in <i>address</i> to <i>drive</i> .														
NETSTAT [- <i>option</i>]	Displays active network connections. The value for <i>option</i> can be: <table> <tr> <td>a</td><td>display all connections</td></tr> <tr> <td>m</td><td>display all multicast connections</td></tr> <tr> <td>i</td><td>display interface information</td></tr> <tr> <td>im</td><td>display interface information for multicast</td></tr> <tr> <td>r</td><td>display routing table</td></tr> <tr> <td>s</td><td>display statistics</td></tr> <tr> <td>b</td><td>display buffer usage</td></tr> </table>	a	display all connections	m	display all multicast connections	i	display interface information	im	display interface information for multicast	r	display routing table	s	display statistics	b	display buffer usage
a	display all connections														
m	display all multicast connections														
i	display interface information														
im	display interface information for multicast														
r	display routing table														
s	display statistics														
b	display buffer usage														

Table F-4 NFU MANAGE commands (continued)

Command	Action
PING <i>ip_address</i>	Send ICMP ECHO_REQUEST packets to the network host. The data in the packet is returned by the host. Reception of the return packet indicates that the TCP/IP connection is functioning.
QUIT	Alias for EXIT. Exit the MANAGE sub-menu.
ROUTE ADD <i>type target</i> [NETMASK <i>mask</i>] <i>gateway</i>	Adds a static route to the network address specified by <i>target</i> . The gateway address is specified by <i>gateway</i> . <i>type</i> can be either -net or -host. If NETMASK is used, <i>mask</i> is the netmask for the target network address.
ROUTE DEL <i>target</i>	Deletes the static route to the network address specified by <i>target</i> .
SHOW DNS	Displays <i>Domain Name System</i> (DNS) configuration details received from DHCP.

Using a script file with NFU

When NFU starts, it attempts to run the NETSTART.BAT file in the MMC or SD card. If the script does not exist, a prompt is displayed on the console. For example, to map a drive and write a file to flash, create the following script file:

```
manage map n: 192.168.0.1
flash write image n:/hello.axf
```

After the file is executed, you can enter additional NFU commands. To run the file, reset the board and use the RUN command from Boot Monitor.

Appendix G

Boot Monitor Commands

This appendix describes Version 4 of the Boot Monitor command set. It contains the following section:

- *About Boot Monitor commands* on page G-2
- *Boot Monitor command set* on page G-3.

G.1 About Boot Monitor commands

The Boot Monitor is the standard ARM application that runs when the system is booted.

The Boot Monitor accepts user commands from the debugger console window or an attached terminal. A command interpreter carries out the necessary actions to complete the user commands.

———— **Note** ————

Commands are accepted in uppercase or lowercase. The Boot Monitor accepts abbreviations of commands if the meaning is not ambiguous. For example, for QUIT, you can type QUIT, QUI, QU, Q, quit, qui, qu, or q.

Optional parameters for commands are indicated by []. For example DIRECTORY [*directory*] indicates that the DIRECTORY command can take an optional parameter to specify which directory to list the contents of. If no parameter is supplied, the default is used (in this case, the current directory).

Type HELP at the Boot Monitor prompt to display a full list of the available commands.

G.2 Boot Monitor command set

Table G-1 Standard Boot Monitor command set

Command	Action
@ <i>script_file</i>	Runs a script file.
ALIAS <i>alias commands</i>	Create an alias command <i>alias</i> for the string of commands contained in <i>commands</i> .
CD <i>directory path</i>	Change directory.
CLEAR BOOTSCRIPT	Clear the current boot script. The Boot Monitor prompts for input on reset even if the S6-1 is set to ON to indicate that a boot script must be run.
CONFIGURE	Enter Configure subsystem. Commands listed in Table G-2 on page G-4 can now be executed.
CONVERT BINARY <i>binary_file</i> LOAD_ADDRESS <i>address</i> [ENTRY_POINT <i>address</i>]	Provides information to the system that is required by the RUN command to execute a binary file. A new file with name <i>binary_file</i> is produced, but with an .exe file extension.
COPY <i>file1 file2</i>	Copy <i>file1</i> to <i>file2</i> . For example, to copy the leds code from the PC to the MMC or SD card enter: COPY C:\software\projects\examples\rvds2.0\leds.axf leds.axf <div style="text-align: center;"> Note </div> Remote file access requires semihosting. Use a debugger connection to provide semihosting.
CREATE <i>filename</i>	Create a new file by inputting text. Press Ctrl-Z to end the file.
DEBUG	Enter the debug subsystem. Commands listed in Table G-4 on page G-6 can now be executed.
DELETE <i>filename</i>	Delete <i>file</i> from MMC or SD card.
DIRECTORY [<i>directory</i>]	List the files in a MMC or SD card directory. Files that are only accessible from semihosting cannot be listed.
DISPLAY BOOTSCRIPT	Display the current boot script.
ECHO <i>text</i>	Echo <i>text</i> to the current output device.
EXIT	Exit the Boot Monitor. The processor is held in a tight loop until it is interrupted by a JTAG debugger.
FLASH	Enter the flash file system for the NOR flash on the baseboard. See Table G-5 on page G-7 for flash commands.

Table G-1 Standard Boot Monitor command set (continued)

Command	Action
HELP [command]	List the Boot Monitor commands. Entering HELP followed by a command displays help for that command.
LOAD name	Load the image <i>name</i> into memory.
QUIT	Alias for EXIT. Exit the Boot Monitor.
RENAME old_name new_name	Rename file named <i>old_name</i> to <i>new_name</i> .
RUN image_name	Load the image <i>image_name</i> into memory and run it.
SET BOOTSCRIPT script_file	Specify <i>script_file</i> as the boot script. If the run boot script switch S4-1 is ON, <i>script_file</i> is run at system reset.
TYPE filename	Display the text file <i>filename</i> .

The Boot Monitor (version 4) includes a set of MMC or SD card commands (SDCARD). The SDCARD commands are provided in a separate sub-menu.

Table G-2 lists the commands for the SDCARD sub-menu.

Table G-2 MMC and SD card sub-menu commands

Command	Action
EXIT	Exit the SDCARD commands and return to executing standard Boot Monitor commands.
[VOLUME <i>label</i>]	Formats the card for use: QUICK – Performs a quick format by overwriting the FAT. VOLUME <i>label</i> – Sets the disk label. ———— Note ———— FAT16 8.3 format is supported up to 2GB.

HELP [command]	List the SDCARD sub-menu commands. Entering HELP followed by a command displays help for that command.
----------------	--

Table G-2 MMC and SD card sub-menu commands (continued)

Command	Action
[CSD CID SCR SDS]	Displays card information: CSD – Returns information from CSD register. CID – Returns information from CID register. SCR – Returns information from SCR register. SDS – Issues SD_STATUS command and returns results.
INITIALISE	If the card has been changed, call INITIALISE to initialize the card and the file system before using any commands, otherwise the behavior is unpredictable and the card can be corrupted. 0 – selects MCIO 1 – reserved (was for MCII on the Emulation Baseboard)
QUIT	Alias for EXIT. Exit the SDCARD commands and return to executing standard Boot Monitor commands.

Table G-3 lists the commands for the Configure sub-menu.

Table G-3 Boot Monitor Configure commands

Command	Action
DISABLE DATA CACHE	Disables the D cache.
DISABLE I CACHE	Disables the I cache.
DISABLE MMU	Disables the MMU.
DISPLAY CLOCKS	Display system clocks.
DISPLAY DATE	Display date.
DISPLAY HARDWARE	Display hardware information, for example, the FPGA revisions.
DISPLAY TIME	Display time.
ENABLE DATA CACHE	Enables the D cache.
ENABLE I CACHE	Enable the I cache.
ENABLE MMU	Enable the MMU.
EXIT	Exit the configure commands and return to executing standard Boot Monitor commands.
HELP [<i>command</i>]	List the configure commands. Entering HELP followed by a command displays help for that command.

Table G-3 Boot Monitor Configure commands (continued)

Command	Action
QUIT	Alias for EXIT. Exit the Configure commands and return to standard Boot Monitor commands.
SET BAUD port rate	Set the baud rate of the UART port specified. Valid port numbers are 0, 1, 2, 3.
SET CLOCK n FREQUENCY frequency	Set the <i>frequency</i> in MHz of the requested CLOCK n. ———— Caution ———— CLOCK 3 is the reference for the test chip and can only be directly modified if the PLL on the test chip is bypassed. See the application note for your product for more information on setting the system clock. ———— Note ———— The Boot Monitor does not set any of the clocks on startup. The clock values are determined by the default values in the FPGA image.
SET DATE dd/mm/yy	Set date. The date can also be entered as <i>dd-mm-yy</i> .
SET TIME hh:mm:ss	Set time. The time can also be entered as <i>hh-mm-ss</i> .

Table G-4 lists the commands for the Debug sub-menu.

Table G-4 Boot Monitor Debug commands

Command	Action
DEPOSIT address value [size]	Load memory specified by <i>address</i> with <i>value</i> . The <i>size</i> parameter is optional. If used, it can be BYTE, HALFWORD, or WORD. The default is WORD.
DISABLE MESSAGES	Disable debug messages.
ENABLE MESSAGES	Enable debug messages.
EXAMINE address	Examine memory at <i>address</i> .
EXIT	Exit the debug commands and return to executing standard Boot Monitor commands.
GO address	Run the code starting at <i>address</i> .
HELP [command]	List the debug commands. Entering HELP followed by a command displays help for that command.

Table G-4 Boot Monitor Debug commands (continued)

Command	Action
QUIT	Alias for EXIT. Exit the Debug commands and return to standard Boot Monitor commands.
MODIFY <i>address value mask [size]</i>	Performs read-modify-write at memory specified by <i>address</i> . The current value at the location is ORed with the result of ANDing <i>value</i> and <i>mask</i> . The <i>size</i> parameter is optional. If used, it can be BYTE, HALFWORD, or WORD. The default is WORD.
START TIMER	Start a timer.
STOP TIMER	Stop the timer started with the START TIMER command and display the elapsed time.

Table G-5 lists the commands for the NOR Flash subsystem.

Table G-5 Boot Monitor NOR flash commands

Command	Action
DISPLAY IMAGE <i>name</i>	Displays details of image <i>name</i> .
ERASE IMAGE <i>name</i>	Erase an image or binary file from flash.
ERASE RANGE <i>start [end]</i>	Erase an area of NOR flash from the <i>start</i> address to the <i>end</i> address. <div style="text-align: center;">Note</div> <p>It is only possible to erase entire blocks of flash. Therefore the entire block of flash that contains <i>start</i>, the block that contains <i>end</i> and all intervening blocks are erased. This might mean that data before <i>start</i> or after <i>end</i> is erased if they are not on block boundaries. If the optional <i>end</i> parameter is not specified, only the single block of flash that contains <i>start</i> is erased.</p> <div style="text-align: center;">Caution</div> <p>This command can erase the Boot Monitor image. See <i>Loading Boot Monitor into NOR flash</i> on page F-7.</p>
EXIT	Exit the NOR flash commands and return to executing standard Boot Monitor commands.
HELP [<i>command</i>]	List the flash commands. Entering HELP followed by a command displays help for that command.
LIST AREAS	List areas in flash. An area is one or more contiguous blocks that have the same size and use the same programming algorithm.
LIST IMAGES	List images in flash.

Table G-5 Boot Monitor NOR flash commands (continued)

Command	Action
LOAD <i>name</i>	Load the image <i>image_name</i> into memory.
QUIT	Alias for EXIT. Exit the NOR flash commands and return to standard Boot Monitor commands.
RESERVE SPACE <i>address size</i>	Reserve space in NOR flash. This space is not be used by the Boot Monitor. <i>address</i> is the start of the area and <i>size</i> is the size of the reserved area.
RUN <i>name</i>	Load the image <i>name</i> from flash and run it.
UNRESERVE SPACE <i>address</i>	Free the space starting at <i>address</i> in NOR flash. This space can be used by the Boot Monitor.
WRITE BINARY <i>file</i> [NAME <i>new_name</i>] [FLASH_ADDRESS <i>address</i>] [LOAD_ADDRESS <i>address</i>] [ENTRY_POINT <i>address</i>]	<p>Write a binary file to flash. By default, the image is identified by its file name. Use NAME <i>new_name</i> to specify a name instead of using the default name.</p> <p>Use FLASH_ADDRESS <i>address</i> to specify where in flash the image is to be located. The optional LOAD_ADDRESS and ENTRY_POINT arguments enable you to specify the load address and the entry point.</p> <p>If an entry point is not specified, the load address is used as the entry point.</p> <p>———— Note ————</p> <p>Remote file access requires semihosting. Use a debugger connection to provide semihosting.</p>
WRITE IMAGE <i>file</i> [NAME <i>new_name</i>] [FLASH_ADDRESS <i>address</i>]	<p>Write an ELF image file to flash. By default, the image is identified by its file name. For example, t:\images\boot_monitor.axf is identified as boot_monitor. Use NAME <i>new_name</i> to specify a name instead of using the default name.</p> <p>Use FLASH_ADDRESS <i>address</i> to specify where in flash the image is to be located. If the image is linked to run from flash, the link address is used and <i>address</i> is ignored.</p> <p>———— Note ————</p> <p>Remote file access requires semihosting. Use a debugger connection to provide semihosting.</p>

Appendix H

Loading FPGA Images

This section describes the format of the board files and how to use the progcards utilities to load images from the supplied CD into the baseboard and Logic Tile FPGAs and PLDs. It contains the following sections:

- *General procedure* on page H-2
- *Board files* on page H-3
- *The progcards utilities* on page H-5
- *Upgrading your hardware* on page H-6.

H.1 General procedure

The general procedure to load an image is:

1. Follow the instructions in the *Versatile CD Installation Guide* to install the software and data files on your hard disk.
2. Set up the baseboard and Logic Tile as described in *Setting up the PB1176JZF-S* on page 2-2.
3. Connect RealView ICE to the JTAG connector or use a USB cable to connect a PC to the USB Config port as described in *Connecting JTAG, Trace, and configuration equipment* on page 2-10.
4. Place the baseboard in configuration mode (FPGA Config switch ON) and power on the development system.
5. Run progcards and select the configuration that matches your board setup. See *Board files* on page H-3.
6. Run the progcards utility and load the image files into the FPGAs. See *Upgrading your hardware* on page H-6). The board file selects the image files to load. Board files have a .brd extension.

———— **Caution** ————

You are advised not to reprogram these devices with any images other than those provided by ARM Limited.

—————

7. After loading new images, set the FPGA images switches to select the appropriate image. See Chapter 2 *Getting Started*.

H.2 Board files

The CD includes both the progcards programming utilities and the images to load into the FPGAs and PLDs. See the *Application Notes* on the CD for the combination of baseboard and Logic Tile that you are using.

H.2.1 Naming conventions for board files

The file name of a board file identifies the PCB, Logic Tile, all programmable devices, and revision. Using the board file eliminates the requirement to load several individual image files. All file names are in lower case with an underscore character separating the fields:

`appnote_boardname_number_core_endian_build_devicelist.brd`

where:

<code>appnote</code>	The <i>Application Note</i> related to this board file.
<code>boardname_number</code>	The name and number identify a specific development board. For example, <code>eb_140c</code> is for the baseboard that uses PCB board HBI-140C.

———— **Note** ————

The full board number is HBI-XXXXR, this is abbreviated to the significant digits and revision, for example, HBI-0140C becomes 140C.

<code>core</code>	The name of the core that is used with this configuration. For example, <code>mpcore_li</code> identifies the ARM11 MPCore operating in little-endian mode.
-------------------	---

———— **Caution** ————

Ensure that you use the board file that matches your system configuration.

<code>buildn</code>	The build number. The number <i>n</i> increments from 0
<code>devicelist</code>	The name of the programmable devices that are specified in this file.

H.2.2 Naming conventions for image files

The image files contain the image for a single FPGA, PLD, or programmable memory device. The file name of an FPGA or PLD image file identifies the PCB, device and revision. All file names are in lower case with an underscore character separating the fields:

boardname_number_devicename_device_buildn.extension

where:

boardname_number The name and number identify a specific development board. For example, eb_140c is for the baseboard that uses PCB board HBI-140C.

devicename_device The name of the programmable devices that match this file. For example, cfg_xc2c128 identifies the Xilinx XC2C128 configuration PLD.

buildn The build number. The number *n* increments from 0

extension The type of device used by this file. For example .svf is used for PLD programming and .bit is used for FPGA programming.

Caution

The baseboard is supplied with the PLD images already programmed. The information in this section is provided, however, in case of accidental erasure of the PLDs. You are advised not to reprogram the PLDs with any images other than those provided by ARM Limited.

Using the board file to control image file loading minimizes the risk of incorrectly programming the board. The board files contains a list of correct image files and eliminates the requirement to select individual image files for the programmable devices on the baseboard or attached Logic Tile.

H.3 The progcards utilities

The progcards utilities are the primary method for programming FPGAs, configuration flash memory, and non-volatile PLDs. These utilities are used during board manufacture and to carry out field upgrades.

progcards reads a description of the board JTAG scan chain and a list of operations from a board description (*.brd) file. The file describes which bitstream and configuration files (*.bit, *.svf) must be downloaded to devices on the board.

The upgrade package for a board contains the new files and all previously released versions. This enables you to return to the original configuration.

Example H-1 Board file

```
[General]
Name = Emulation Board HPI-0140 B build 7 MPCore build working interrupts
Priority = 1
Board = Emulation_Board
[ScanChain]
TAPs = 3
TAP0 = XC2V6000
TAP1 = XC2C128
TAP2 = XC2C128
[Program]
SequenceLength = 4
Step1File = an151_eb_140b_cfg_xc2c128_build1.svf
Step1Method = PLD
Step1Tap = 1
Step2Method = Virtex2
Step2Tap = 0
Step2File = an151_eb_140b_xc2v6000_via_build1.bit
Step3Method = IntelFlash
Step3Tap = 0
Step3Address = 400000
Step3File = an151_eb_140b_ctmpcore_li_build7.bit
Step4File = an151_eb_140b_mux_xc2c128_build1.svf
Step4Method = PLD
Step4Tap = 2
```

H.4 Upgrading your hardware

Use one of the progcards utilities and the board description (*.brd) files to load configuration images to the FPGA:

progcards_rvi.exe

progcards_rvi.exe uses RealView ICE and the JTAG interface. It runs on a PC host in a DOS window and communicates with the RealView ICE interface box.

See *Procedure for progcards_rvi.exe* for detailed instructions.

progcards_usb.exe

progcards_usb.exe uses the built-in USB Config port (USB to JTAG interface logic) on the baseboard. A standard USB cable connects the baseboard to the PC running progcards_usb.exe.

See *Procedure for progcards_usb.exe* on page H-8 for detailed instructions.

Note

The latest version of the RVI firmware can be downloaded from the Technical Support area of the ARM web site.

H.4.1 Procedure for progcards_rvi.exe

1. Ensure that the RealView ICE firmware is version 1.4.1 (or later) and has the additional patch required for running progcards_rvi. The patch can be downloaded from the downloads page on the Technical Support section of the ARM web site. See the readme file supplied with progcards_rvi for information on updating the firmware.
2. Connect the 20-way JTAG cable from the RealView ICE JTAG interface to the JTAG connector on the rear panel of the micro ATX enclosure. See *About the PB1176JZF-S* on page 1-2.
3. Set the CONFIG switch to ON.
4. Turn on the power, the orange Config indicator D6.
5. Start a command window by selecting **Run** from the **Start** menu and entering command in the text box.
6. Change directory to the directory that contains board description (*.brd) files for the design to be programmed.

7. Start the programming utility by entering `progcards_rvi` at the command prompt.
8. A menu is displayed asking which interface box you want to connect to. Select the interface that connects to the baseboard.

————— Note —————

See the documentation supplied with `progcards_rvi` for information on connecting directly to a specified interface that connects to either the network or the local USB connection on the PC.

9. RVI attempts to autoconfigure. If auto-configuration fails, see the documentation supplied with `procards_rvi`.
10. `progcards_rvi` searches for board description files that match the JTAG scan chain. All board descriptions matching the first part of the chain are presented as a menu and you can select the file to use.

`progcards_rvi` runs through the steps required to completely reprogram the boards.
11. To bypass programming a Logic Tile or the baseboard select the Skip option from the menu. `progcards_rvi` then looks for board description files that match the next segment of scan chain and then the next segment until the procedure is completed. Typically one menu is displayed for the Logic Tile and one menu is displayed for the baseboard. If only one board description matches your hardware, it is automatically selected and no menu is displayed.

————— Caution —————

Ensure that the image file you are loading matches your system configuration. If the incorrect files are loaded, the baseboard and tiles might not function or might be unreliable.

12. After downloading the image completes, turn the power off and move the Config switch.
13. Set the configuration switches to match the boot option you are using. See *Setting the configuration switches* on page 2-3).
14. Power on and use the Boot Monitor to load your application. See Appendix F *Boot Monitor and platform library*.

If you are not using the Boot Monitor, use a JTAG debugger to load and run an application. See the documentation supplied with your debugger for details.

H.4.2 Procedure for progcards_usb.exe

1. If it is not already installed, install the USB Config Direct Control software.

Note

Windows USB Config drivers must be installed before using the progcards_usb utility. Information on installing the USB drivers can be found in `\boardfiles\USB_Config_driver\readme.txt`.

2. Connect the USB cable from the host PC to the USB Config port on the front panel of the micro ATX enclosure. See *About the PB1176JZF-S* on page 1-2.
3. Set the CONFIG switch to ON.
4. Turn on the power. The orange Config LED lights.
5. Start a command window by selecting **Run** from the **start** menu and entering command in the text box.
6. Change directory to the directory that contains board description (*.brd) files for the design to be programmed.
7. Start the programming utility by entering progcards_usb at the command prompt.

Note

If progcards_usb.exe is not in the current working directory, set your PATH environment variable to point to the directory that contains progcards_usb.exe.

8. Progcards_usb searches for board description files that match the scan chain. All board descriptions matching the first part of the chain are presented as a menu and you can select the file to use.

progcards_usb runs through the steps required to completely reprogram the boards.
9. To bypass programming a Logic Tile or the baseboard select the Skip option from the menu. progcards_usb then looks for board description files that match the next segment of scan chain and then the next until the process is completed.

Typically one menu is displayed for the Logic Tile and one menu is displayed for the baseboard. If only one board description matches your hardware, it is automatically selected and no menu is displayed.
10. After downloading the image completes, turn the power off and move the Config switch to the OFF position.

11. Set the configuration switches to match the boot option you are using. See *Setting the configuration switches* on page 2-3.
12. Power on the board and use the Boot Monitor to load your application. See Appendix F *Boot Monitor and platform library*.

If you are not using the Boot Monitor, use a JTAG debugger to load and run an application. See the documentation supplied with your debugger for details.

H.4.3 Troubleshooting

If the upgrade process fails at any time, or the progcards utility reports an error, then check the following:

1. The Config switch is ON and the orange Config LED is on.
2. If you are using progcards_rvi.exe, see the documentation supplied with progcards_rvi.
3. If you are using progcards_usb.exe ensure that:
 - a. the USB cable is plugged into the USB Config port.
 - b. the USB Config drivers are installed on your machine.
4. Ensure that any Logic Tiles are correctly stacked on the baseboard. If necessary, push them firmly to ensure a proper connection.
5. Look for any readme.txt files that might be present in the directory that contains the board description (*.brd) files. Follow the instructions provided for new or updated software or engineering changes.

Caution

The 1.5V cell battery provides the **VBATT** backup voltage to the external DS1338 time-of-year clock and FPGA encryption key circuitry within the FPGA. Removing the battery erases the encryption key.

See *FPGA configuration* on page 3-30 for details safely replacing the battery.

Glossary

This glossary lists abbreviations used in this guide.

ADC	<i>Analog to Digital Converter.</i> A device that converts an analog signal into digital data.
AACI	<i>Advanced Audio CODEC Interface.</i>
AHB	<i>Advanced High-performance Bus.</i> The ARM open standard for on-chip buses.
AMBA	<i>Advanced Microcontroller Bus Architecture.</i>
APB	<i>Advanced Peripheral Bus.</i> The ARM open standard for peripheral buses. This design is optimized for low power and minimal interface complexity.
APC	<i>Advanced Power Controller.</i> National Semiconductor device used to monitor and control power. This is used by the IEM subsystem.
AXD	<i>ARM eXtended Debugger.</i>
AXI	<i>Advanced eXtensible Interface.</i> The ARM open standard for high-performance and high-frequency buses.
BOM	<i>Bill Of Materials.</i> A list of all the parts used on the printed circuit board and any specific build instructions for board variants.

CLCD	<i>Color Liquid-Crystal Display.</i>
CODEC	<i>COder DECoder</i> for converting between analog and digital audio signals.
DAC	<i>Digital to Analog Converter.</i> A device that converts digital data into analog level signals.
DCC	<i>Debug Communications Channel.</i>
DDR	<i>Double Data Rate</i> , DRAM with high-speed data access.
DOC	<i>Disk-On-Chip.</i> A non-volatile flash memory device with an interface that simplifies file accesses. Also called NAND flash referring to the logic gates used internally. The memory can only be accessed sequentially in blocks.
DMC	<i>Dynamic Memory Controller.</i>
DRAM	<i>Dynamic Random Access Memory.</i>
DSR	<i>Data Set Ready</i> , a UART flow-control signal.
DTR	<i>Data Terminal Ready</i> , a UART flow-control signal.
ETB	<i>Embedded Trace Buffer.</i>
ETM	<i>Embedded Trace Macrocell.</i>
FET	<i>Field Effect Transistor.</i>
FPGA	<i>Field Programmable Gate Array.</i>
GIC	<i>Generic Interrupt Controller.</i>
GPIO	<i>General Purpose Input/Output.</i>
GTC	<i>Generic Test Chip.</i> A packaging and signal assignment specification for test chips.
ICE	<i>In Circuit Emulator.</i> A interface device for configuring and debugging processor cores.
IEM	<i>Intelligent Energy Management.</i> A system for monitoring and controlling chip voltages and frequencies to reduce power consumption.
I/O	<i>Input/Output.</i>
IP	<i>Intellectual Property.</i>
JTAG	<i>Joint Test Action Group.</i> The committee which defined the IEEE test access port and boundary-scan standard.
KMI	<i>Keyboard/Mouse Interface.</i>
LCD	<i>Liquid Crystal Display.</i>

LED	<i>Light Emitting Diode.</i>
MAC	<i>Media Access Control.</i> A layer in the Ethernet specification.
MCI	<i>MultiMedia Card Interface.</i>
MMC	<i>MultiMedia Card.</i>
Multi-ICE	Multi-ICE is a system for debugging embedded processor cores using a JTAG interface. See ICE.
NAND flash	Non-volatile memory. <i>NAND</i> refers to the type of logic gate used internally. See <i>DOC</i> .
NOR flash	Non-volatile memory. <i>NOR</i> refers to the type of logic gate used internally. Any memory address can be accessed randomly.
OTG	<i>On-The-Go</i> , a USB specification.
PCB	<i>Printed Circuit Board.</i>
PCI	<i>Peripheral Component Interconnect.</i> A computer bus for attaching peripherals.
PHY	<i>PHYsical</i> layer. The layer in the Ethernet specification that describes the physical interface.
PISMO	<i>Platform Independent Storage Module.</i> Memory specification for plug in memory modules.
PLD	<i>Programmable Logic Device.</i>
PLL	<i>Phase-Locked Loop</i> , a type of programmable oscillator.
POR	<i>Power On Reset.</i>
RAM	<i>Random Access Memory.</i>
RVI	<i>RealView ICE.</i> A system for debugging embedded processor cores using a JTAG interface. See also ICE.
RTC	<i>Real-Time Clock.</i>
RVD	<i>RealView Debugger.</i>
SRAM	<i>Static Random Access Memory.</i>
SBZ	<i>Should be Zero.</i> Indicates that the bit in the register is reserved and must be set to zero.
SCI	<i>Smart Card Interface.</i>
SD	<i>Secure Digital</i> memory card specification.
SMC	<i>Static Memory Controller.</i>

SMM	<i>Soft Macrocell Model</i> of a CPU core.
SSP	<i>Synchronous Serial Port.</i>
TCM	<i>Tightly Coupled Memory.</i> Memory present inside the test chip that typically runs at or near the processor speed.
TPA	<i>Trace Port Analyzer.</i>
TrustZone	ARM TrustZone technology is a key enabling technology for securing consumer products such as mobile phones, PDAs, set top boxes or other systems running open Operating Systems.
UART	<i>Universal Asynchronous Receiver/Transmitter.</i>
USB	<i>Universal Serial Bus.</i>
VGA	<i>Video Graphics Array.</i>